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(12) **United States Patent**  
**Snider**

(10) **Patent No.:** **US 9,271,430 B2**  
(45) **Date of Patent:** **Feb. 23, 2016**

(54) **FLEXIBLE ELECTRONIC CIRCUIT ENCLOSURE ASSEMBLY**

USPC ..... 174/50, 520, 559, 560, 350, 377, 382, 174/386, 391, 394, 535; 220/3.2, 3.3, 4.02; 361/600, 601, 816, 679.01, 679.02, 361/724, 730, 800.76; 248/27.1, 27.3; 439/76.1, 76.2; 29/592.1

(75) Inventor: **Chris R. Snider**, Noblesville, IN (US)

(73) Assignee: **Delphi Technologies, Inc.**, Troy, MI (US)

See application file for complete search history.

(\* ) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 103 days.

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*Primary Examiner* — Angel R Estrada

(74) *Attorney, Agent, or Firm* — Lawrence D. Hazelton

(21) Appl. No.: **14/000,763**

(22) PCT Filed: **Mar. 9, 2012**

(86) PCT No.: **PCT/US2012/028416**

§ 371 (c)(1),  
(2), (4) Date: **Aug. 21, 2013**

(87) PCT Pub. No.: **WO2012/125436**

PCT Pub. Date: **Sep. 20, 2012**

(65) **Prior Publication Data**

US 2013/0333941 A1 Dec. 19, 2013

**Related U.S. Application Data**

(60) Provisional application No. 61/451,795, filed on Mar. 11, 2011.

(51) **Int. Cl.**  
**H05K 9/00** (2006.01)  
**H05K 13/00** (2006.01)

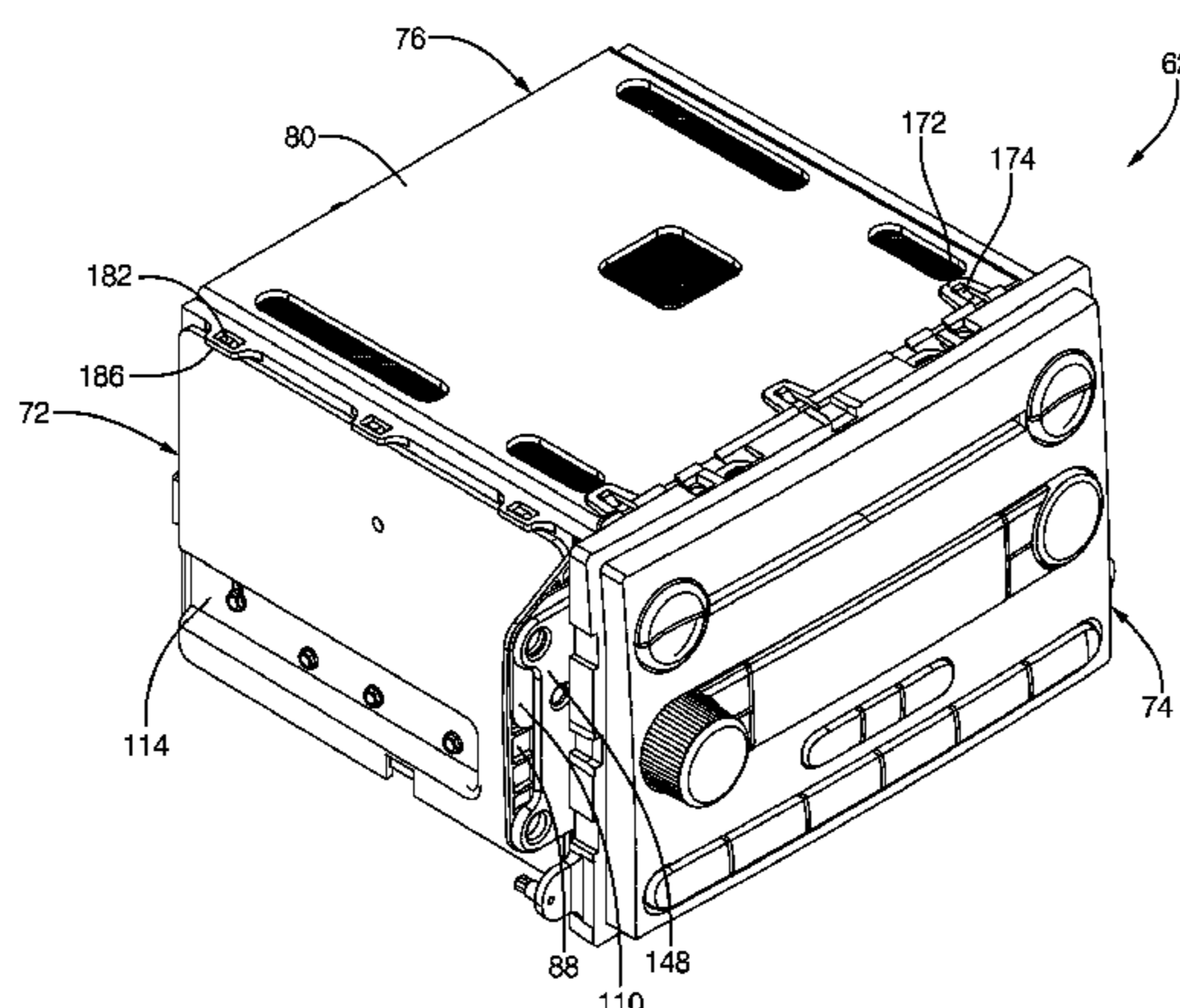
(52) **U.S. Cl.**  
CPC ..... **H05K 9/0007** (2013.01); **H05K 9/0043** (2013.01); **H05K 13/00** (2013.01); **Y10T 29/49002** (2015.01)

(58) **Field of Classification Search**  
CPC ..... H02G 3/08; H02G 3/081; H02G 3/086; H02G 3/088; H05K 5/00; H05K 5/02; H05K 5/04; H05K 9/00; H05K 9/0007; H05K 13/00; H05K 9/0043; H01H 9/02; H01H 9/04; Y10T 29/49002

(57) **ABSTRACT**

A flexible enclosure assembly for an electronic device for vehicular application is virtually “fastenerless” and includes a preform blank of conductive sheet material such as wire screen mesh or the like which defines upper, lower and a plurality of side wall portions flexibly interconnected by living hinges. A framework of resilient elastomeric material is insert molded to the preform blank to provide three-dimensional case details to accept one or more electronic devices such as circuit boards required for electrical control and display of vehicle based systems. The conductive sheet material is preferably a wire mesh which provides shielding from electrical anomalies and grounding of the circuit boards via exposed wire mesh pads and adjacent ground clips. Major components and subassemblies are self-fixturing during the final assembly process, eliminating the need for dedicated tools, fixtures and assembly equipment.

**22 Claims, 59 Drawing Sheets**



(56)

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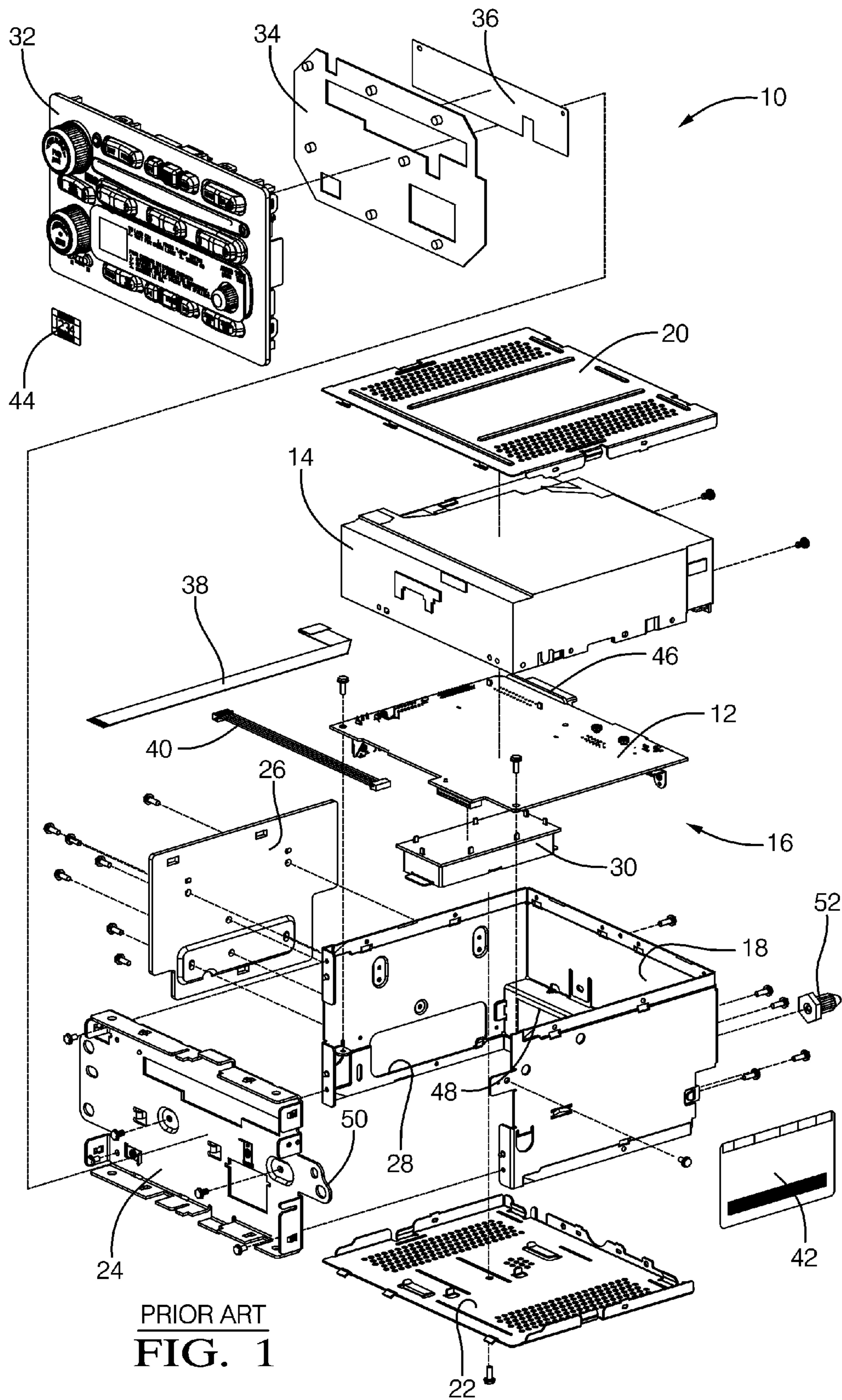
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PRIOR ART  
**FIG. 1**



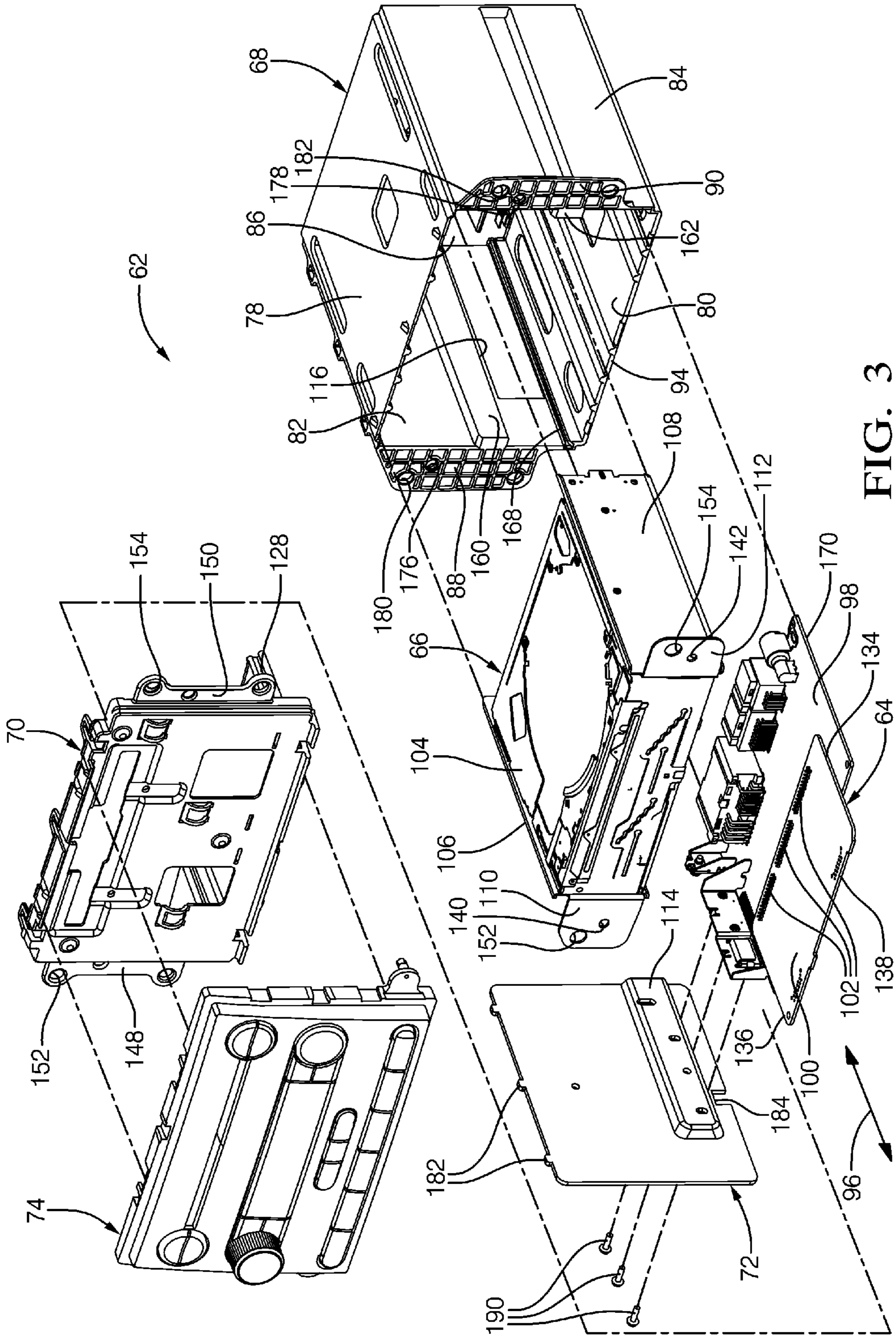


FIG. 3

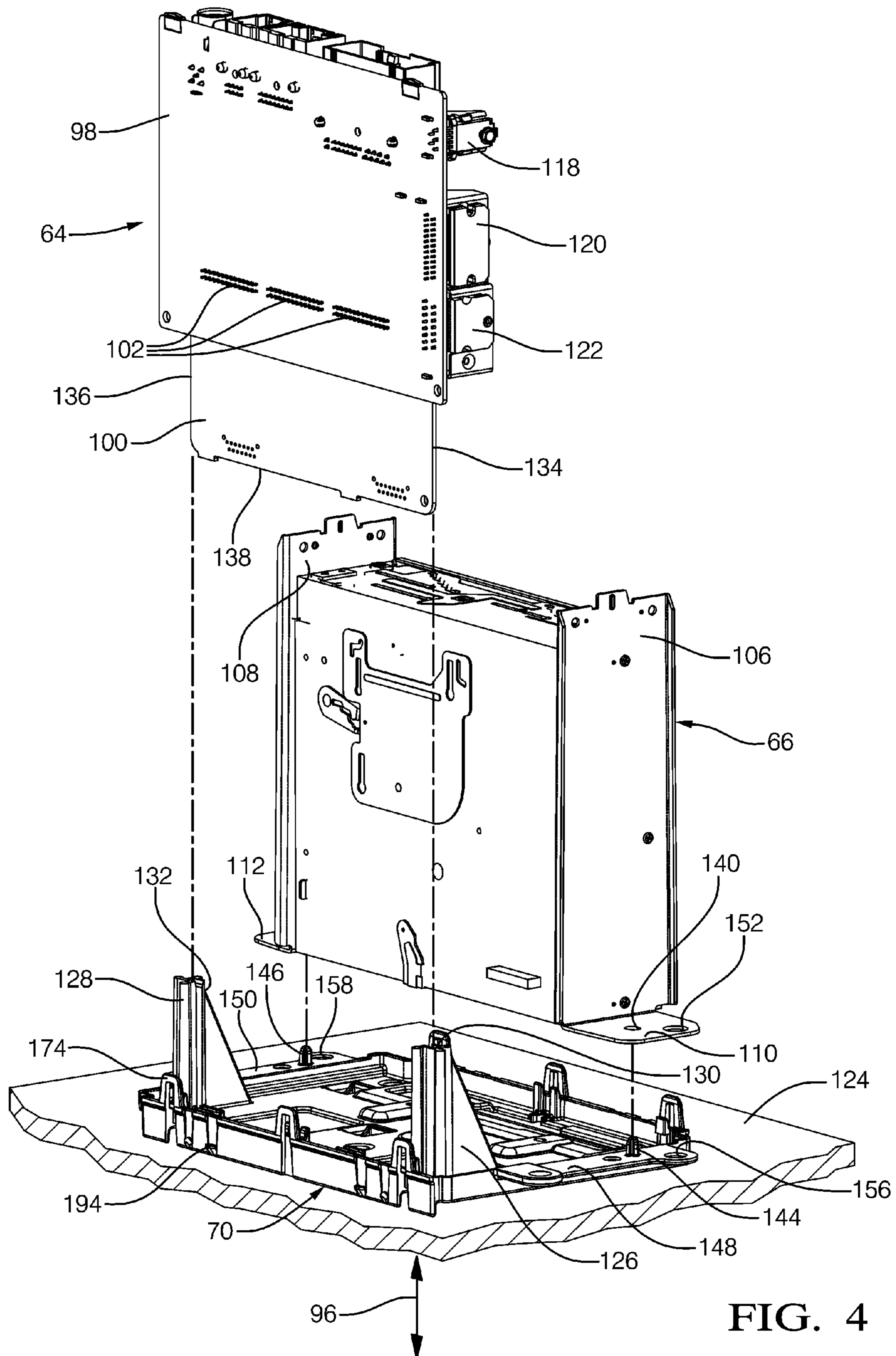


FIG. 4

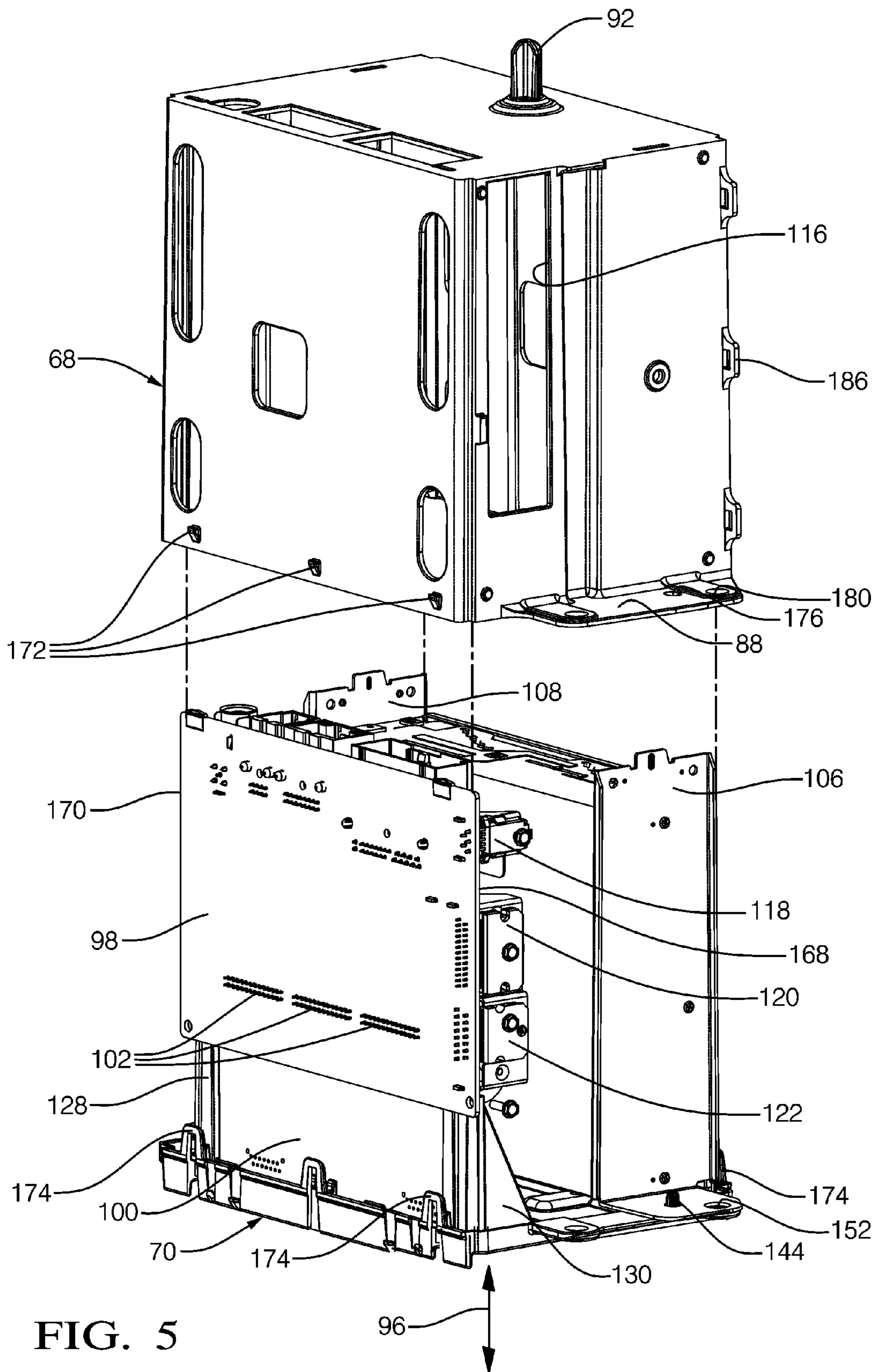


FIG. 5

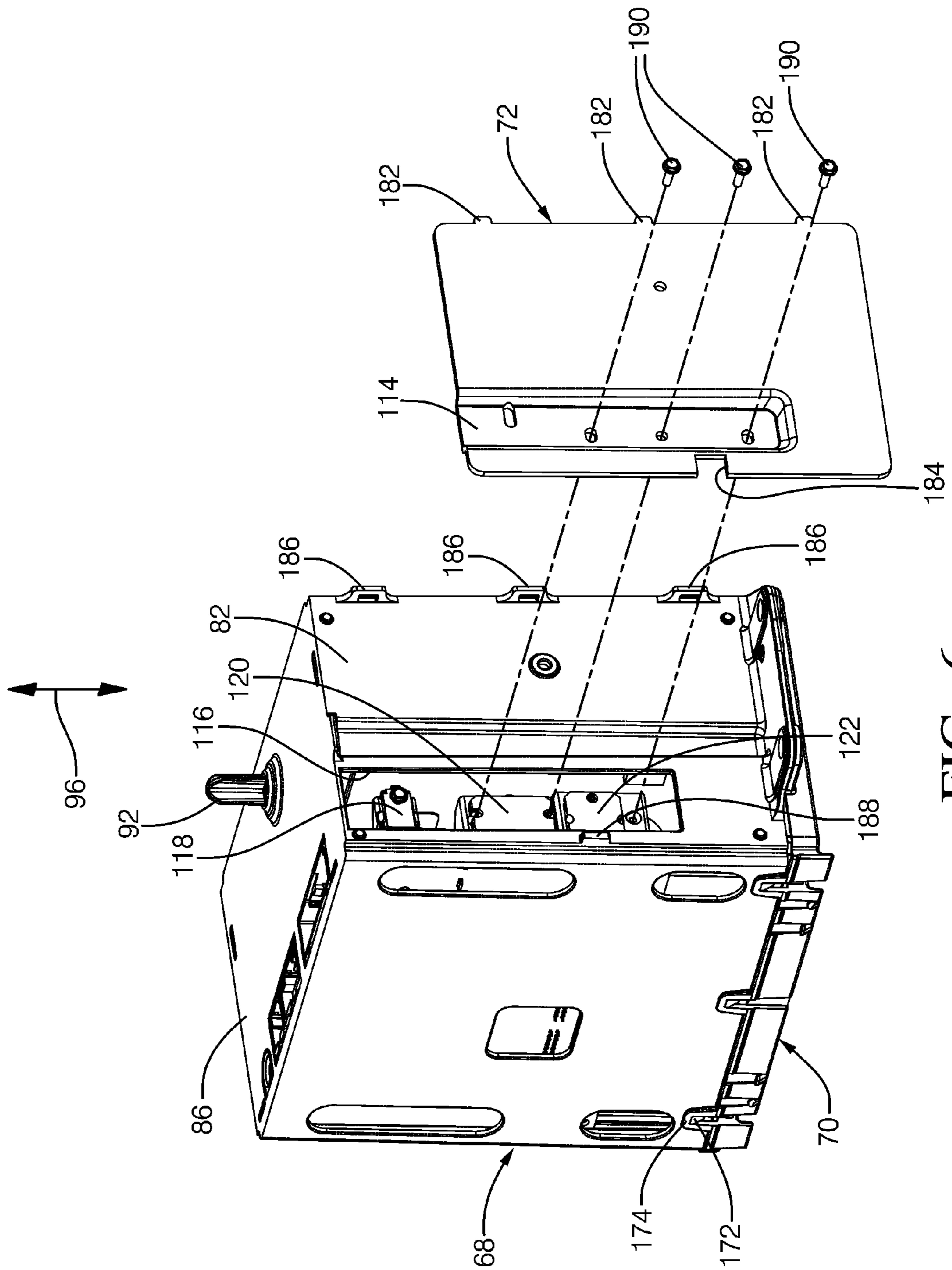


FIG. 6



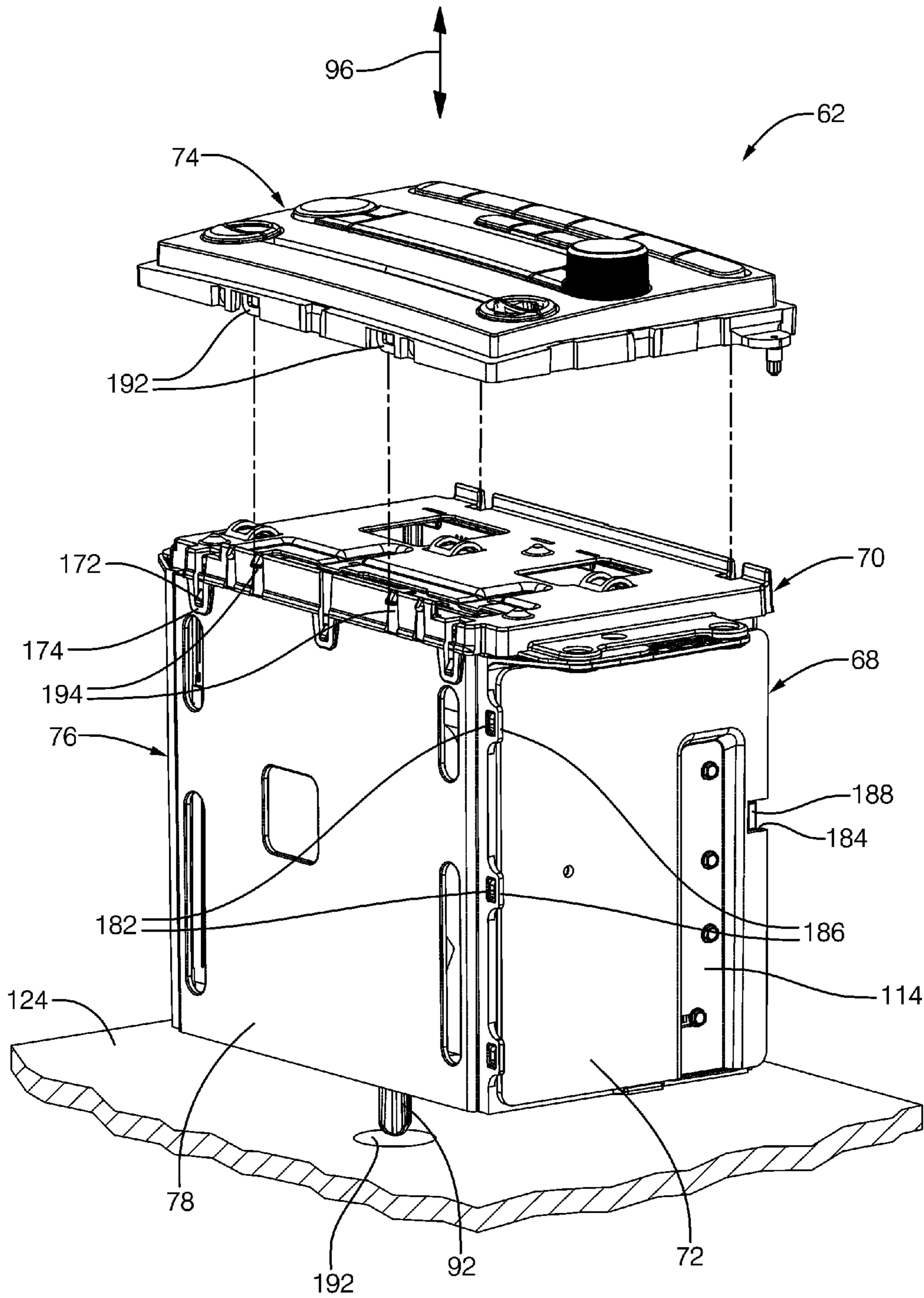


FIG. 7

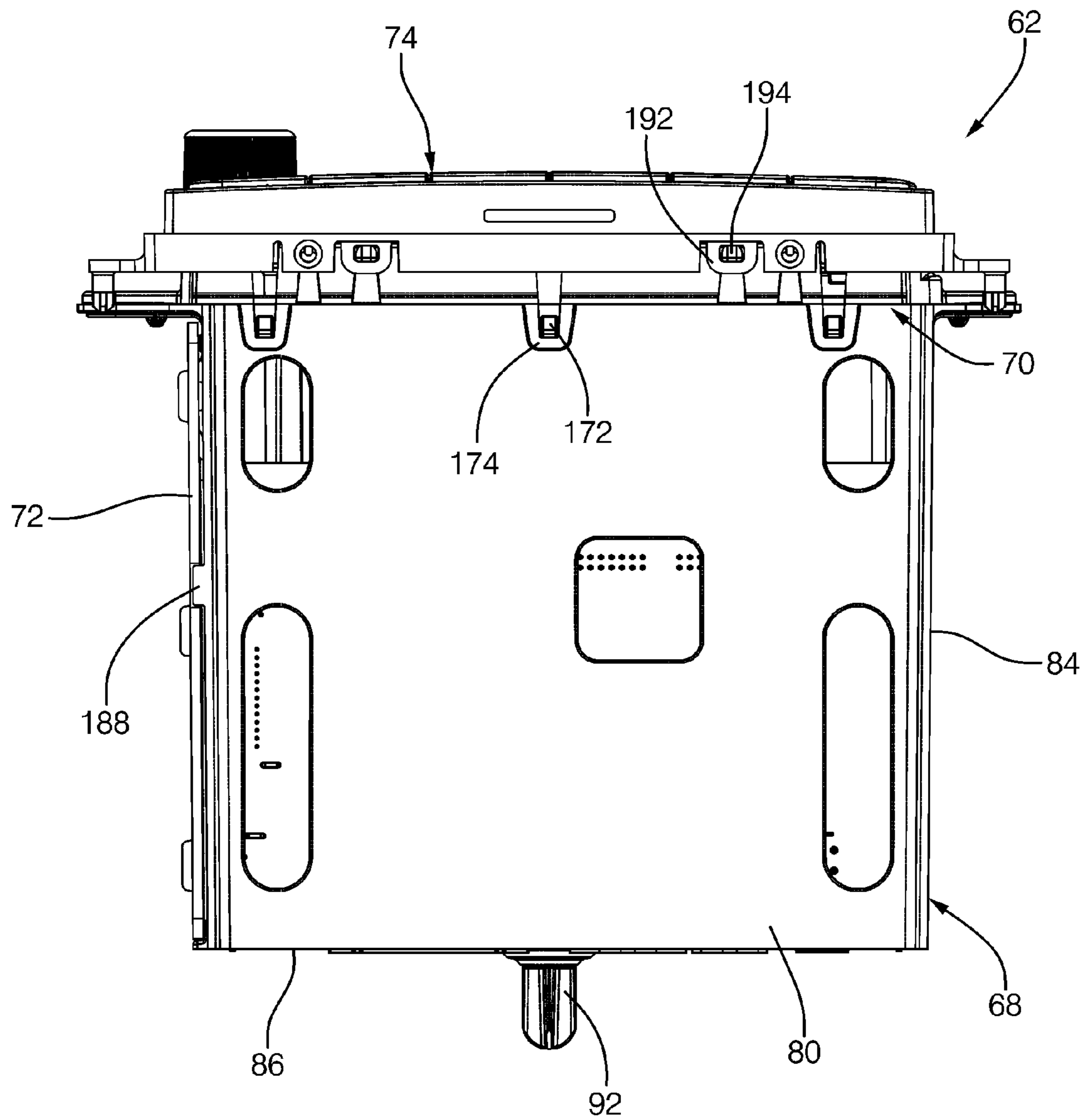


FIG. 8

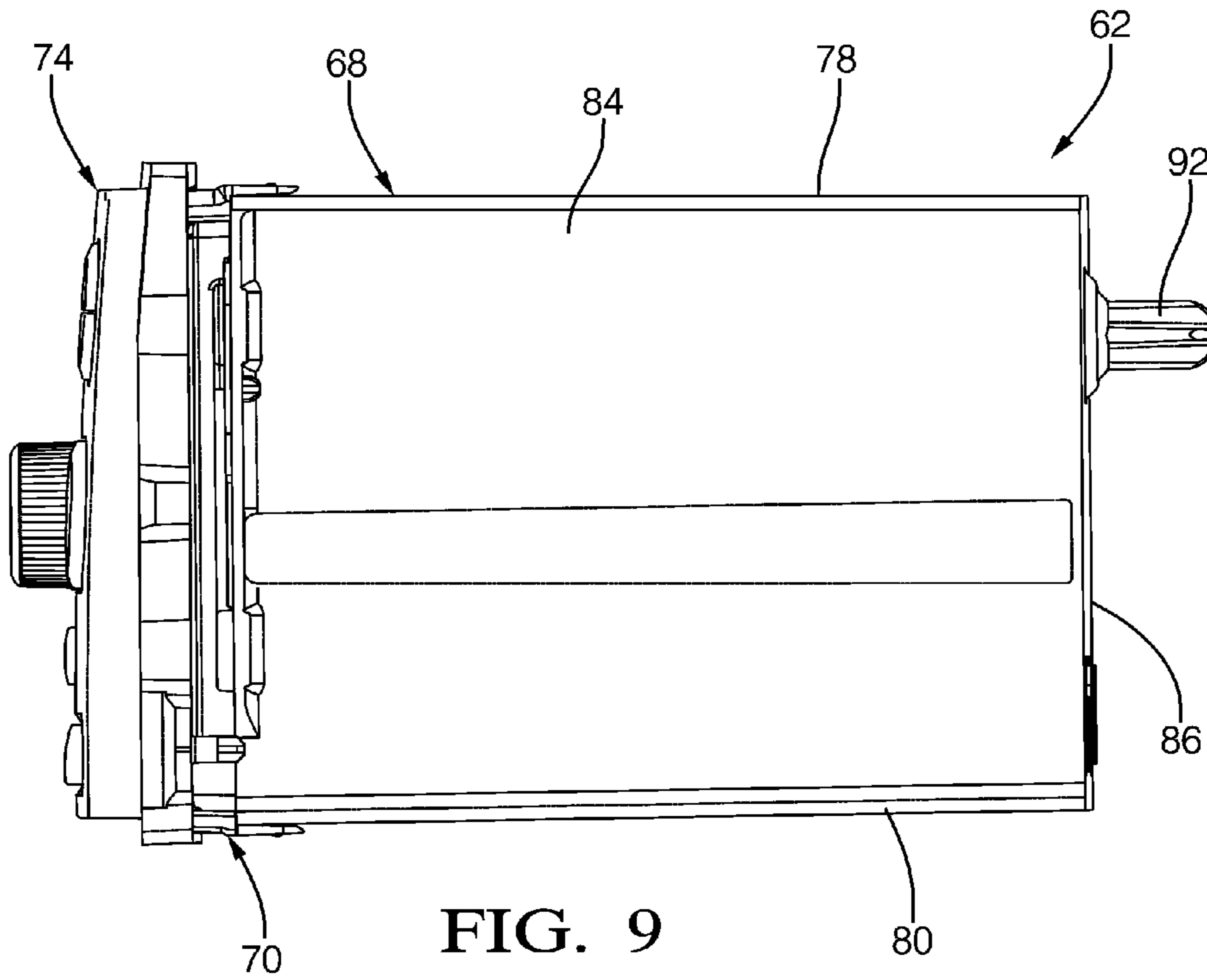


FIG. 9

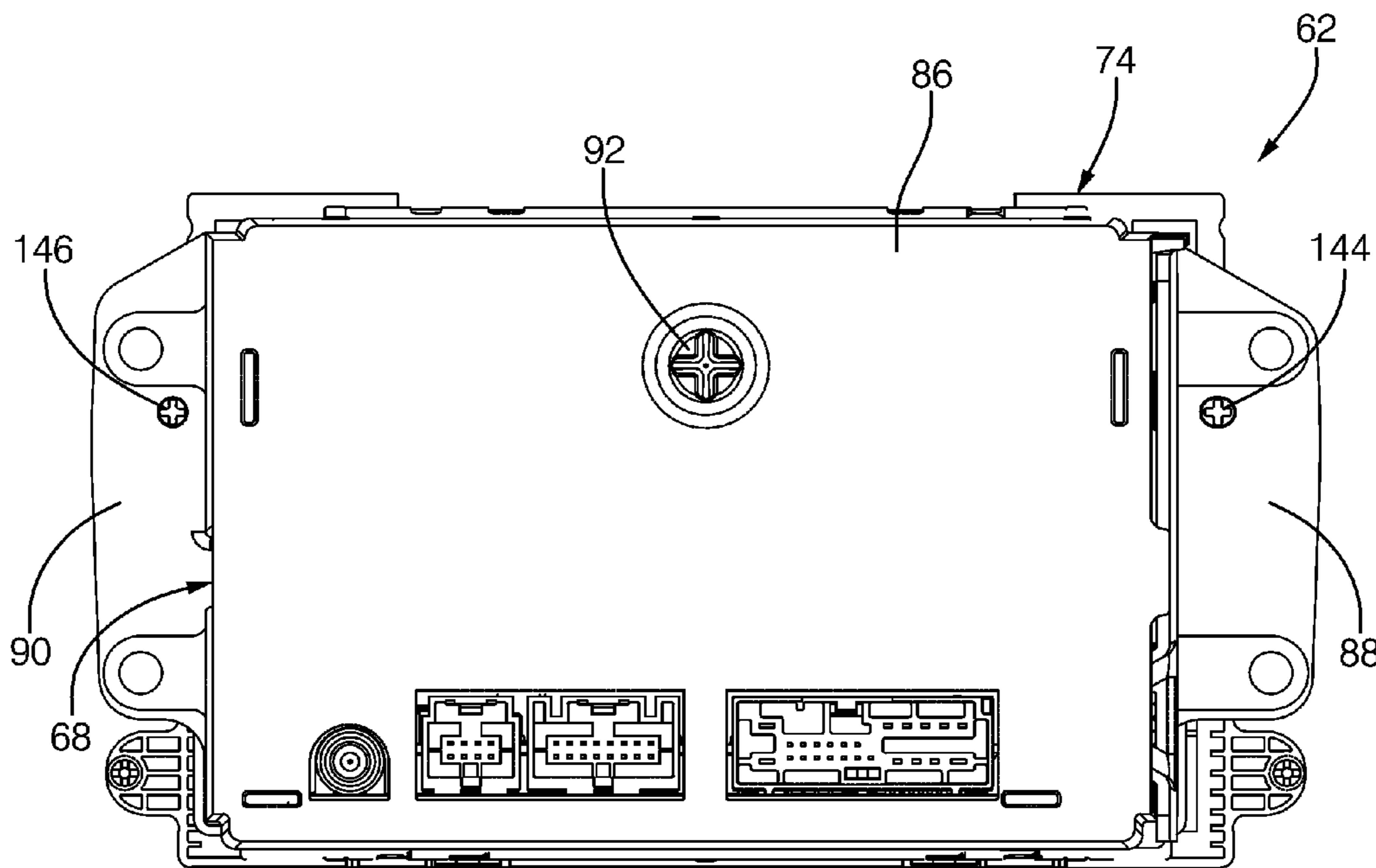


FIG. 10

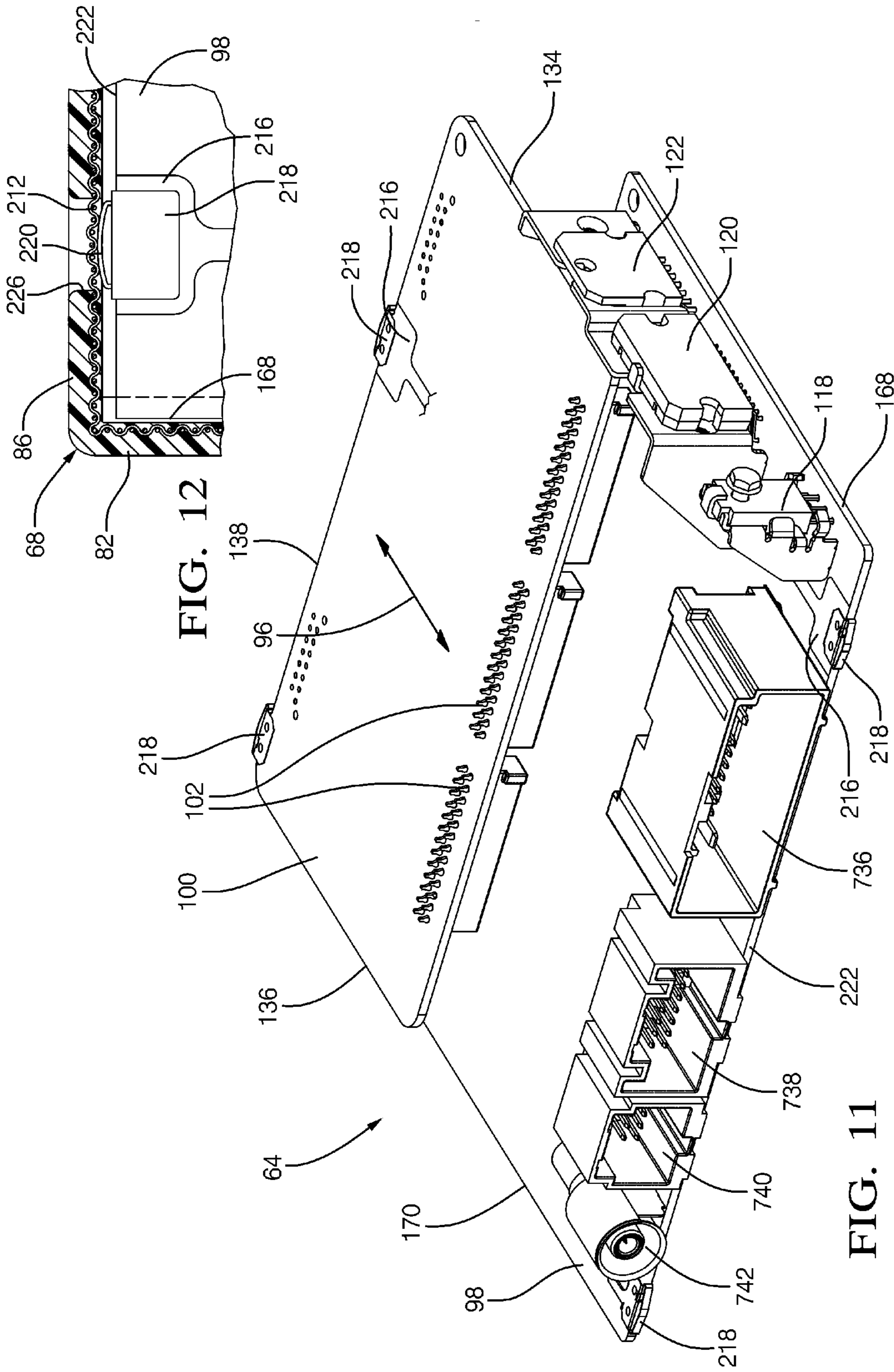


FIG. 12

FIG. 11

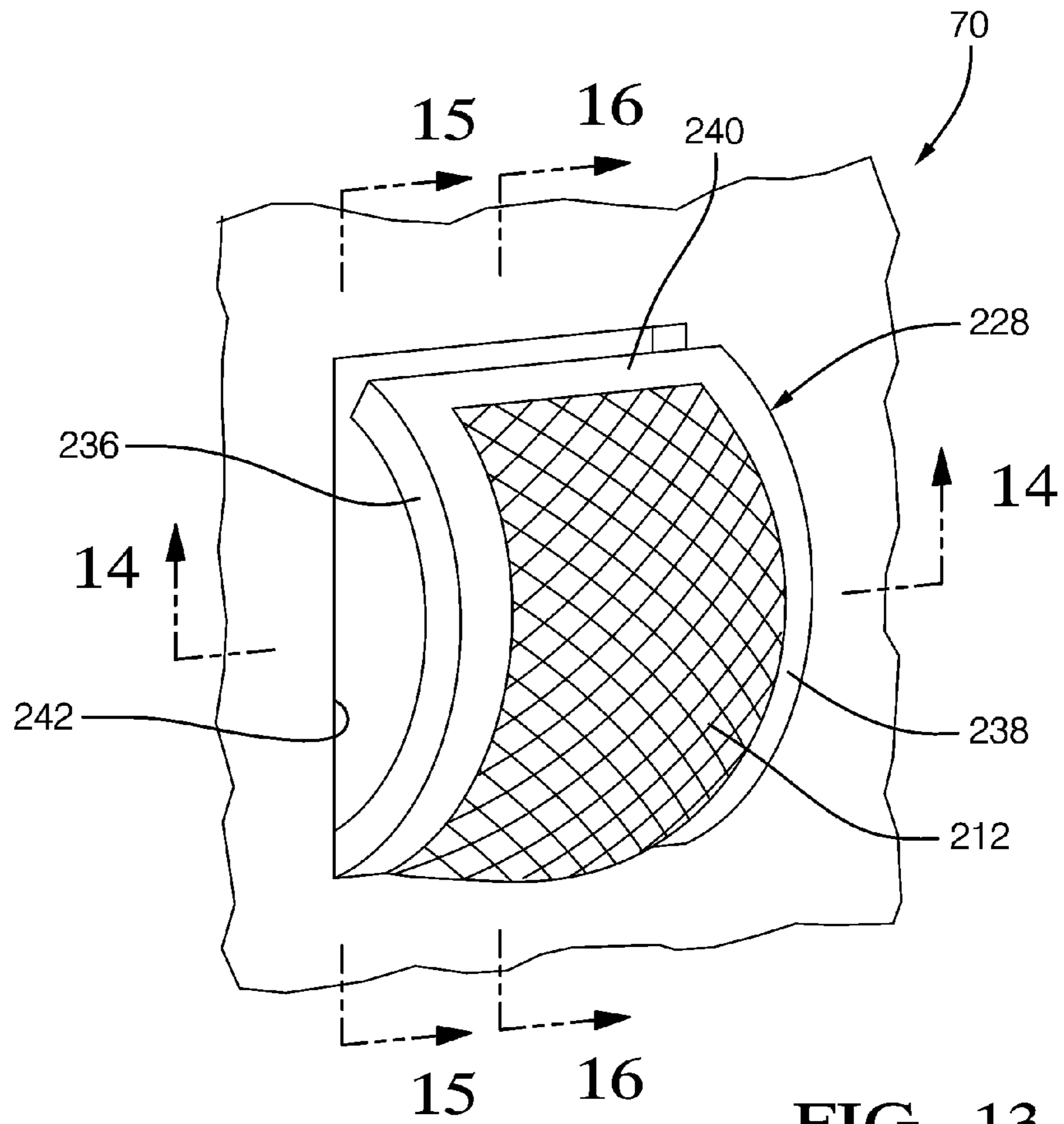


FIG. 13

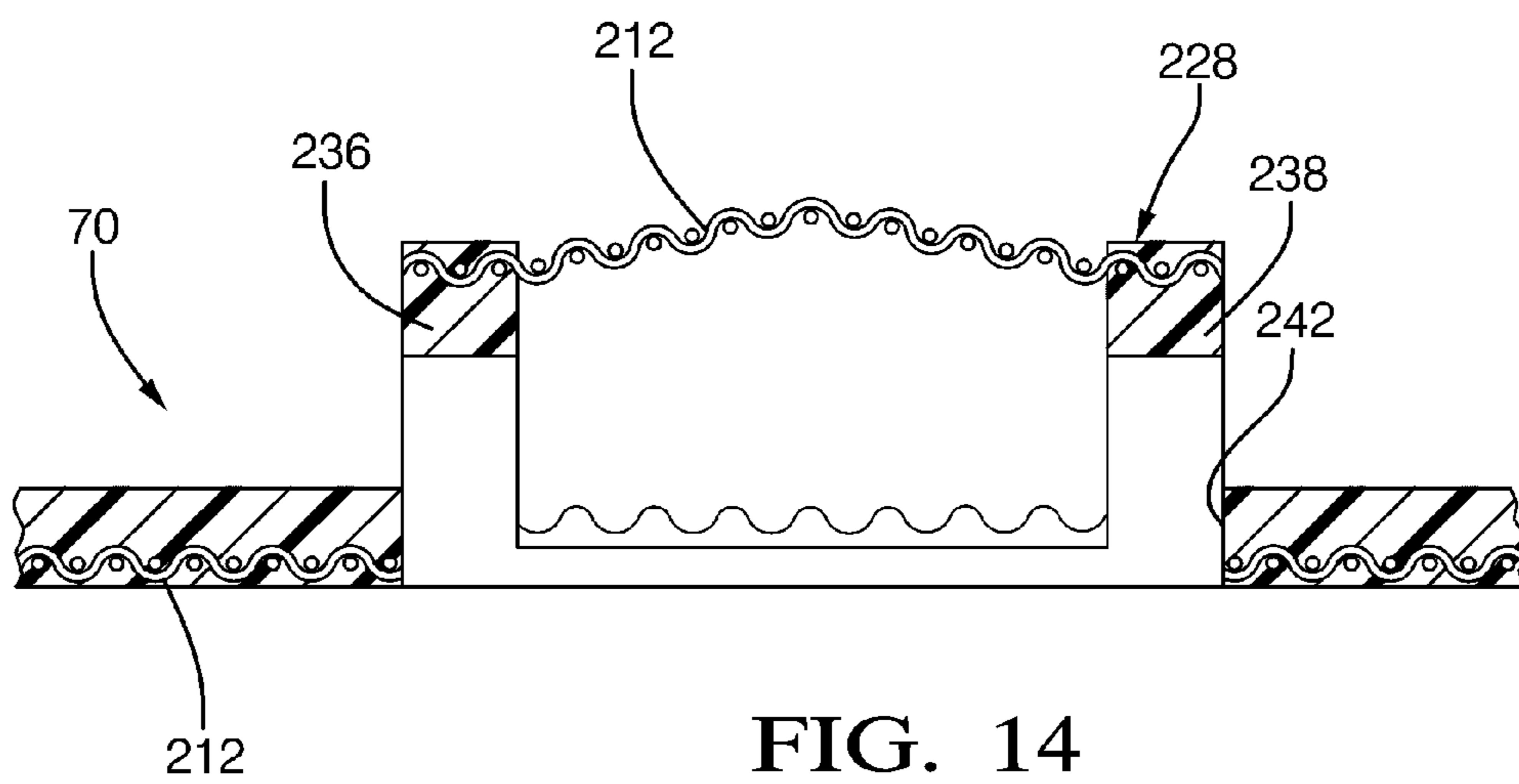


FIG. 14

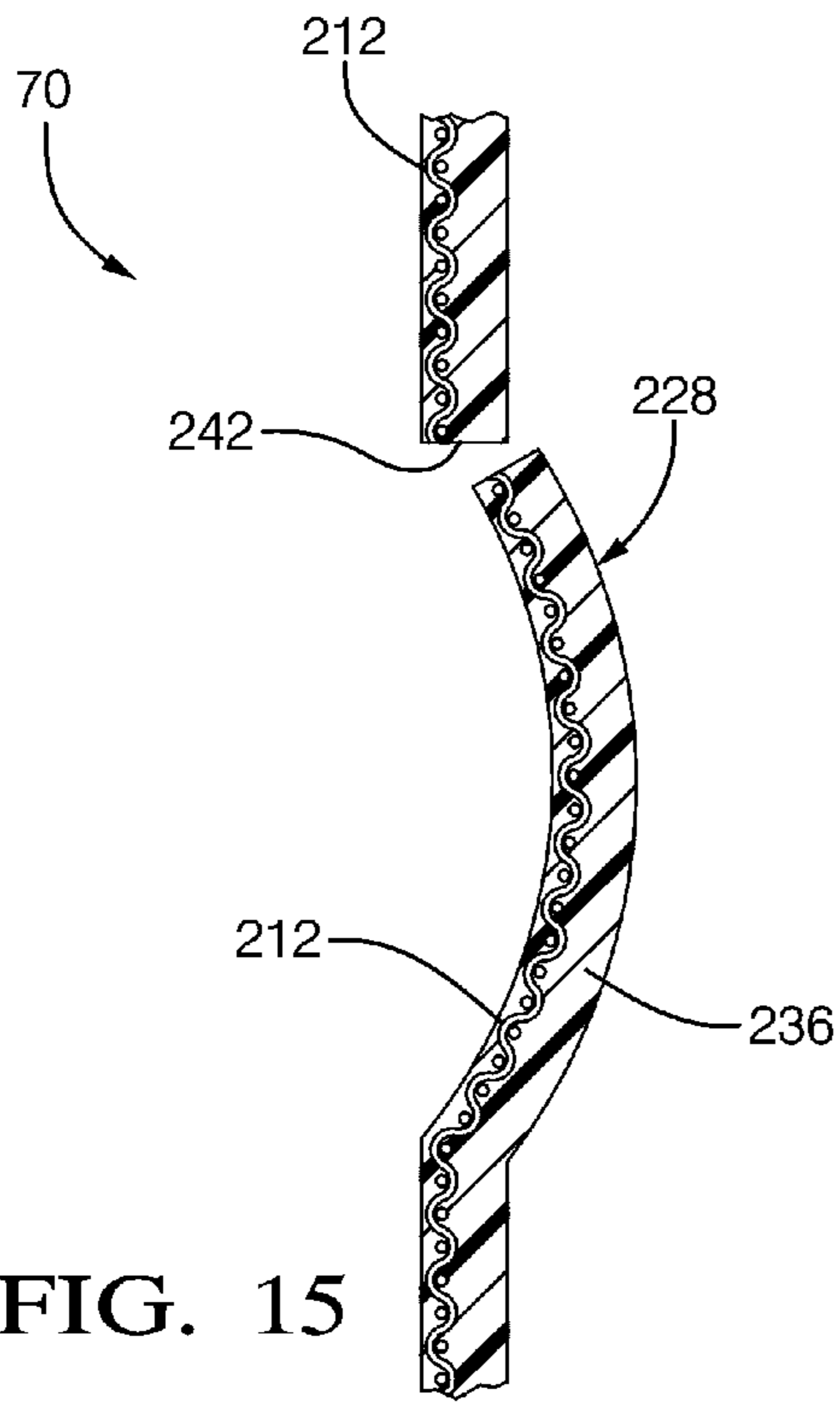


FIG. 15

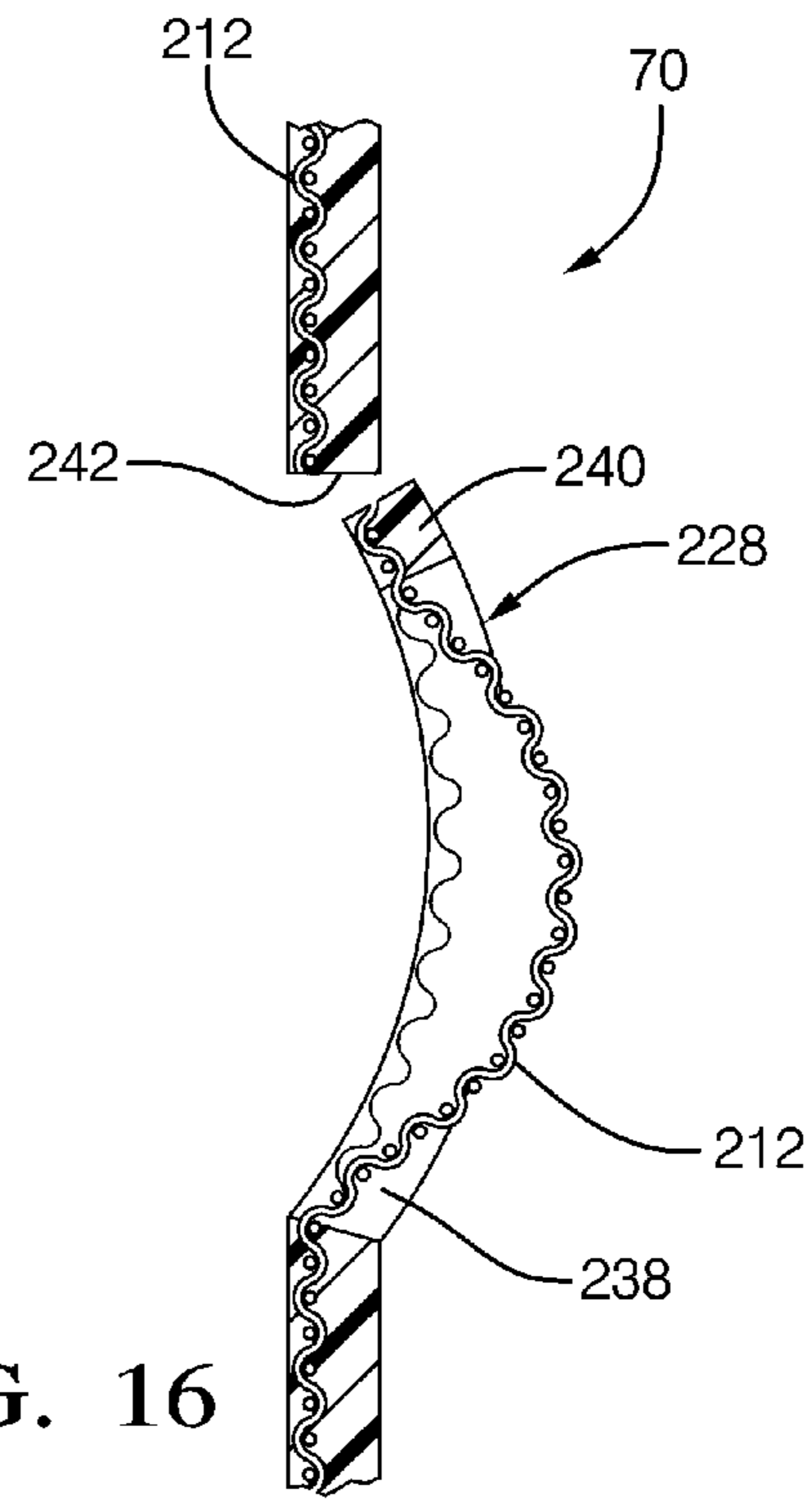
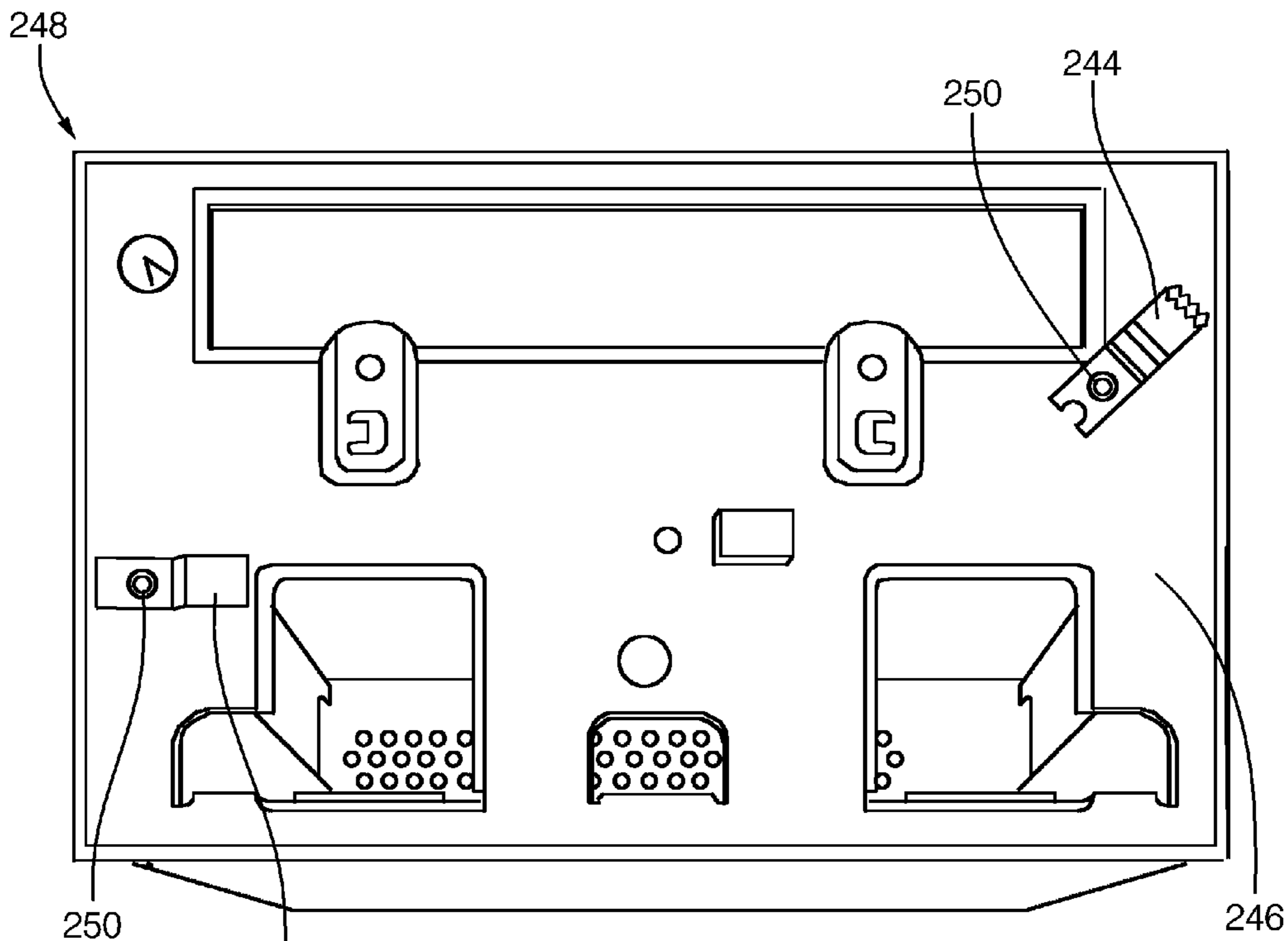


FIG. 16



PRIOR ART  
FIG. 17

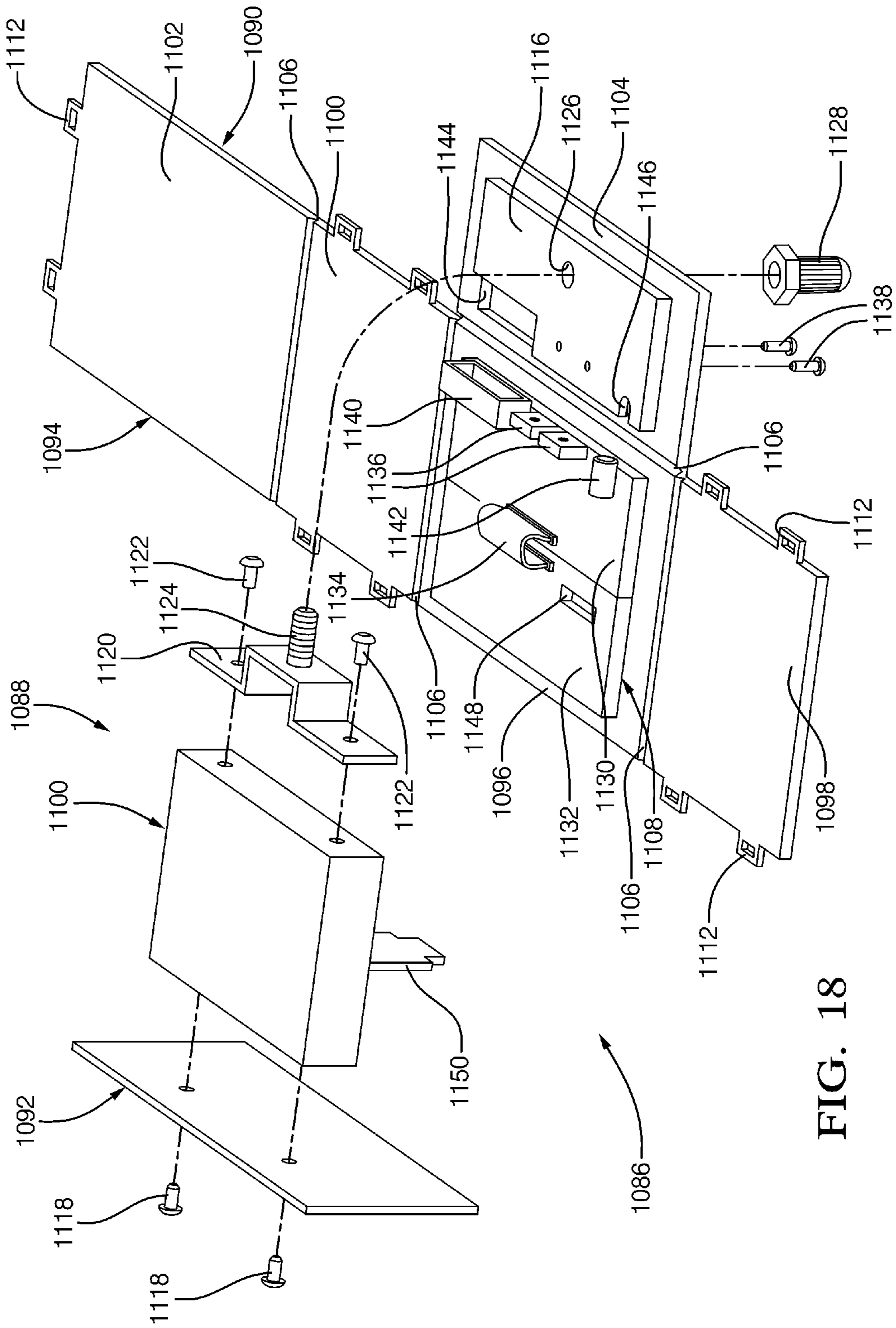


FIG. 18

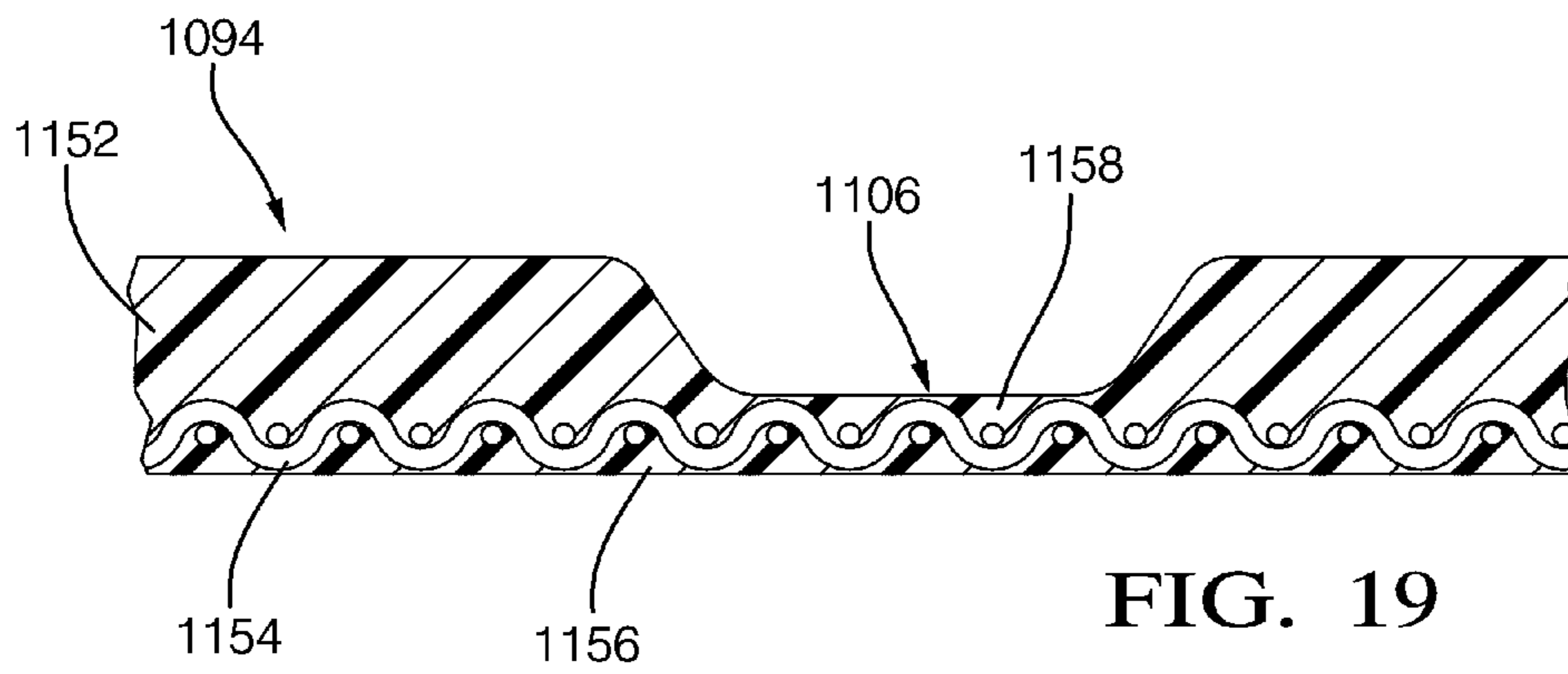


FIG. 19

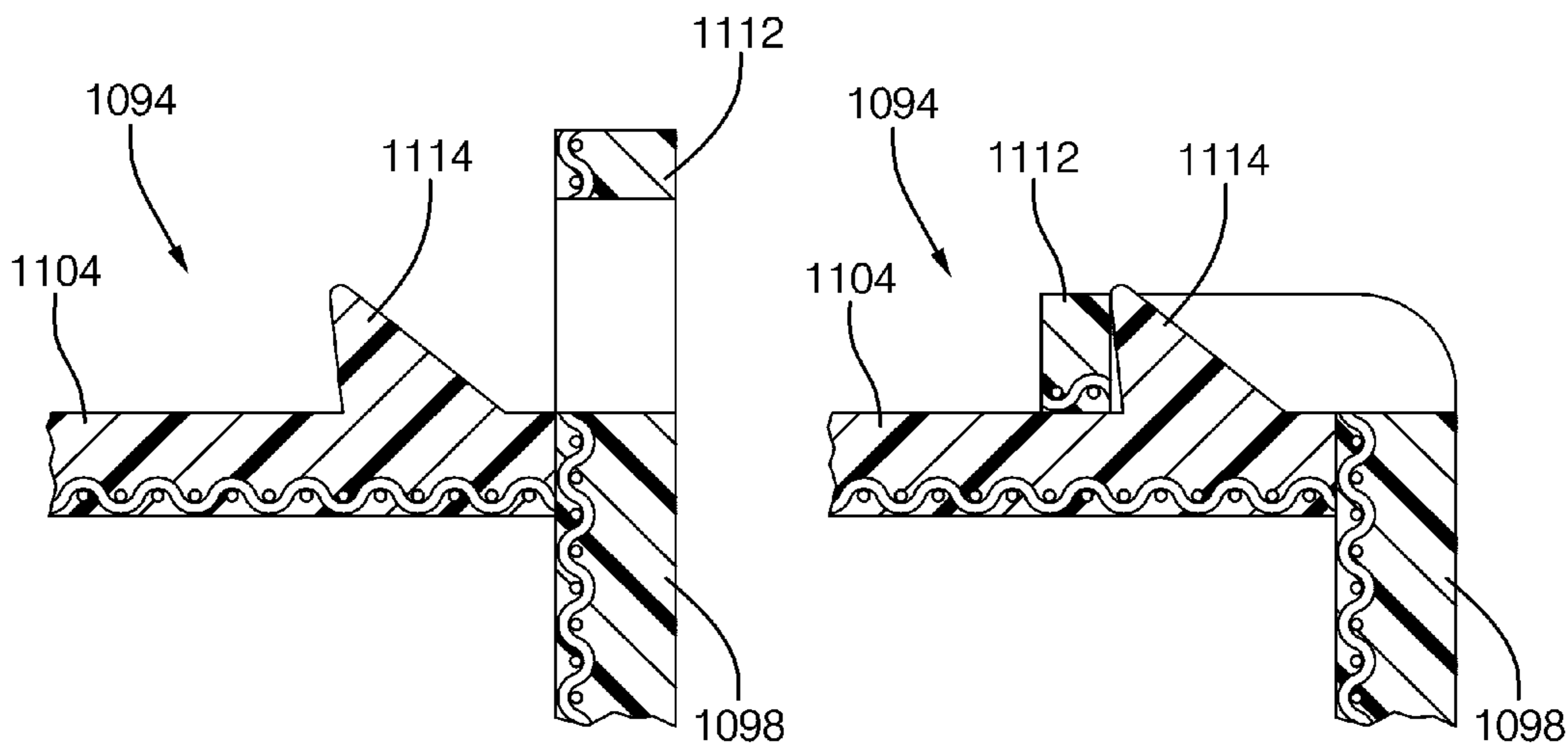


FIG. 20

FIG. 21

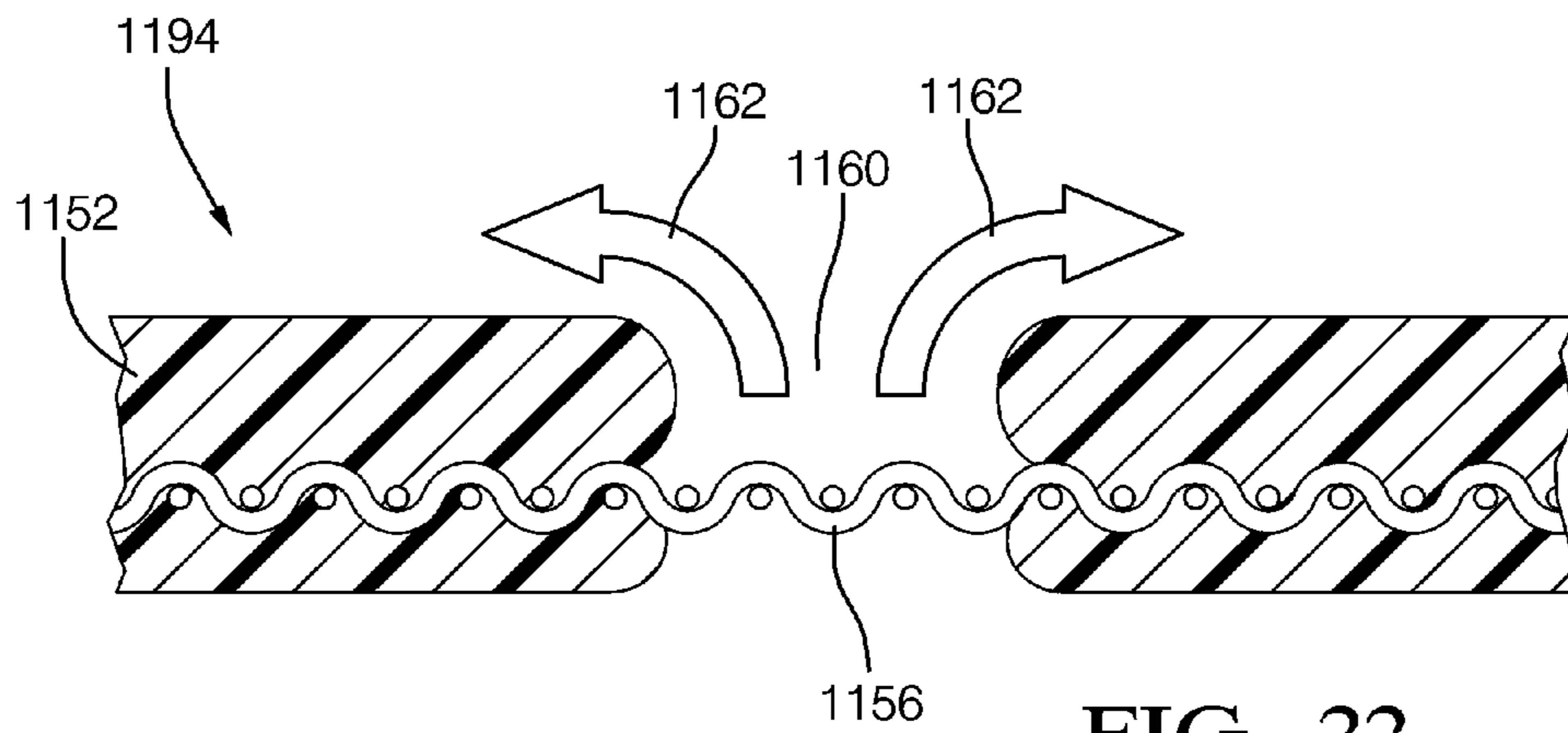


FIG. 22



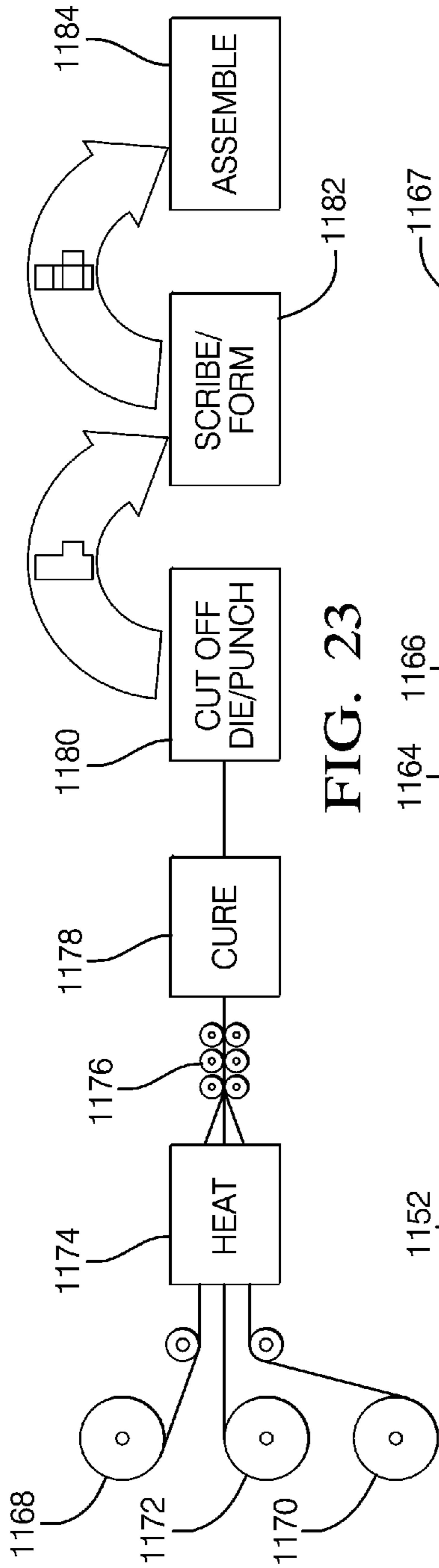


FIG. 23

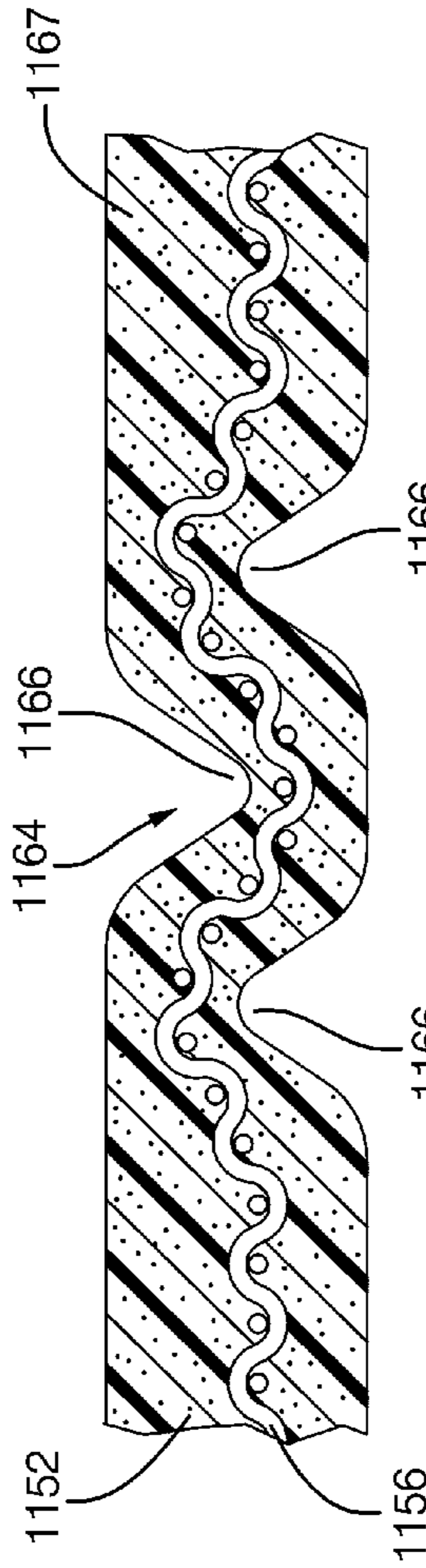


FIG. 24

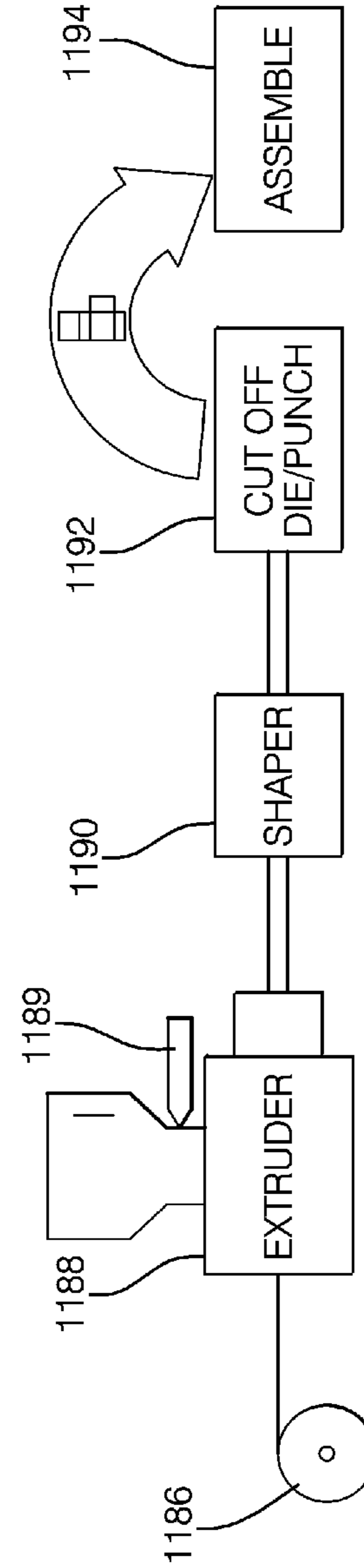


FIG. 25

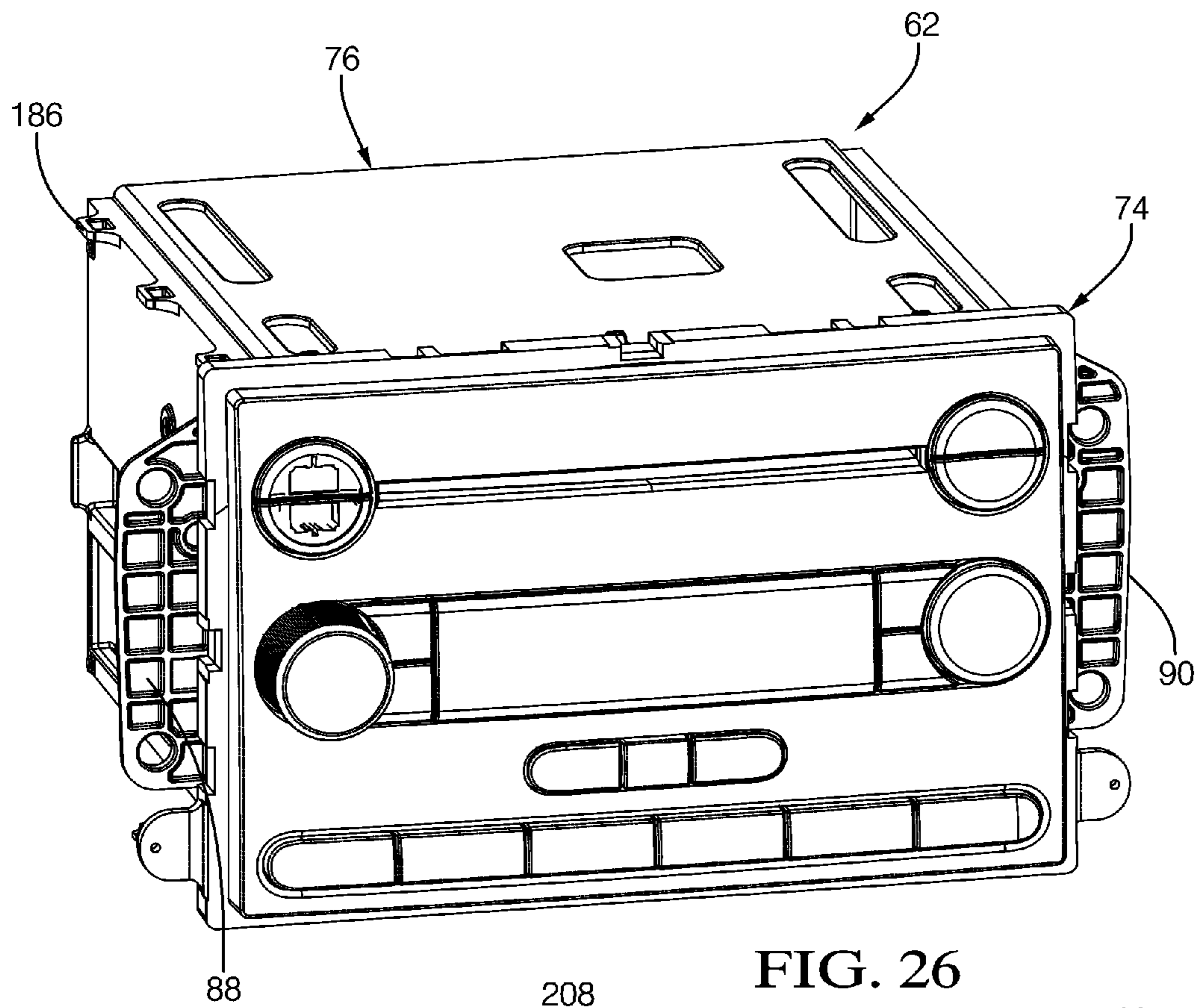


FIG. 26

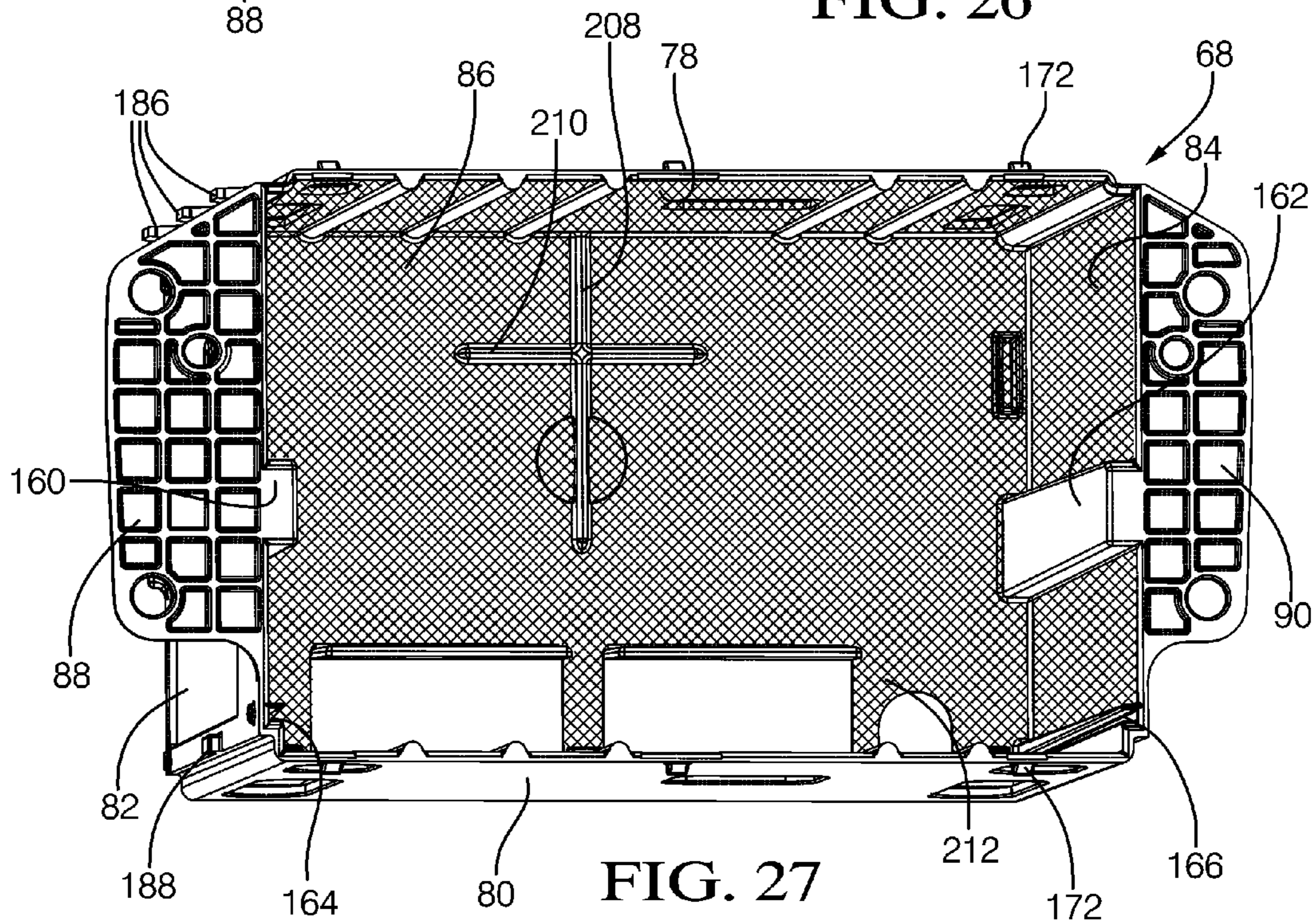


FIG. 27

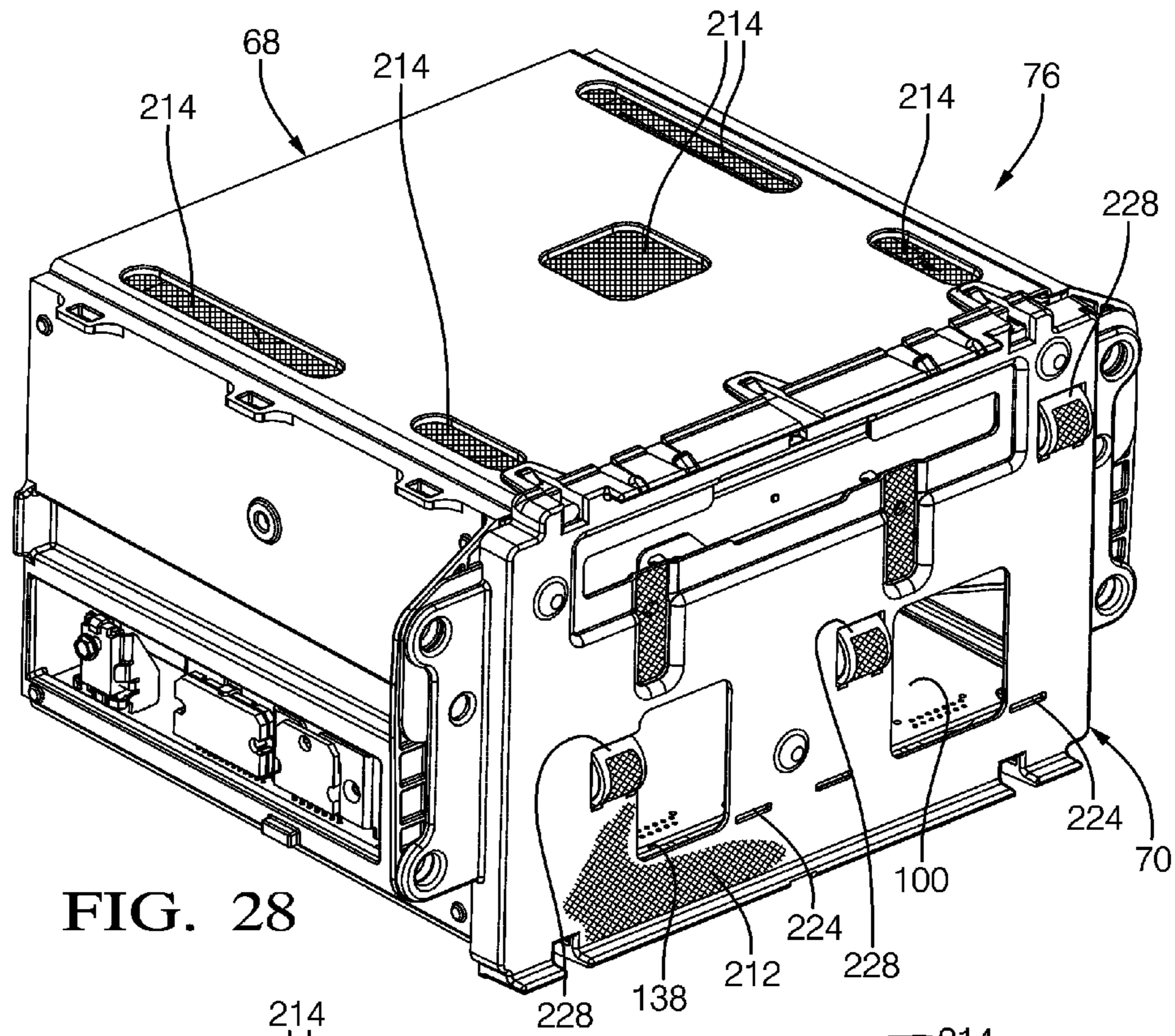


FIG. 28

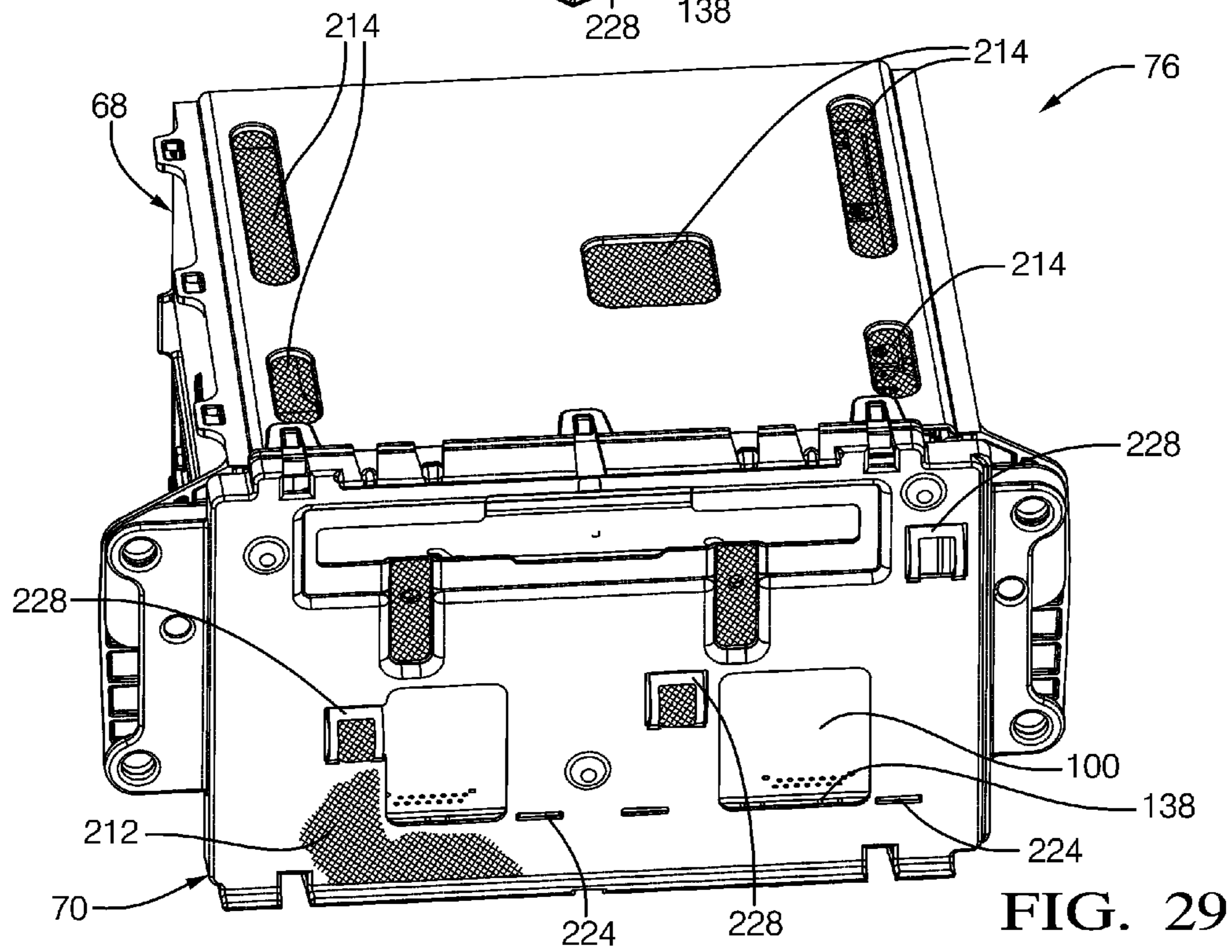


FIG. 29

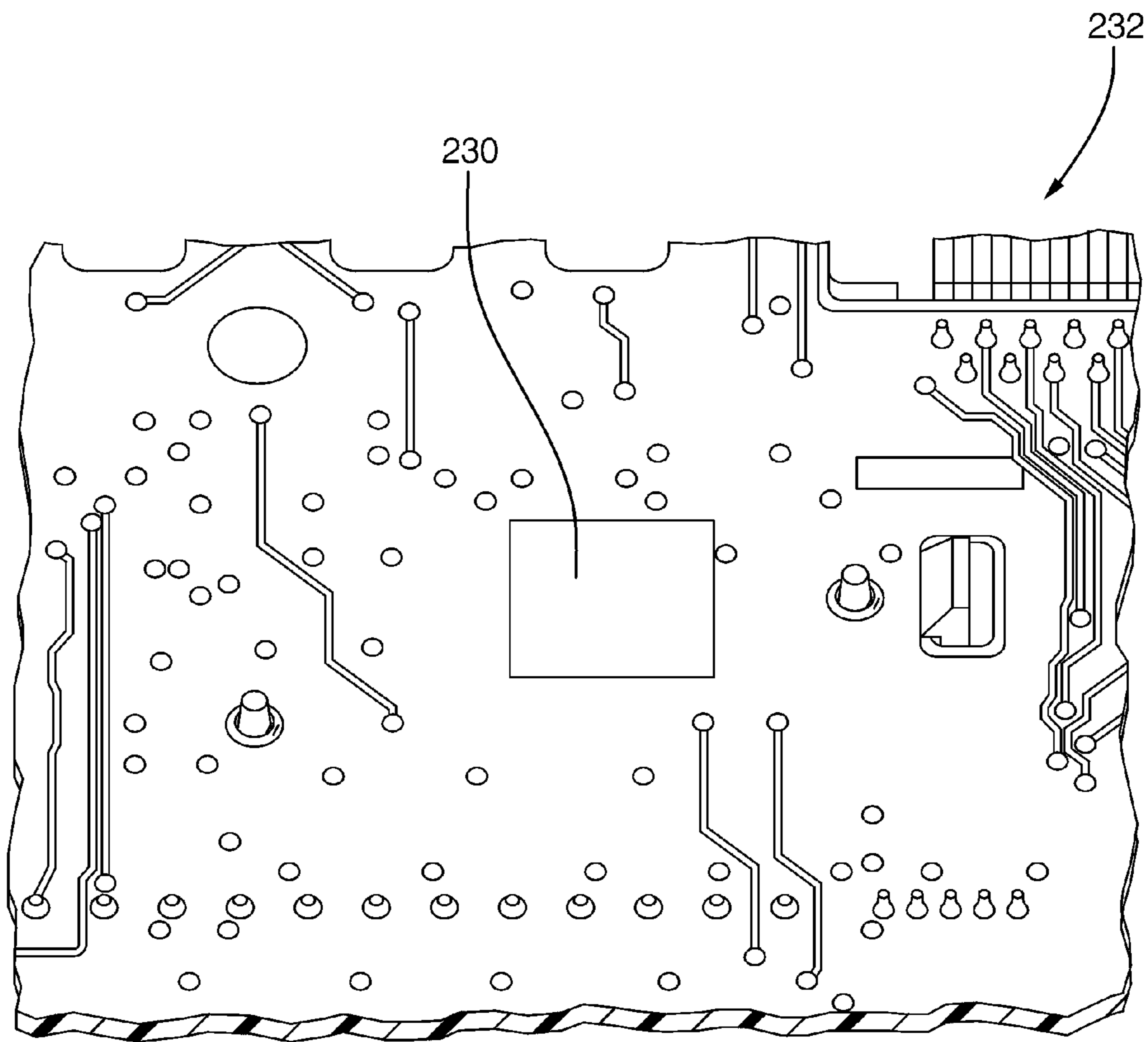
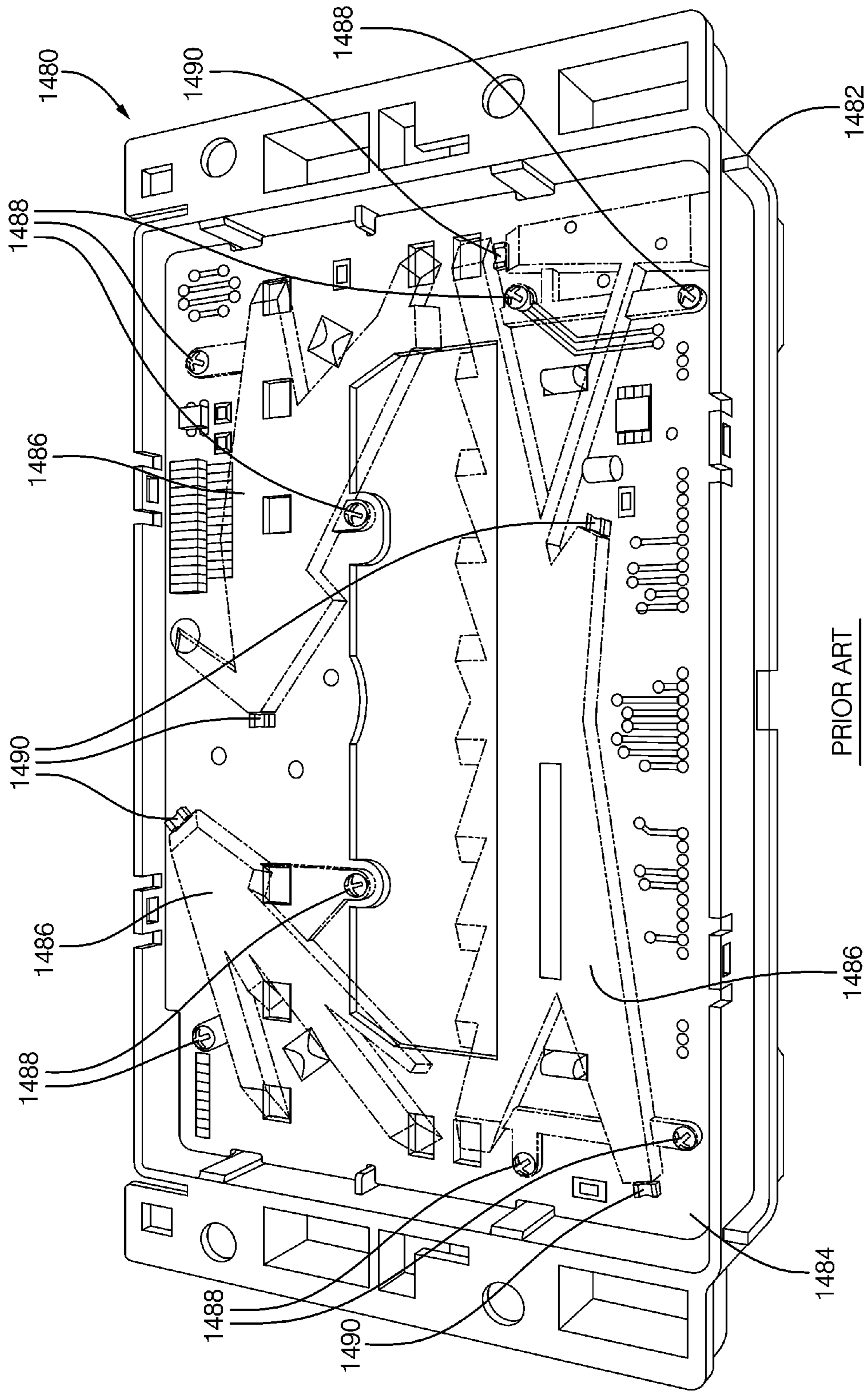


FIG. 30



PRIOR ART  
**FIG. 31**

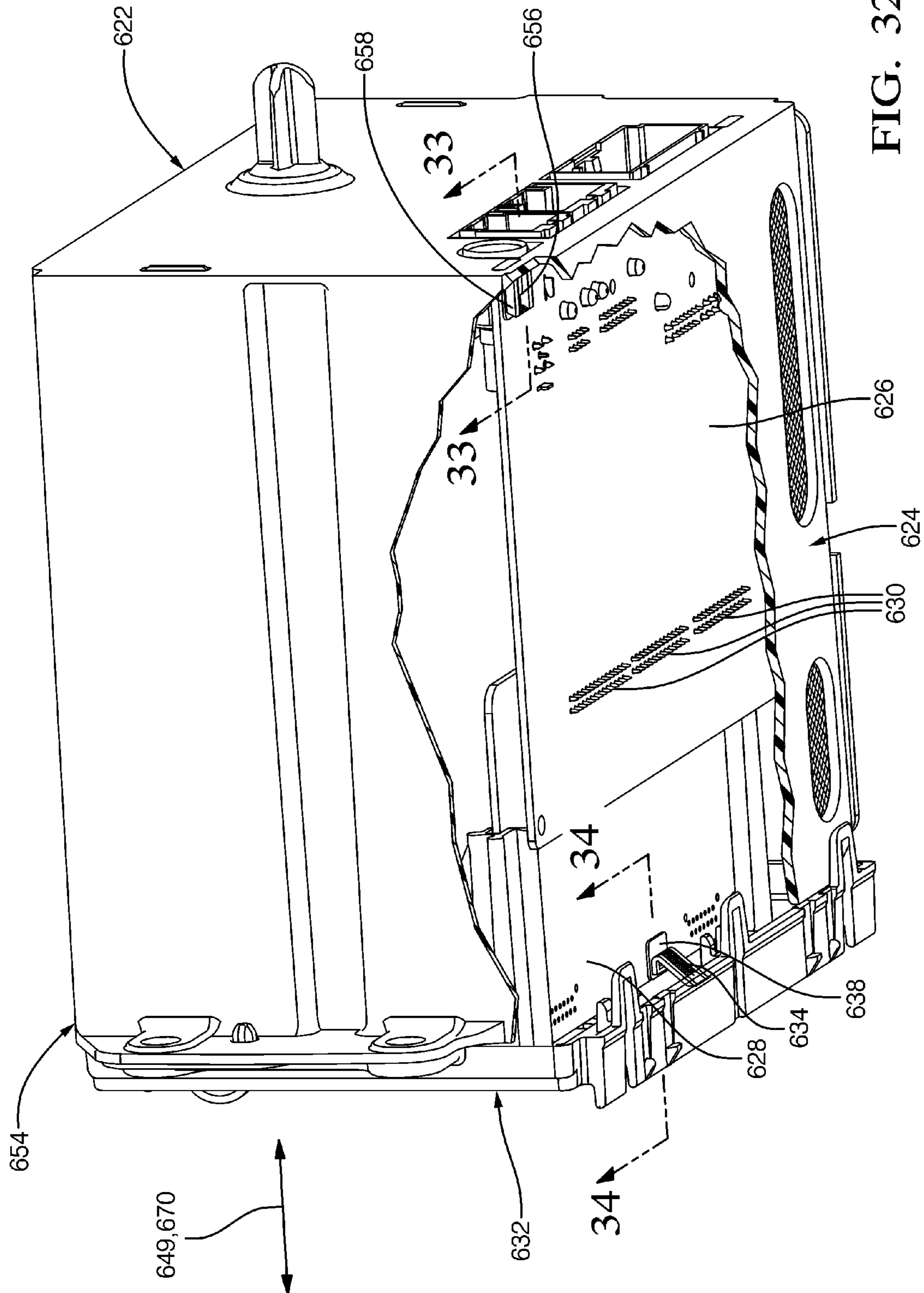
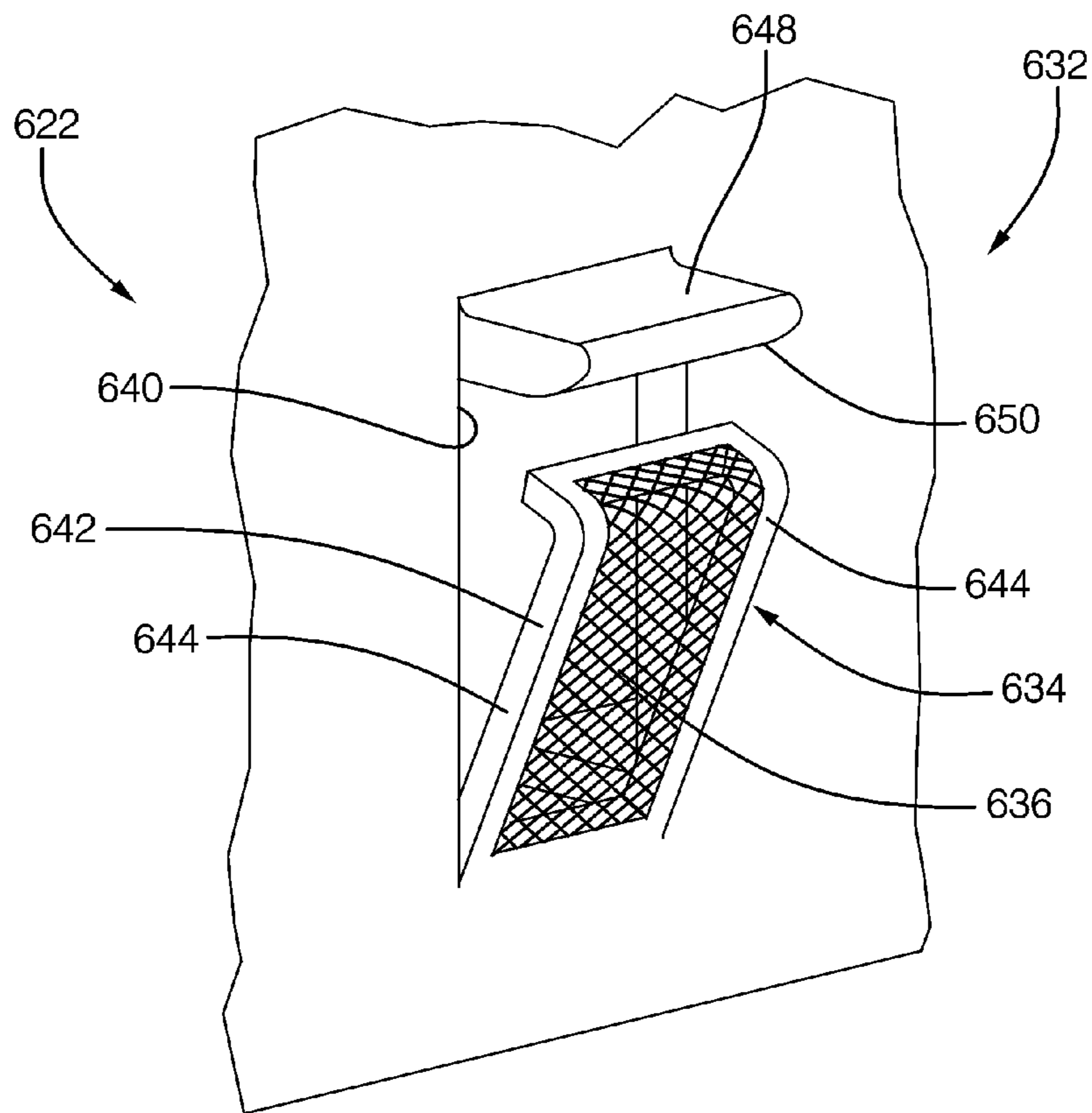
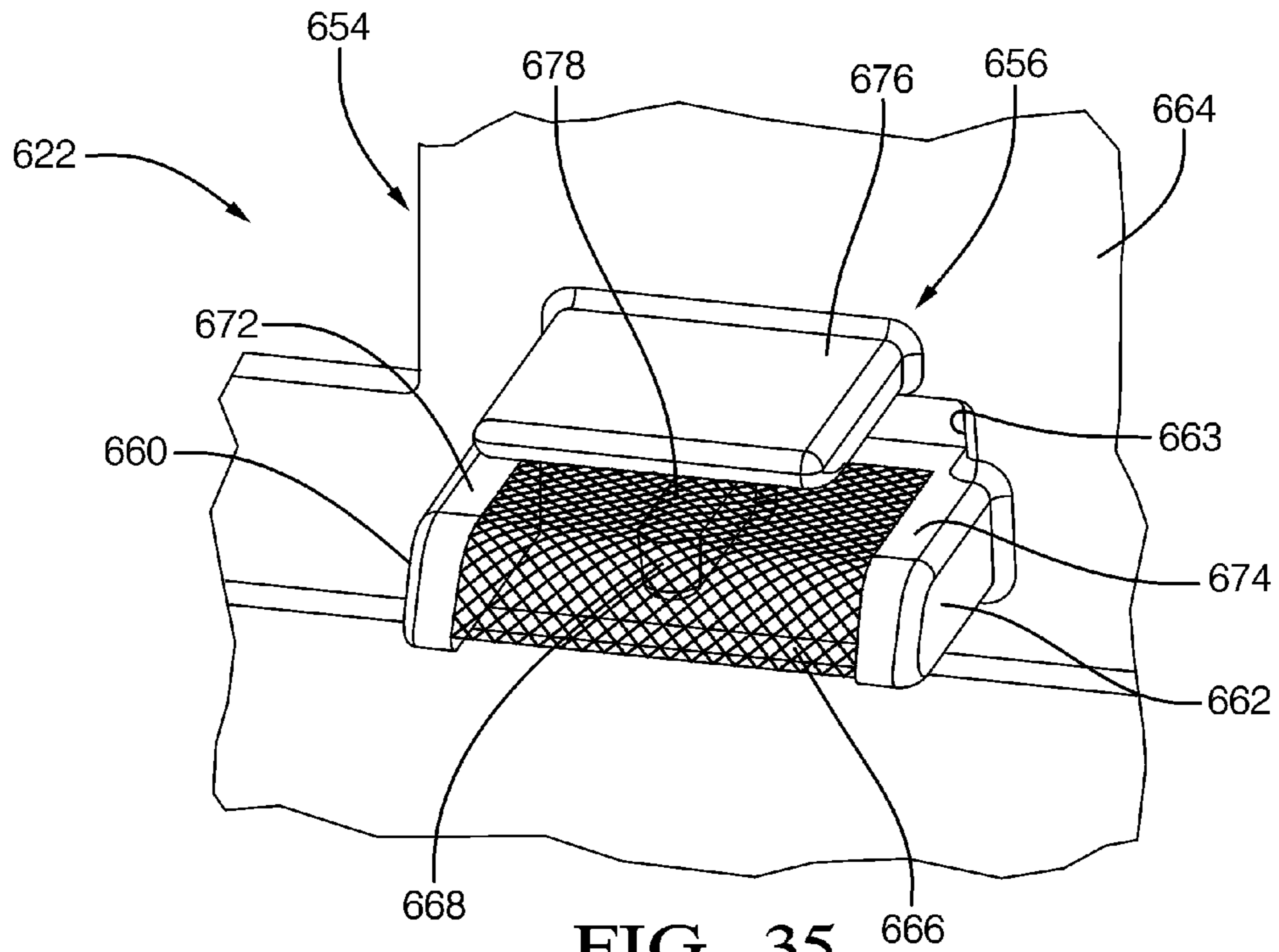


FIG. 32







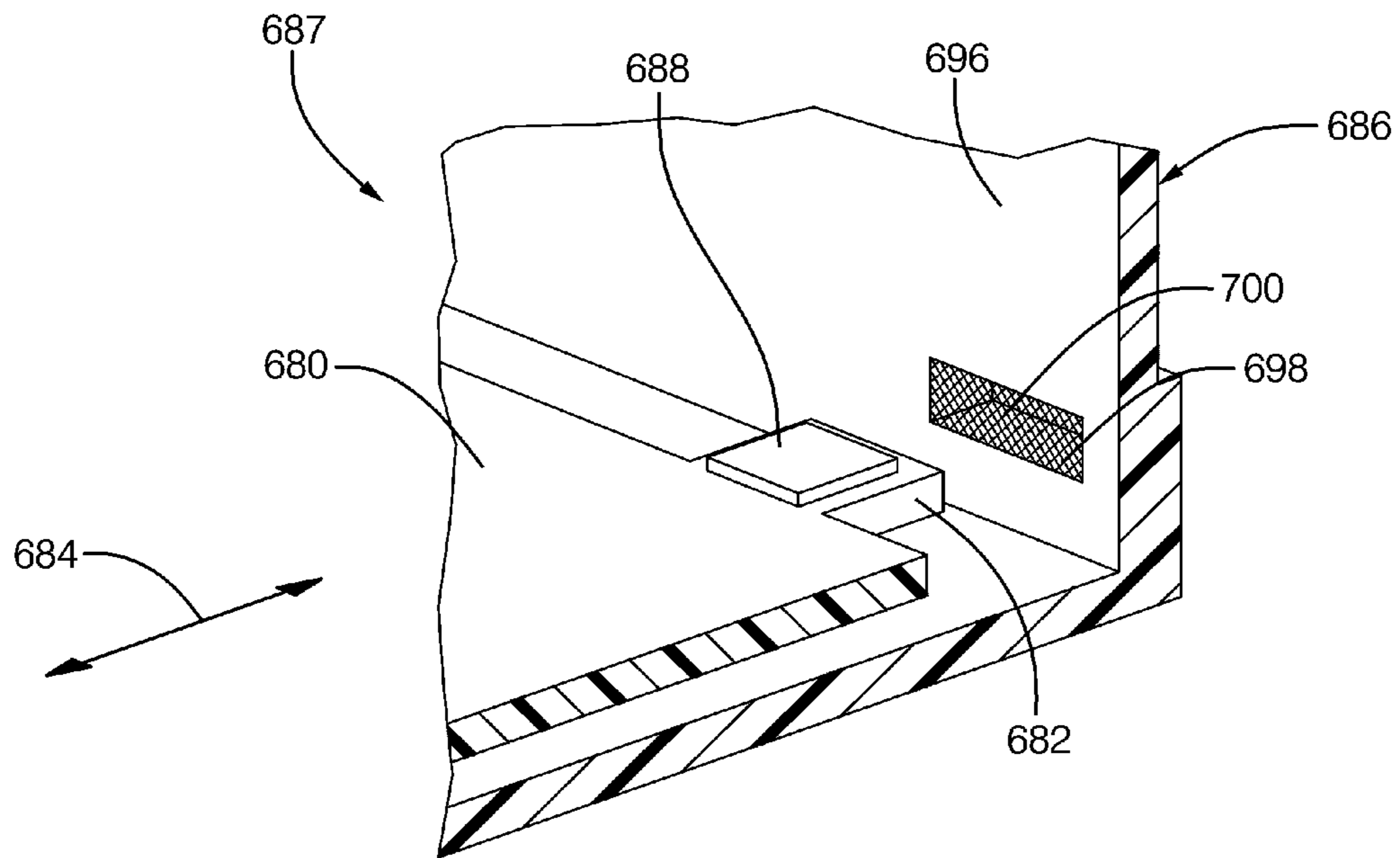


FIG. 37

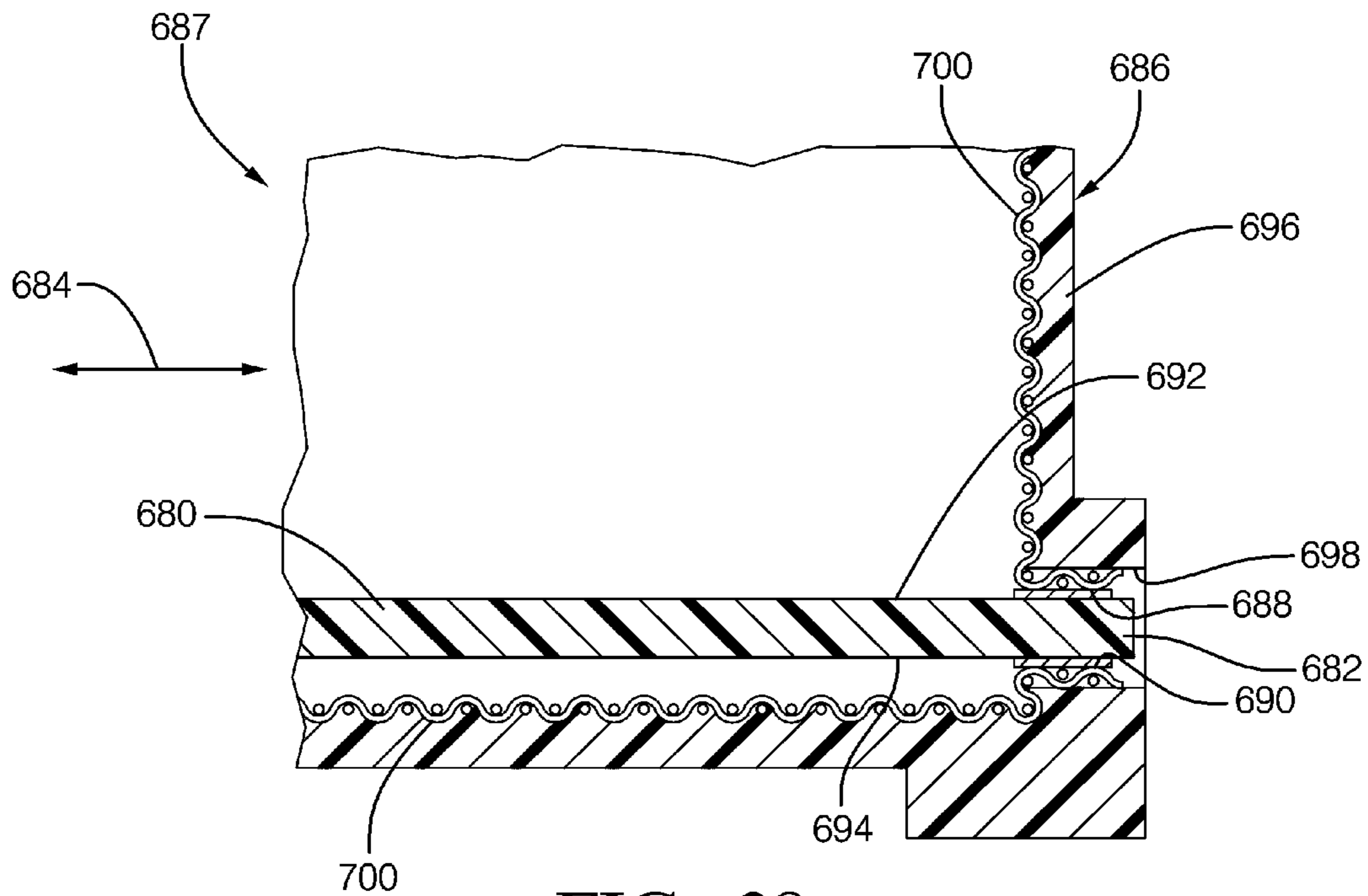


FIG. 38

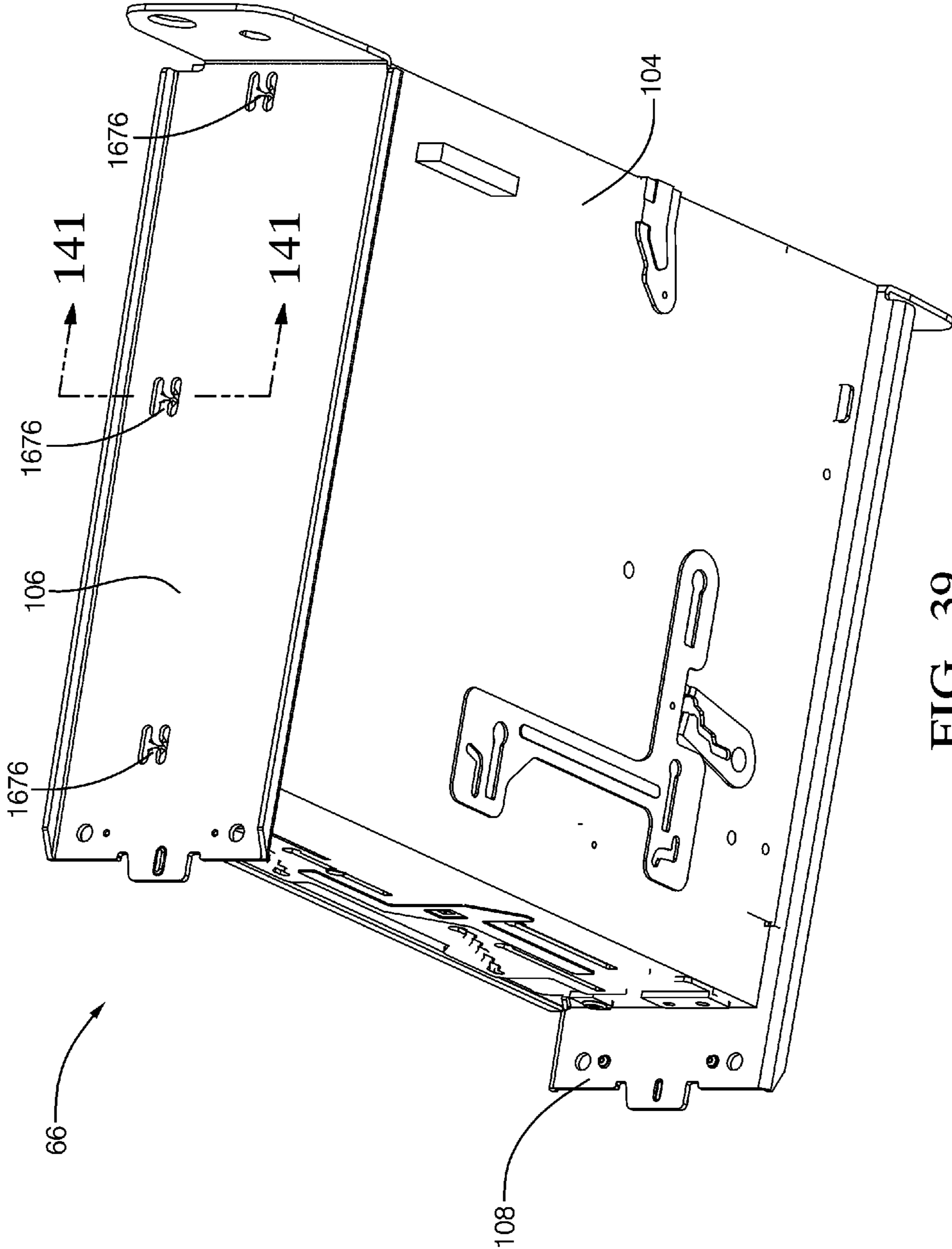


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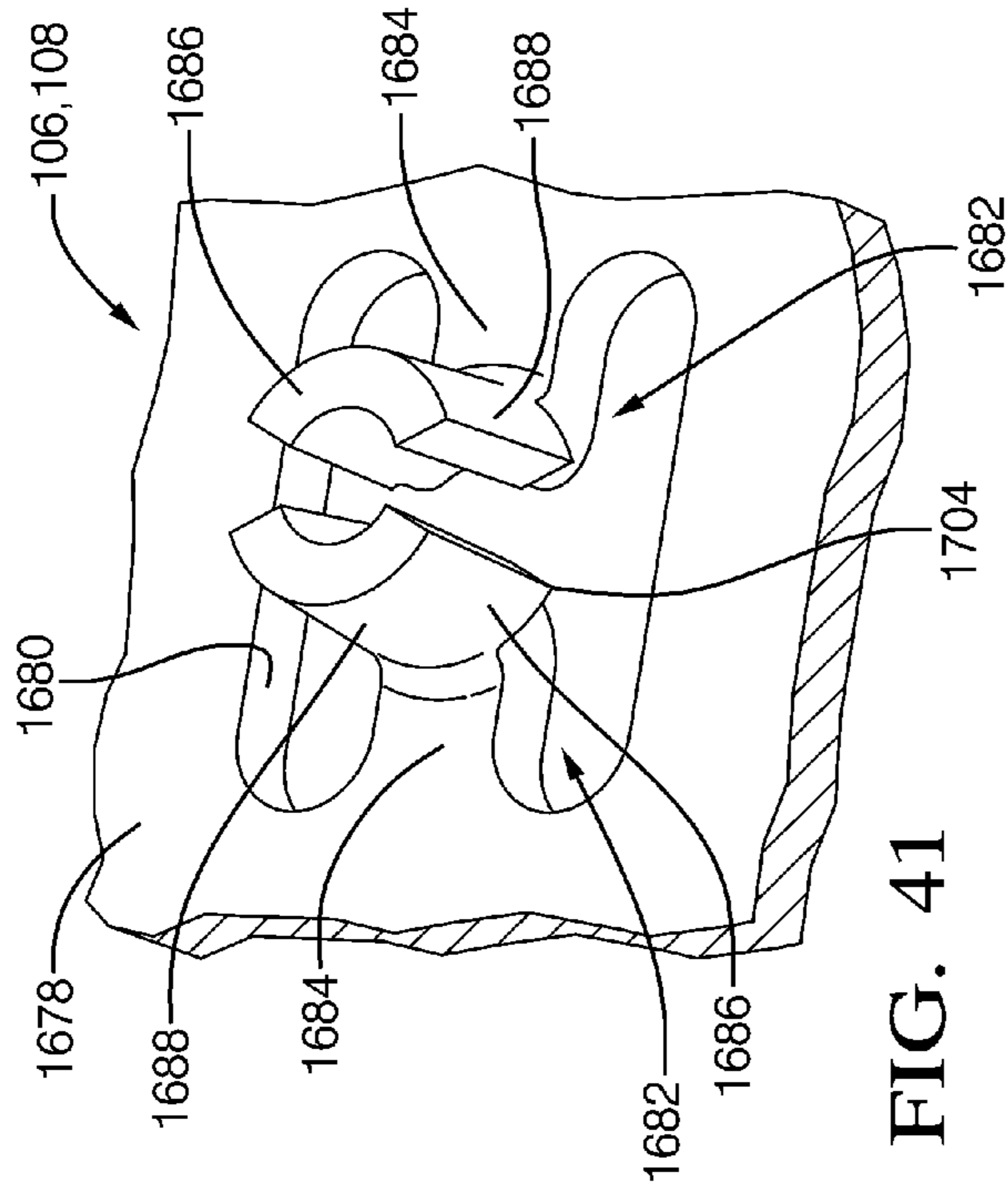


FIG. 40

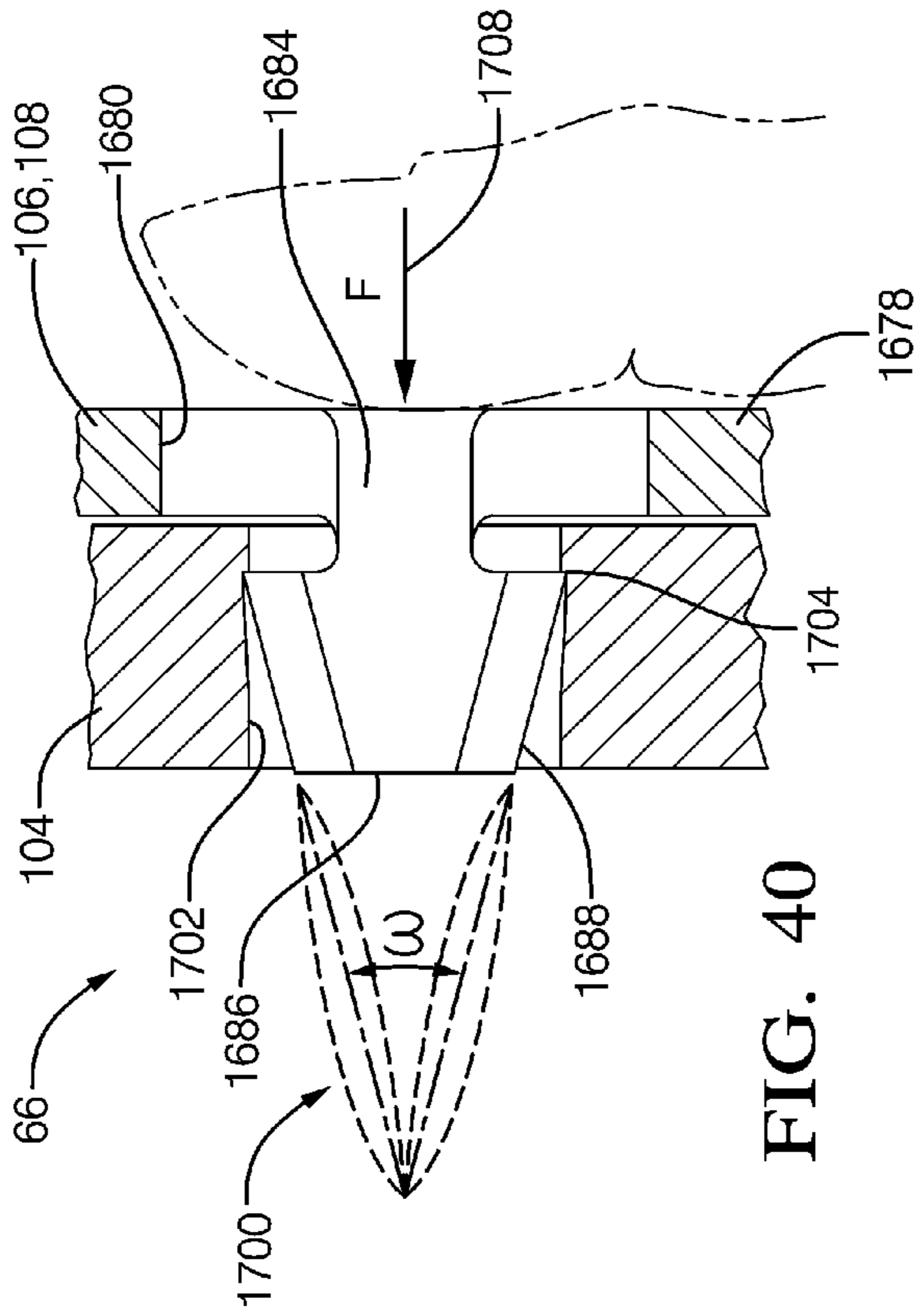


FIG. 41

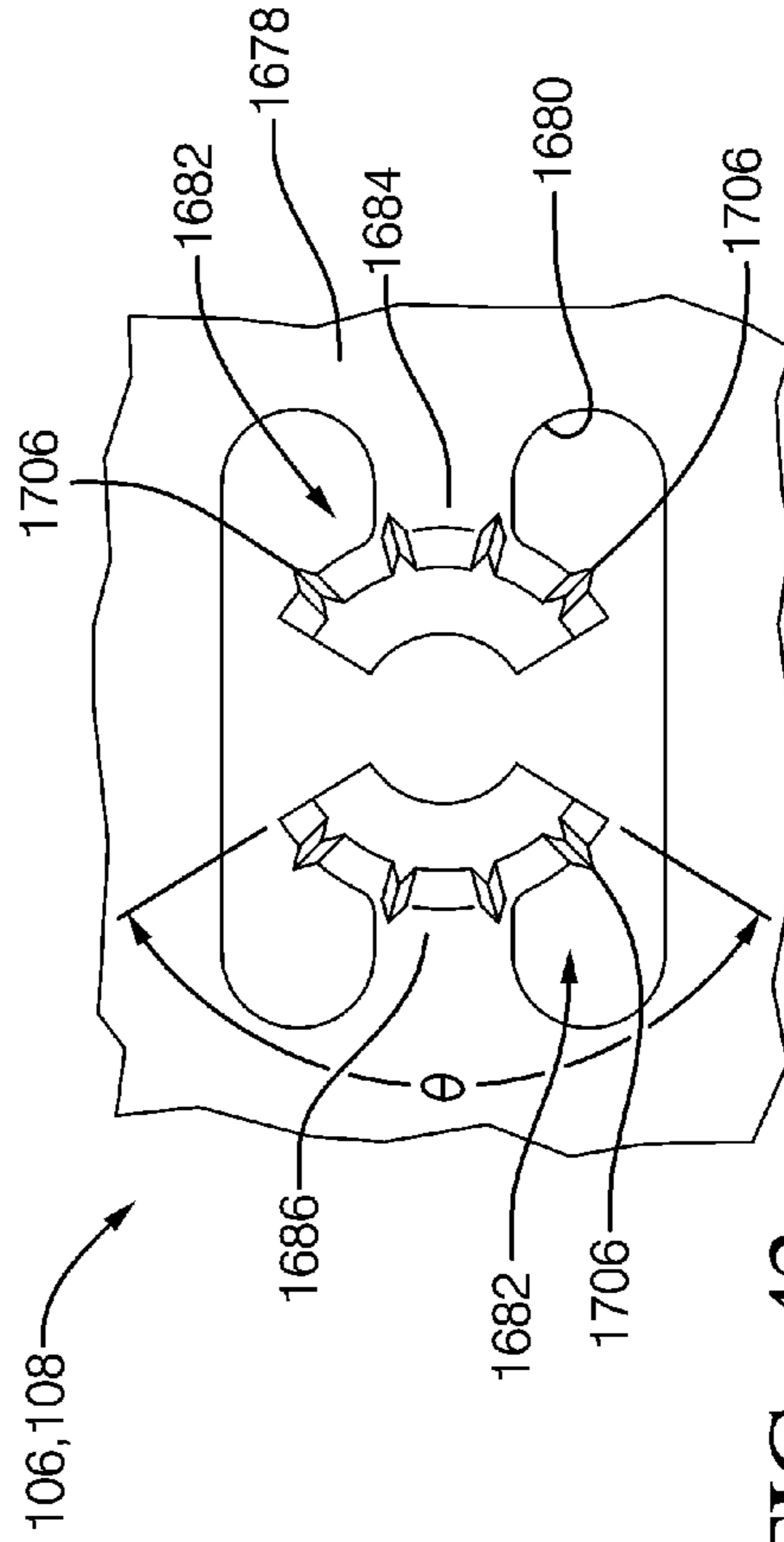


FIG. 42

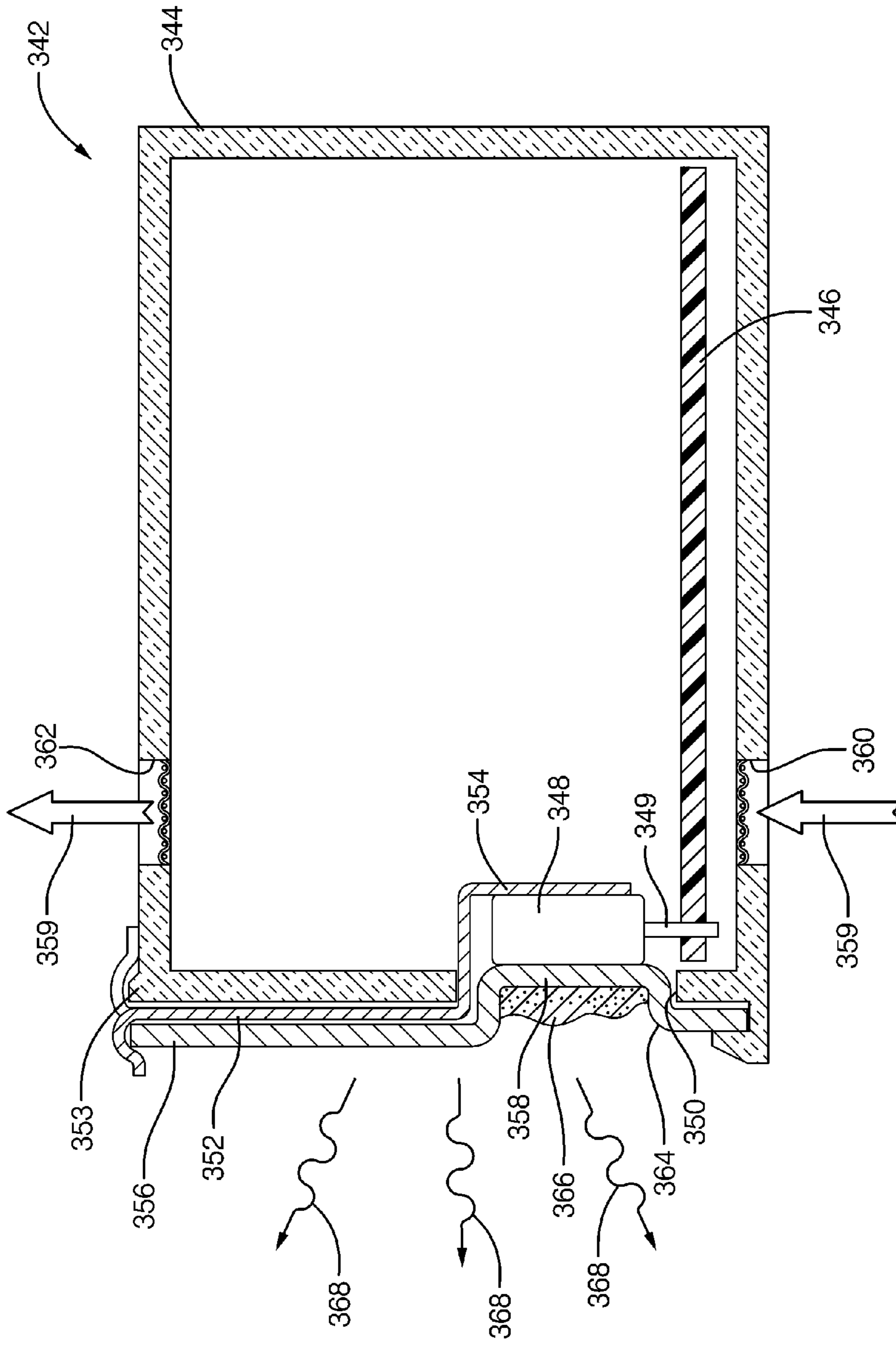


FIG. 43

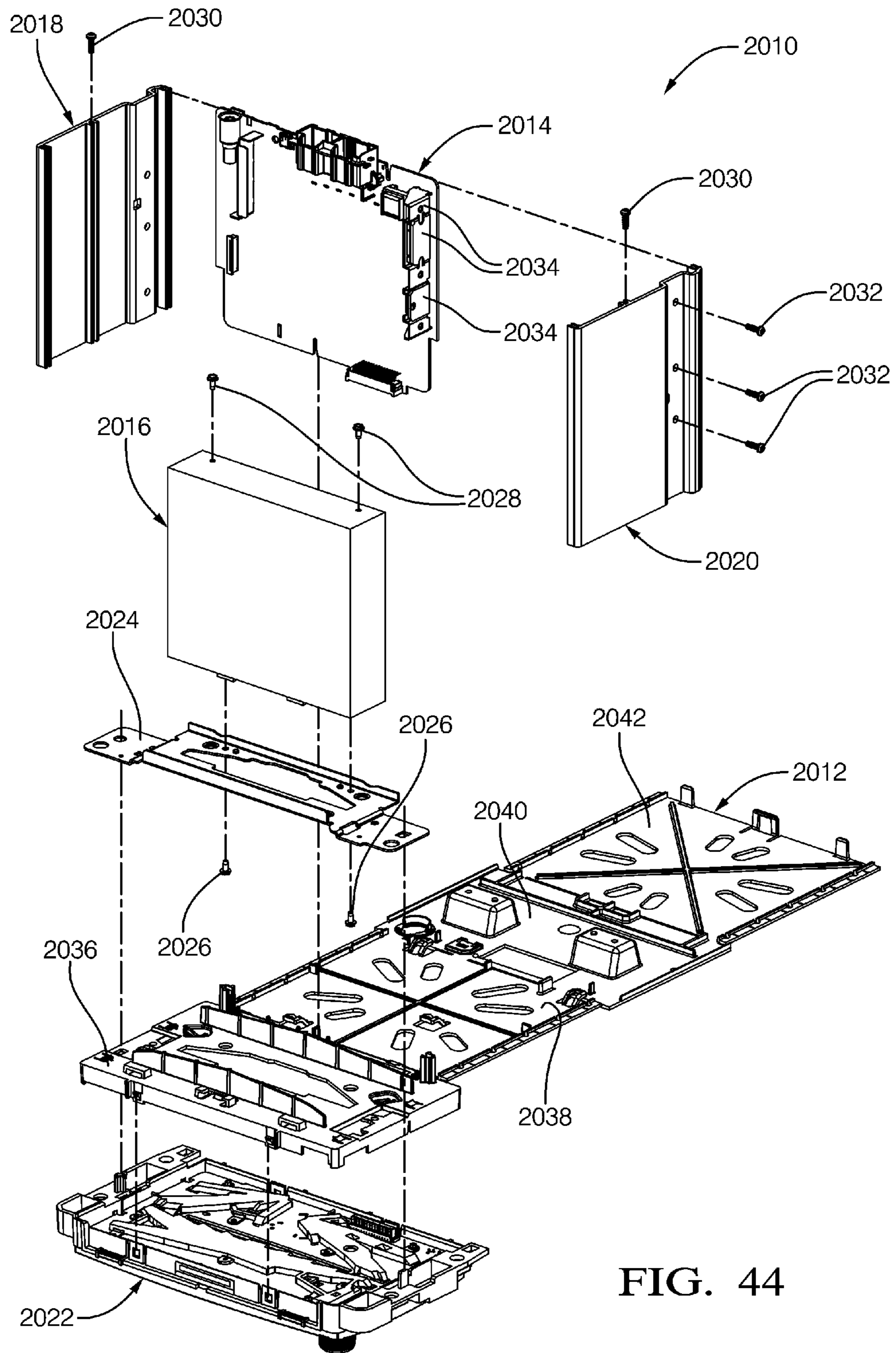


FIG. 44

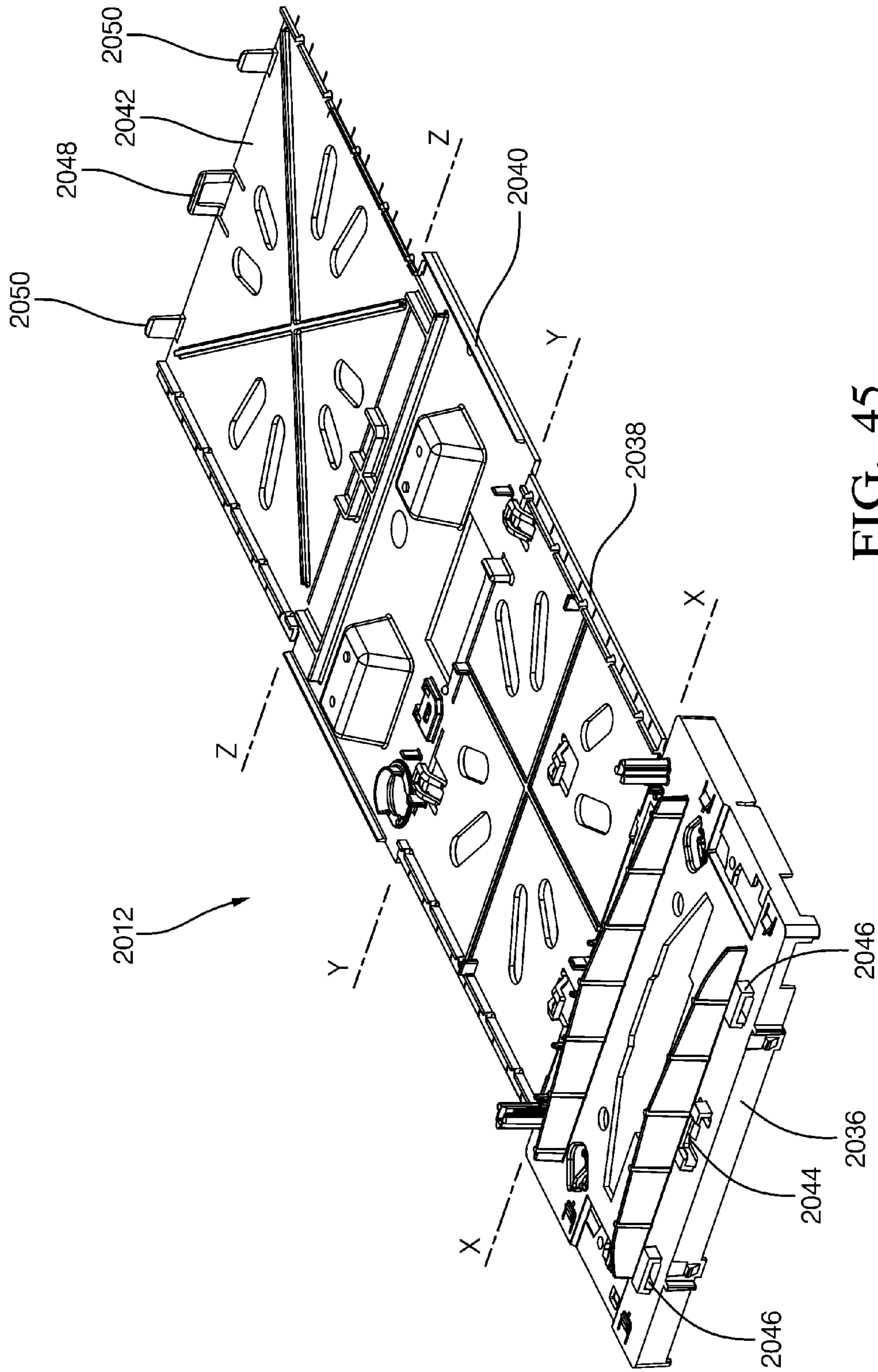


FIG. 45

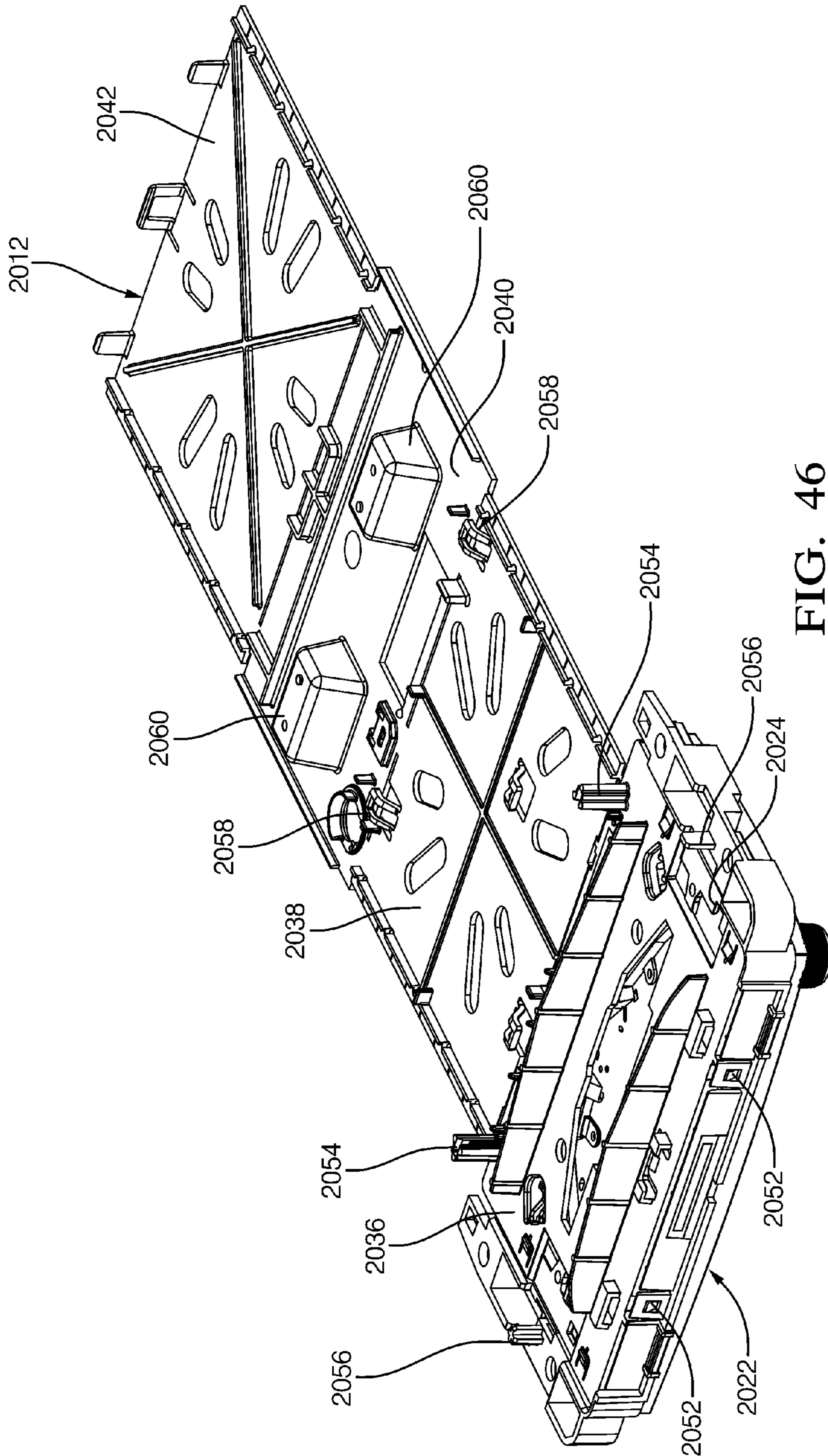


FIG. 46

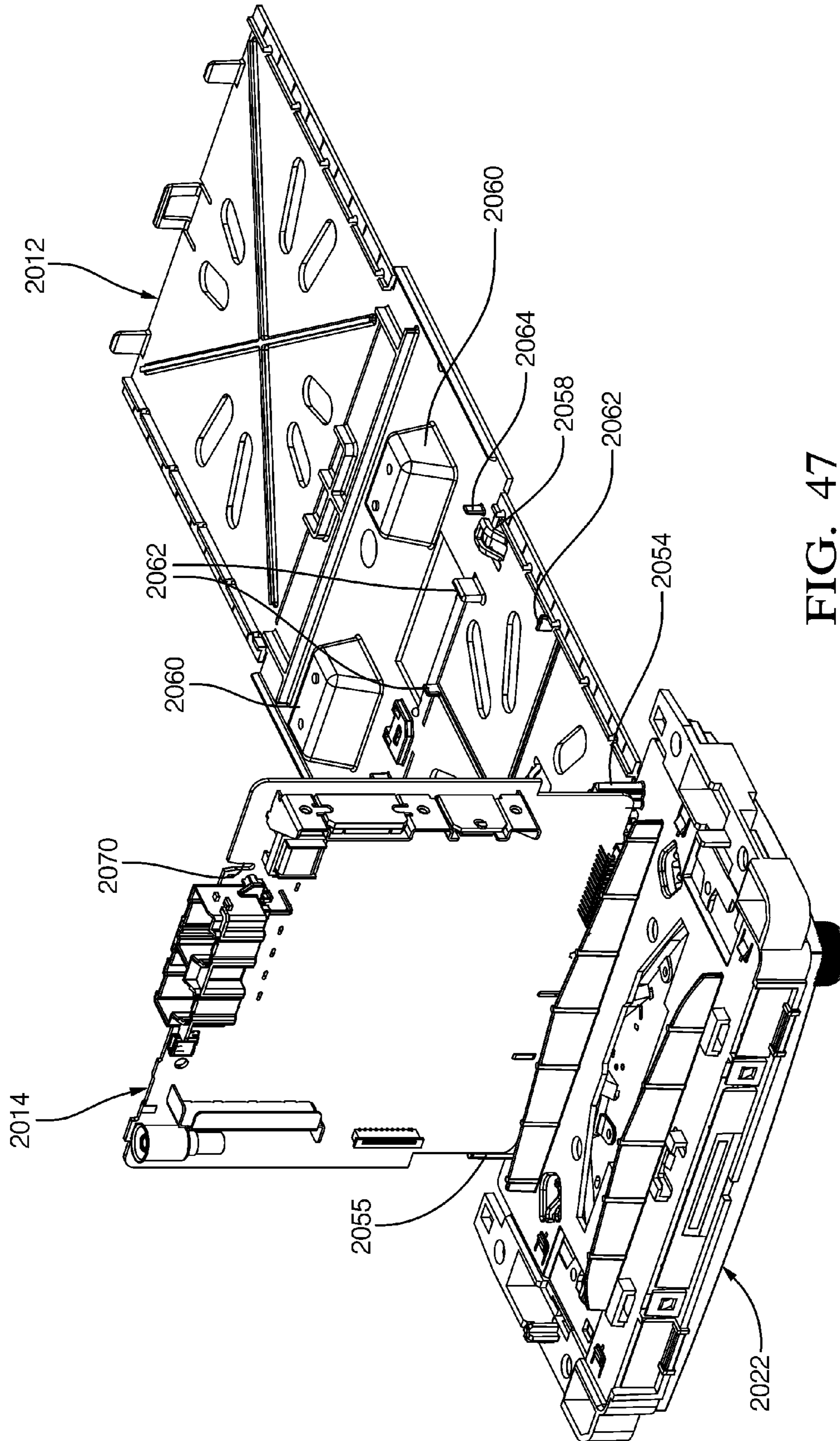


FIG. 47



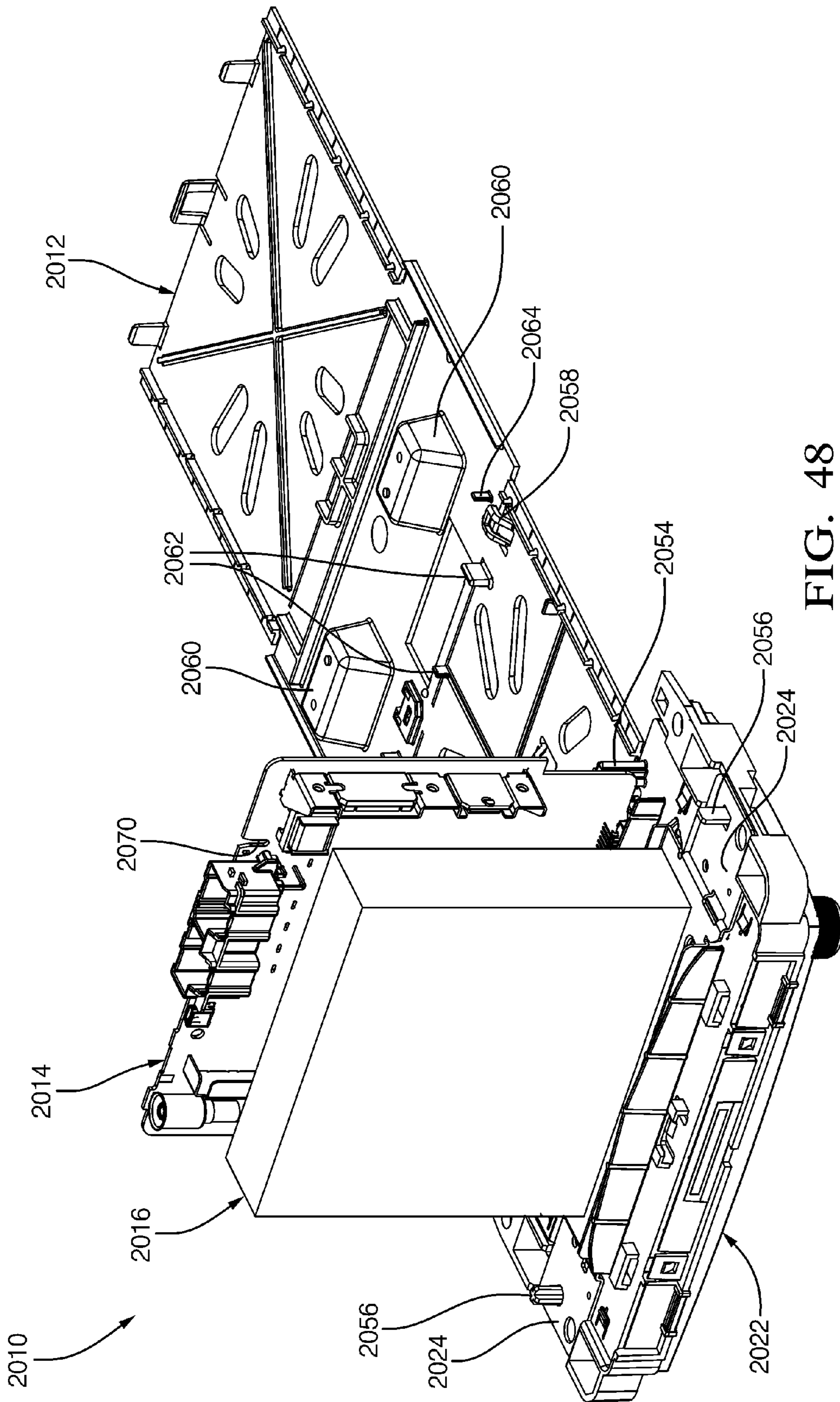


FIG. 48

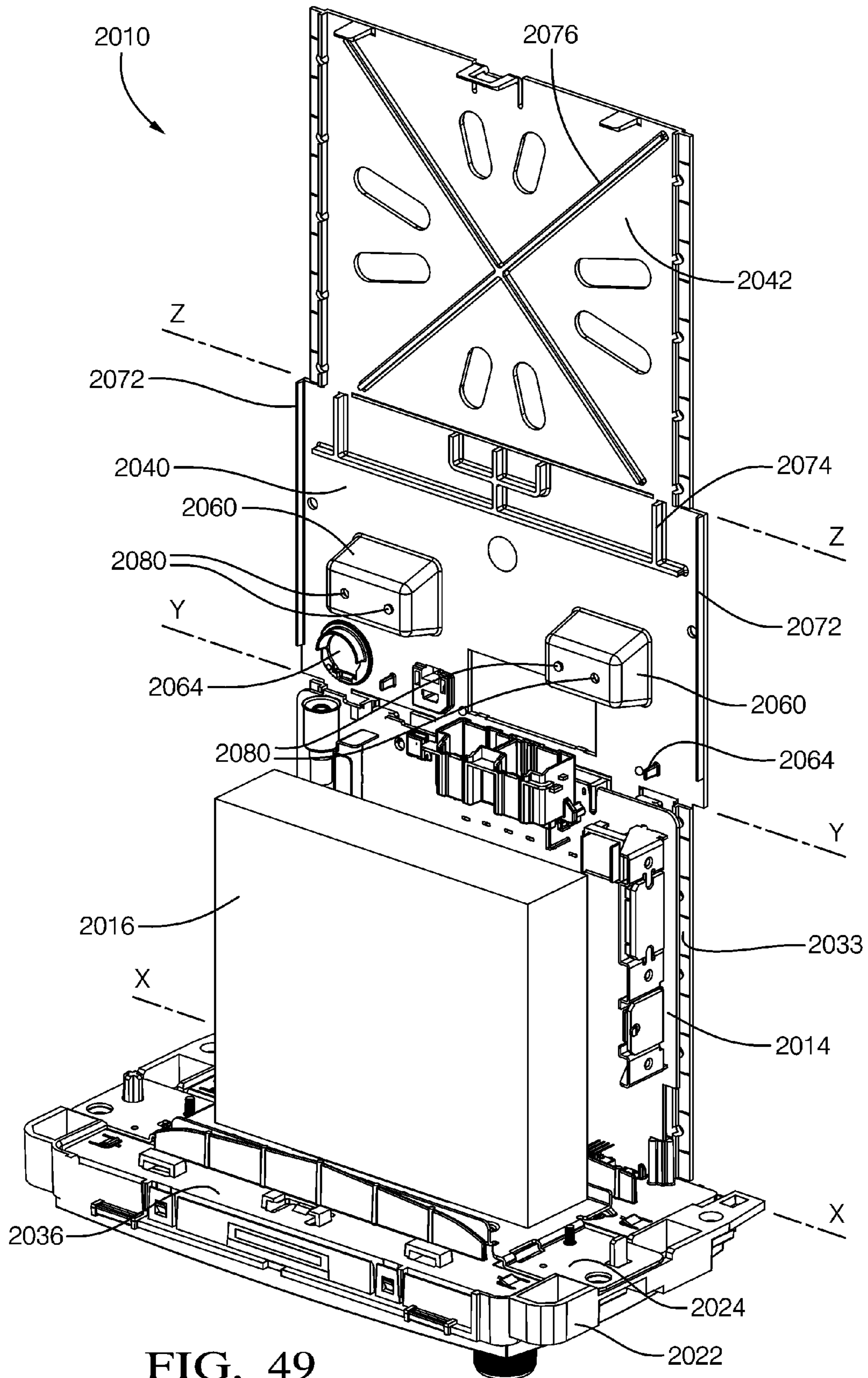


FIG. 49

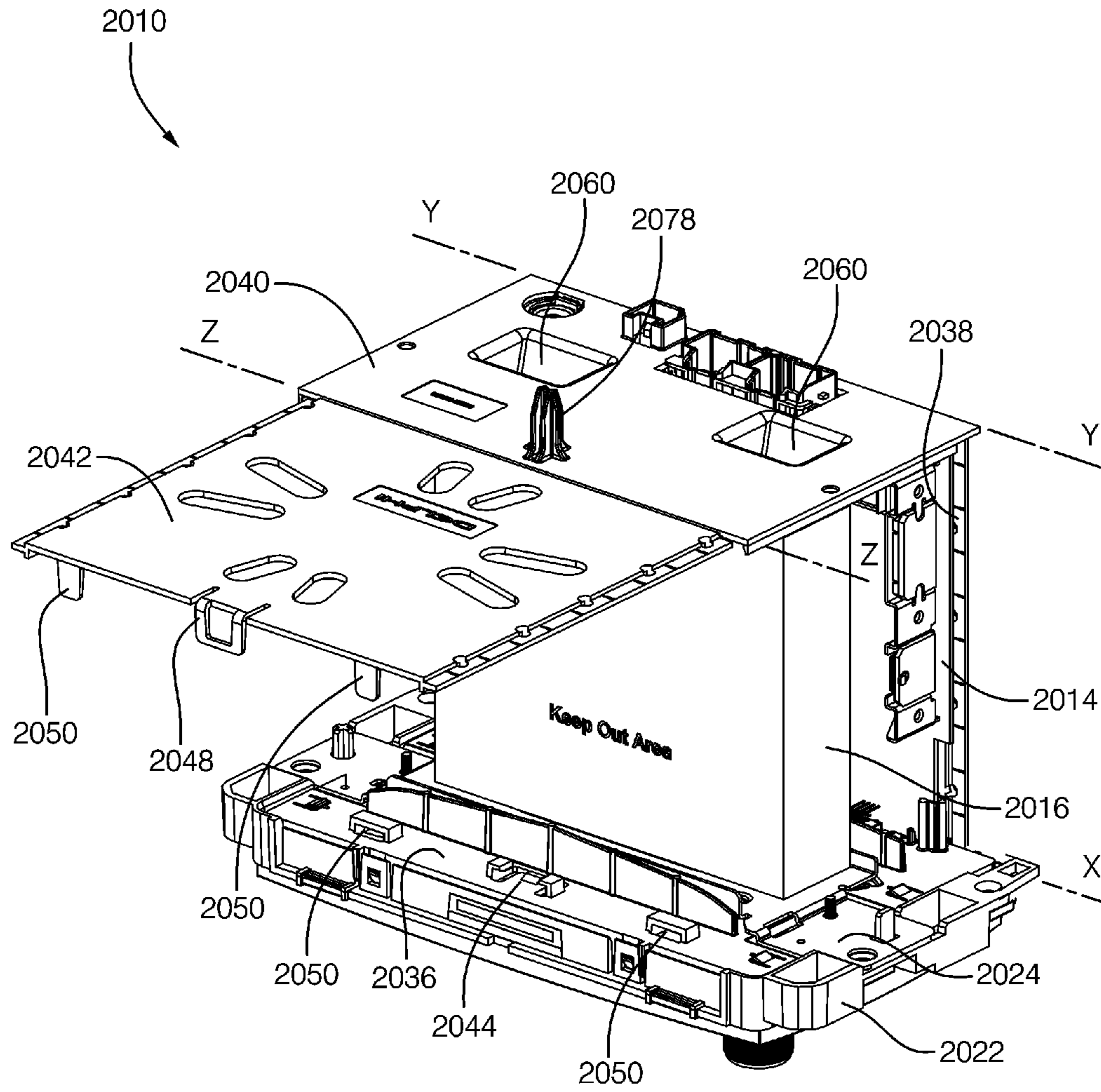


FIG. 50

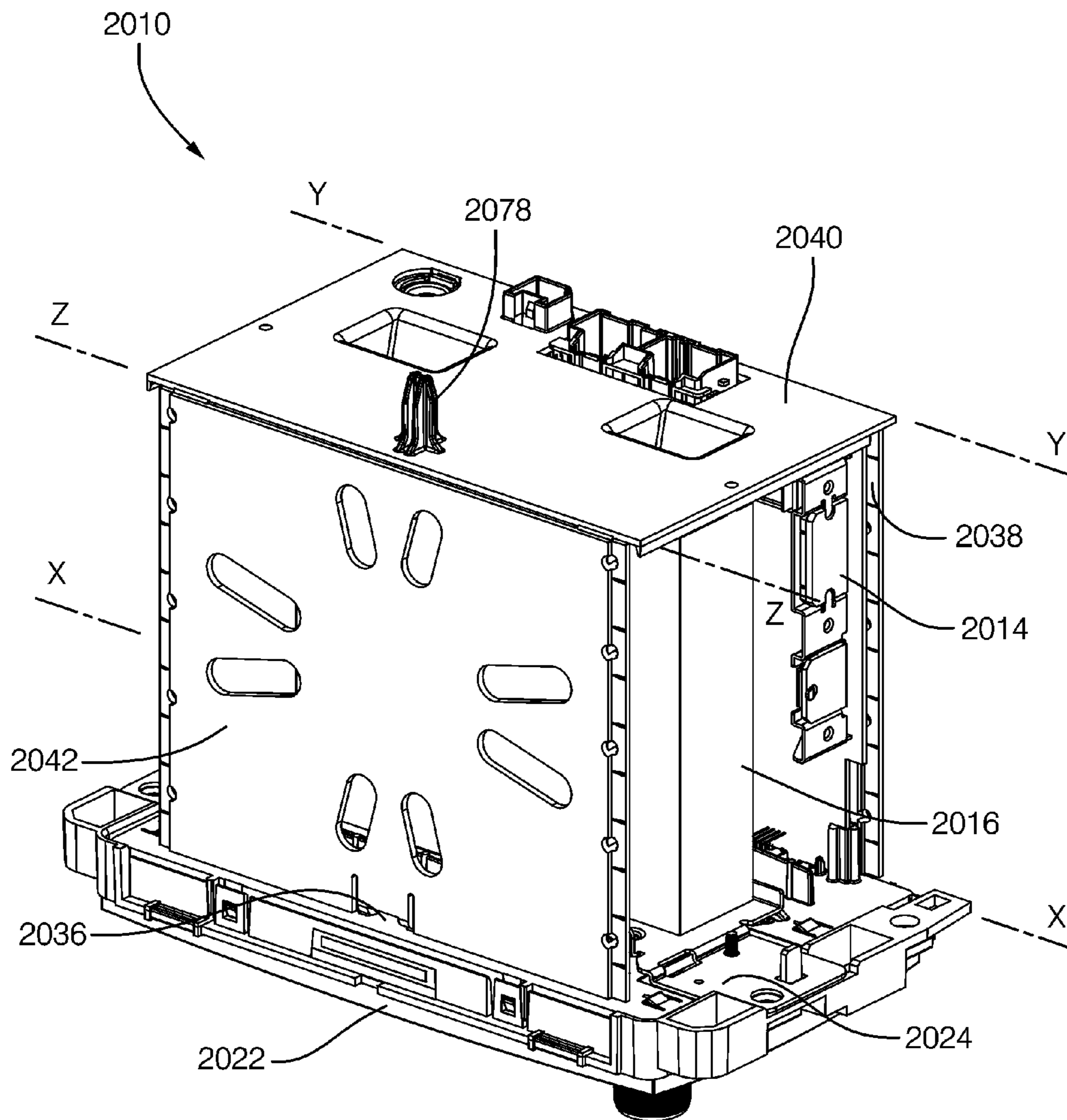


FIG. 51

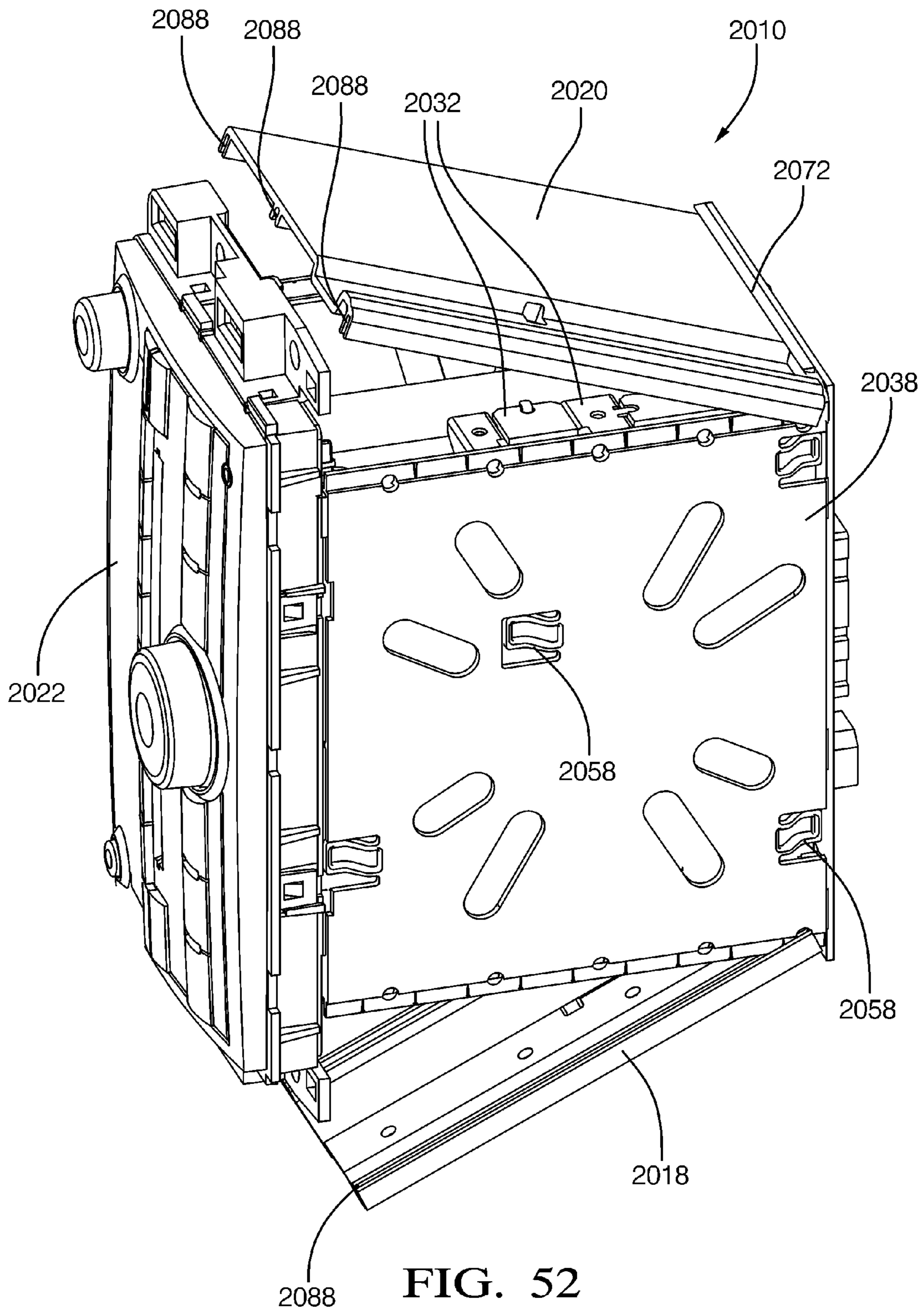


FIG. 52

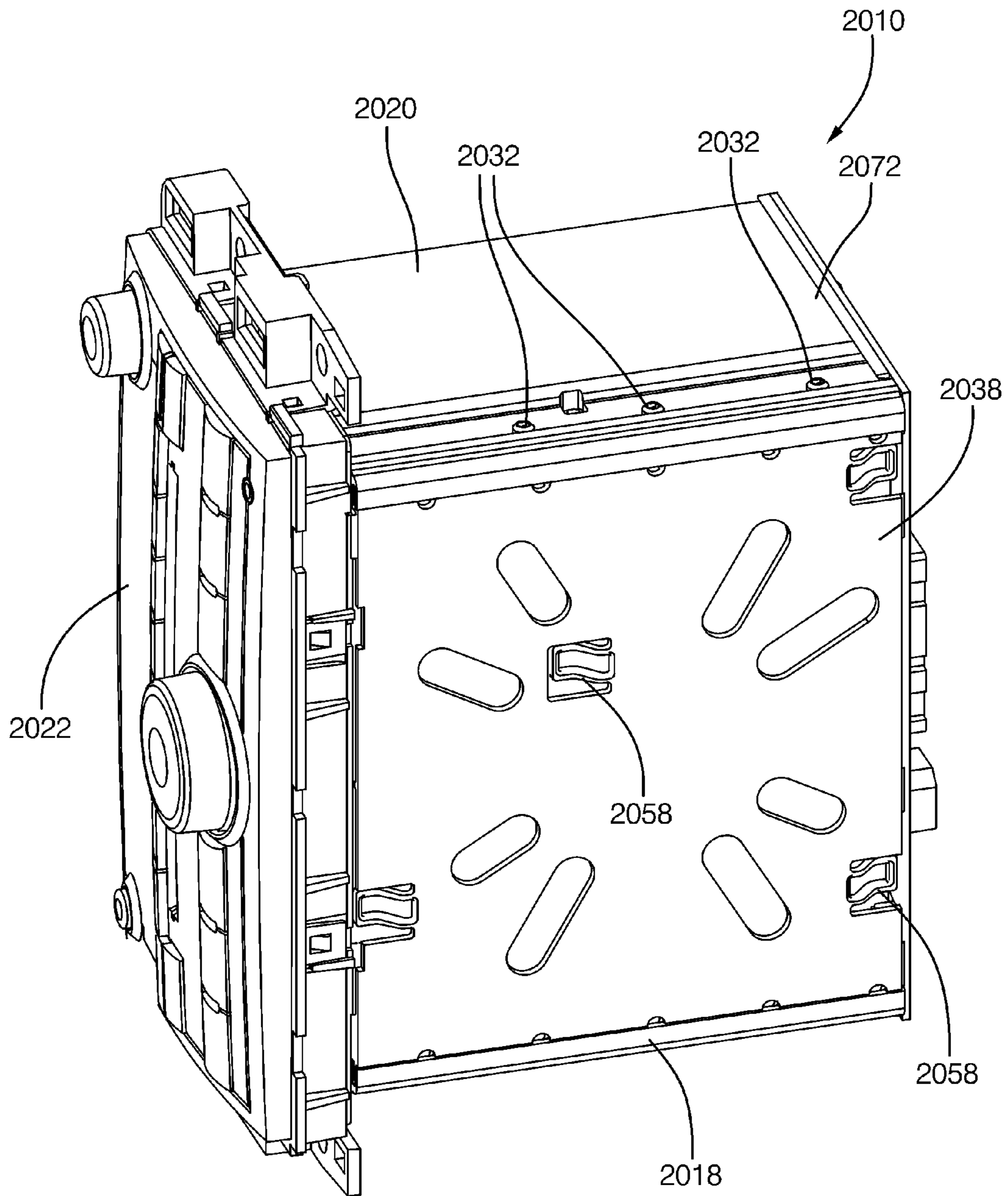


FIG. 53

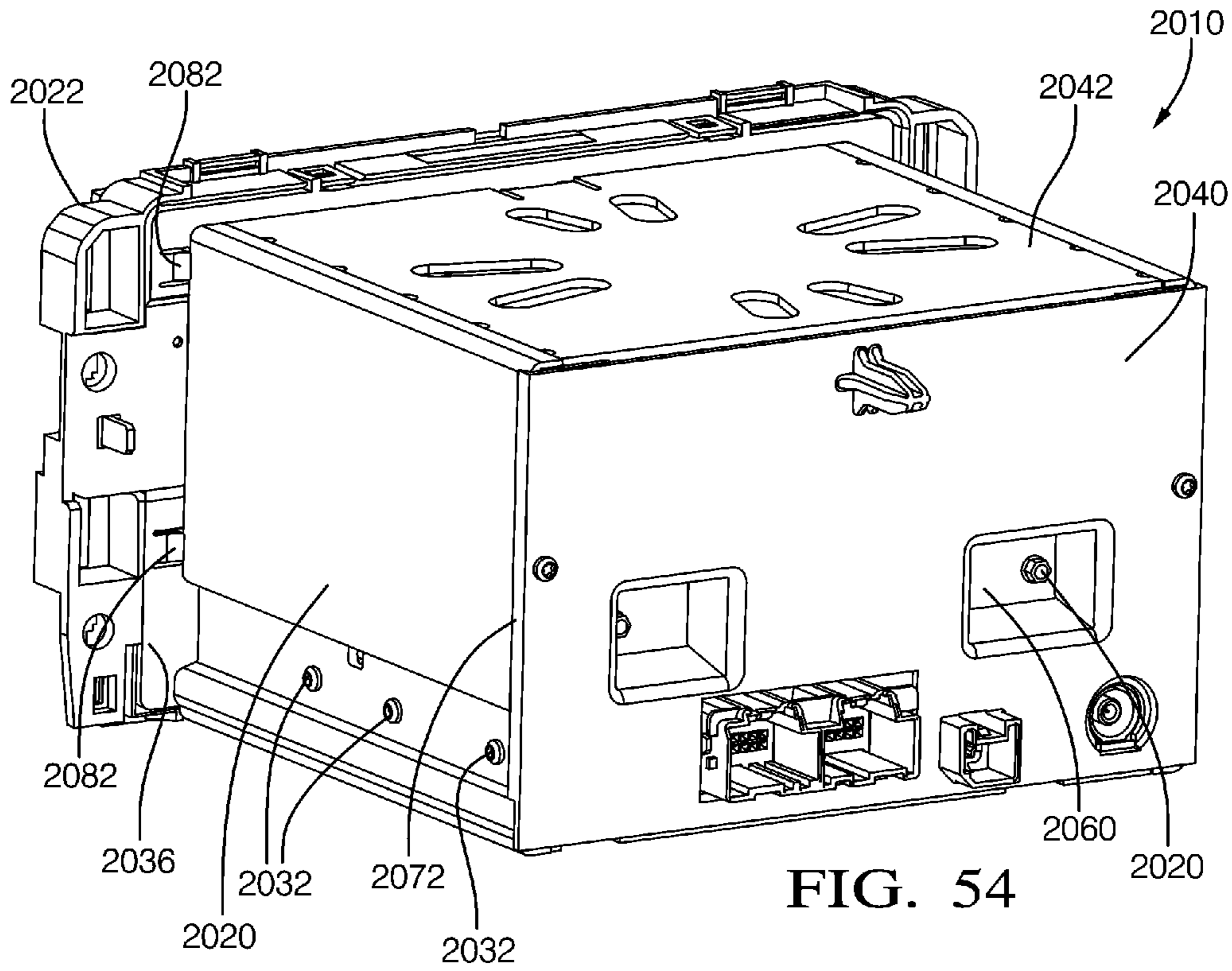


FIG. 54

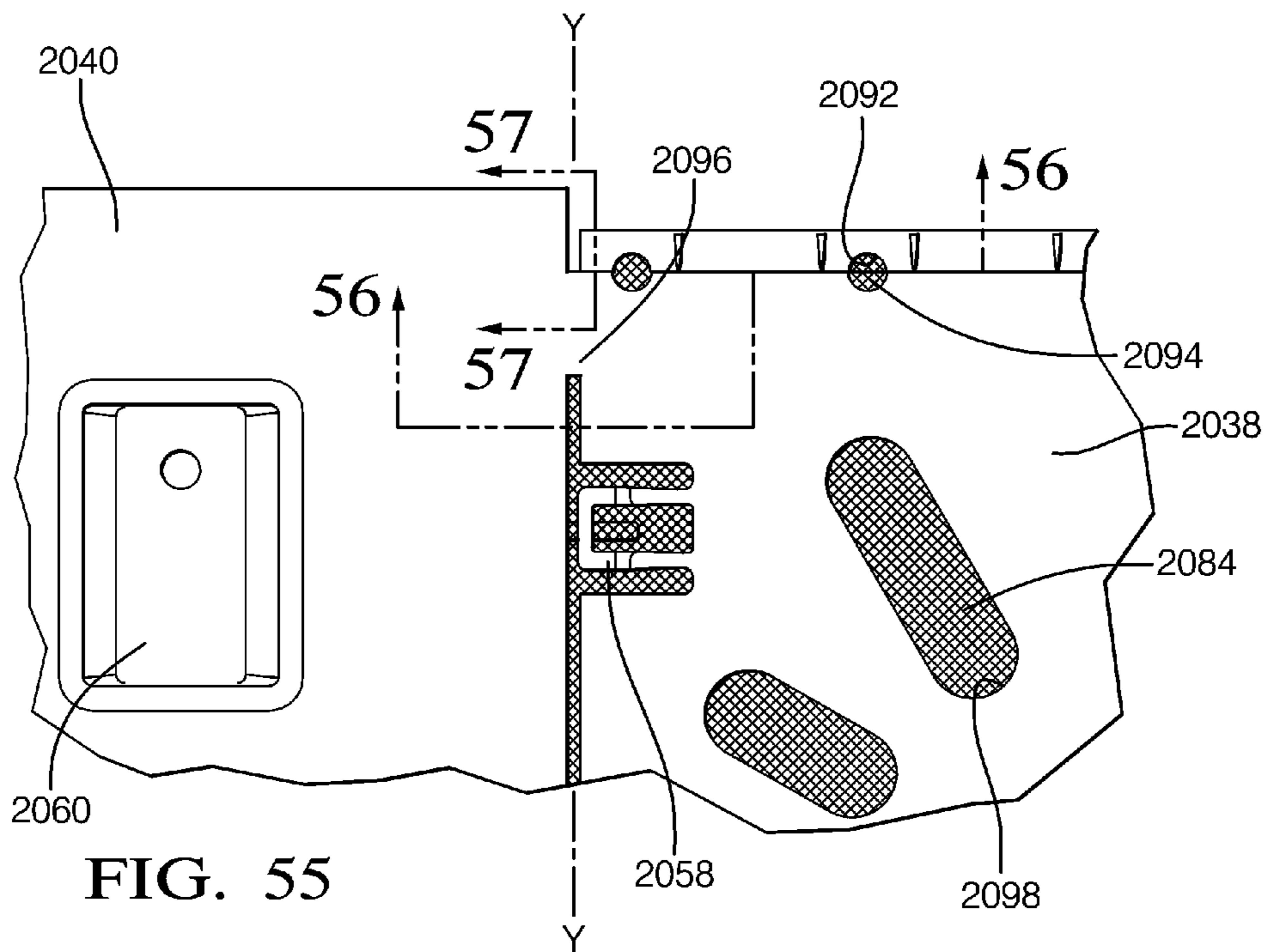
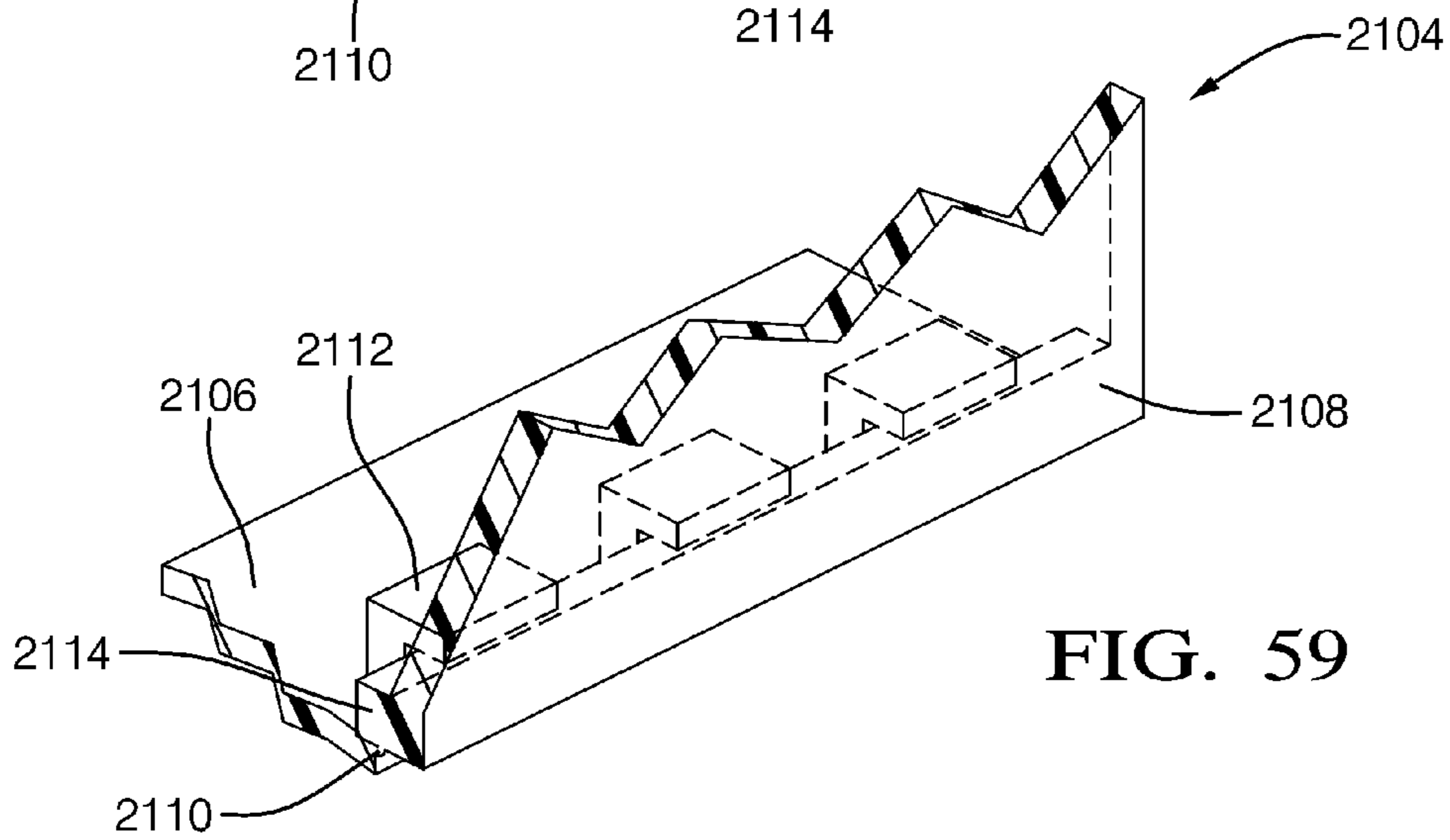
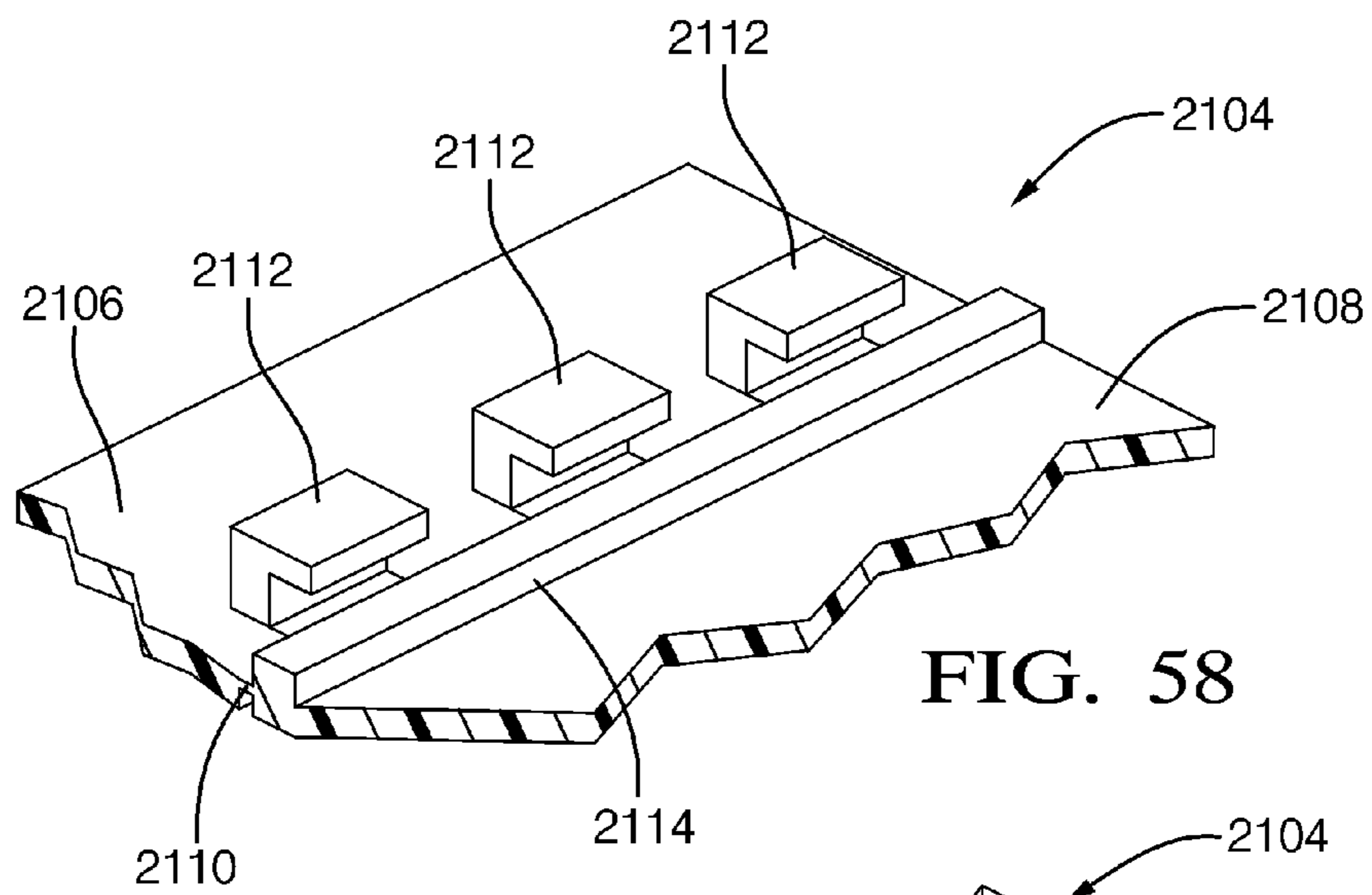
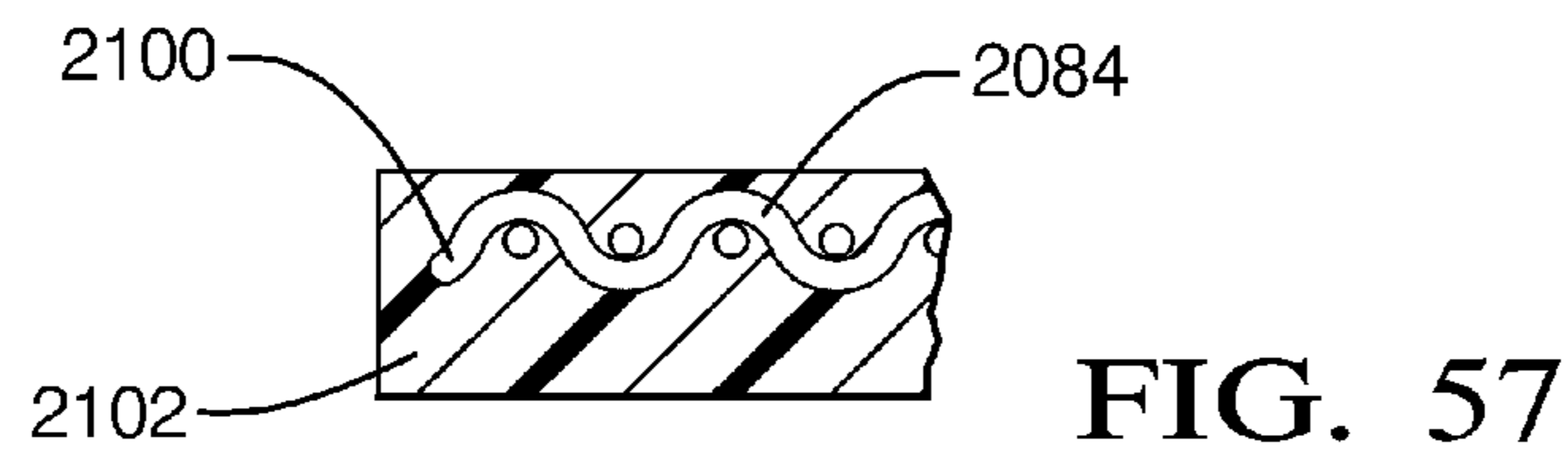
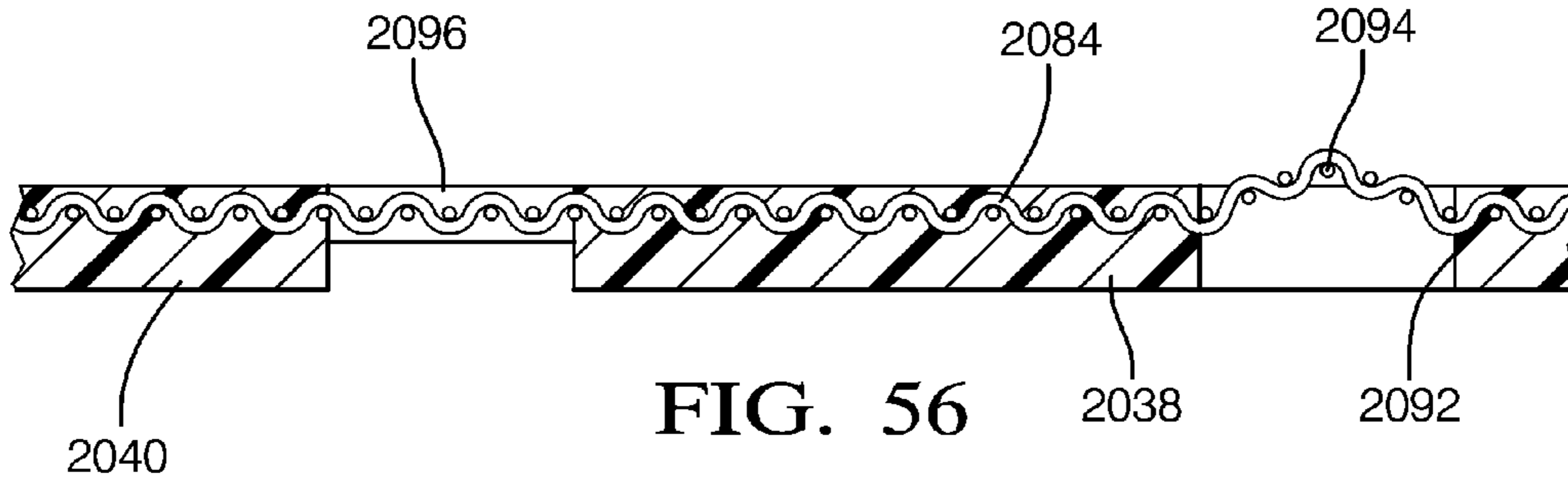


FIG. 55





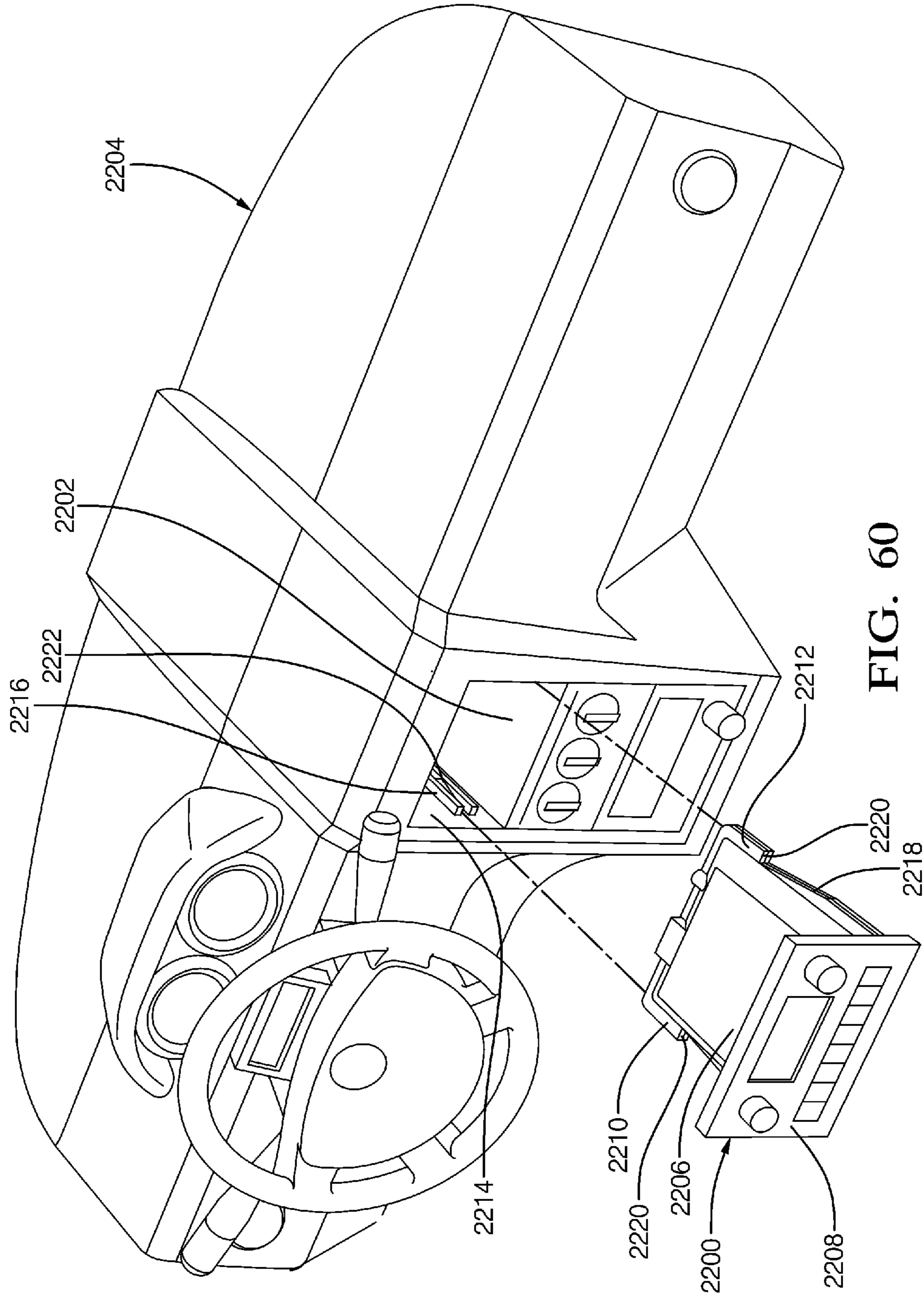


FIG. 60

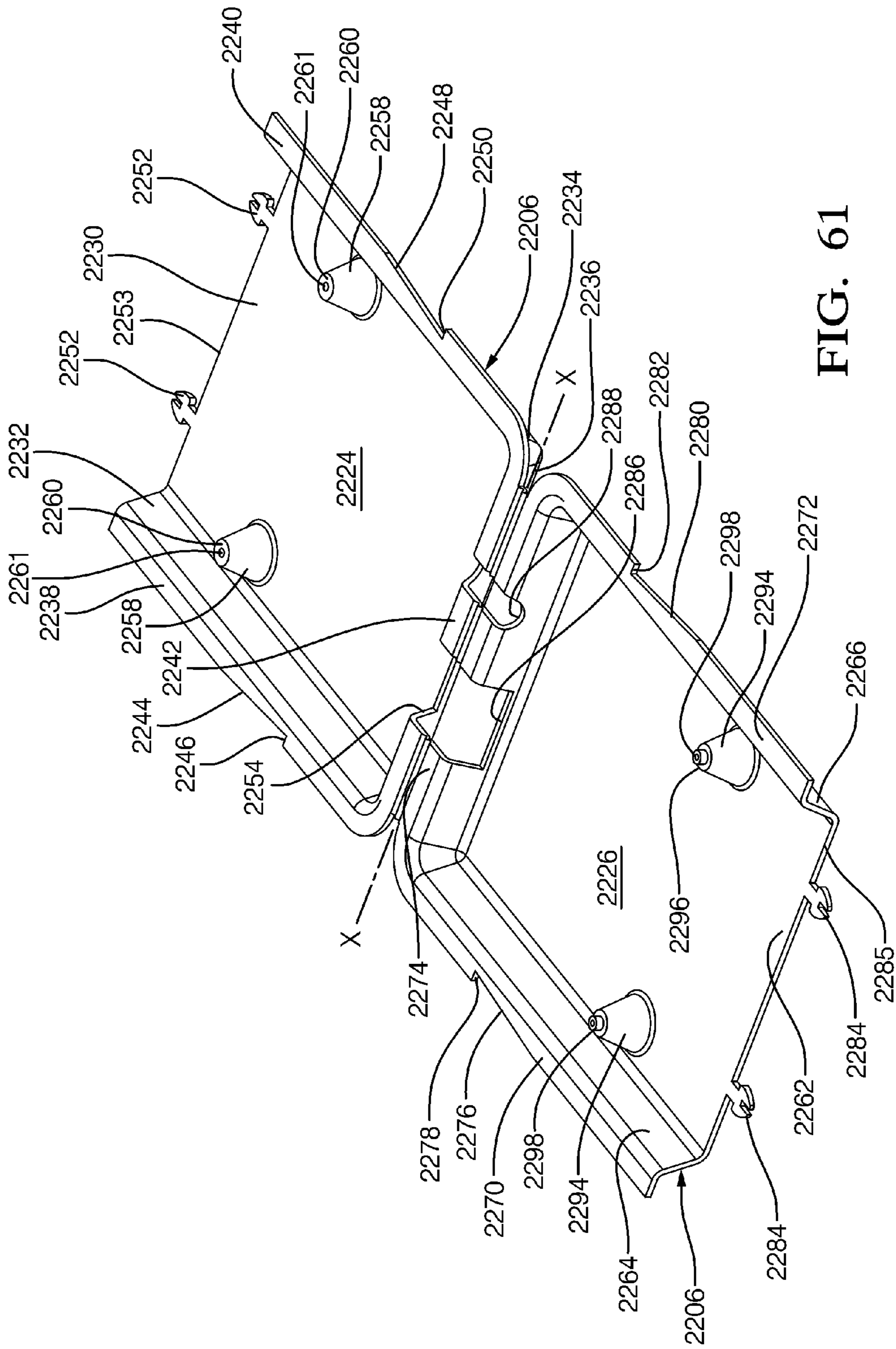


FIG. 61

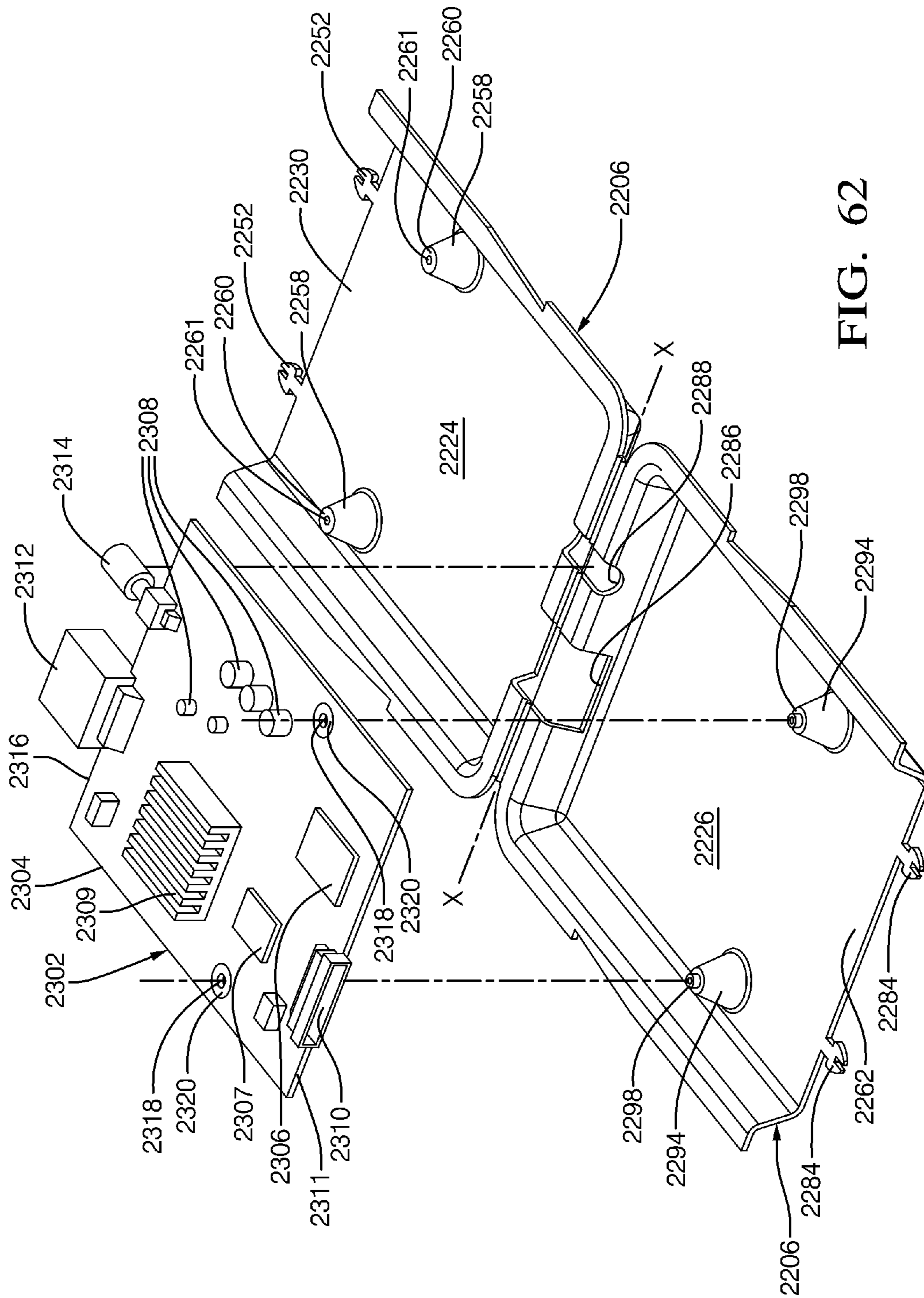


FIG. 62

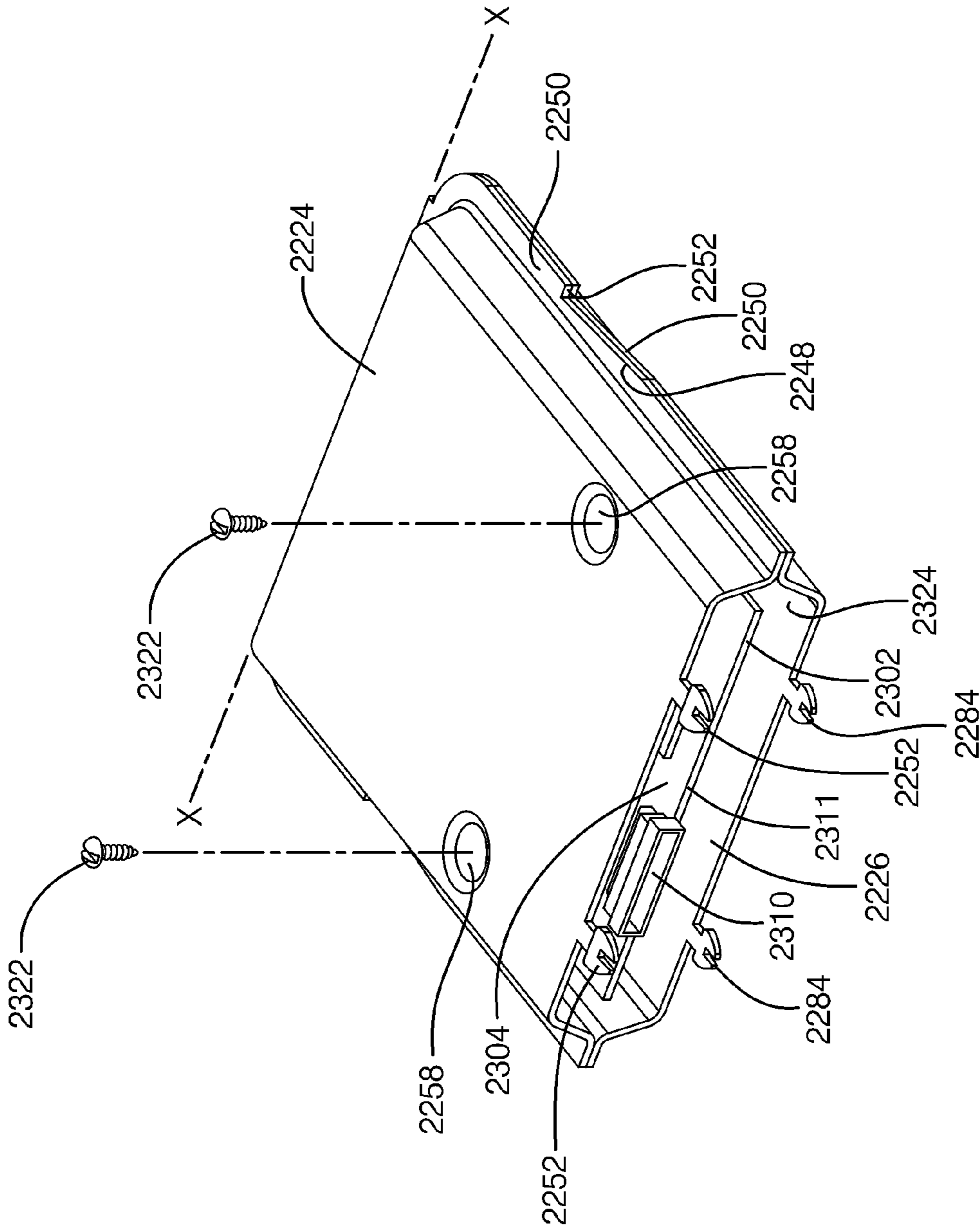


FIG. 63

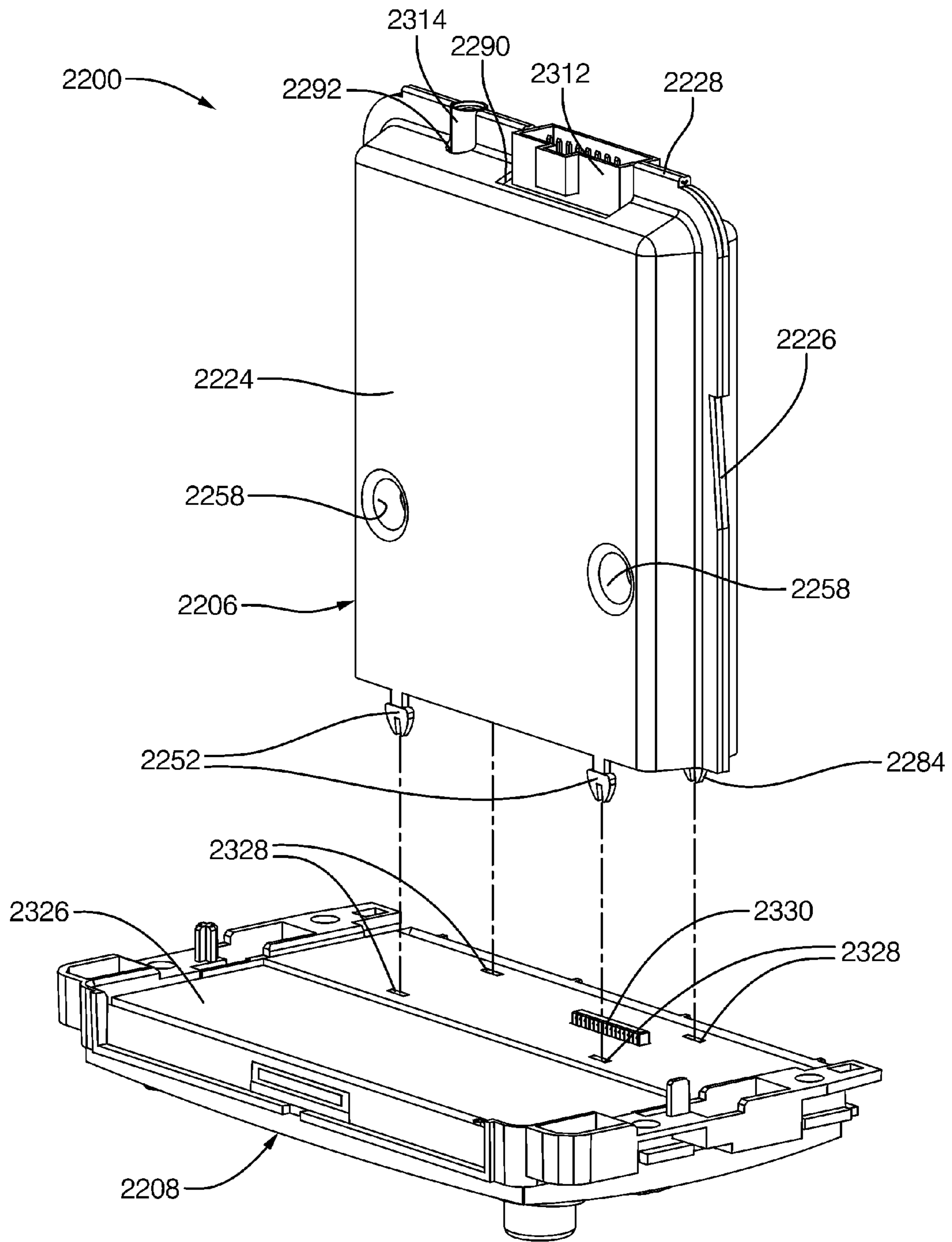


FIG. 64

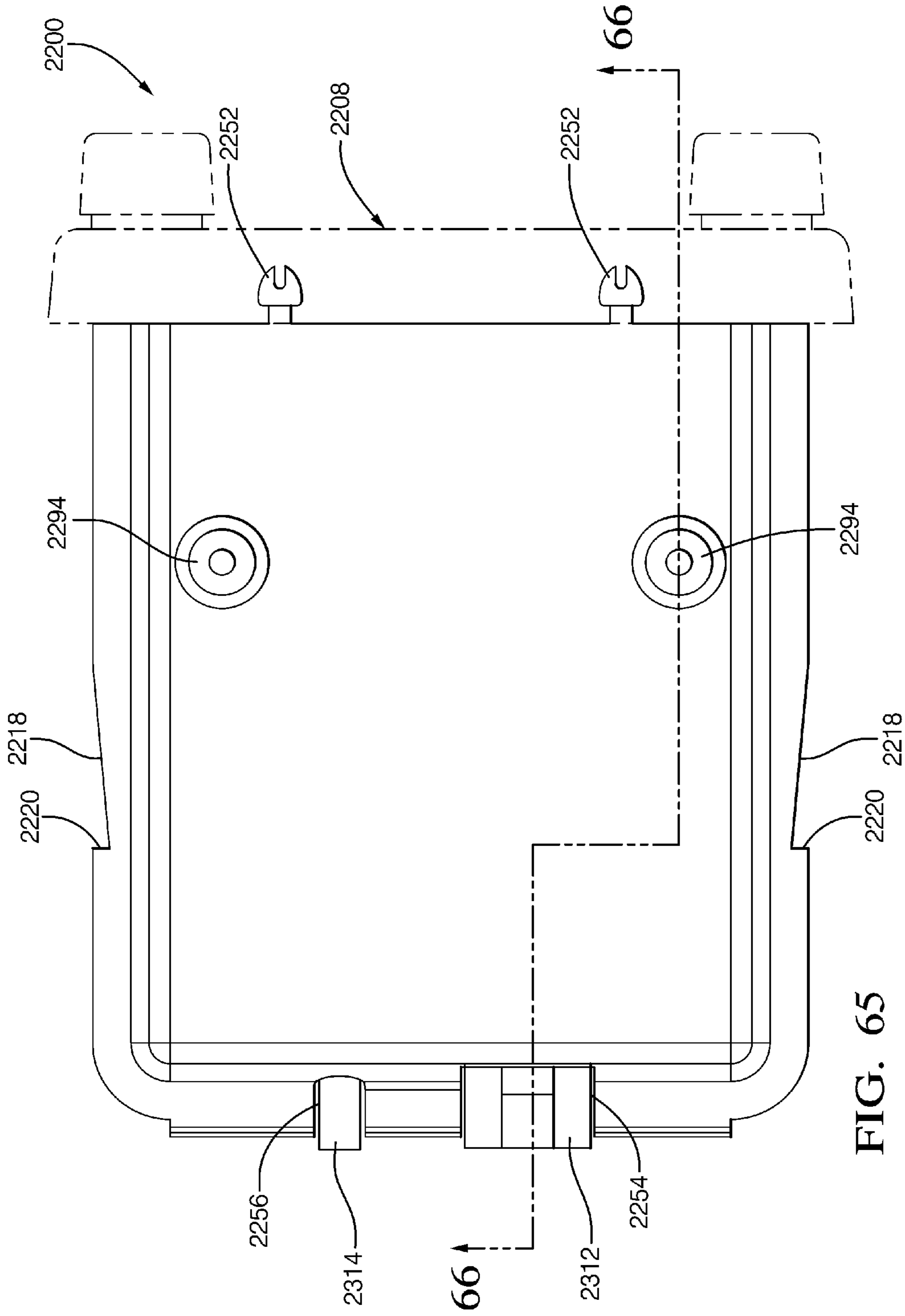


FIG. 65

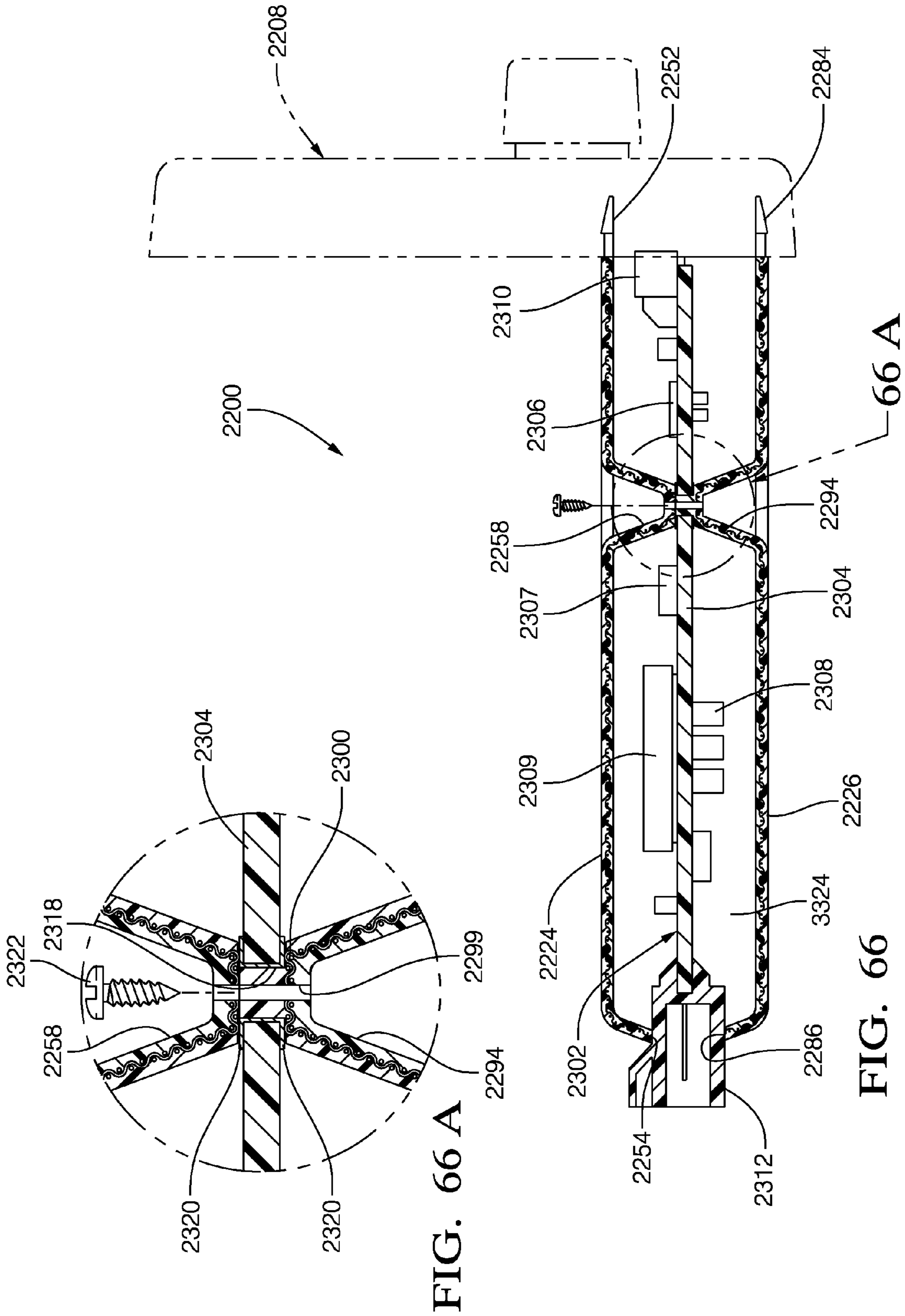


FIG. 66 A

FIG. 66

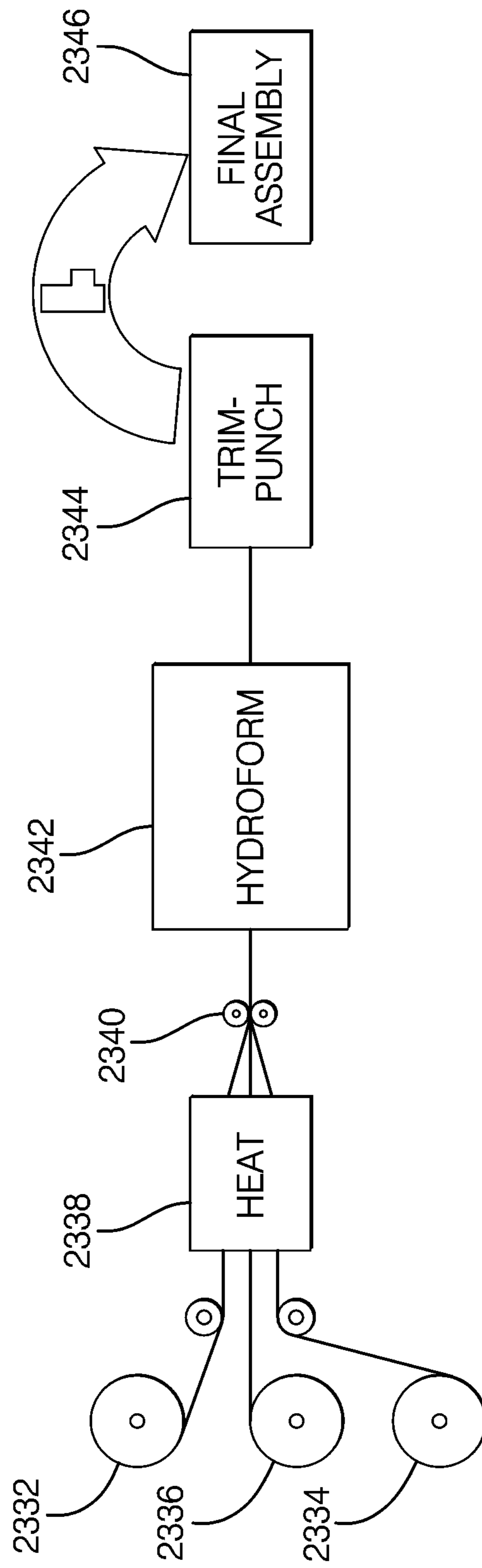


FIG. 67



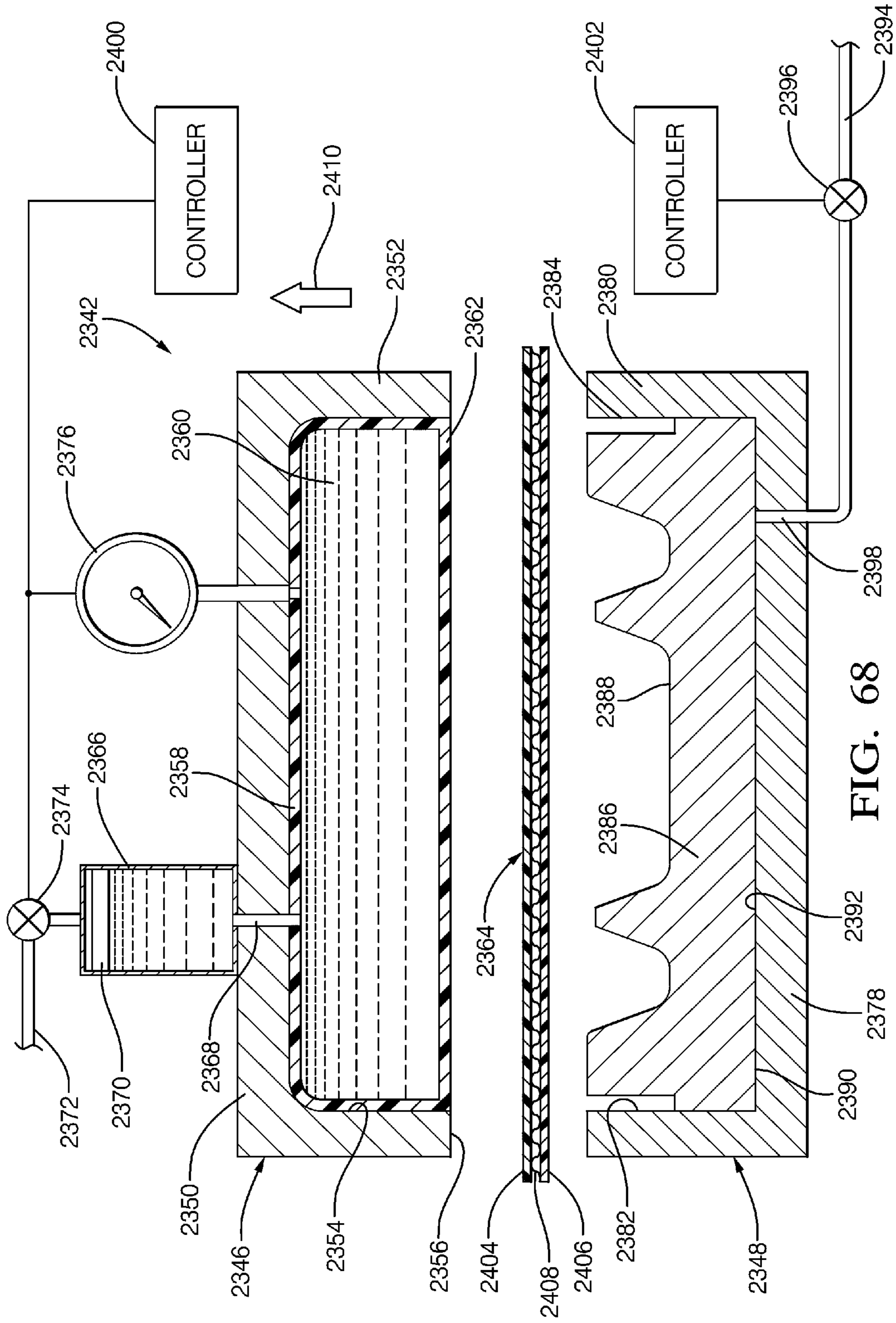


FIG. 68

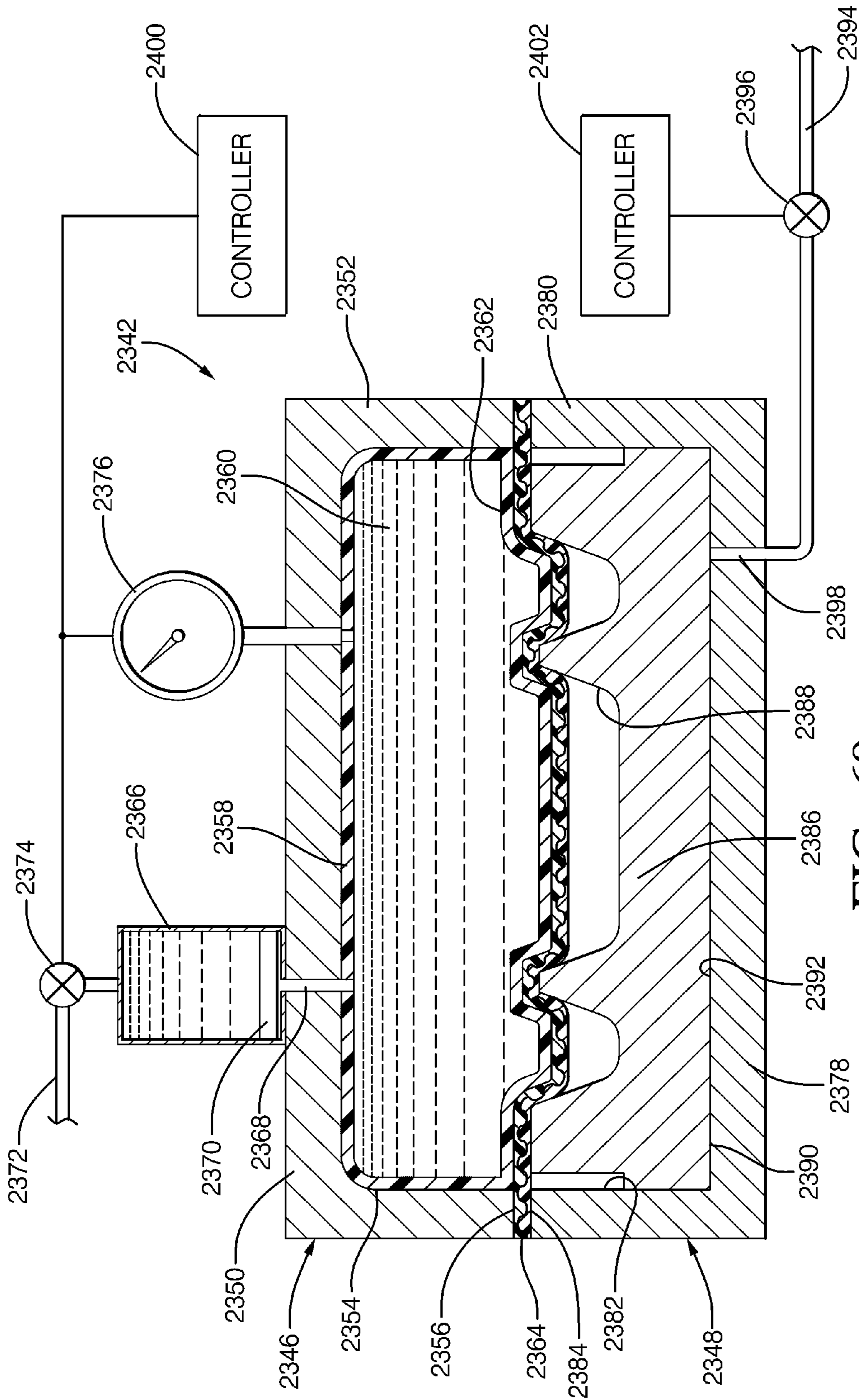


FIG. 69



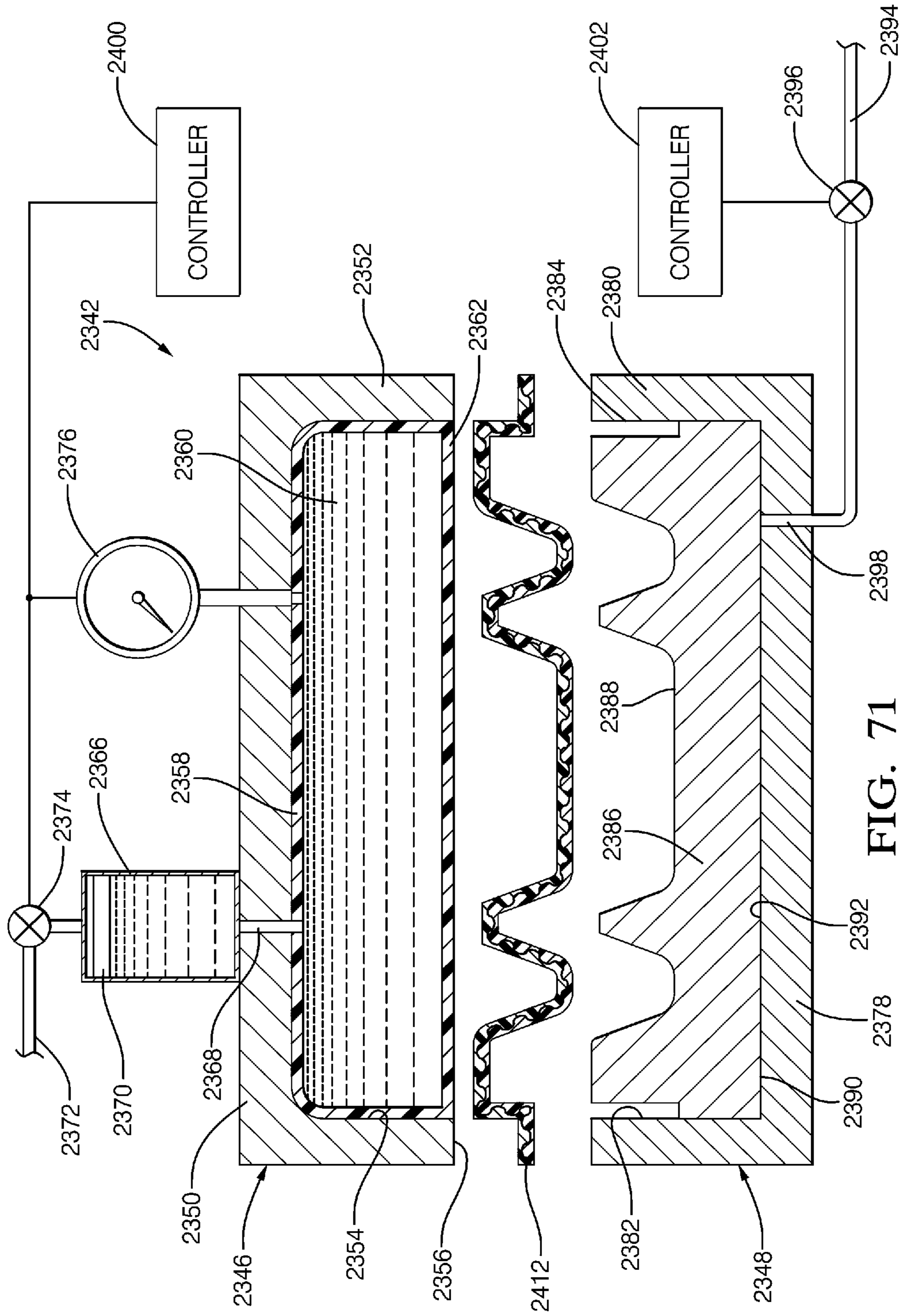


FIG. 71

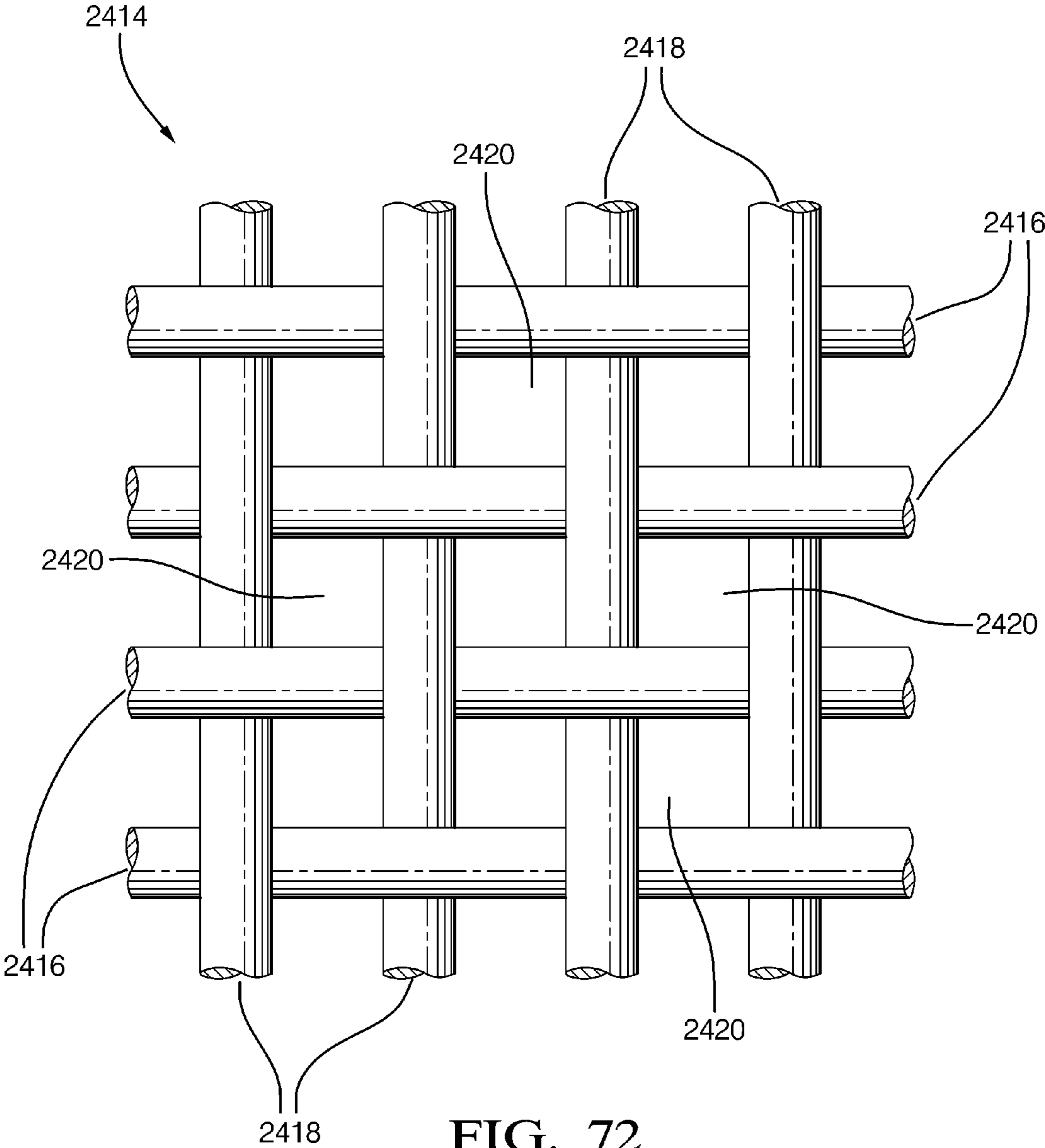
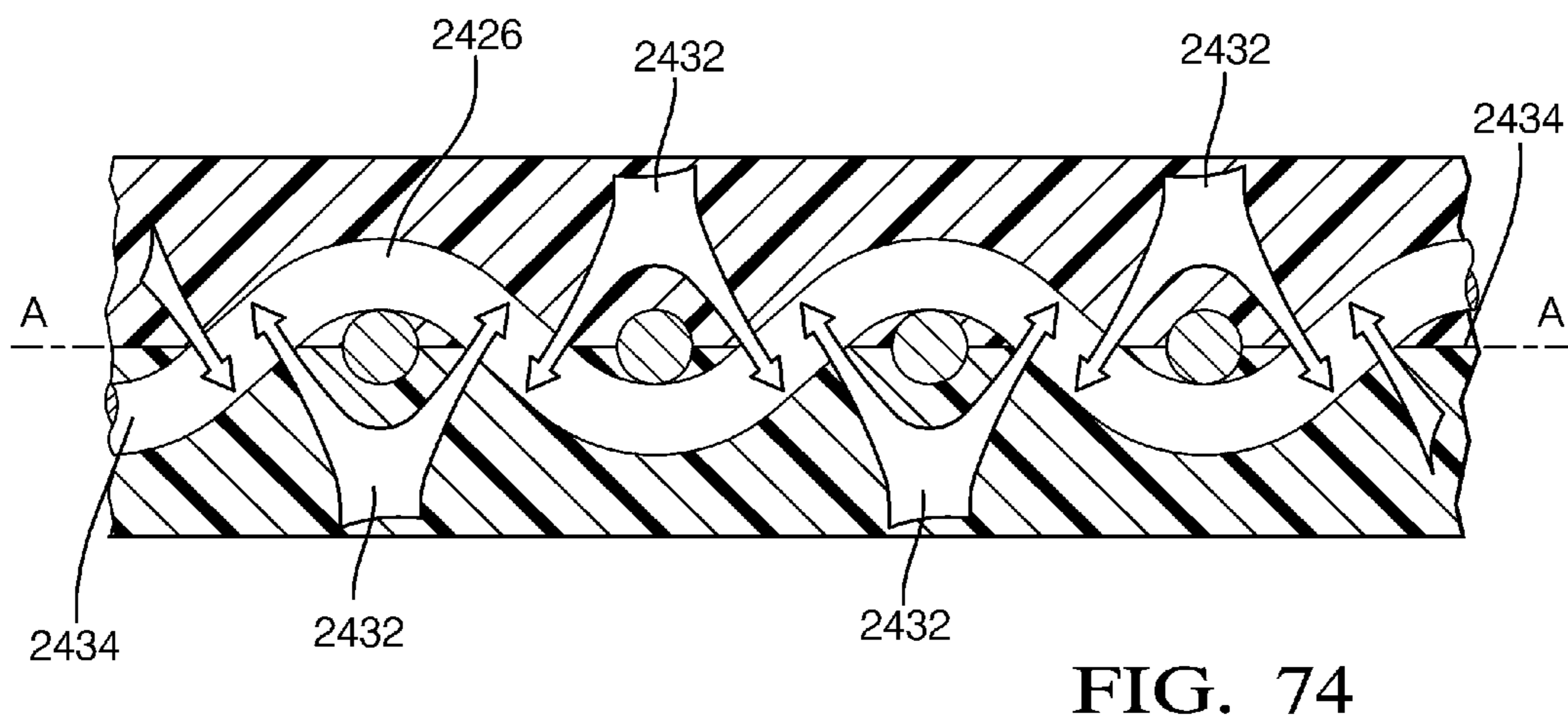
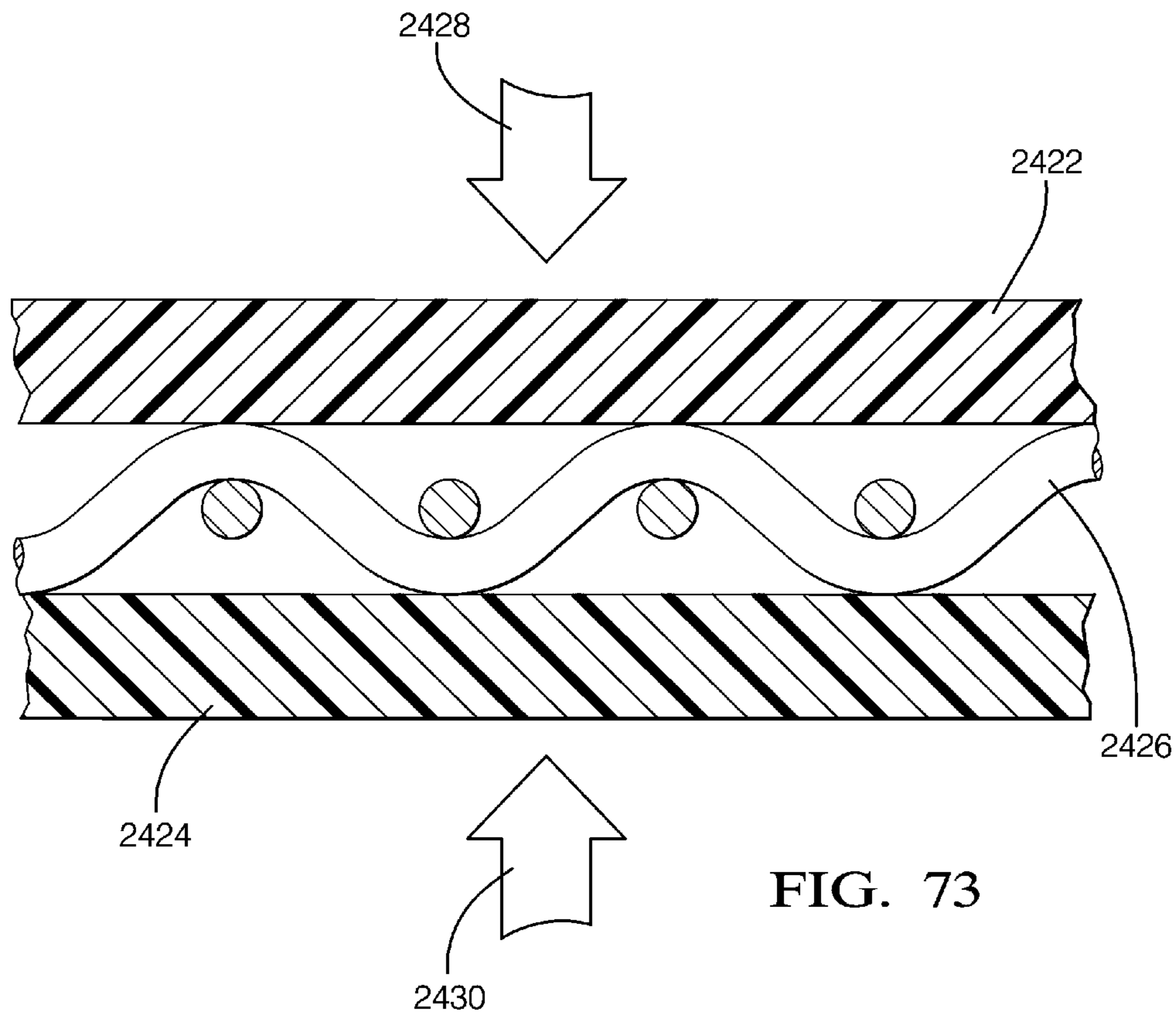


FIG. 72



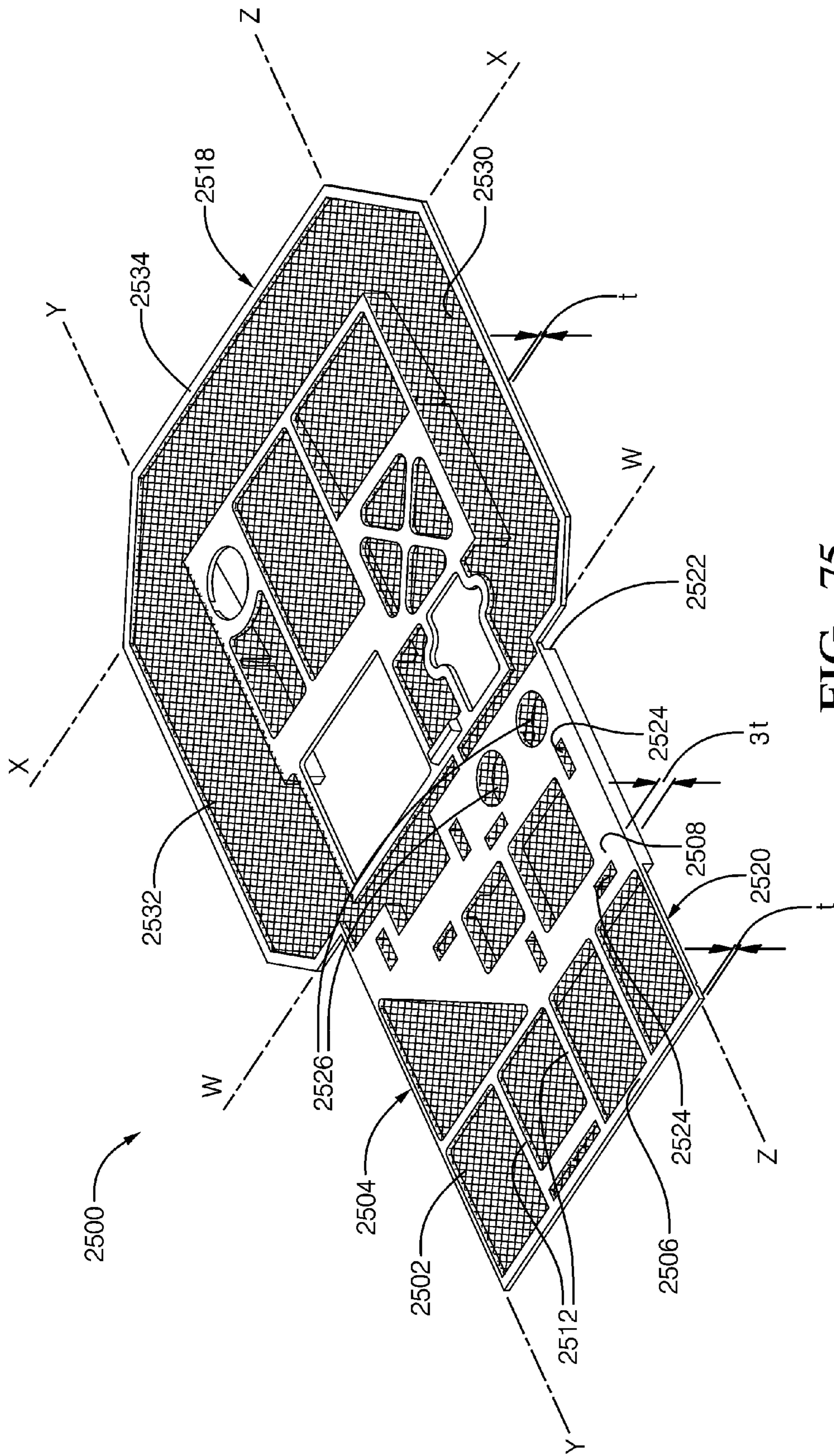


FIG. 75

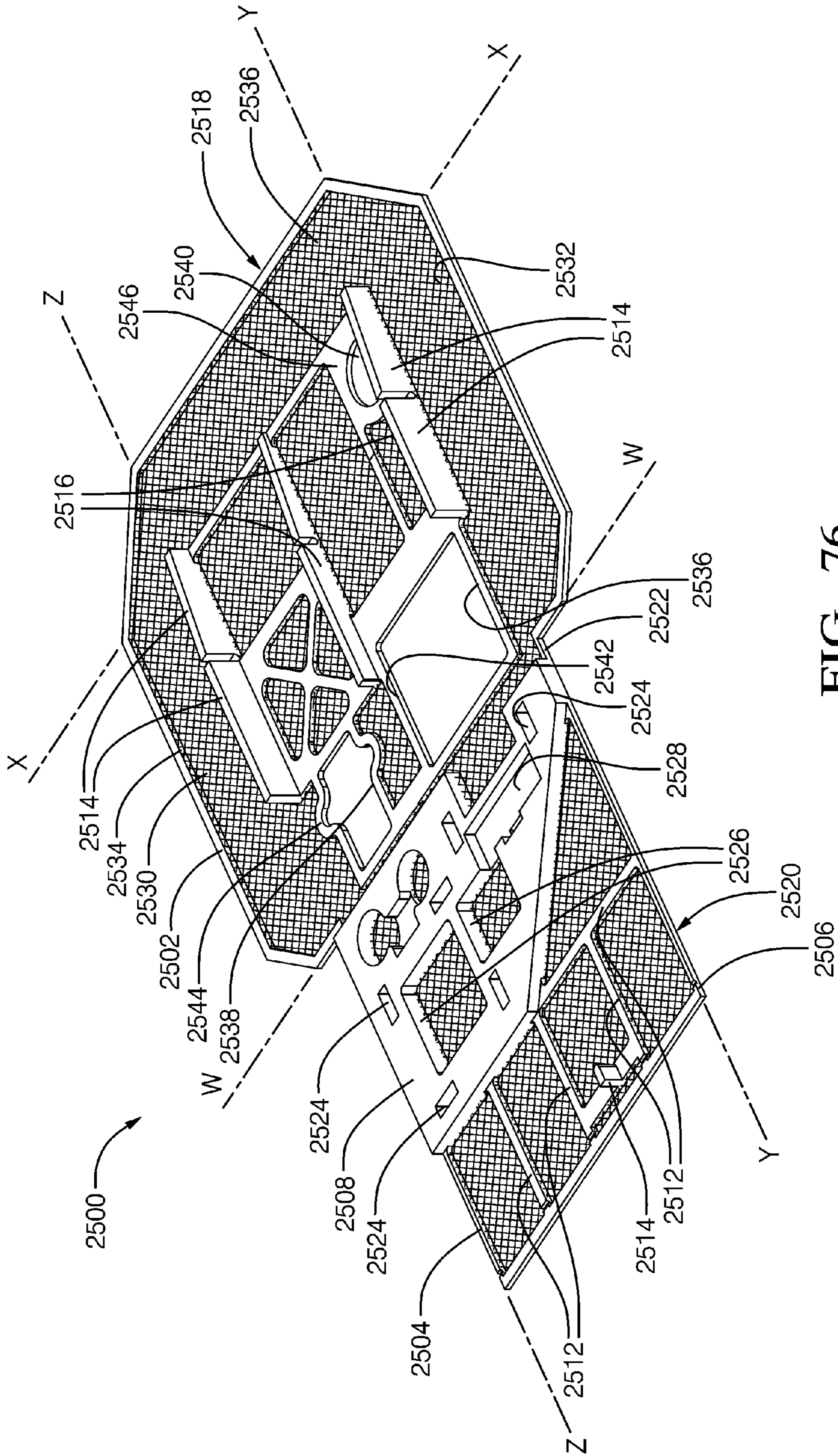


FIG. 76



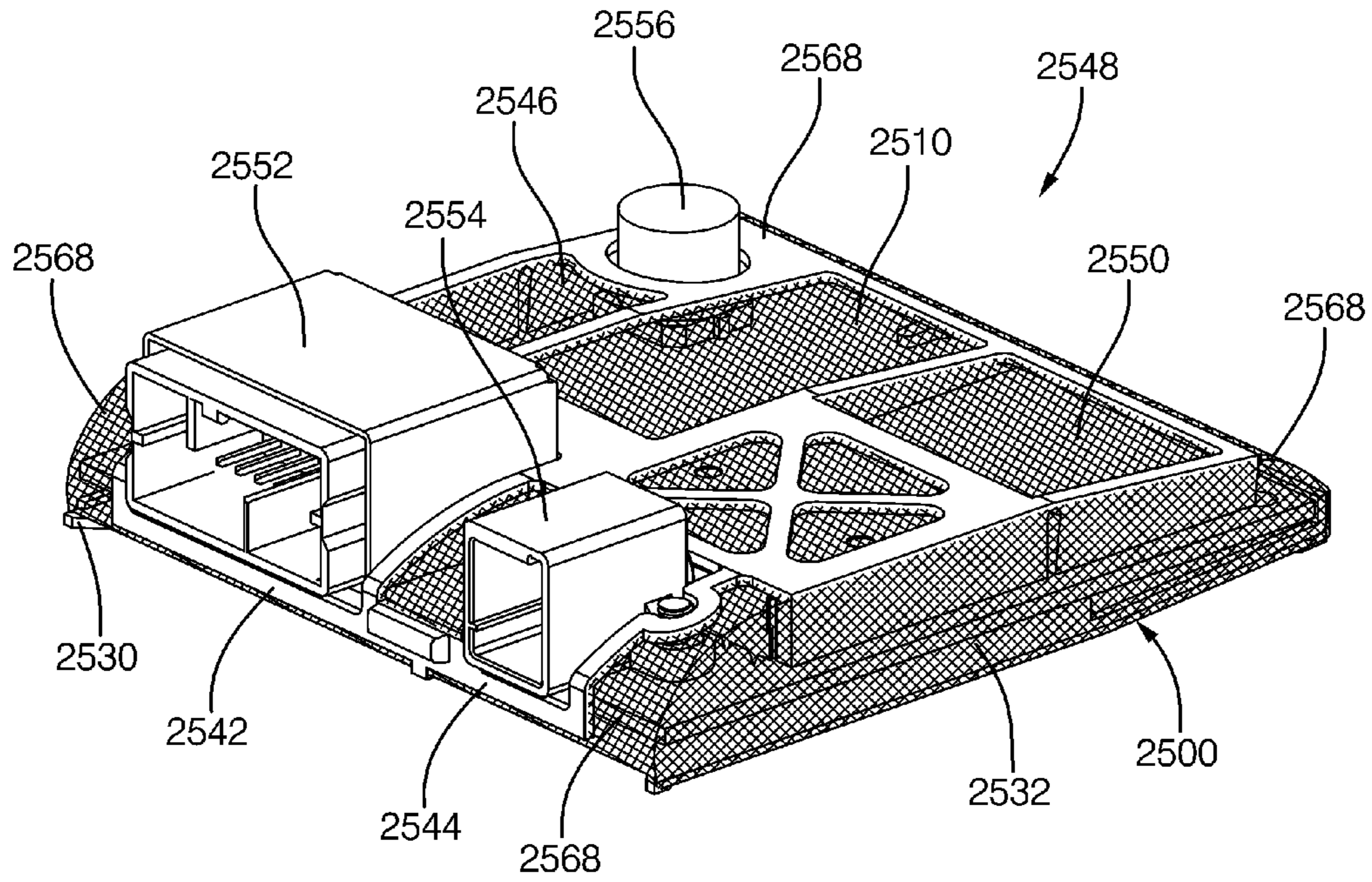


FIG. 77

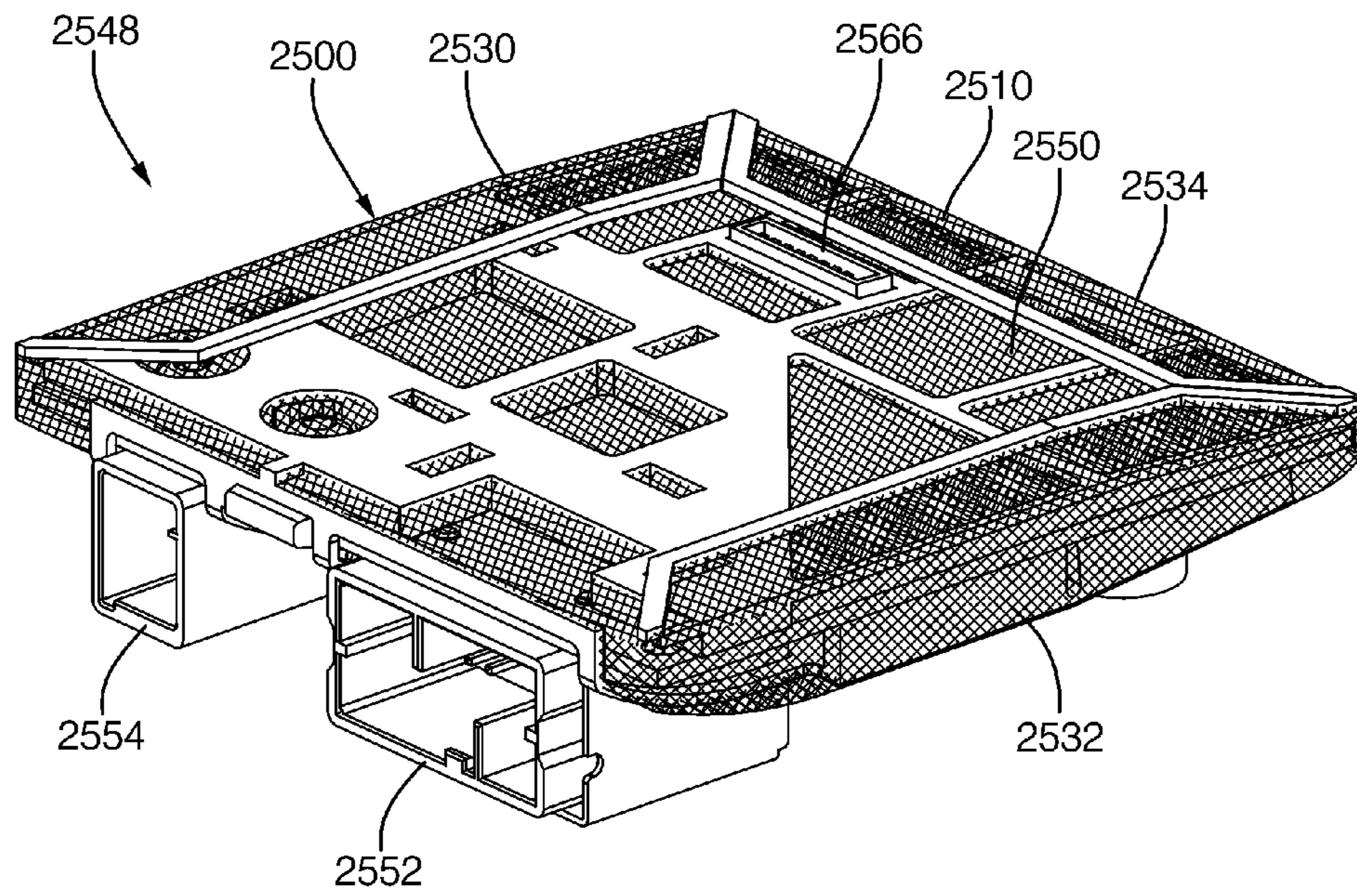


FIG. 78

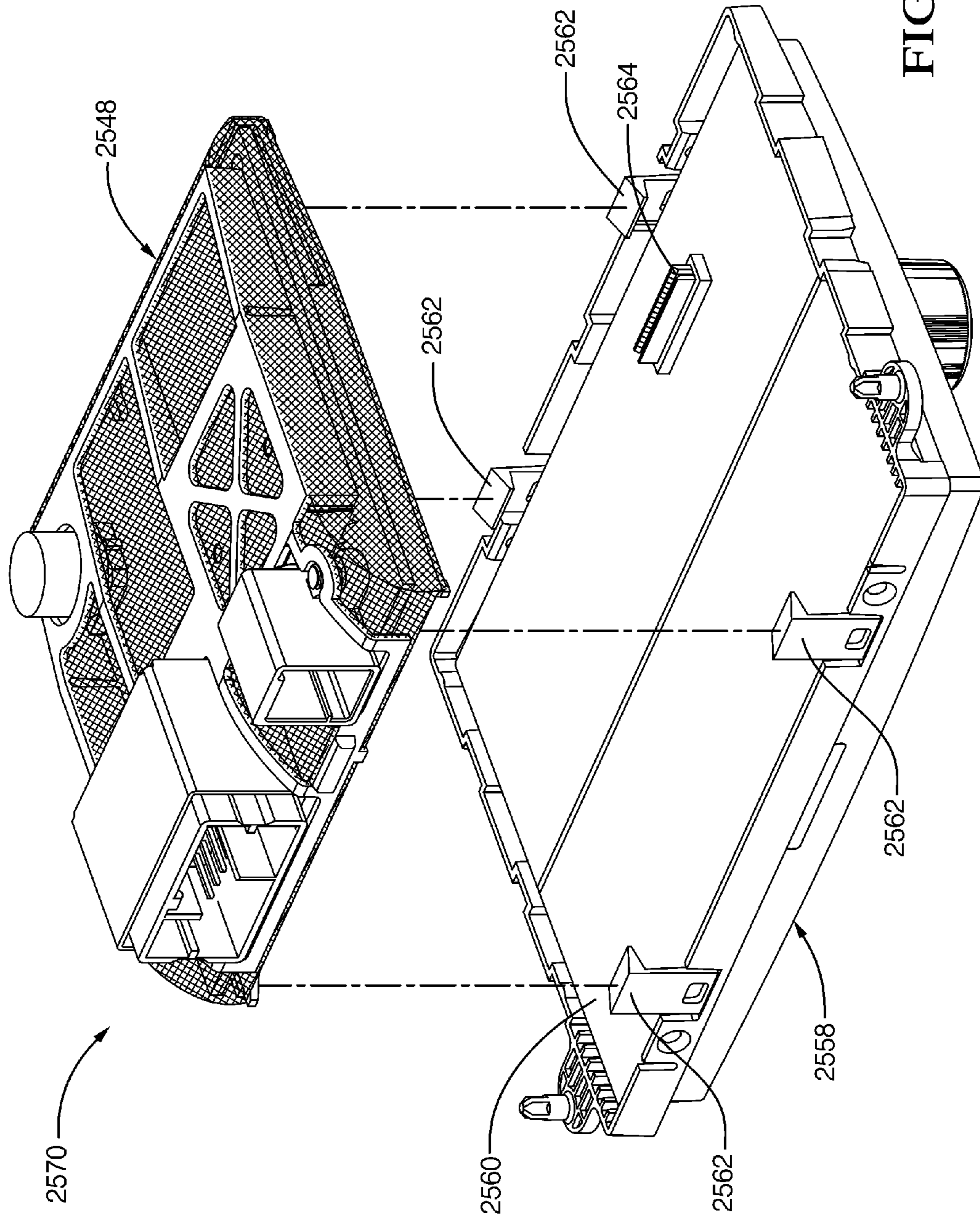


FIG. 79

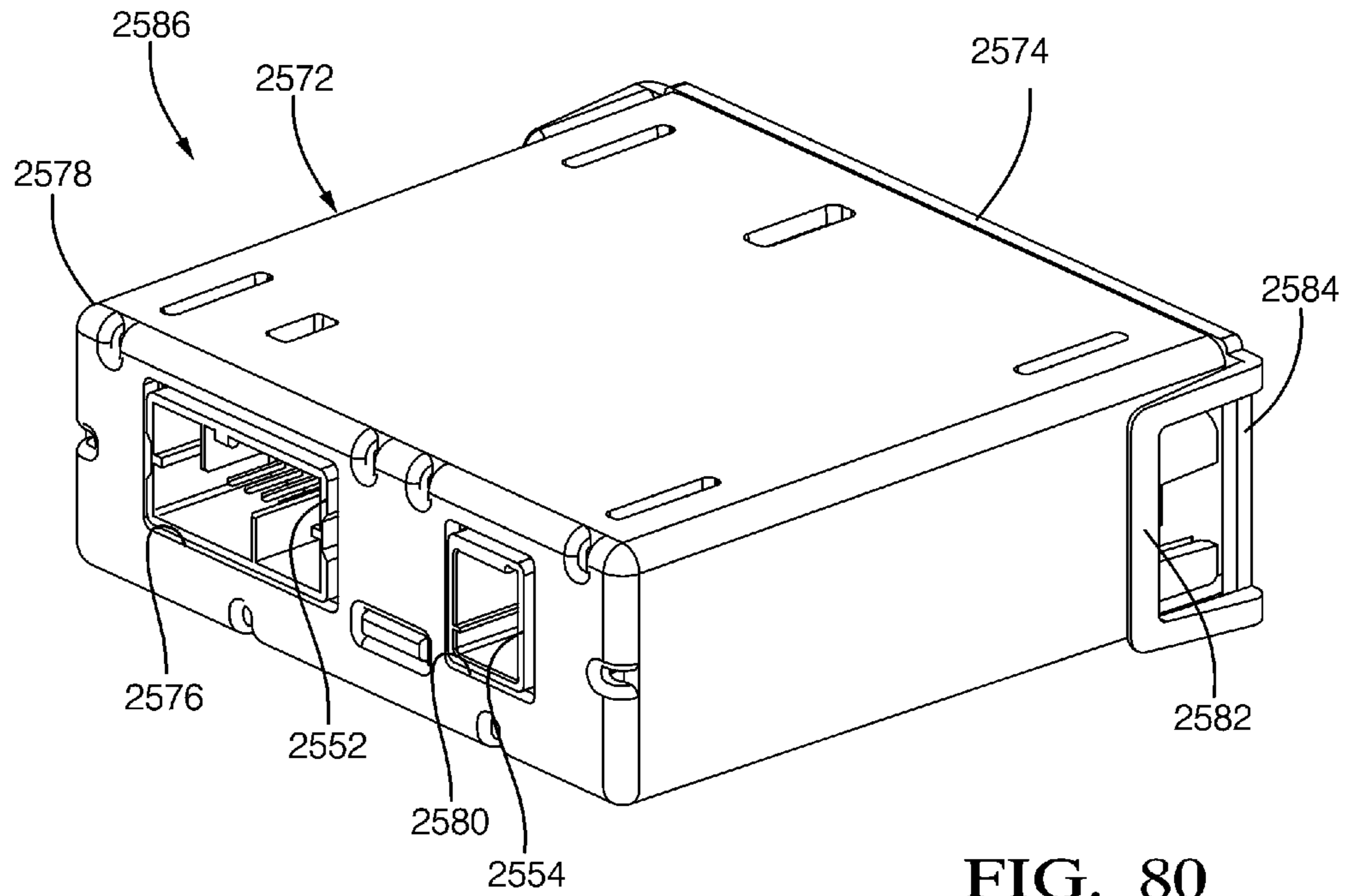


FIG. 80

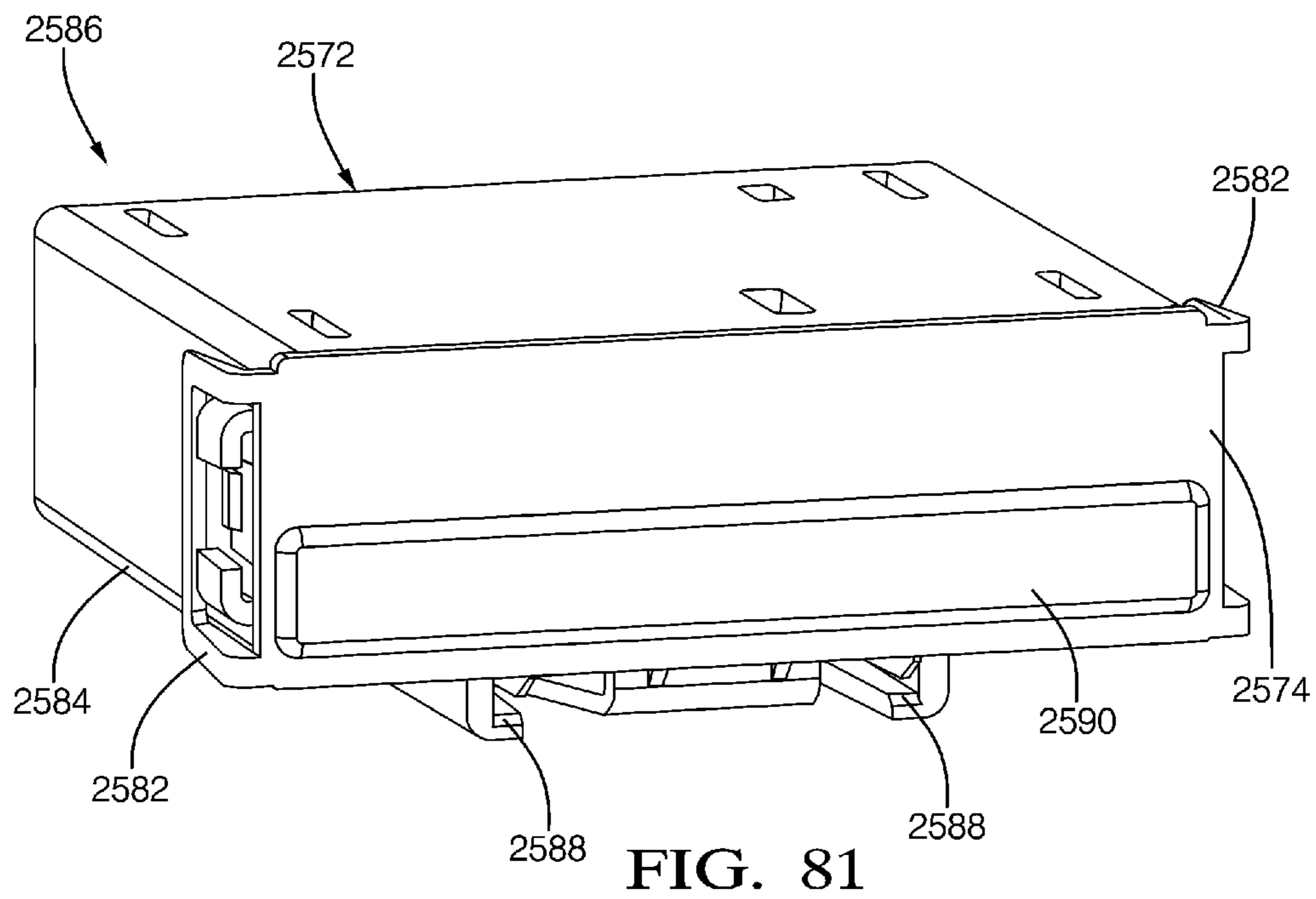
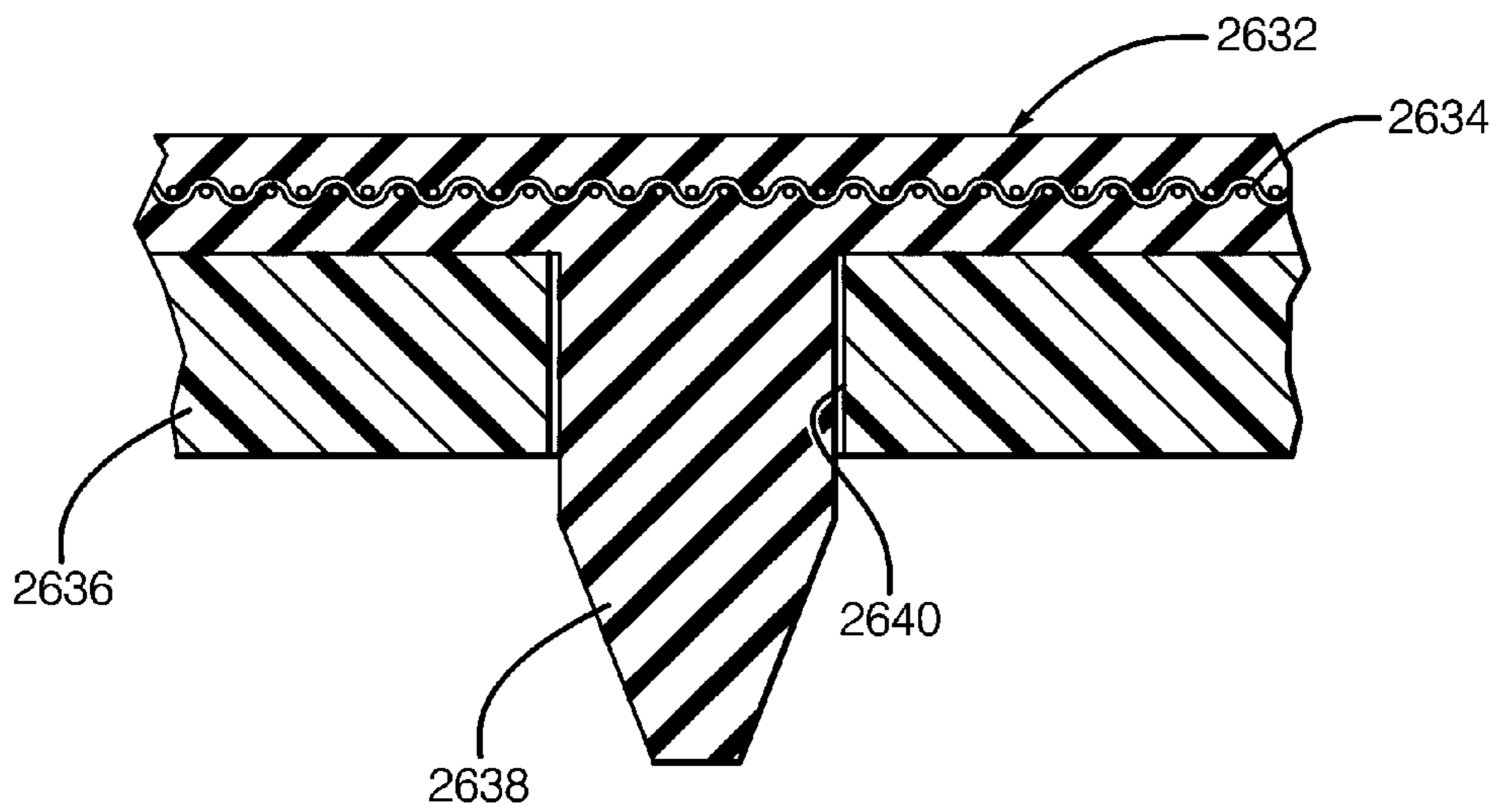
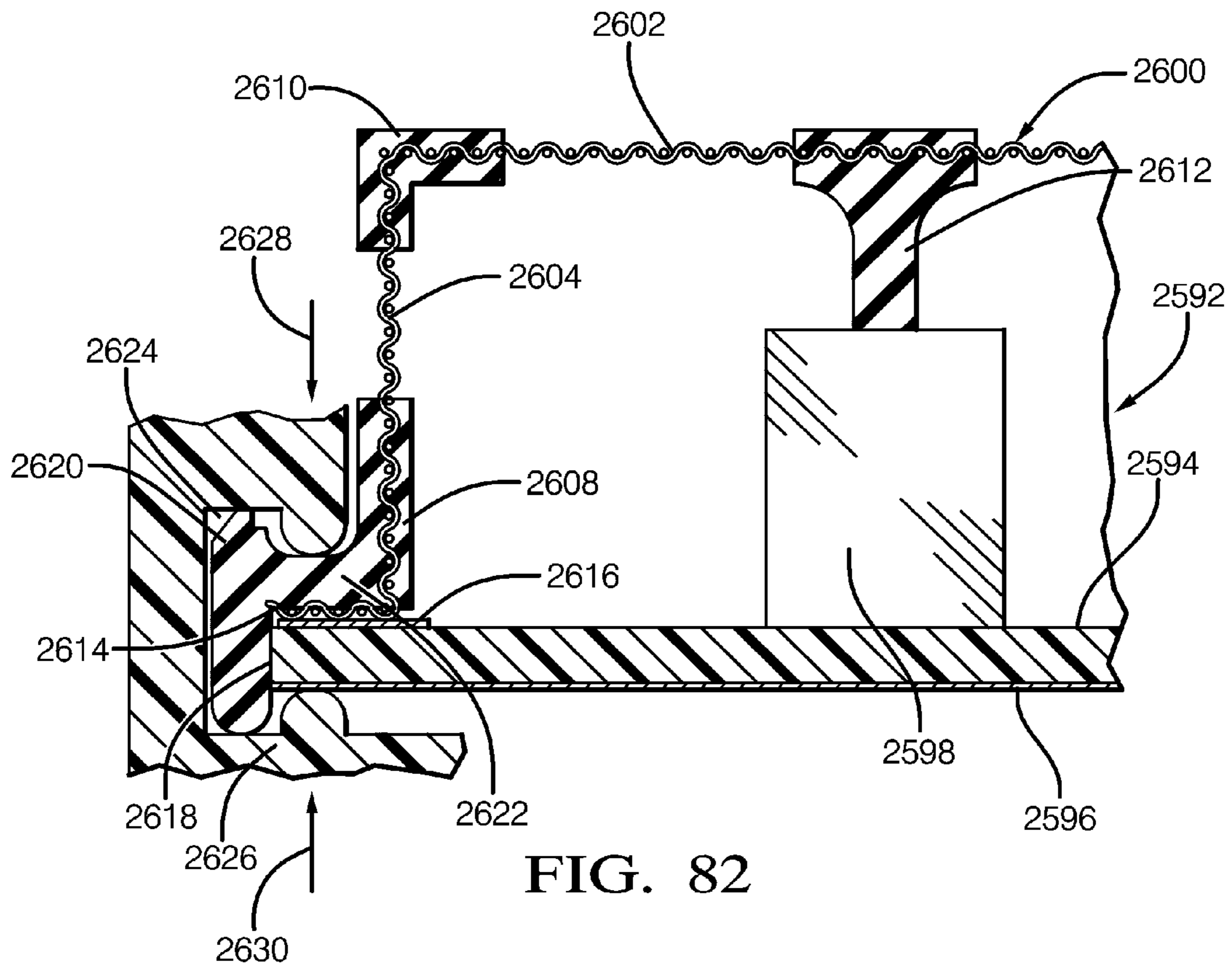


FIG. 81



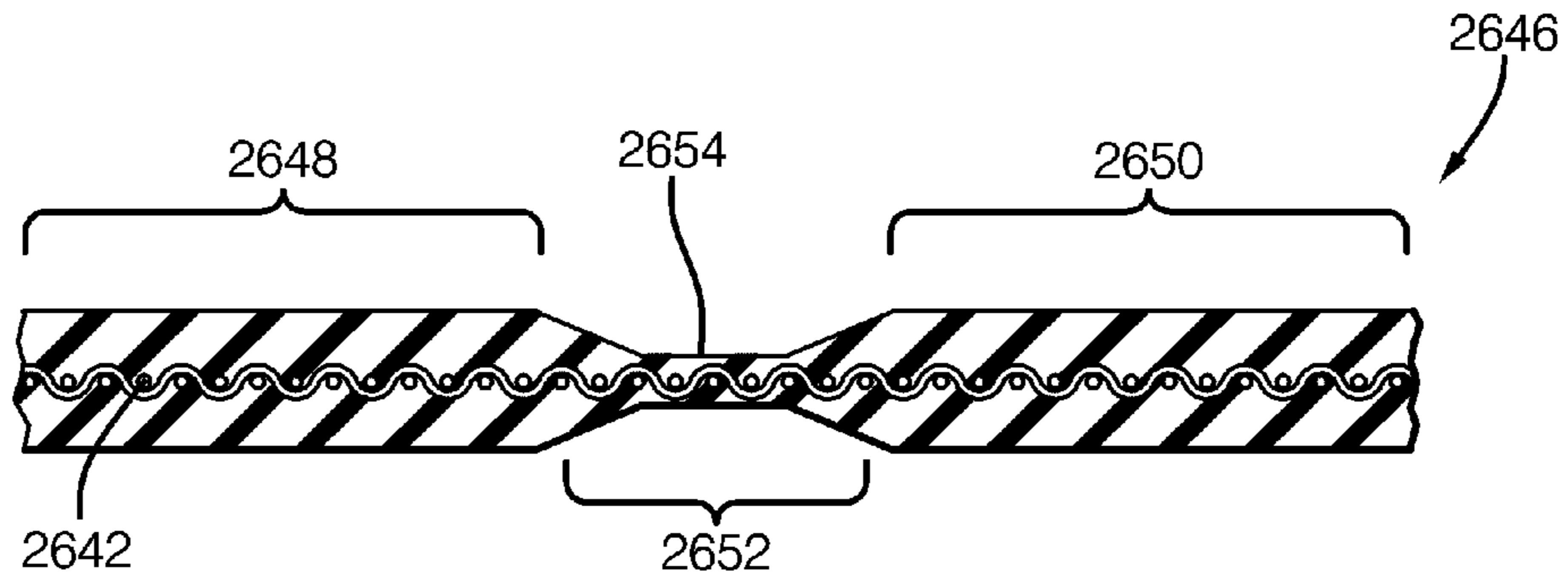


FIG. 84

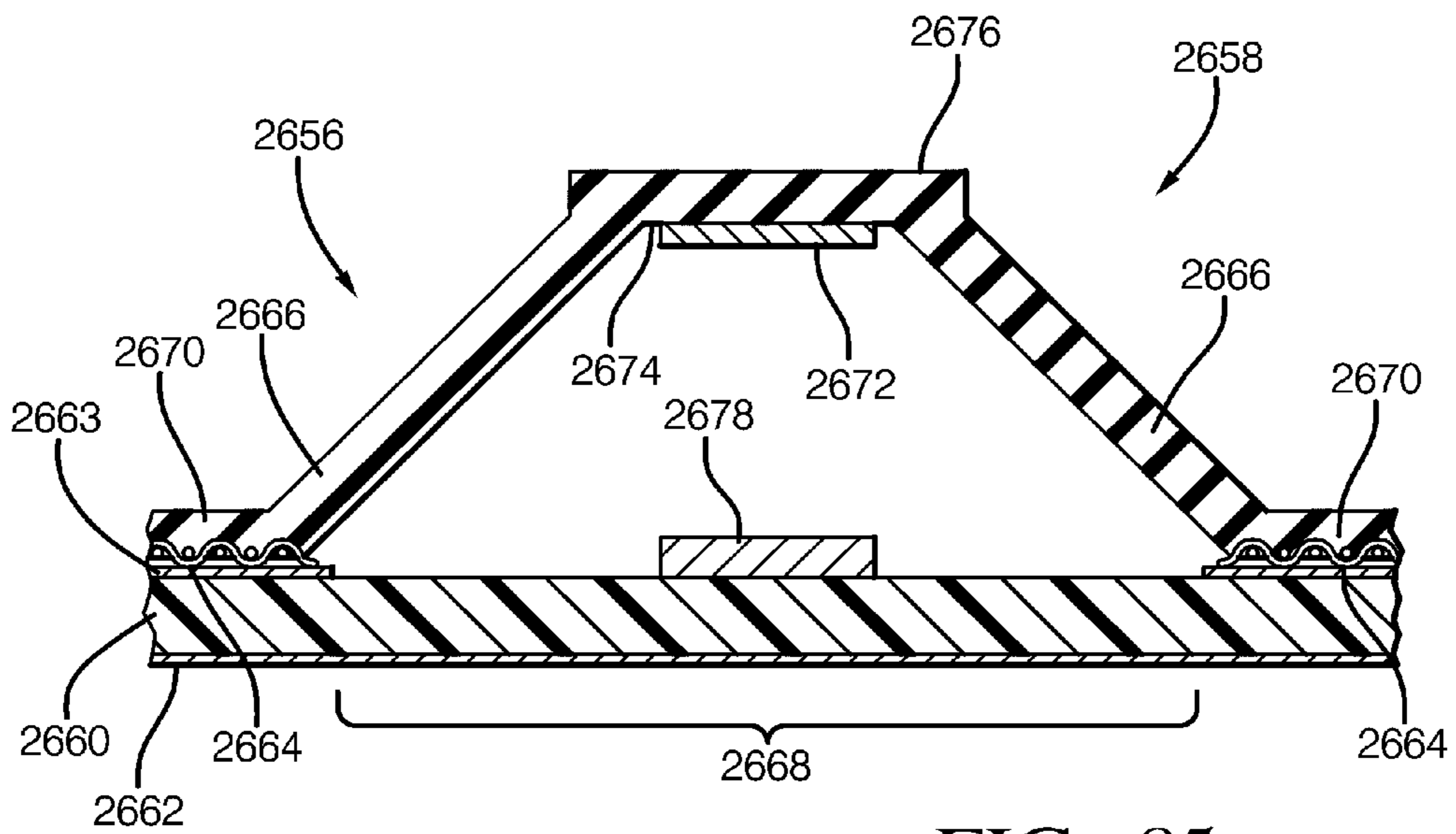


FIG. 85

## FLEXIBLE ELECTRONIC CIRCUIT ENCLOSURE ASSEMBLY

### RELATED APPLICATIONS

The present application claims the benefit under 35 U.S.C. §371 of Published PCT Application Number PCT/US2012/028416, filed 09 MARCH 2012, which claims priority to Provisional application U.S. Ser. No. 61/451,795 filed 11 Mar. 2011 to Chris R. Snider, entitled Lightweight Audio System for Automotive Audio Systems and Method, and is related to Continuation in Part application of U.S. Ser. No. 12/787,452 filed 26 May 2010, which is a Continuation in Part application of Ser. No. 12/708,911 filed 19 Feb. 2010, which is a Continuation in Part application of U.S. Ser. No. 11/893,357 filed 15 Aug. 2007 claiming priority to Provisional applications U.S. Ser. No. 60/838,698 filed 18 Aug. 2006 to Chris R. Snider et al., entitled Lightweight Automotive Radio/CD Player and U.S. Ser. No. 60/931,467 filed 23 May 2007 to Chris R. Snider et al., entitled Lightweight Automotive Telematic Device, both assigned to a common assignee.

### TECHNICAL FIELD

The present invention relates generally to apparatus for enclosing electrical subassemblies, and more specifically relates to apparatus for efficiently securing subassemblies to a chassis of an electrical assembly such as an automobile radio, compact disc playing mechanism, cassette tape playing mechanism, navigational aid, personal computer, personal and telematic communication devices or disk drive mechanism.

### BACKGROUND OF THE INVENTION

Devices such as automobile radios or personal computers contain subassemblies such as cassette playing mechanisms or disk drives that are attached to the chassis using threaded fasteners. The chassis provides structural support for the subassemblies and also provides electromagnetic shielding to limit electromagnetic interference (EMI) experienced by, and/or created by the device. The fasteners ensure that each subassembly within the chassis is properly located and securely retained within the chassis.

The use of such fasteners can have numerous drawbacks, particularly in a high volume production setting. The process for applying or installing fasteners can vary, but there is usually some degree of automation required, ranging from manually loading a screw into a bit on a pneumatic driver to using self-feeding automated machines. Typically, the torque applied by the device used to drive the fasteners must be monitored regularly and adjusted in order to assure proper seating of the fasteners. When fasteners are used, sheet metal tolerances, as well as tolerances of the fasteners themselves, have to be maintained at tight levels to allow for the minimization of stress in the assembly when aligning multiple fasteners with corresponding holes in the chassis and in the subassembly.

When threaded fasteners are used to assemble an electrical device, the assembly cycle time can be very long especially in high volume production. An operator assembling the device must typically first obtain the threaded fastener, orient and position it in alignment with the driver bit, then manipulate or actuate the machine to drive the threaded fastener. Furthermore, using threaded fasteners presents a risk of any one of the following upstream failures occurring: stripping of fas-

tener threads; insufficient torque resulting in an unseated fastener; excessive torque resulting in distension/deformation of the fastener or adjacent electrical components; installation of the wrong fastener type or size; foreign object damage due to fasteners and/or metal shavings dropping onto the assembly and/or subassembly; and stripping of the head of the threaded fastener. Also, a fastener installation tool such as a driver and bit can slip off the fastener and impact an electrical component resulting in a damaged assembly.

If self-tapping fasteners are used, the process of driving the self-tapping fasteners into sheet metal often causes shavings of sheet metal to disperse into the assembly. Such shavings have been known to cause electrical failures, such as shorts or corruption of magnetic components that can permanently damage the product. If self-tapping fasteners are not used, an extra production step is required to pre-form threads in the sheet metal of the chassis and/or the subassembly to be installed within the chassis.

Fasteners further require an additional inventory burden on the production line in that the production line must be continuously stocked with part numbers (fasteners) other than the integral components that add value to the assembly. Also special tools specifically required for assembly, using fasteners, such as drivers and bits, must be continuously monitored and maintained for proper performance, wear and torque specifications. Typically, the top and/or bottom surface of the chassis must be secured in place after the subassembly is attached to the chassis.

Special fixtures are often required on the production line to secure a subassembly in a proper location and orientation while it is mounted within the chassis with fasteners. Such fixtures can be very complex, and the use of such fixtures usually requires extra handling of both the subassembly and of the resulting assembly thereby adding to the production cycle time and potentially compromising quality of the final product.

FIG. 1 illustrates the construction of a typical prior art automotive radio/compact disc (CD) player 10. Radio/CD player 10 comprises a radio subassembly whose principle circuit components are carried on a circuit board 12 and a CD player subassembly 14. The circuit board 12 and the CD player 14 are encased within a common chassis 16 made up of sheet metal components. Chassis 16 includes a wraparound housing 18 defining a back and sidewalls, a top cover 20, a bottom cover 22 and a front plate 24 which are interconnected by numerous threaded fasteners to collectively enclose the subassemblies. The top and bottom covers 20 and 22, respectively, are provided with large arrays holes or openings for airflow and ventilation of heat generated within the radio/CD player 10. A convector or heat sink 26 is carried on an outer surface of one of the chassis sidewalls and is interconnected through a port/window 28 to a power device assembly 30. A trim plate assembly 32, along with a support pad 34 and CD dust cover 36 are affixed to the front plate 24, providing an operator control interface with the radio/CD player 10. Circuit board 12 is electrically in-circuit with the CD player subassembly 14 through an intermediate flex wire cable 38 and with the power device assembly 30 through a jumper cable 40. Information bearing labels 42 and 44 are provided for future reference by the operator and service technicians. The radio/CD player 10 is electrically interconnected with an antenna, power supply, speakers and other related systems of a host vehicle by rear-facing connectors 46 carried on the circuit board 12 which are registered with openings 48 in the rear wall of wraparound housing 18. The radio/CD player 10 is mounted within a host vehicle by threaded fasteners passing through openings in mounting features 50 extending from

front plate 24 and a rearwardly directed mounting bushing 52 which is threadably affixed to a stud 54 carried on the outer surface of the rear wall 56 of wraparound housing 18. As best seen in FIGS. 11 and 12, the shank of the stud 54 extends outwardly through a hole 58 disposed concentrically with a localized recess 60 and the stud 54 is seated within the recess 60. FIG. 90 illustrates another known stud design including a threaded shank secured to the rear wall 53 of a radio set 51 by a set nut 55 and receiving a molded rubber, plastic or vinyl stud 57 thereover. Note the large number of threaded fasteners 59.

The radio/CD player 10 of FIG. 1 is of ordinary complexity and may require fifty or more threaded fasteners to complete the manufacturing process. Installation of that many fasteners may require that the in-process chassis be re-positioned/re-fixed ten to fifteen times as it passes along an assembly line of eight to ten skilled workers/work stations.

Vehicle entertainment systems usually include an audio component such as a radio to enable receiving signals from antennas, contain various forms of playback mechanisms, and have the capacity to accept data from user devices like MP3 players. Typically, the radio has a decorative assembly that provides man-machine interface as well as displaying pertinent data relative to the selected media and audio settings. Also, the back-end or chassis is constructed of metal to provide various functions to ensure the performance of the radio in the vehicular environment. The structure to contain the mass from playbacks, the heat conductive properties, and the electrical shielding and grounding are just a few of the advantages to using the metal construction. Unfortunately, with the density of the metal, the disadvantage of added weight is a side effect of the typical construction. In a vehicle, added weight impacts fuel economy, as well as other hidden costs during assembly that can effect the cost of the product, like sharp edges of metal can be a potential hazard for assemblers in the manufacturing plant as well as added weight can limit the packaging of multiple parts in containers for inter and outer plant distribution.

#### Thermal Management System

Devices such as automobile stereos, audio amplifiers, home stereo systems, two-way radios, computers, signal conditioners/amplifiers, compact disc playing mechanisms, and cassette tape playing mechanisms are examples of products that typically require electrical components to amplify signals and regulate power. Accordingly, such devices typically contain numerous electrical components such as single in-line package (SIP) amplifiers and regulators that are typically soldered into printed circuit boards. Such electrical components generate heat in use. The heat must be dissipated away from the electrical components to avoid damage that can be caused by excessive temperatures in the electrical components. For example, excessive temperatures can cause delicate electrical leads to fail or insulating materials to melt, thereby causing a short circuit resulting in damage to, or even failure of, the entire electrical device.

A convector is often mounted to an outer surface of such a device to dissipate heat generated by components by transferring the heat away from the components and the device to the convector and then to the air through radiation. In order to accomplish this, it is preferable that the convector be physically in contact with the component. The components and the convector can be pressed together to allow even better heat conduction from the components to the convector. Sometimes an intermediary material such as a thermal pad or silicon grease is used between the component and the convector to assist in creating an adequate heat transfer junction.

Many convectors are made from aluminum due to the high heat conductivity of that material. Convectors often include a plurality of fins to increase the effective surface area of the convector and thereby increase the rate at which the convector can dissipate heat. Typically, aluminum, convectors are formed by an extruding process, during which the fins can also be formed integrally therewith.

Convectors are usually assembled to the component or components during final assembly of the overall device in which they are used. At final assembly, components such as SIP amplifiers are already soldered into a printed circuit board. The order of assembly can vary as to which component is assembled into the chassis first. The printed circuit board can be installed into the chassis before the convector is mounted to the printed circuit board and the chassis. Alternatively, the convector can be mounted to the chassis before the printed circuit board is mounted to the convector. Sometimes, the convector is assembled to the printed circuit board to form a subassembly before being assembled to the chassis.

Typically, components are attached to the convector using a clip and one or more threaded fasteners that extend through a hole in the clip and into a hole in the convector. The clip, component and convector must all be simultaneously held in a fixture and then be fastened together with a threaded fastener. If the component includes a hole to accept a threaded fastener, it can be mounted directly to the convector using a threaded fastener that extends through that hole, without using a clip.

The use of such fasteners can have numerous drawbacks, particularly in a high volume production setting. Often, each hole in the convector that receives a fastener must be separately drilled or punched. This is especially true for an extruded convector if the axis of the hole is not aligned with the direction in which the convector is extruded. The fastening process can vary, but there is usually some degree of automation required, ranging from manually loading a screw into a bit on a pneumatically or electrically powered driver to using self-feeding screw machines. Typically, the torque applied by the device must be monitored regularly and adjusted in order to assure proper seating of the fasteners.

The clamping force between the convector and the component should be at a proper level to ensure sufficient heat transfer to the convector. When fasteners are used to attach the convector to the component, clamping force is a function of the type of fastener and its condition and degree of assembly (e.g. the level of torque applied during installation of the fastener). Thus, a threaded fastener that is not seated all the way will give less clamping force than one that is seated all the way. Or, a stripped or improper type of fastener may provide an insufficient clamping force.

Special fixturing is often required to hold a component in the proper location while it is mounted to the convector using one or more fasteners. Such fixturing can be very complex and use of such fixturing usually requires extra handling of both the component and of the resulting assembly, thereby adding to the production cycle time and potentially compromising quality of the final product.

When threaded fasteners are used, the assembly cycle time can be very long, especially in high volume production. The operator must specifically obtain the threaded fastener, bring it in contact with the driver bit, then drive the threaded fastener. If self-tapping fasteners are used, the process of driving the self-tapping fasteners into metal often causes metal shavings to disperse into the assembly. Such shavings have been known to cause electrical failures that can permanently dam-

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age the product. If self-tapping fasteners are not used, an extra production step is necessary to form threads in the metal of the convector.

Accordingly, there is a need for electrical assemblies that do not require fasteners or tooling for securing a component to a convector.

Vehicular radio chassis assemblies may typically contain a circuit board assembly and a playback mechanism that may have ground points from the circuit board to the enclosure. They also tend to have heat sinks added for conducting unwanted heat away from the radio circuit board power components to transfer the heat outside of the chassis. When the enclosure has been constructed of a non-metallic material such as plastic, the grounding and shielding has been provided by a variety of methods, including, but not limited to using a metal wire mesh that is insert molded with the structure of the plastic enclosure. Another method may include using localized shields that are assembled and soldered to the circuit board. However, this approach only provides a shield, not a ground. While plastic enclosures are desirable for manufacturing assembly simplification through the elimination of fasteners as well as weight reductions from the metal enclosures, the capitalization to provide a wire mesh insert to a plastic part has been a drawback, especially in low volume applications. Also, the manufacturing process flow has typically coupled the wire mesh insert fabrication cell directly with the plastic molding press, which may not be desired is the molding process utilization is not at a high enough percentage of the available molding press time.

#### Electrostatic Discharge Device

Static electricity (electrostatics) is created when two objects having unbalanced charges touch one another, causing the unbalanced charge to transfer between the two objects. This phenomenon commonly occurs in homes, vehicles and other environments when the air is dry (i.e. has a characteristic relatively low level of humidity). For instance, when a person slides onto a car seat, electrons may transfer between the two, causing the surface of the person's body to store a charge. When the person, then, touches a vehicle component, the charge may travel (discharge) from the body to the component, thus creating static electricity. If the object touched is an electronic device, such as a home stereo, home theatre system, computer, vehicle entertainment system or other electronic media system, this electrostatic discharge can be harmful to the sensitive electronic components of the device. For instance, when a person slides onto a vehicle seat and inserts a disc into the car stereo, a charge may travel from the body through the disc to the sensitive electronic components in the vehicle stereo. Similar problems may occur when using DVD and other magnetic media and disc players.

Accordingly, problems with the drainage of a static electric charge impacting sensitive electronic components continue to persist.

#### SUMMARY OF THE INVENTION

The present invention provides numerous product and process advantages which collectively result in substantial cost and labor savings. By way of example, the preferred design optimizes the assembly process. It minimizes the required handling of major components and subassemblies during the assembly cycle. Final assembly is optimized, wherein only three major components and subassemblies are involved. This minimizes the number of work stations and fixtures, in-process transfers between work stations and total assembly cycle time. The inventive design permits selection of the optimal mechanical product configuration for a given

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receiver family. Furthermore, it permits idealized electrical and mechanical building block partitioning for common and unique elements.

The preferred embodiment of the invention contemplates screwless final assembly without the use of tools, fixtures and assembly machines. This greatly enhances in-process product flow in the factory, improves scheduling of final assembly, and allows labor intensive processes such as stick lead assembly to be largely moved off-line. This greatly reduces both direct and indirect labor requirements. Furthermore, inventory control is simplified inasmuch as position part proliferation is deferred to or near the end of process.

An embodiment of the invention described herein provides an electronic system housing assembly and method which includes a compression molded three-dimensional case configured to define a substantially closed cavity, either in its own right, or in combination with a front closure member. The case is formed of layered coalesced composite of one or more layers of relatively rigid polymer sheet material and a layer of electrically conductive sheet material operative to shield an electronic component within the cavity and to mount the housing assembly within a host vehicle.

A preferred embodiment of the present invention describes a flexible enclosure assembly for an electronic device for vehicular application is virtually "fastenerless" and includes a preform blank of conductive sheet material such as wire screen mesh or the like which defines upper, lower and a plurality of side wall portions flexibly interconnected by living hinges. A framework of resilient elastomeric material is insert molded to the preform blank to provide three-dimensional case details to accept one or more electronic devices such as circuit boards required for electrical control and display of vehicle based systems. The conductive sheet material is preferably a wire mesh which provides shielding from electrical anomalies and grounding of the circuit boards via exposed wire mesh pads and adjacent ground clips. Major components and subassemblies are self-fixturing during the final assembly process, eliminating the need for dedicated tools, fixtures and assembly equipment.

These and other features and advantages of this invention will become apparent upon reading the following specification, which, along with the drawings, describes preferred and alternative embodiments of the invention in detail.

#### BRIEF DESCRIPTION OF THE DRAWINGS

The present invention will now be described, by way of example, with reference to the accompanying drawings, in which:

FIG. 1, is an exploded, perspective view of a prior art automotive radio/CD player combination in a common chassis constructed of sheet metal and a large number of threaded fasteners;

FIG. 2, is a front-left perspective view of an alternative embodiment of the present invention embodied in an automotive radio/CD player;

FIG. 3, is an exploded, perspective view of the radio/CD player of FIG. 2, illustrating the major subcomponents and subassemblies thereof;

FIG. 4, is an exploded, perspective view of the radio/CD player of FIG. 2, illustrating final assembly step I in the production thereof wherein the playback mechanism and circuit board assembly are slid and snapped to the faceplate;

FIG. 5, is an exploded, perspective view of the radio/CD player of FIG. 2, illustrating final assembly step I in the production thereof wherein the case is slid and snapped to the faceplate;



FIG. 6, is an exploded, perspective view of the radio/CD player of FIG. 2, illustrating final assembly step III in the production thereof wherein the power device retainer clip and heat sink are consecutively anchored, pivoted and snapped to the side of the case;

FIG. 7, is an exploded, perspective view of the radio/CD player of FIG. 2, illustrating final assembly step IV in the production thereof wherein the trim plate assembly is snapped to the faceplate/back-end assembly;

FIG. 8, is a bottom plan view of the radio/CD player of FIG. 2;

FIG. 9, is a left side plan view of the radio/CD player of FIG. 2;

FIG. 10, is a rear plan view of the radio/CD player of FIG. 2;

FIG. 11, is a perspective view of the circuit board assembly with ground clips installed thereon;

FIG. 12, is a fragmentary, cross-sectional view of a ground clip and an associated portion of the printed circuit board on an enlarged scale in assembly with an adjacent portion of the case to effect a grounding point with the integral wire mesh;

FIG. 13, is a fragmentary, perspective view of a keypad grounding clip integrally formed on the front side of the faceplate;

FIG. 14, is a cross-sectional view taken on lines 14-14 of FIG. 13;

FIG. 15, is a cross-sectional view taken on lines 15-15 of FIG. 13;

FIG. 16, is a cross-sectional view taken on lines 16-16 of FIG. 13;

FIG. 17, is a front perspective view of a prior art faceplate illustrating rivet/staked spring clips for ESD protection to associated contact pads on a trim plate assembly;

FIG. 18, is an exploded, perspective view of a second alternative embodiment of a radio/CD player featuring an unfolded case which provides a single plane bottom up assembly configuration;

FIG. 19, is a representative cross-section of the case wall structure of the radio/CD player of FIG. 18, on a greatly enlarged scale, illustrating a thin wall section forming a living hinge;

FIG. 20, is a fragmentary, cross-sectional detail of adjacent case panel edge portions of the radio/CD player of FIG. 18, on an enlarged scale, in a post assembly orientation prior to engagement of cooperating integral latch features;

FIG. 21, is a fragmentary, cross-sectional detail of adjacent case panel edge portions of the radio/CD player of FIG. 18, similar to that of FIG. 20, in a post assembly orientation after engagement of cooperating integral latch features;

FIG. 22, is a representative cross-sectional detail of a variant of the case wall structure of the radio/CD player of FIG. 18, on a greatly enlarged scale, illustrating a screen only section forming a living hinge;

FIG. 23, is a schematic representation of manufacturing process equipment for producing a continuous strip of composite/laminate (plastic-screen-plastic) material for subsequent formation of the case structure of the radio/CD player of FIG. 18;

FIG. 24, is a representative view, on a greatly enlarged scale, of laminate case material produced by the process equipment of FIG. 23, illustrating a localized deformation of the material to define a reduced thickness, undulating living hinge section;

FIG. 25, is a schematic representation of alternative manufacturing process equipment for producing a continuous strip

of composite (plastic & screen) material for subsequent formation of a case structure suitable for the radio/CD player of FIG. 18;

FIG. 26, is a front perspective view of an alternative embodiment of the invention, substantially similar to that of FIG. 2, but with I/O control device function graphical detail highlighted;

FIG. 27, is a front perspective view of the interior surface details of the case/back-end of FIG. 10 illustrating the wire mesh screen which has been insert molded within the case adjacent the inner surface portions thereof;

FIG. 28, is a front-above perspective view of a partially assembled radio/CD player, substantially similar to that illustrated in FIG. 7 (prior to installation of the trim plate assembly), illustrating, inter alia, (1) three outwardly directed spring contacts carried by resilient members integrally formed with the faceplate and (2) the juxtaposition of the wire mesh within the faceplate adjacent the outer surface thereof;

FIG. 29, is a front-left perspective view of the partially assembled radio/CD player of FIG. 28, illustrating the same features from a different perspective;

FIG. 30, is a fragmentary, perspective view of a keyboard assembly printed circuit board carried on the inside surface of the trim plate assembly illustrating one of three contact pads which, after assembly, register with and establish electrical interconnection with spring contacts illustrated in FIGS. 28 and 29;

FIG. 31, is a perspective view of the back side of the trim plate assembly of the prior art radio/CD player illustrated in FIG. 1, illustrating the surface details thereof;

FIG. 32, is a broken, bottom-rear perspective view of an audio system assembly embodying an alternative embodiment of the present invention illustrating internal PCB front and rear edge self-grounding with integral features of the audio system housing assembly;

FIG. 33, is a broken, cross-sectional view, on an enlarged scale, of the rear edge of the PCB of FIG. 32 self-engaging and self-grounding with exposed electrically conductive shield and guide tangs integrally formed with the audio system housing assembly;

FIG. 34, is a broken, cross-sectional view, on an enlarged scale, of the front edge of the PCB of FIG. 32 self-engaging and self-grounding with exposed electrically conductive shield and guide tangs integrally formed with the audio system housing assembly;

FIG. 35, is a broken, rear facing perspective view of the exposed electrically conductive shield and guide tangs of FIG. 33, with the PCB removed;

FIG. 36, is a broken, forward facing perspective view of the exposed electrically conductive shield and guide tangs of FIG. 34, with the PCB removed;

FIG. 37, is a broken, perspective, cross-sectional view of an alternative approach to self-grounding a PCB, wherein a rearwardly directed extension of the PCB containing grounding pads on the top or bottom (or both) surfaces thereof registers with an opening formed in the rear wall of the case exposing electrically conductive screen;

FIG. 38, is a broken, cross-sectional view of the alternative embodiment of FIG. 37, with the PCB is in its installed design position wherein the extension has pierced the exposed screen and established electrical connection between the grounding pads and the screen;

FIG. 39, is a bottom-rear perspective view of a CD player subassembly affixed to opposed left and right mounting brackets via integral squirts;

FIG. 40, is a broken, cross-sectional view, on an enlarged scale, of one of the squirts taken on line 139-139 of FIG. 39,

as it is manually applied (as illustrated in phantom) within an adjacent opening in the CD player subassembly;

FIG. 41, is a broken, perspective view, on an enlarged scale, of one of the squirts of FIG. 39;

FIG. 42, is a top plan view of an alternative embodiment of one of the squirts of FIG. 39;

FIG. 43, is a cross-sectional schematic view of a simplified inventive thermal control apparatus;

FIG. 44, is an exploded, perspective view of a preferred embodiment of a radio/CD player, illustrating the major sub-components and subassemblies thereof;

FIG. 45, is a perspective view of a generally planer preform blank as formed, such as by injection molding, prior to beginning the final assembly process;

FIG. 46, is a perspective view of the radio/CD player of FIG. 44, illustrating final assembly step I in the production thereof wherein the trim plate assembly is snapped to the outer surface of one of the four wall portions, specifically the front wall portion, defined by the preform blank of FIG. 45;

FIG. 47, is a perspective view of the radio/CD player of FIG. 44, illustrating final assembly step II in the production thereof wherein the circuit board assembly is slid and snapped to the inner surface of the front wall portion defined by the preform blank of FIG. 45;

FIG. 48, is a perspective view of the radio/CD player of FIG. 44, illustrating final assembly step III in the production thereof wherein the playback mechanism is slid and snapped to the inner surface of the front wall portion defined by the preform blank of FIG. 45;

FIG. 49, is a perspective view of the radio/CD player of FIG. 44, illustrating final assembly step IV in the production thereof wherein the remaining three wall portions (top, back and bottom) defined by the preform blank of FIG. 45 are folded by rotation about a first living hinge from a horizontal orientation illustrated in FIG. 48 to a substantially vertical orientation;

FIG. 50, is a perspective view of the radio/CD player of FIG. 44, illustrating final assembly step V in the production thereof wherein the remaining two wall portions (back and top) defined by the preform blank of FIG. 45 are folded by rotation about a second living hinge from a vertical orientation illustrated in FIG. 49 to a substantially horizontal orientation;

FIG. 51, is a perspective view of the radio/CD player of FIG. 44, illustrating final assembly step VI in the production thereof wherein the remaining wall portion (top) defined by the preform blank of FIG. 45 is folded by rotation about a third living hinge from a horizontal orientation illustrated in FIG. 50 to a substantially horizontal orientation, thus forming the case into a three dimensional configuration;

FIGS. 52 and 53, are perspective views of the radio/CD player of FIG. 44, illustrating final assembly step VII in the production thereof wherein the discrete right side wall closure member is installed via snap-fit engagement features and thermally coupled with power devices carried with the circuit board assembly;

FIG. 54, is a rear side perspective view of the completed radio/CD player;

FIG. 55, is a broken segment of the front wall portion interconnected to a broken segment of the bottom wall portion by the first living hinge of FIG. 45, in an enlarged scale;

FIG. 56, is a broken cross-sectional view taken along lines 56-56 of FIG. 55;

FIG. 57, is a broken cross-sectional view taken along lines 57-57 of FIG. 56;

FIGS. 58 and 59, are perspective views of living hinge reinforcement features in the preform blank respectively inte-

grally formed with two adjacent wall portions which self-engage and interlock upon displacement of the adjacent wall portions from a parallel orientation to a normal orientation;

FIG. 60, is an exploded, perspective view of the cockpit area of an automobile, illustrating an instrument panel mounted electronic system embodying the present invention;

FIG. 61, is a perspective view of the inside details of a compression molded clamshell-shaped case of the electronic system of FIG. 60, including upper and lower case halves joined by a living hinge in an as-molded configuration;

FIG. 62, is an exploded, perspective view of the clamshell case of FIG. 61 aligned for assembly with an electronic circuit assembly;

FIG. 63, is a perspective view of the exploded assembly of FIG. 62 with the upper and lower case halves folded about the living hinge to define a cavity enclosing the electronic circuit assembly;

FIG. 64, is an exploded, perspective view of the folded case assembly of FIG. 64 aligned for assembly with a vehicle operator accessible trim panel;

FIG. 65, is a top plan view of the electronic system of FIG. 65;

FIG. 66, is a cross-sectional view of the electronic system taken along lines 66-66 of FIG. 65;

FIG. 66A is a broken segment of a portion of the cross-sectional view of FIG. 66 on an enlarged scale, illustrating details of the mounting of the electronic circuit assembly within the housing case between two opposed locating pedestals;

FIG. 67, is a schematic representation of manufacturing process equipment for producing a continuous strip of composite/laminate (plastic/screen/plastic) material for subsequent compression molding via hydroform technique for formation of a case structure of the electronic system of FIG. 60;

FIG. 68, is a cross-sectional view of a hydroform die employed in the manufacturing process of FIG. 67, including an upper portion including a draw ring and a fluid filled flexible bladder, a lower portion guiding a displaceable male punch die, and an intermediate work piece;

FIG. 69, is a cross-sectional view of the hydroform die of FIG. 68, wherein the upper and lower portions have been closed to clampingly engage the work piece and the flexible bladder has been pressurized to press the work piece against the male punch die to partially deform the work piece against the male punch die;

FIG. 70, is a cross-sectional view of the hydroform die of FIG. 68, wherein the upper and lower portions remain in the closed position and the male punch die is hydraulically displaced upwardly to fully deform the work piece to mimic the contours of the male punch die;

FIG. 71, is a cross-sectional view of the hydroform die wherein the fluid pressure in the bladder has been released, the male punch die is retracted to its released position, and the upper and lower portions are spaced to release the fully shaped work piece;

FIG. 72, is a broken segment of sheet wire mesh, on an enlarged scale, of the type continuously deployed from a center feed roller of FIG. 67;

FIG. 73, is a broken segment of feed material including the wire mesh of FIG. 72 arranged with upper and lower layers of polymer sheet material prior to hydroforming;

FIG. 74, is a broken segment of post-hydroforming coalesced composite material wherein localized portions of the upper and lower polymer sheet material flows inwardly within wire mesh interstices to mechanically couple therewith, forming a knit line nominally coincident the center line of the adjacent wire mesh;

FIG. 75, is a perspective view of the outer surface of a composite insert molded silicone elastomeric material—wire mesh blank employed in a preferred embodiment of the present invention;

FIG. 76, is a perspective view of the inner surface of the composite insert molded silicone elastomeric material—wire mesh blank of FIG. 75;

FIG. 77, is a perspective top view for the composite blank of FIGS. 75 and 76 folded to enclose an electronic device for shielding from electrical anomalies;

FIG. 78, is a perspective bottom view for the composite blank of FIG. 77 illustrating the folded external flaps;

FIG. 79, is an exploded, perspective view of the assembled, shielded electronic device of FIGS. 77 and 78 in application with an operator interface, such as a vehicle audio system trim panel;

FIG. 80, is a perspective rear view of the assembled, shielded electronic device of FIGS. 77 and 78 in application with a remote closure assembly not requiring displays and operator inputs;

FIG. 81, is a perspective front view of the assembled, shielded electronic device of FIGS. 77 and 78 illustrated in FIG. 80;

FIG. 82, is a broken, cross-sectional view of a section of molded plastic case circuit board assembly slot operative to compressively support the adjacent edges of a printed circuit board and an associated composite insert molded silicone elastomeric material—wire mesh blank;

FIG. 83, is a broken, cross-sectional view of a push/pull through integrally formed with a composite insert molded silicone elastomeric material—wire mesh blank for securing same to an associated printed circuit board;

FIG. 84, is a broken, cross-section of a portion of a composite insert molded silicone elastomeric material—wire mesh blank forming a living hinge area; and

FIG. 85, is a broken, cross-section of a portion of a composite insert molded silicone elastomeric material—wire mesh blank forming an integral switch pad dome.

Although the drawings represent varied embodiments and features of the present invention, the drawings are not necessarily to scale and certain features may be exaggerated in order to illustrate and explain the present invention. The exemplification set forth herein illustrates several aspects of the invention, in one form, and such exemplification is not to be construed as limiting the scope of the invention in any manner.

#### DESCRIPTION OF THE ILLUSTRATIVE EMBODIMENTS

The present invention can be applied in its broadest sense to electronic devices and systems where shielding from radio frequency interference (RFI), electromagnetic interference (EMI), bulk current injection (BCI) and/or electrostatic discharge (ESD) is required. In addition to vehicle based radios and audio entertainment systems, the invention can be advantageously applied in “infotainment” and telematic systems. Furthermore, the present invention employs virtually “fastenerless” design architecture to facilitate low-cost, high volume production techniques.

A telematics product is a two-way communication/receiver system that enables access by a vehicle occupant to vehicle related information like geographic position/location through the use of a GPS module with antenna, vehicle diagnostics, crash sensors and air bag deployment. It also contains a phone module that is linked through a microphone in the vehicle and the radio speaker system for hands free calling via voice

recognition and links to a call center for a variety of services, including but not limited to emergency help, concierge, vehicle theft recovery, turn-by-turn route guidance, vehicle diagnostics and vehicle unlock.

For convenience of understanding, the following description will be focused primarily upon an automotive radio/CD player system.

#### Lightweight Radio/Cd Player for Vehicular Application

The present invention reflects an improved design to reduce the overall weight of an automotive radio/CD player without compromising the strength of the unit. The present invention employs a polymer based material that can be molded to provide the necessary features for the chassis as well as the frontal interface to the decorative front-end assembly described for the man-machine interface. By molding a case with the necessary details to accept the playback mechanisms (if desired) as well as the circuit board(s) needed for the electrical control, the required functionality of the unit is maintained as compared to the typical metal box. The necessary shielding and grounding is accomplished by insert-molding a mesh screen wire that has been pre-formed to contour with the molding operation. The grounding of the circuit boards may be accomplished by using ground clips attached directly to the ground pads of the circuit board that would interface directly with exposed screen wire mesh of the molded part. While metal is also a good conductor for the thermal load inside the unit, openings must be incorporated to allow airflow for additional cooling. The same openings can compromise the shielding. With in-molded mesh screen wire, the mesh acts as a Faraday cage to shield the electronics, but the open weave allows airflow to promote the dissipation of the thermal load from inside the unit, to the exterior. Besides the reduction of mass offered by the molded polymer material for the unit chassis and front plate, the hidden benefits include ease of handling in the assembly process as well as less container and shipping weight.

To facilitate assembly, the molded polymer chassis and front plate can use integral or molded in guideways and snaps, thereby eliminating the typical screw fastener assembly method previously used for these components. To enhance the rigidity, the component parts that comprise the assembly are sandwiched at the common vehicle instrument panel attachment points such that when the mounting screws are driven, they firmly clamp the component pieces to the host vehicle. In the event a playback mechanism of substantial mass and volume is required, the sub-assembly structure for the mechanism would utilize formed attachment tabs that would be an intermediate layer in the aforementioned component part sandwich. Another benefit for the mounting at the back of the radio is often vehicles have a receptive hole or slot in the inner cavity of the instrument panel carrier that accepts a mounting bushing or “bullet” shaped extension that is screwed to a mounting stud that is typically swaged to the back of the metal enclosure of the radio. The mounting “bullet” can be molded directly in the polymer-based case eliminating the additional part and the assembly of that additional part.

To replace the metal structure of the vehicle radio, a galvanized (or appropriately coated) steel mesh wire screen will be cut, formed, and molded with a polymer resin to provide necessary details for assembly of components required for the functionality of the radio including, but not limited to, a circuit board assembly, a heat sink for audio power and switching components, a playback mechanism, and a man-machine interface or trim plate assembly, as well as vehicle mounting features. While the polymer or plastic provides the majority of the mechanical structure for the radio, the in-

molded mesh screen wire provides the needed protection from various electrical anomalies including electromagnetic contamination, radio frequency interference, bulk current injection, and electrostatic discharge, to name a few. The screen mesh also allows openings necessary for air passage or venting of heat from the radio by molding the radio back end or case and front plate. The many details and features needed in a typical assembly can be incorporated directly into the parts, eliminating the need for fasteners and separate additional parts often required with parts fabricated in metal.

The specific materials selected for fabricating the radio case and front plate will vary depending upon the application, including the contained mass of the mechanisms employed as well as the severity of the contemplated environment (esp. temperature and vibration). Examples of materials that could be employed for typical automotive applications are:

Case: Glass-filled polyester, Glass-filled polypropylene, Polycarbonate, ABS.

Front Plate: Polycarbonate, ABS, PC/ABS and Noryl.

Major components which contact one another or are mechanically interconnected preferably are formed from material having substantially differing surface finish and hardness characteristics to minimize the possibility of resulting squeaks, rattles and the like.

Although presently viewed as cost prohibitive for automotive applications, it is contemplated that nano carbon tube filler can be employed within the plastic material forming the case and front plate to provide effective shielding and enhance the structural strength of the case assembly.

In addition to weight savings, which may amount to well over one pound (0.4536 Kg), the part handling is improved to reduce the amount of fasteners as well as separate component parts. Often a radio may be constructed from a wrap-around, a cover and the fasteners along with a mounting bushing or "bullet" screwed to a "swaged" threaded stud in the metal case. Also, the metal pieces require assembly personnel to wear gloves during handling to avoid any cuts or damage to their hands as well as protection from any metal fabrication fluid residue. Molded plastic does not require any special gloves, or the concerns of cuts to the skin. Aside to the benefit to the vehicle by reducing the radio weight by over one pound (0.4536 Kg), the savings for a manufacturer include reduced shipping cost through the weight reduction and potential container efficiency improvements. Product labeling can be improved through laser engraving the plastic with the desired number, customer logos, etc. Metal typically requires a stamping detail (not easily changed) and/or a printed label that is adhesively applied. This offers greater flexibility and eliminates additional parts (like labels) to use the plastic, as well as better durability than a label.

Referring to FIGS. 2-10, a consolidated radio/CD player apparatus 62 embodying many aspects of the present invention is illustrated. The radio/CD player 62 is an assemblage of six major components or subassemblies, a circuit board subassembly 64, a CD player subassembly 66, a box-like housing case 68, a front closure member or front plate 70, a convector or heat sink 72 and a trim plate subassembly 74.

It is envisioned that each of the major components/subassemblies would be produced "off-line" and the final assembly process would comprise the efficient, high volume joining of the major components/subassemblies and end-of-line testing of the completed units.

FIGS. 2 and 8-10 depict plan and perspective views of the fully assembled radio/CD player apparatus 62. FIG. 3 is an exploded view illustrating the juxtaposition of the respective major components during the assembly process. FIGS. 4-7

depict specific assembly steps of the major components as will be described hereinbelow.

The case 68 and front plate 70 are each preferably injection molded of polymer based material and collectively comprise a substantially closed housing assembly 76. The case 68 has a box-like structure, including upper and lower wall portions 78 and 80, respectively, left and right side wall portions 82 and 84, respectively, and a rear wall portion 86. The case 68 also has mounting features extending externally of the case walls, including left and right front mounting flanges 88 and 90, respectively, extending from the forward edges of the left and right side walls 82 and 84, respectively, and a mounting stud 92 extending rearwardly from the rear wall 86. All of the case wall portions and mounting features of the case 68 are integrally formed in a single injection molding process. The case defines a front opening 94 which, upon assembly, is closed by front plate 70. An assembly axis 96 extends symmetrically from front to rear of the case 68, exiting opening 94 along the nominal centerline of the case 96.

The circuit board subassembly 64 consists of a common or main printed circuit board (PCB) 98 and a unique, application specific PCB 100 which are electrically and mechanically interconnected by several pin connectors 102. It is envisioned that edge connectors, ribbon connectors or the like could be substituted for the pin connectors 102. The common PCB 98 contains all surface mount components. The circuit board subassembly 64 comprises an audio component.

The CD player subassembly 66 consists of a conventional multi-disc player unit 104 and substantially mirror-image left and right side mounting brackets 106 and 108, respectively, affixed thereto by integral fastener devices such as "squirts" (refer FIGS. 40-42). Note that there are slight differences between the left and right mounting brackets 106 and 108, but they are deemed to be inconsequential for purposes of the present invention. The left and right mounting brackets 106 and 108 have outwardly directed mounting flanges 110 and 112, respectively, which, upon assembly, register with case mounting flanges 88 and 90, respectively. The CD player subassembly 66 comprises an audio component.

The heat sink 72 comprises a substantially flat, stamped aluminum plate adapted for mounting to the outer surface of the left case sidewall 82 and includes a recessed portion 114 which, upon installation, extends inwardly through a port 116 in left case sidewall 82 for thermal interconnection to heat generating and power circuit components 118, 120 and 122 carried on the main PCB 98.

The trim plate subassembly 74 is configured to organize audio system input/output and display devices, informational indicia and decorative display devices for an associated host vehicle operator.

Referring particularly to FIGS. 4-7, a method of assembly of the lightweight audio system 62 of the present invention is illustrated. Audio system 62 can be assembled manually by an ordered process wherein a single (preferably, but not limited to) operator, who sequentially assembles the six major components or subassemblies on a designated work surface 124. No specialized tools or separate/dedicated fixtures are required. No threaded fasteners/screws are required. Each of the major components and subassemblies form integral features which cooperate to interact with features of the other components and subassemblies to register, align and guide the components and subassemblies during adjoining thereof as well as to removably affix the components and subassemblies to one another when in their final design position. This process is referred to herein as the Slide-lock Snap-lock™

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Screwless Assembly Technology and Method or "SLAT". In effect, the components "self-fixture one another in combination the manipulation of the

Assembly of the radio/CD player 62 is affected by the assembly technician or operator taking the following steps:

As illustrated in FIG. 4, place the front plate 70 on the work surface 124 in an inverted position with the outer surface of the front plate disposed upon the work surface 124. The centerline of the front plate 70 defines an assembly axis, as designated by arrow 96 extending normally to the work surface 124.

The front plate has two laterally spaced, rearwardly directed extensions 126 and 128 integrally formed therewith. Extensions 126 and 128 form guideways or opposed slots 130 and 132, respectively, which open towards one another and are directed parallel to the assembly axis 96. Lateral edge guide surfaces 134 and 136 of the application specific PCB 100 register within slots 130 and 132 and are guided thereby during the insertion process until the leading edge surface 138 of the PCB 100 contacts the inside (upward facing in FIGS. 4 and 5) surface of front plate 70. At this point, common PCB 98 is cantilever suspended from PCB 100 via pin connectors 102 and other supports (not illustrated). Referring FIG. 5, the circuit board subassembly 64 is retained in position by the interfit of the edge surfaces 134 and 136 within slots 130 and 132.

The CD player subassembly 66 is next installed by manipulating it along the assembly axis 96 until through holes 140 and 142, formed in bracket mounting flanges 110 and 112, register with locating pins or nibs 144 and 146 integrally formed in laterally extending mounting flanges 148 and 150, respectively, integrally formed in front plate 70. Thereafter, the CD player subassembly is displaced downwardly along the assembly axis 96 until the lower surfaces of bracket mounting flanges 110 and 112 abut the upper surfaces of front plate mounting flanges 148 and 150. The CD player subassembly 66 is retained in the position illustrated in FIG. 5 by an interference fit between the front plate nibs 144 and 146, and the mounting bracket flange through holes 140 and 142.

Mounting bracket flanges 110 and 112 have secondary, larger diameter through holes 152 and 154 formed therein which register with similarly dimensioned through holes 156 and 158, respectively, formed in front plate mounting flanges 148 and 150 for receiving attachment means such as bolts, for affixing the completely assembled radio/CD player 62 to a host vehicle.

The steps of installing the circuit board subassembly 64 and the CD player subassembly can be reversed from that describer hereinabove.

The housing case 68 is next installed by manipulating it along the assembly axis 96 whereby the case wall portions 78, 80, 82, 84 and 86 fully envelop the circuit board subassembly 64 and CD player subassembly 66 in combination with the front plate 70.

As best viewed in FIGS. 3, 5 and 27, the centerline of the case 68 is first manually aligned with the assembly axis 96 and rotationally positioned with the subassembly consisting of the circuit board subassembly 64, CD player subassembly 66 and the front plate 70, whereby a first cooperating pair of guideways 160 and 162 integrally formed in case sidewall portions 82 and 84 register with the CD player mounting brackets 106 and 108 and, simultaneously, a second cooperating pair of guideways 164 and 166 integrally formed in case sidewall portions 82 and 84 register with lateral edge guide surfaces 168 and 170 of common PCB 98. The case 68 is then manually displaced along the assembly axis 96 until the leading edge thereof defining front opening 94 contacts the rear

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surface of the front plate 70. Thereafter, cooperating ramped snap-engagement features 172 and 174 integrally formed with upper and lower wall portions 78 and 80 of the case 68 and the front plate 70, respectively, momentarily self-displace one another and snap back to self-engage to establish a positive interlock therebetween.

The case mounting flanges 88 and 90 form through holes 176 and 178 which register and self-engage with nibs 144 and 146, respectively, to provide a redundant engagement feature. Furthermore, the case mounting flanges 88 and 90 form a second set of through holes 180 and 182, respectively, which register with through holes 152 and 154 of mounting brackets 106 and 108, and through holes 152 and 154 of front plate mounting flanges 148 and 150, respectively.

As best viewed in FIGS. 2, 6 and 7, the heat sink 72 is next installed. The heat sink 72 includes several locating tabs 182 integrally formed along one edge thereof and a locator recess 184 formed in an opposed edge. The heat sink 72 is manually affixed to the outer surface of the case left side wall portion 82 which defines integral tab receiving extensions 186 along the upper edge thereof. Once the heat sink locating tabs 182 are inserted within their respective case wall portion extensions 186, the heat sink 72 is rotated into its design position illustrated in FIG. 7 wherein a resilient ramped catch member 188 integrally formed along the bottom edge of the left side wall portion 82 snap engages the recess 184 to fixedly interlock the heat sink 72 to the case 68.

When the heat sink 72 is in its installed position, the recessed portion 114 extends inwardly into the case 68 through the port 116. The inner surface of the recessed portion 114 establishing an abutting relationship against the power circuit components 118, 120 and 122 to provide a cooling thermal convector to the exterior of the case 68. Means are provided to ensure that components 118, 120 and 122 remain in intimate contact with the heat sink 72 such as screws 190, or, preferably to continuously resiliently urge the components into engagement with the recessed portion 114 of the heat sink 72.

It is contemplated that the heat sink 72 could be alternatively mounted to the case rear wall portion 86, whereby it would be installed along the assembly axis 96.

Referring to FIG. 7, the final step of assembling the major components and subassemblies is illustrated. First, the subassembly of the components illustrated in FIG. 6 is manually inverted, with the case rear wall portion 86 disposed on the designated work surface 124. Due to the localized outward projection of the stud 92, a stability enhancing spacer (not illustrated) or, alternatively, a recess 192 in the work surface 124 ensures a stable platform to complete assembly.

The trim plate subassembly 74 is then manipulated to become in register with the case 68 and manually displaced along the assembly axis 96 until the lower surface of the trim plate assembly 74 contacts the upper surface of the front plate 70 (as depicted in FIG. 7). Thereafter, cooperating ramped snap-action engagement features 192 and 194 integrally formed with upper and lower edge skirt surfaces of the case trim plate assembly 74 and the front plate 70, respectively, momentarily self-displace one another and snap back to self-engage to establish a positive interlock therebetween.

The completed assembly of the major components and subassemblies is depicted in FIGS. 2, 8-10 and 26. Following the assembly process, the completed radio/CD player 62 is placed in a queue for testing and quality checks.

As is best illustrated in FIG. 27, vertical and horizontal bosses 208 and 210, respectively, are located directly interiorly of the stud 92 to reinforce the rear wall portion 86 of the

case 68 to prevent “oil-canning” and allows use of relatively thin wall section for enhanced weight saving.

FIGS. 27-29 illustrate an alternative construction of the case 68 and front plate 70 of the housing assembly 76 wherein both elements of the case assembly 76 are formed of a composite of relatively rigid polymer material and electrically conductive material operable to shield the audio components (such as the circuit board subassembly 64 and the CD player subassembly 66) from electrical anomalies including radio frequency interference (RFI), electromagnetic interference (EMI), bulk current injection (BCI) and electrostatic discharge (ESD). The electrically conductive material comprises substantially continuous planer sheet portions applied to surfaces of or within polymer housing assembly wall portions as discrete elements, electrically conductive paint, foil or electrostatic or vacuum deposition applied material. Alternatively, the electrically conductive material comprises a wire mesh screen 212 which has been cut and folded to net shape and inserted within a mold cavity whereby it is effectively insert molded within the polymer based material. Preferably, the wire screen 212 is centered within the wall portions of the case and front plate whereby electrically insulating polymer material effectively covers the wire screen 212, both inside and out, to prevent inadvertent grounding of the housing assembly to interior or exterior structures.

Through empirical testing and development, the inventors have found that it is preferable to locate the wire screen 212 near the inside surface of the case 68 and the outside surface of the front plate 70. Openings 214 are provided in the case 68 by locally eliminating the polymer material but leaving the wire screen intact, whereby judiciously positioned openings 214 provide natural convection cooling to the ambient without having a break or gap in the electrical anomaly protection provided by the wire screen 212.

#### Circuit Board Grounding to Wire Mesh System

The common circuit board and the unique circuit board are grounded to the molded in wire mesh by using a grounding clip that contacts the ground plane on the circuit board to the metal mesh by pressing the circuit board with the clip installed into a hole or recess in the plastic box that exposes the mesh. A point/ridge/protuberance is used on the clip to press into the mesh and increase the pressure for intimate contact. An alternative of this clip is one that gets surface mounted and soldered to the board and does not require manual assembly.

Referring to FIGS. 15 and 16, one form of grounding the ground plane 216 of the circuit board subassembly 64 to the wire screen 212 is illustrated. The leading edge surface 138 of the unique PCB 100 carries two beryllium copper grounding clips 218, which are electrically and mechanically connected to the PCB ground plane 216. Similarly, a trailing edge surface 222 of the common PCB 98 carries two grounding clips 218. Each grounding clip 218 includes a resilient contact arm 220 extending outwardly along the assembly axis 96. Upon assembly, the grounding clips 218 carried on the leading edge surface 138 of PCB 100 register with exposed wire screen 212 within windows 224 in front plate 70 (refer FIGS. 94 and 95), and the grounding clips 218 carried on the trailing edge surface 222 of PCB 98 register with exposed wire screen 212 within windows 226 in the rear wall portion 86 of the case 68. The contact are 220 of each grounding clip 218 is configured to continuously bear against the adjacent exposed wire screen 212 to maintain electrical contact therewith.

Referring to FIGS. 32-38, alternative forms of grounding the ground plane 216 of the circuit board subassembly 64 to the wire screen are illustrated. FIG. 133 illustrates a radio/CD player 622 similar in all material respects to the radio/CD

player 62 described hereinabove in connection with FIGS. 2-10 and 15-20 inter alia, with the exceptions described immediately hereinbelow. In essence, in this embodiment, the four ground clips 218 contained on the circuit board subassembly 64 are deleted and replaced by connectors integrally formed with the housing assembly 76.

Referring to FIGS. 32, 34 and 36, a circuit board subassembly 624 includes a common PCB 626 interconnected with a unique PCB 628 by pin connectors 630. A leading edge 631 of the unique PCB 628, when installed within a front plate 632, engages two Z-clips 634 integrally formed within the front plate 632, whereby wire screen 636 exposed in the Z-clip 634 engages a contact pad/plane 638 carried on the unique PCB 628 adjacent its leading edge 631. A trailing edge 652 of the common PCB 626, when installed in a housing case 654, engages two grounding clips 658 integrally formed within the case 654, whereby wire screen 636 exposed in the grounding clip 656 engages a contact pad/plane 658 carried on the common PCB 626 adjacent its trailing edge 652.

As best viewed in FIGS. 34 and 36, the Z-clip 634 includes a frame 640 integrally formed adjacent one side of an associated opening 642 and extending inwardly (within an associated housing case 643) therefrom as a resilient cantilever. The frame 640 includes two parallel “L” or “J” shaped leg portions 644 interconnected by a cross support portion 646. A flap of wire screen 636 is die-cut prior to being injection molded within the front plate 632. During the injection molding process, the edges of the wire screen flap are insert molded within the leg portions 644, the cross-support portion 646 and the adjacent front panel of the front plate 632, thereby exposing the wire screen flap 636 for electrical connection with the unique PCB contact pad 638. An inwardly directed boss 648 is integrally formed on the front plate 632 adjacent an edge of the opening 642 opposite from the leg portions 644, and extends substantially parallel to an assembly axis 649. The boss 648 forms a guide/abutment surface 650 which is spaced from the exposed wire screen flap 636 by a dimension slightly less than the thickness of the unique PCB 628 to ensure a tight compressive fit when the leading edge 631 of the unique PCB 628 is inserted therebetween. The natural resiliency of the polymer material forming the Z-clip frame 640 ensures continued continuity of the electrical connection between the exposed wire screen 636 of the Z-clip and the unique PCB contact pad 638.

As best viewed in FIGS. 33 and 35, the grounding clip 656 includes a cooperating pair of laterally spaced support members 660 and 662 integrally formed in a rear wall portion 664 of the case 654 adjacent the bottom edge of an associated opening 663 and extending inwardly therefrom. A flap of wire screen 666 is die-cut prior to being injection molded within the case 654. During the injection molding process, the lateral edges of the wire screen flap 666 are insert molded within the support members 660 and 662 and the adjacent portion of the case rear wall portion 664, thereby exposing the wire screen flap 666 for electrical connection to the common PCB 626 contact pad 658. A wire screen positioning finger 668 is integrally formed in the rear wall portion 664 of the case 654 laterally intermediate the support members 660 and 662, and extends inwardly from the rear wall portion 664 substantially parallel to an insertion axis 670 as a resilient cantilever. The positioning finger 668 is vertically positioned with respect to the support members 660 and 662 to continuously contact the lower surface of the wire screen flap 666 to ensure that the lateral center portion of the wire screen flap 666 is bowed slightly upwardly and resiliently maintained at least slightly above the upper surface portions 672 and 674 of the support members 660 and 662, respectively. An inwardly directed

boss 676 is integrally formed on the rear wall portion 664 of the case 654 adjacent the top edge of the opening 663 opposite from and laterally centered with the support members 660 and 662. The boss 676 forms a guide/abutment surface 678 which is spaced from the exposed wire screen flap 666 by a dimension slightly less than the thickness of the common PCB 636 to ensure a tight compressive fit then the trailing edge 652 of the common PCB 636 is inserted therebetween. The natural resiliency of the polymer material forming the ground clip 656 structural elements ensures continued continuity of the electrical connection between the exposed wire screen 666 of the ground clip 656 and the common PCB contact pad 658.

Referring to FIGS. 37 and 38, another example of self-grounding is illustrated wherein a PCB 680 includes an extension 682 projecting forwardly therefrom in line with an assembly axis 684 of a housing case 686 for an audio system 687. Contact pads 688 and 690 are carried on upper and lower surfaces 692 and 694 of the PCB extension 682. A rear wall portion 696 of the case 686 forms a window 698 exposing a portion of wire screen 700 which is aligned with the PCB extension 682. When the wire screen 700 is insert molded within the polymeric material forming the case 686, the portion thereof coinciding with the window 698 is left intact. During the assembly process of the audio system 687, wherein the PCB is installed by insertion along guideways (not illustrated) within the case 686, the PCB is inserted with sufficient force to locally rupture and penetrate the exposed wire screen 700 within the window 688. Following the rupture of the wire screen 700, the residual separation edges thereof are drawn into the window 698 by friction caused by motion of the upper and lower PCB surfaces 692 and 694, respectively. When the PCB 680 assumes its installed position, as illustrated in FIG. 139, the rended portions of the wire screen 700 are compressively fit between the contact pads 688 and 690 and the adjacent edges of the window 698, ensuring continued continuity of the electrical connection between the exposed wire screen 700 and the PCB contact pads 688 and 690. It is contemplated that a single (one side of the PCB) contact pad can also be employed. However, the redundancy afforded by the dual contact pads 688 and 690 is preferable.

A modification of the self-grounding system described in connection with FIGS. 138 and 139 can enhance assembly of an audio system 702 for simplified and improved unit-to-unit repeatability. A housing case 704 includes a wall portion 706 forming a window 708 exposing a wire screen 710 to establish a point of electrical connection to an audio component within the case 704. After the wire screen 710 is insert molded within the polymer material forming the case 704, but before the assembly of the audio system 702, a tool, such as a cooperating punch 712 and die 714 is pressed simultaneously against the inner and outer surfaces of the exposed screen 710 within the window 708 to form perforations or weakenings, indicated by dotted lines 716. This process step is indicated by arrows 718. The perforations 716 make the exposed wire screen 710 more predictably frangible for improved unit-to-unit quality. Thereafter, during final assembly of the audio system 702, the wire screen 710 separates along the perforations 716 when contacted by the leading edge of a PCB extension 682 (refer FIGS. 37 and 38).

An alternative self grounding approach involves modifying a leading surface 720 of an extension 722 of a PCB 724 to form a sharpened, laterally extending leading edge 726. The leading edge 726 can be formed by the PCB material itself or, preferably, by hardened material, such as a metal appliqué or band formed in a "U" or a "V" configuration engaging the PCB 724 by upper and lower members 728 and 730 affixed to

the upper and lower surfaces 732 and 734 of the PCB extension 722 such as by soldering. The upper and lower members 730 and 732 can serve as electrical ground pads. Upon installation of the PCB 724, the sharp leading edge 726 first contacts and cleaves the exposed wire screen 710 into the form illustrated in FIG. 139.

In addition to the forgoing, punch dies 712/714 such as those depicted in FIG. 156 can be employed in modified form to actually sever and/or remove a portion (or all) of the wire screen 710 after the molding of the housing case 704, but before the final assembly of the audio system 702. Furthermore, one or more service access windows can be provided elsewhere in the walls of the housing case 704. The service windows are closed at the time of manufacture by exposed screen including perforations, as depicted in FIG. 155. The exposed screen could be severed by a tool or process later in the service life of the audio system 702 to service or modify the system.

#### Front Plate ESD Grounding to Keyboard Through Wire Mesh

The method of grounding the plastic front plate (with molded in metal mesh) to the keyboard is by using plastic spring clip that contains an open window to expose the mesh where the spring clip comes into contact with a tinned pad on the keyboard. This provides an ESD path to ground when inserting a static charged CD into the CD changer.

Referring to FIGS. 13-17 and 28-30, several spring clip structures 228 are integrally formed in the front plate 70 which, in assembly, continuously resiliently bear locally exposed segments of the wire screen 212 against a tinned grounding pad 230 (only one is illustrated) on a keypad PCB 232 to establish a ground path therebetween.

Each spring clip structure 228 has a frame 234 including two parallel arc shaped portions 236 and 238 and a cross-support portion 240 integrally formed with front plate 70 and extending therefrom as a resilient cantilever. An opening 242 in the front plate registers with each spring clip 228 to permit flexure thereof.

Prior to molding of the wire screen 212 within the front plate 70 the screen preform is die-cut to form an integral flap which is captured within the mold and the edges thereof encased within arc-shaped portions 236 and 238 and cross-support portion 240. The central portion of the exposed wire screen is expanded or stretched to form an outward bow shape (refer FIGS. 18 and 20) to ensure that the resulting exposed screen protuberance firmly contacts the PCB grounding pad 230.

Referring to FIG. 17, a prior approach is illustrated wherein separate spring grounding clips 244 are each mechanically affixed to the front plate 246 of a radio/CD player assembly 248 by a rivet 250 or other suitable fastener. The rivets are required to establish an electrical ground path as well as to mechanically secure the spring clips 244 to the front plate 246, adding labor, cost and complexity to the manufacturing process.

#### Front Plate with Integral Assembly Fixturing

Using a plastic front plate enables assembly fixturing for the CD mechanism and circuit boards for slide lock and snap lock assembly instead of the screws used in a traditional receiver.

Referring to FIGS. 4 and 5, guideways in the form of slotted extensions 126 and 128, as well as locator/retention features 144 and 146 integrally formed on the reverse (inside) surface of the front plate 70 provides a number of significant advantages in the manufacture and final assembly of the

radio/CD player **62** by reducing product part count, assembly time, and substantially eliminates dedicated hard fixturing and tools to affect assembly.

Thermal Management System for Vehicular Radio Application

The thermal devices are placed in a window in the plastic box and are attached to the heat sink, which is attached to the inside of the box. This puts a plastic wall (a good insulator) between the heat sink and the CD mechanism to minimize the temperature that a CD reaches inside the box metal case. The thermal efficiency of this system eliminates the need for a cooling/ventilation fan.

Referring to FIG. **159**, another simplified alternative embodiment of a fastenerless thermal control system for an audio device **342** is illustrated. The audio device **342** comprises a case **344** formed of thermally insulating material. A PCB **346** is disposed within the case **344** which has a power circuit component **348** cantilever affixed thereto via its lead frame **349** positioned adjacent a thermal port **350**. A retainer/backing clip **352** is snap-engaged with a feature **353** on the exterior of the case **344** and includes a resilient integral support member **354** extending through the port **350** and continuously resiliently urging the power circuit component **350** toward the port **350**. A heat sink **356** snap-engages with features on the case **344** and backing clip **352** to retain it in its illustrated position wherein the power circuit component **348** is maintained in intimate contact with the inner surface of a recessed portion **358** of the heat sink **356** extending through the port **350**.

Convection air flow (arrows **359**) can be provided by providing inlet and outlet windows **360** and **262** in the case **344**. A pocket **364** formed on the outer surface of the heat sink **356** as part of the recessed portion **358** can be filled with a thermally conductive material **366** to increase the effective thermal mass of the heat sink **356** and to improve radiant thermal rejection as indicated by arrows **368**.

Low Cost Structural Support for Cd Changer For Vehicular Radio Application

Using a plastic box for the receiver enables low cost location and support for the CD mechanism and enables for slide lock assembly instead of the screws used in a traditional receiver. The brackets on the CD mechanism have a 1° taper that matches a 1° taper on the support shelf in the plastic box. This makes it easy for an operator to start the slide, but all of the clearances go to zero as the box snaps into place providing a strong rattle free assembly without the use of the traditional screws.

Wire Mesh for Structural Component

Molding in metal mesh into the plastic receiver case and front plate increases the strength of the material (much like putting re-bar into concrete) while still weighing less than a steel case. The gauge of the wire forming the mesh can be increased and the amount of plastic material can be substantially reduced, resulting in a very thin wall, robust structure.

As an alternative, the plastic can be eliminated from the center portions of some or all of the individual side, front, back, top and/or bottom panel portions of the case and front plate. This configuration would have the appearance of a screen box, with a molded plastic peripheral frame circumscribing each panel portion.

A lightweight automotive audio system **471** can include a housing case **472** constructed of a composite of polymer based material with a wire screen **474** insert molded therein to isolate audio components therein from various electrical anomalies. To further reduce overall weight, the gauge of the wire screen can be increased whereby the screen contributes a significant component of the resulting overall structural

strength of the case, while the nominal section or thickness of the polymer material can be substantially reduced. By way of example, the case **472** top and bottom wall portions **476** and **478**, respectively, and left and right side wall portions **480** and **482**, respectively, injection molded into a single unified structure, with the enlarged gauge wire screen **474** insert molded adjacent the inner surfaces thereof. Edges and corners of the case **472** formed at the intersection of two or three adjacent wall portions can be locally thickened to increase structural rigidity of the case **472** as well as to provide internal and external mounting and interface ports. The intersecting edges of the top wall portion **476** and the left and right side wall portions **480** and **482**, respectively, form thickened left and right upper edge frames **484** and **486**, respectively. Likewise, the intersecting edges of the bottom wall portion **478** and the left and right side wall portions **480** and **482**, respectively, form thickened left and right lower edge frames. Lower edge frames **488** and **490** are locally vertically extended openings **492** and **494** for exposing the wire screen **474** to establish electrical contact with contact clips **496** and **498** carried by PCBs **500** and **502**, respectively, interconnected by pin connectors **504** within the case **472**.

Slide-Lock Snap-Lock Screwless Assembly Method

Using plastic for a receiver case enables low cost assembly of the components. The circuit boards and the CD mechanism can slide into place and then be locked or they can be snapped into place without screws. This reduces the number of parts required in the assembly and reduces the amount of direct and indirect labor to put a receiver together. The plastic case can be easily molded into a net shape forming the slides and snaps needed for assembly.

Referring to FIGS. **2-10**, the apparatus and assembly method described substantially reduces the labor and component cost of the radio/CD player **62**, as well as the required capital costs. Furthermore, it substantially enhances product quality by substantially eliminating the possibility of extraneous or missing (small) parts and/or improper assembly.

EMC, RFI, BCI, ESD Wire Mesh Protection System

Using the molded in metal mesh in the receiver plastic box that is grounded to the circuit boards creates a Faraday cage that provides shielding protection for RFI (Radio Frequency Interference), EMI (Electro Magnetic Interference), BCI (Bulk Current Injection), and ESD (Electrostatic Discharge).

Refer to FIG. **12** and their associated descriptions

Partitioned Main Board into Common and Unique

Using the principle of communization and modularity, the receiver main board has been divided into a common board and a unique board. This is counterintuitive because a single board is less expensive than two boards performing the same function. However, the common board contains all surface mount components (no stick lead or wave solder) and very large volumes can be produced without reconfiguring the assembly/production line. This will substantially reduce the manufacturing cost of this portion of the main board.

Referring to FIG. **11**, automotive audio systems are unique in that they are typically designed in modular form and, in response to the requirements of individual customers, are produced by assembling individual units from varied combinations and permutations of modularized subcomponents. This, however, can be contrary to the manufacturing doctrine of large enterprises wherein large volume production of common designs is preferred for its inherent efficiencies. In the practice of the present invention, the individual electrical components to be assembled on the circuit board subassembly **64** are segregated into those which will be employed in each specie and sub-specie in a given product family. The commonly employed circuit elements (typically surface



mount devices) are assembled on the “common” PCB **98**. The application specific circuit elements (typically “stick” mount devices) are assembled on the “unique” PCB **100**. The common PCB **98** is assembled employing highly automated manufacturing techniques for maximum efficiency, while the unique PCB **100** are assembled employing a different mix of labor and automation to maximize overall efficiency. Standard connector assemblies **736**, **738** and **740** are provided on the common PCB **98** for interfacing the radio/CD player **62** with speakers, ground, power and associated control/readout systems via wire harnesses. A standard coaxial cable connector **742** is also provided on the common PCB **98** for interfacing with a vehicle antenna system.

An audio product manual entitled “2004 Model Year Ford Freestar Radios” (Document Number 04-RDPD-12-MA-F), dated 7 Oct. 2005, describes in detail the circuit architecture of a family of modern automotive audio systems developed and produced by the assignee of this application. In addition, the manual enumerates the individual electrical components employed and their arrangement in various audio subsystems. In the practice of the present invention, the listed individual electrical components would be segregated into the common PCB **98** and unique PCB **100** in keeping with the teachings herein. Accordingly, the above referenced audio product manual is incorporated herein by reference for the sake of completeness and to serve as a resource in understanding and practicing the present invention.

#### Guillotine Heat Sink

The guillotine heat sink uses a flat aluminum plate as a heat sink. It slides down a slot on each side of the plastic box until it comes to rest on the quad bridge amplifier (QBA) IC and the power supply IC. Each IC will have a silpad on top to provide compliance and facilitate heat transfer. A downward force will be applied to the heat sink through a molded leaf spring in the lid of the plastic box when it is snapped into place. An additional feature of the plastic box is to provide pillars under the FR-4 board in the location of the power ICs to provide a backstop for the leaf spring force.

#### Screwless Power Clip

The screwless power clip is an extension of a clip that Grundig uses in automotive radios produced in Europe today. The Grundig clip uses a long lever arm that must be snapped after the PCB is assembled into the metal wrap around. This requires an operator to reach in with a tool and snap (distend and release) the clip.

In the present invention, the long lever arm is eliminated. The present invention uses the assembly action of hooking the bottom of the heat sink into plastic stirrups and rotating the top of the heat sink until it snaps at the top of the plastic box to provide the lever action. This assembly technique can be accomplished by an operator without the use of expensive or specialized tools.

An additional approach to this idea is to eliminate the clip altogether and to employ a spring material as part of the lead frame.

#### Fold-Up Case

In this mechanical configuration, the case starts out as a flat set of plastic sides with molded in metal mesh to act as the hinges for folding the case into a three-dimensional structure. This approach allows for bottom-up assembly that starts by snapping the board to molded features in the bottom plate. The heat sink is snapped to features in the back plate and the CD mechanism is attached to the front plate with two screws. The box is then folded up and snapped together.

The common edges of adjacent case panels define living hinges extending partially or entirely along the length thereof. The living hinge can consist of wire mesh only, where there is

a gap in the plastic material, as illustrated in FIG. **22**. Alternatively, the living hinge can comprise a thin web of plastic only, wherein the wire mesh has been interrupted. In another embodiment, the plastic-wire mesh composite can be molded to define a thin web as the living hinge, as illustrated in FIG. **17**. In another embodiment, the plastic-wire mesh composite can be crushed or deformed to define the living hinge, as illustrated in FIG. **24**. Finally, a portion of the plastic and/or wire mesh can be scribed or machined away to expose the wire mesh to define the living hinge. If the case material is thin enough at the hinge point, the hinge can be segmented, rather than continuous.

Referring to FIGS. **18-25**, several variants of a housing assembly **1086** for an automotive audio system **1088** are illustrated. This version of the audio system **1088** is configured to be hand assembled and is nearly fastener-less. The fasteners which are employed are extremely elemental and require only the most rudimentary of hand tools to affect assembly. In essence, the audio system housing assembly **1086** comprises a case portion **1090** and a closure member or front plate **1092**. The case **1090** is presented to the assembler in an unfolded, two-dimensional arrangement whereby he/she can easily complete the final assembly process on a table top, eliminating complex and expensive tooling fixtures and multiple work stations.

The case portion **1090** is initially created as a sheet-like preform **1094** consisting of a number of flat panels interconnected along their adjacent edges. As best viewed in FIG. **18**, the preform **1094** defines five distinct panels, which will constitute a bottom or lower wall portion **1096**, a right side wall portion **1098**, a left side wall portion **1100**, a top or upper wall portion **1102** and a rear wall portion **1104**. The adjacent panels are commonly joined or integrally interconnected by living hinges **1106**, enabling the panels to be repositioned normally to one another to form a three-dimensional box-like case **1090**.

The preform **1094** can be die cut from a continuous sheet of source material or, alternatively, injection molded in a net shape as illustrated in FIG. **18**. In either case, the material employed to make the preform is a composite of at least one layer of relatively rigid polymer based material and at least one layer of electrically conductive material capable of shielding audio components, such as a radio receiver circuit **1108** or a CD player subassembly **1110** from electrical anomalies such as radio frequency interference (RFI), electromagnetic interference (EMI), bulk current injection (BCI), and electrostatic discharge (ESD). Cooperating engagement features such as tabs **1112** and catches **1114** are affixed to or integrally formed with the preform **1094**. Refer FIGS. **20** and **21**. By way of example, after installation of the internal sub-components, the case preform is folded to assume its ultimate box-like configuration. This places cooperating associated pairs of tabs **1112** and catches **1114** in an assembly orientation with the tab **1112** carried on the edge of one panel (the right side wall portion **1098**, for example) and the catch **1114** carried adjacent the edge of a now adjoining panel (the rear wall portion **1104**, for example). Final structural fixation of the preform **1094** in the form of the housing case **1086** is completed by simply snap-engaging the tab **1112** with the catch **1114** from the configuration of FIG. **20** to the configuration of FIG. **21**. After all of the tab **1112**/catch **1114** pairs are interconnected, the formation of the case **1090** is complete.

Prior to folding up the case **1090**, the radio receiver circuit **1108** is positioned and affixed to the exposed surface of the lower wall portion **1096**. A heat sink **1116** is similarly positioned and affixed to the exposed surface of the rear wall portion **1104**. The positioning and attachment of the internal

components can be accomplished by features integrally formed in the formation of the preform **1094** (such as snaps, locating guides and the like), adhesives, discrete attachment and guide elements or inter-engagement with the various wall portions and other assembly elements within the case **1090**.

After formation of the case **1090**, the CD player subassembly **1110** can be pre-assembled with the closure member **1092** via screws **1118** or other interconnecting features described herein. A rear bracket **1124** secured to the back side of the CD player subassembly **1110** by screws **1122** includes a rearwardly extending threaded post **1124** which, upon final assembly extends through registering passageways **1126** in the heat sink **1116** and rear wall portion **1104** and engages a mounting bushing **1128**. This arrangement provides an extremely robust overall structure to the overall audio system.

The electrical components comprising the radio receiver circuit **1108** are arranged on a "common" component PCB **1130** and a "unique" PCB **1132**. The common and unique PCBs **1130** and **1132** are electrically interconnected by a ribbon connector **1134**. The heat generating electrical components **1136** are arranged on the common PCB **1130** and are affixed to the heat sink **1116** by screws **1138** or other suitable means, to enhance thermal coupling therebetween. Electrical connectors **1140** and **1142** are also arranged on the common PCB **1132** in register with port openings **1144** and **1146** in the rear wall portion **1104** of the case **1090**. A vertically opening electrical socket **1148** is centrally disposed in the unique PCB **1132** to receive a rigid connector **1150** extending downwardly from the CD player subassembly **1110**. This arrangement electrically interconnects the two audio components as well as provides structural support thereof.

One embodiment of the composite material employed for the housing assembly **1086** consists of a layer of elastomeric material **1152** with a continuous wire screen **1154** insert molder therein adjacent an interior wall surface **1156** of the composite structure. Referring to FIG. **19**, the living hinges can be formed by an extremely locally thin (or non-existent) layer **1158** of polymeric material and the wire screen **1156**.

Referring to FIG. **22**, air vents **1160** can be provided in the case **1090** by locally eliminating the polymeric material layer **1152** while maintaining the continuity of the wire screen **1156** to permit airflow, as indicated by arrows **1162**, there-through.

Referring to FIG. **24**, an alternative living hinge **1164** can be formed post-production of the composite material by pressing alternating undulations **1166** therein along the axis of the intended living hinge **1164**.

Referring to FIG. **23**, a first process for producing composite material is illustrated, including drawing polymeric sheet material off upper and lower continuous rolls **1168** and **1180** to enclose an intermediate layer of wire screen from a third roll **1172**. The three discrete sheets are heated at station **1174**, rolled together at station **1176**, cured at station **1178**, cut-off or die cut to form performs at station **1180**, scribed, punched treated and/or formed at a station **1182**, and, finally, assembled at a workstation **1184**.

Referring to FIG. **23**, a second, alternative process for producing composite material is illustrated drawing a continuous sheet of wire screen off a roll **1186** and drawing it through a continuous extruder/molder **1188** to form the composite structure. Thereafter, the composite sheet is shaped at station **1190**, cut off and/or punched at a station **1192**, and, finally, assembled at a work station **1194**.

Assembly of the audio system **1088** is completed by affixation of a trim plate subassembly (not illustrated) such as the device described in connection with FIGS. **2-10** hereinabove.

Referring to FIG. **31**, a known trim plate assembly **1480** is illustrated to highlight the substantial complexity, high part count, and design shortcomings resulting from providing back-illumination using traditional design and assembly techniques. The trim plate assembly **1480** includes a black plastic front panel **1482** (with operator controls and displays affixed on the opposed side), a printed circuit board (PCB) **1484** mounted on the exposed face of the front panel **1482**, three separate and discrete lightpipes **1486** mounted on the exposed face of the PCB **1484** by eight fastening screws **1488** and five light emitting diodes (LEDs) **1490** carried on the PCB **1484**.

#### Squirts

To further the innovative construction of the present invention, "squirts" or screwless retention features are employed. Restated, squirts are a drawn feature from a structural element, or a styled protrusion at the interface of two structural elements. Although applicable broadly, squirts are principally applied in the preferred embodiment of the invention to secure the CD player subassembly to the left and right CD player guide brackets. This allows the elimination of six additional screws.

A squirt is a retention feature which is integrally formed in a typically planer region of a structural member, such as a CD player guide bracket, which extends above one surface thereof and, during assembly, self-engages within an opening formed in an adjacent structural element, such as a hole in the outer case of the CD player subassembly. Squirts permit assembly of the guide brackets to the CD player assembly by hand without the need for special fixtures and power tools.

The squirts are formed from stock material during formation of the brackets themselves and do not add significant cost to the finalized bracket component. Similarly, mating holes can be easily punch formed in the adjacent case panels of the CD player subassembly.

In addition to reduced cost and ease of assembly, the squirt self-aligns the respective components during the attachment process, thereby ensuring their precise juxtaposition. Furthermore, the squirt is permissive of lower tolerances in the forming and assembly of its associated elements. In fact, the presence of slightly misshapen features or metal flash resulting from low tolerance punching operations can actually result in enhanced retention performance.

Referring to FIGS. **39-42**, the application of "squirts" **1676** to affix the left and right side mounting brackets, **106** and **108**, respectively to the multi-disc CD player unit **104** to form the CD player subassembly **66**, is illustrated. The squirts are preferable die-punch formed simultaneously with the formation of the mounting brackets **106/108** themselves. It is noted that the brackets **106/108** can be configured symmetrically, whereby one design can be used for both sides of the CD player unit **104**, thereby further reducing the overall part count. The squirts **1676** are preferably formed on relatively regions **1678** of their associated bracket **106/108**. A single through passage **1680** if formed in the planer region **1678**. Two or more substantially symmetrical forms **1682** extend radially inwardly from the edge of the through passage **1680**. Each form **1682** has a neck region **1684** and a tapered region or sector **1686**. The tapered region **1686** is supported as a cantilever by the neck region **1684**. The tapered regions **1686** collectively co-act to define (in the case of two forms) a bisected frustoconical form, wherein each tapered region **1686** defines an outside peripheral surface **1688** which are acutely converging upon an axis normal to the planer region **1678**. The taper of an imaginary cone **1700** extended from surfaces **1688** is designated by the angle  $w$ . As illustrated by alternative phantom depictions, the overall shape of the

imaginary cone **1700** can be parabolic or hyperbolic. The outer peripheral surface **1688** of each tapered region or sector **1686** has a circumferential range designated by the angle  $\theta$ , which with two forms is preferably in the range of  $90^\circ$ - $120^\circ$ .

In application, the collective outer peripheral surface of the sectors **1686** engage a surface forming the outer diameter of a recess or through hole **1702** in an adjacent structure **104** to which the bracket **106/108** is to be attached. As illustrated in FIG. **40**, the maximum diameter edge surface **1704** sectors **1686** effect line contact to maximize pull-out performance.

Referring to FIG. **42**, localized radially outwardly projecting knurls, ridges or extensions **1706** to provide point contacts with the adjacent structures.

Attachment of the squirt **1676** to an adjacent structures is affected simply by aligning the sector **1686** with the through hole **1702** and pressing inwardly, as indicated by the phantom finger tip and resultant force arrow **1708**.

In essence, the present invention uses a multi-sided fold-up polymer based case or "preform blank", for the chassis of the radio assembly that is molded in a relatively flat state. During the assembly of the radio, the preform blank is folded into the resultant three dimensional case shape. The sections or wall portions (top, back, bottom and front) of the case are interconnected by a hinge style detail that allows the folding to occur with a snap feature to help secure the sections after folding into the three-dimensional assembly. The shielding and/or grounding may be achieved through using an insert molded wire mesh or a post molding plating process like vacuum metal deposition, as an example. The hinge portion may consist of only wire mesh, or a combination of polymer and wire mesh depending on the polymer capability. If a vacuum metal deposition process is used instead of mesh, the hinge will require special design features outside of the hinge to enable an EMC shield to overcome any potential micro-cracking that may occur in the deposited metal from the fold-up assembly at the hinge point when the walls of the fold-up are in the final assembled position. The shield will be enabled after the detail is in the resultant folded-up shape.

The case has the capability for molded-in details to enhance the assembly with mounting features and snap retention details. Also, this allows for pliable ground details that can interface with the circuit board ground pad areas. The structure of the chassis is provided using two aluminum extrusions on the opposing sides of the radio case. One or both of the extrusions may be used for heat dissipation of the power devices on the circuit board assembly. In the event of a playback mechanism like a CD player is used, the front bracket typically used to secure the mechanism in the audio assembly will also provide the vehicle mounting of the audio assembly. Unlike metal chassis radio assemblies that may use a bottom-up assembly, this approach allows the back wall to be folded up and into place to provide the back of the mechanism stability by driving screws through the wall section into the mechanism. This eliminates an extra metal bracket for securing the CD player often used with other approaches.

The extrusions are assembled to the multi-sided fold-up by loading the extrusions into a molded detail at the back of the case and pivoting the extrusion along molded rails at the top and bottom of the sides to enable an interference fit to the molded rails with the front of the extrusions deflecting molded-in snaps on the front section to reach the final seated position. In this manner, the extrusions act both as a component (side wall) and as their own assembly tool.

The molded multi-sided fold-up polymer based case allows for assembly details as described but offers the advantage of being processed through a less expensive tooling option than a molded box-like case with a frontplate as

described in connection with FIG. **3**. The fold-up approach tooling does not require side coring and after molding the relatively flat nature of the part enables easier shipping and storage if needed. In the event an insert molded wire mesh is used, the mesh also does not require forming and can simply be cut and loaded, reducing the expenditure for the wire mesh form processing equipment.

The grounding details in the fold-up approach are better suited for interface to the circuit board than the box-style case in that they can be designed to compress against the ground pads and the folding sections can also be enabled with details locally to secure the ground points from the prior section part during the assembly as opposed to trying to provide a slide clearance and not hinder the assembly.

The design detail that enables both flexibility and minimized cost over the box-like case and front plate assembly is that the molding for the fold-up portion is one tool and the extrusions can be the same part reused on each side of the radio case. A part molded in a relatively flat state is both economical for part transportation and storage. The structure for the chassis uses a process based on the incremental strength leveraged from assembling each component part to finalize the structure as a container for the playback mechanism and circuit boards. The interface between the extruded aluminum sides and the molded fold-up offers an interference fit on molded details to help stabilize the structure of the final assembly. This is unique in that typically the extrusion may only be a heat sink for the power devices from the circuit board. This invention enables the extrusion to provide a structural and shielding component in addition to the heat flow function.

Referring to FIG. **44-54**, a consolidated radio/CD player apparatus **2010** embodying many aspects of the present invention is illustrated. The radio/CD player **2010** is an assemblage of six major components or subassemblies, a generally planer, composite preform blank **2012**, a circuit board subassembly **2014**, a CD player subassembly **2016**, a left side closure member **2018**, a right side closure member **2020** and a trim plate subassembly **2022**. Additionally, an adaptor or mounting bracket **2024** is pre-attached to the CD player assembly **2016** by screws **2026**. As will be described in greater detail hereinbelow, rear wall mounting screws **2028** are affixed to the CD player **2016**, rear panel reinforcement screws **2030** are affixed to the rear edges of the left and right side closure members **2018** and **2020**, respectively, and screws **2032** affix the right side closure member **2030** to three power devices **2032** mounted on the circuit board subassembly **2014**.

It is envisioned that each of the major components/subassemblies would be produced "off-line" and the final assembly process would comprise the efficient, high volume joining of the major components/subassemblies and end-of-line testing of the completed units.

FIGS. **53** and **54** depict perspective views of the fully assembled radio/CD player apparatus **2010**. FIG. **44** is an exploded view illustrating the juxtaposition of the respective major components during the assembly process. FIGS. **45-53** depict specific assembly steps of the major components as will be described hereinbelow.

As best seen in FIG. **45**, the preform blank **2012** is preferably injection molded of polymer based material in a generally planer configuration and, when finally assembled, forms a box-like, three dimensional case. The blank **2012** defines a front wall portion **2036**, a bottom wall portion **2038**, a rear wall portion **2040** and a top wall portion **2042** respectively integrally interconnected by "living hinges" extending along axes designated as X-X, Y-Y and Z-Z, respectively. All of the

blank wall portions are integrally formed in a single injection molding process and comprises a composite of a pre-shaped planer piece of wire screen wire insert molded within a layer of relatively rigid polymer material such as glass filled polypropylene. Each of the wall portions is deemed to have a leading edge, a trailing edge and an opposed pair of side edges.

The front wall portion **2036** has a female engagement feature **2044** and a pair of female guide features **2046** integrally formed adjacent the leading edge thereof. Similarly, the top wall portion **2042** has a male engagement feature **2048** and a pair of male guide features **2050** integrally formed adjacent the trailing edge thereof. The trailing edge of the front wall portion **2036** is interconnected with the leading edge of the bottom wall portion **2038** along hinge line X-X. The trailing edge of the bottom wall portion **2038** is interconnected with the leading edge of the rear wall portion **2040** along hinge line Y-Y. The trailing edge of the rear wall portion **2040** is interconnected with the leading edge of the top wall portion **2042** along hinge line Z-Z.

The circuit board subassembly **2014**, CD player subassembly **2016** and trim plate subassembly **2024** are substantially similar to the corresponding major components described hereinabove in connection with the embodiment of FIG. 3. For the sake of brevity, the details thereof will not be repeated here.

Referring particularly to FIGS. 46-53, a method of assembly of the lightweight audio system **2010** of the present invention is illustrated. Audio system **2010** can be assembled manually by an ordered process wherein a single (preferably, but not limited to) operator, who sequentially assembles the six major components or subassemblies on a designated work surface. No specialized tools or separate/dedicated fixtures are required. No threaded fasteners/screws are required. Each or the major components and subassemblies form integral features which cooperate to interact with features of the other components and subassemblies to register, align and guide the components and subassemblies during adjoining thereof as well as to removably affix the components and subassemblies to one another when in their final design position. This process is referred to herein as the Slide-lock Snap-lock™ Screwless Assembly Technology and Method or “SLAT”. In effect, the components “self-fixture” one another in combination. The assembly of the radio/CD player **2010** is effected by the assembly technician or operator taking the following steps:

Referring to FIG. 46, the trim plate subassembly **2022** can be affixed to the outer (bottom as depicted) surface of the front wall portion **2036** by self-aligning, self-engaging engagement features **2052**. Thus configured, the illustrated subassembly defines rearwardly (upwardly) directed extension pairs **2054** and **2056** integrally formed on the inner surface of the front wall portion **2036** and trim plate subassembly **2022**, respectively. The inner surface of the bottom wall portion **2038** defines four integrally formed grounding clips **2058** and two pedestals **2060** extending upwardly.

Referring to FIG. 47, the circuit board subassembly **2014** is inserted downwardly to self-align, self-position and self-engage with guideways formed by the extensions **2054**. Inso doing, the electrical circuitry contained on the circuit board subassembly **2014** is electrically interconnected with the circuitry on the trimplate subassembly **2022**, as well as the other components via registering interconnects and plugs (not illustrated).

Referring to FIG. 48, the CD player subassembly **2016** is inserted downwardly to self-align, self-position and self-engage with locating pins formed by the extensions **2056**. Typi-

cally, an electrical umbilical (not illustrated) interconnects the CD player subassembly **2016** and the circuit board subassembly **2014**.

Referring to FIGS. 49-51, the preform blank **2012** is then folded, transitioning it from its original generally planer configuration to a three dimensional box-like configuration. Referring to FIG. 49, the first step of folding the preform blank entails manually or mechanically rotating bottom wall portion **2038** substantially 90° about axis X-X from its original horizontal orientation illustrated in FIG. 48 co-planer with the front wall portion **2036** to a vertical orientation substantially perpendicular or normal with front wall portion **2036**. Note that in this step, rear wall portion **2040** and top wall portion **2042** remain co-planer with bottom wall portion **2038**, assuming a vertical orientation.

As best viewed in FIG. 47, the inner surface of the bottom wall portion **2038** has integrally formed inwardly directed guide retainer features **2062** which, in combination with the grounding clips **2058**, function to position, secure and electrically ground the circuit board subassembly **2014** upon final assembly of the radio/CD player apparatus **2010**. The guide retainer features **2062** positionally secure the circuit board subassembly **2014** by engaging side edges and slots **2070** formed therein.

Inwardly directed, laterally opposed edge retention ribs **2072** are integrally formed on the inner surface of the rear wall portion **2040**. Furthermore, integral reinforcing ribs **2074** extend from the inner surface of the rear wall portion **2040** to secure a rear integral mounting stud **2078** extending from the outer surface of the rear wall portion **2040**. See FIG. 50. Similarly, the inner surface of the top wall portion **2042** has X-shaped reinforcement ribs **2076** integrally formed on the inner surface thereof to prevent “oil canning”.

Referring to FIG. 50, the second step of folding the preform blank entails manually or mechanically rotating rear wall portion **2040** substantially 90° about axis Y-Y from its vertical orientation illustrated in FIG. 49 co-planer with the bottom wall portion **2038** to a horizontal orientation substantially parallel with front wall portion **2036**. Note that in this step, top wall portion **2042** remains co-planer with rear wall portion **2040**, assuming a horizontal orientation. Although not illustrated, after completion of the step of FIG. 50, guide retainers **2064** serve to abut the rearmost edge surface of the circuit board subassembly **2014** to effect longitudinal support thereof.

Referring to FIGS. 49, 50 and 54, screws **2028** are then applied, extending through holes **2080** formed in the pedestals **2060** of rear wall portion **2040** and engaging the rear wall of the CD player subassembly **2016**, rigidly securing rear wall portion **2040** and bottom wall portion **2038** in their respective positions as illustrated in FIG. 50.

Note that during the process of forming the preform blank **2012**, the screen is stretched, punched or weakened in the areas corresponding with the pedestals **2060** such as illustrated in FIGS. 37 and 38. Extra screen inserts can be provided within the portions of the mold forming the pedestals or external EMI patches or surface coatings can be provided to ensure complete shielding is provided by the final assembly.

Referring to FIG. 51, the third step of folding the preform blank entails manually or mechanically rotating top wall portion **2042** substantially 90° about axis Z-Z from its horizontal orientation illustrated in FIG. 50 co-planer with the rear wall portion **2040** to a vertical orientation substantially parallel with bottom wall portion **2038**. While transitioning from the orientation of FIG. 50 to that of FIG. 51, the male engagement feature **2048** and guide features **2050** extending from the leading edge of the top wall portion **2042** are respectively

guidingly received within the corresponding female engagement feature **2044** and guide features **2046** to self-position and self-engage the top wall portion **2042**. As illustrated in FIG. **51**, the perform blank **2012** has been fully folded into a three-dimensional box-like configuration.

The wire screen/conductive layer is continuous throughout the full extent of the four contiguous wall portions **2036**, **2038**, **2040** and **2042**, with the exception of where the leading edge of the front wall portion **2036** adjoins the trailing edge of the top wall portion **2042**. The slight gap at the point of contact of the front wall portion **2036** and **2042** is believed by the inventors to result in only deminimus RF leakage that, if required can be effectively blocked by application of a local conductive patch.

Referring to FIGS. **52**, **53** and **54**, the application of the left and right side closure members **218** and **220** is illustrated. As illustrated in FIG. **52**, the rear edge portions of closure members are initially angularly positioned under their respective retention rib **2072** and then pivoted thereabout to assume the final, installed position illustrated in FIG. **53**. As the side closure members **2020** and **2022** are fully installed, the forward edges thereof are retained in the installed position by self-engaging retention features **2082** integrally formed on the rear surface of the front wall portion **2036**. Thereafter, screws **2032** are applied through holes in the right side closure member **2020** to engage their respective power devices **2034** to establish the right side closure member **2020** as a heat sink. After this step, final assembly is essentially complete.

As best viewed in FIG. **52**, the side closure members **2018** and **2020** are identical, formed from a continuous extrusion process, having a typical cross-section defining inwardly directed upper channels **2086**, lower channels **2088** and center channels **2090**. During installation, each upper channel **2086** forms an interference fit with a respective edge portion of the top wall portion **2042**. Similarly, each lower channel **2088** forms an interference fit with a respective edge portion of the bottom wall portion **2038**. Redundant retention can be applied by screws **2030** which extend through mating holes formed in the front and rear wall portions **2036** and **2042**, to engage the adjacent center channel **2090**.

Referring to FIG. **55**, the exposed edges or alternatively, a molded rail, of the top wall portion **2042** and bottom wall portion **2038** have a series of openings **2092** exposing the screen **2084**. The exposed segments of screen have an upward/downward extending dome or distension **2094** locally raising the screen above the outer surface of the adjacent wall portion. Once installed, the inner surfaces of the channels **2086** and **2088** compressively engage the screen domes **2094** to establish reliable, multi-point electrical contact therebetween.

Referring to FIGS. **55-57**, detail of one of the “living hinges” is illustrated. Adjacent edges of the bottom wall portion **2038** and rear wall portion **2040** are slightly spaced apart to expose electrically conductive material such as screen **2084** extending along the hinge axis Y-Y. This arrangement assures that each of the wall panels remain substantially rigid while the hinge portions are relatively flexible, and maintains its EMI isolation characteristics.

Referring to FIGS. **55** and **56**, preferably, at each end of each living hinge is a relatively thin web of plastic **2096** integrally interconnecting the adjacent wall portions **2038** and **2040** to provide torsional rigidity to the hinge, as well as the overall housing assembly.

Air flow openings **2098** are formed in the top and bottom wall portions closed by screen **2084** while permitting free ventilation of the interior of the housing assembly.

Referring to FIG. **57**, all cut edges **2100** of the screen **2084** are fully encased in a layer of plastic **2102** to prevent unraveling of the screen **2084** and/or inadvertent electrical shorts or injury to an assembly technician.

Referring to FIGS. **58** and **59**, an alternative hinge design **2104** is illustrated. Adjacent edges of a first wall portion **2106** and a second wall portion **2108** are integrally interconnected by a thin web **2110** of plastic material. In this embodiment, the inner surfaces of both wall portions **2106** and **2108** are coated by an electrically conductive surface layer (not illustrated). A similar web with wire mesh is depicted in FIG. **19** above. A series of spaced retention hooks **2112** are integrally formed on the first wall portion **2160** extending adjacently along the hinge line/axis. A cooperating retention rib **2114** is integrally formed on the second wall portion **2108** extending adjacently parallel to the hinge line/axis. The hooks **2112** and cooperating rib **2114** are dimensioned to cooperatively self-engage one another as the wall portions **2016** and **2018** are transitioned from the co-planer orientation depicted in FIG. **58** to the right angle configuration depicted in FIG. **59**. This embodiment ensures robust continuous electrical interconnection between the adjacent conductive layers, even in the case of micro-cracking during the folding process.

Insert molded wire mesh in plastic has been successful for replacing metal enclosures typically utilized for packaging electronics that require EMC shielding and grounding. Virtually any plastic resin can be molded with a wire mesh which makes it advantageous for almost any application requiring these unique characteristics that offer many assembly and weight reductions that are the result of replacing metal enclosures with a molded plastic version. A limiting factor with some plastic resins is the ability for dimensional stability and especially warpage characteristics that may be a hindrance to the final molded part to meet the same requirements as a similar metal version. As an example, some plastic resins like polypropylene may tend to warp during the cooling phase after mold ejection which can disrupt the dimension stability. This may, in turn, threaten the ability of the part to mate with adjoining component parts in an assembly.

By using a nozzle injected gas product like the MuCell process (offered by Trexel) for the insert molded part operation, the wire mesh insert molding can be fabricated to offer a dimensionally stabilized part that is resistant to warpage that is now better suited for the assembly of the electronics enclosure. Without the process, additional fixtures or clamping may be necessary to prevent post molding warpage or creep of the material due to non-uniform cooling that can take place after the part is molded and ejected from the tool. This is critical for use with the wire mesh in plastic molding with electronic enclosures to prevent unwanted wire mesh contact with electrical contacts due to warpage or dimensional variation. This also allows interface contact between assembly parts to be aligned within normal material tolerance eliminating the need to construct additional controls into the parts and/or molding.

Referring to FIGS. **24** and **25**, an injection molding machine or extruder **1188** can be modified to accommodate nitrogen gas injection via an injector **1189** to implement the MuCell process. As a result, the resulting molded or extruded plastic parts are filled with micro-bubbles of nitrogen gas **1167** whereby the flow of the molten plastic within the mold is enhanced, reducing warpage and improving part-to-part repeatability. Furthermore, the process further reduces weight of the molded parts and reduces the required tonnage of the molding machine.

### Hydroforming

In generally accepted engineering parlance, the term “hydroforming”, (or, alternatively “hydramolding”) is a cost-effective way of shaping malleable metals such as aluminum or brass into lightweight, structurally stiff and strong work pieces or end products. One of the largest applications of hydroforming is for automotive components, which makes use of the complex shapes possible by hydroforming to produce stronger, lighter and more rigid unibody structures for vehicles. This technique is particularly popular with the high-end sports car industry and is also frequently employed in the shaping of aluminum tubes for bicycle frames.

Hydroforming is a specialized type of die forming that uses high pressure hydraulic fluid to press room temperature working material into a die. To hydroform aluminum into a vehicle’s frame rail, a hollow tube of aluminum is placed inside a negative mold that has the shape of the desired end result. High pressure hydraulic pistons then inject a fluid at very high pressure inside the aluminum, which causes it to expand until it matches the mold. The hydroformed aluminum is then removed from the mold.

Hydroforming allows complex shapes with concavities to be formed, which would be difficult or impossible with standard solid die stamping. Hydroformed parts can often be made with a higher stiffness to weight ratio and at a lower per unit cost than traditional stamped or stamped and welded parts.

In sheet hydroforming (SHF), there is “bladder forming” (where there is a bladder that contains the liquid, with no liquid contacting the sheet stock) and hydroforming where the fluid contacts the sheet stock (no bladder). A work piece is placed on a draw ring (blank holder) over a male punch then the hydraulic chamber surrounds the work piece and a relatively low initial pressure seats the work piece against the punch. The punch then is raised into the hydraulic chamber and pressure is increased to as high as 15,000 psi which forms the part around the punch. Then the pressure is released, the punch is retracted and the hydraulic chamber lifted and the process is complete.

In tube hydroforming (THF) there are two major practices: high pressure and low pressure. With the high pressure process, the tube is fully enclosed in a die prior to pressurization of the tube. In the low pressure process, the tube is slightly pressurized to a fixed volume during the closing of the die (formerly known as the Variform process). In tube hydroforming, pressure is applied to the inside of the tube that is held by dies with the desired cross-sections and forms. When the dies are closed, the tube ends are sealed by axial punches and the tube is filled with hydraulic fluid. The internal pressure can go up to a few thousands of bars causing the tube to calibrate against the dies. The fluid is injected into the tube through one of the two axial punches. Axial punches are movable and their action is required to provide axial compression and to feed material towards the center of the bulging tube. Transverse counterpunches may also be incorporated in the forming die in order to form protrusions with small diameter/length ratio. Transverse counterpunches may also be used to punch holes in the work piece at the end of the forming process.

Industrial hydroforming machines use a piston to generate pressure in the hydraulic fluid used in hydroforming, but an experimental alternative is the use of explosives to generate the pressure. Called explosive hydroforming, this method places an explosive charge, with or without an additional working fluid, on the high pressure side of the material. When

the charge is ignited, the explosive pressure forces the working material into the die, at pressures up to millions of pounds per square inch.

One advantage of hydroforming is the savings on tools. For sheet metal only, a draw ring and punch (metalworking) or male die is required. The bladder of the hydroform itself acts as the female die eliminating the need to fabricate a matching female die. This allows changes in material thickness to be made with usually no necessary changes to the tool. However, dies must be highly polished and in tube hydroforming a two-piece die is required to allow opening and closing. Tools and punches can be interchanged for different part requirements.

Another advantage of hydroforming is that complex shapes can be made in one step. In sheet hydroforming (SHF), with the bladder acting as the female die, almost limitless geometries can be produced. However, the process is limited by a very high closing force required in order to seal the dies, especially for large panels and thick, hard materials. Small concave corner radii are difficult to be completely calibrated, i.e. filled. Because too large a pressure would be required. Limits on the SHF process are due to risks of excessive thinning, fracture, wrinkling and are strictly related to the material formability and to the proper selection of process parameters (e.g. hydraulic pressure vs. time curve). Tube hydroforming (THF) can produce many geometric options as well, reducing the need for tube welding operations. Similar limitations and risks can be listed as in SHF. However, the maximum closing force is seldom a limiting factor in THF.

Hydroforming is capable of producing parts within tight tolerances including aircraft tolerances where a common tolerance for sheet metal parts is within thirty thousandths of an inch. Sheet metal hydroforming also allows for a smoother finish as draw marks produced by the traditional method of pressing a male and female die together are eliminated.

Electronic assemblies typically contain a circuit board assembly that may have ground points from the circuit board to the enclosure. When the enclosure has been constructed of a non-metallic material such as plastic, the grounding and shielding has been provided by a variety of methods including, but not limited to using a wire screen mesh that is formed and insert molded with the structure of the plastic enclosure. While the plastic enclosures are desirable for manufacturing assembly simplification, through the elimination of fasteners as well as weight reductions from the metal enclosures, the capitalization to provide a wire mesh part insert to a molded plastic part has been a limiting factor, especially with low volume build applications. The manufacturing process flow has typically coupled the plastic molding press directly with the wire mesh insert fabrication cell. This coupling may not be desired if the molding press utilization is not at a high enough percentage of the available molding press time.

Hydroforming has been a process typically used for producing metal parts that can have some complex details and patterns. Due to the nature of the hydroforming equipment having a bladder to impart the forming and a form cavity to enable the final desired shape the investment for the equipment offers a less costly alternative to typical mesh cell forming equipment. Also, to change the set-up to produce different parts is easier, for only the form cavity is the only part change required, since the bladder is universal for this process. By using insulating elastomeric material to provide localized areas of encapsulation of the wire mesh, this not only allows for isolation from electrical contact where it is not desired on the circuit board in the final assembly, but also helps to prevent wear or damage of the hydroform equipment from any cut or sharp areas of the wire mesh fabric.

To enable the elastomeric material to encapsulate the wire mesh, the wire mesh can be precut to allow exposed mesh areas and the elastomeric material either to be positioned to provide the wire mesh as the interlayer or the elastomeric material may be applied in a controlled dispensing format directly to the form with the wire mesh placed on top of it such that when the process is initiated, the wire mesh will be substantially embedded in the elastomeric material as the elastomeric material solidifies or cures after the hydroforming has been completed. If elastomeric layers are to be used in the hydroforming process with the wire mesh at the middle layer an adhesive may be used that is activated with pressure to provide a "binder" for the layers.

Hydroforming wire mesh in an elastomeric material reduces the investment required for the mesh forming cell. It also offers greater flexibility for change-over to accommodate different component configurations. The final part could conceivably be an enclosure for a circuit board assembly or function as a ground/shield within a plastic enclosure.

The present invention offers an encapsulated wire mesh in an elastomeric to provide a volume efficient electronics enclosure that offers shielding and grounding capabilities produced through a hydroforming process that minimizes the tooling for there is typically only one die required used in conjunction with an oil bladder.

Referring to FIG. 60, an electronic system housing assembly 2200, embodied in one application as an automotive audio system, is illustrated in assembly within a central opening 2202 formed in an instrument panel 2204 of a host automobile. The housing assembly 2200 includes a three-dimensional case 2206 cooperating with an operator accessible trim panel 2208. As will be described in greater detail herein, the case 2206 and trim panel 2208 and/or a discrete closure member cooperate to define a substantially closed cavity for carrying at least one electronic component such as a radio circuit assembly.

Although primarily intended for application in automotive audio systems, the present invention can also be employed in packaging navigation, object detection, telematics, system controllers, power supplies and other systems including electronic devices requiring shielding from electronic anomalies.

In the illustrative embodiment of the invention, the instrument panel opening 2202 is located conveniently adjacent a designated operator seating position whereby input/output devices and displays of the audio system 2200 installed therein are easily accessible. The case 2206 includes left and right longitudinally extending guides 2210 and 2212, respectively, integrally formed therewith. The instrument panel opening 2202 is configured to nestingly receive the audio assembly 2200 which is front-loaded therein. The instrument panel opening 2202 defines left and right sidewalls 2214 which include opposed, cooperating longitudinally extending guideways 2216 configured to slidably receive the audio system guides 2212 and 2214. Each case guide 2210 and 2212 forms a laterally inwardly directed notch 2218 therein including a rearwardly facing stop surface 2220. Guideways 2216 form an integral catch 2222 which, upon installation of the audio system 2200, self-engages a corresponding stop surface 2220 to secure the front surface of the trim panel 2208 with the adjacent portion of the instrument panel 2204 without the need for separate fasteners.

Referring to FIG. 61, case 2206 is illustrated in its "as formed" configuration illustrating the internal details thereof. As described herein, case 2206 is compression molded by hydroforming process forming a layered coalesced composite of inner and outer discrete layers of relatively rigid polymer sheet material enclosing an intermediate discrete layer of

electrically conductive sheet material, preferably wire screen. The sheets of polymer and conductive material are continuously fed in parallel alignment into the hydroforming press which serially forms three-dimensional case blanks, which are trimmed and punched to final net form either during the hydroforming process or thereafter as a separate process step.

In the preferred embodiment, case 2206 is formed in a unitary clamshell configuration including a first or upper case half 2224 and a second or lower case half 2226 integrally interconnected along a common edge by a living hinge 2228. The case halves 2224 and 2226 are substantially mirror-images of one another and configured to be manually folded about common edge axis X-X from the initial open position of FIG. 61 to the closed orientation of FIG. 63 during the final assembly process. Details of the case 2206 are described herein below as if the case 2206 is in the folded orientation as illustrated in FIG. 63.

The upper case half 2224 defines a top wall 2230, left and right upper partial side walls 2232 and 2234, respectively, and an upper partial rear wall 2236. The lowermost edges of the left and right upper partial side walls 2232 and 2234 transition into laterally outwardly extending integral flanges 2238 and 2240, respectively, and the lowermost edge of the upper partial rear wall 2236 transitions into a rearwardly extending integral flange 2242. Flanges 2238, 2242 and 2240 extend substantially continuously about the lower edge of the upper case half 2224 to provide a seat surface with the lower case half 2226 and to rigidify the overall structure of the housing assembly 2200. A laterally inwardly transiting notch edge 2244 terminating in a stop surface 2246 is formed in the outer portion of the flange 2238. Likewise, a laterally inwardly transiting notch edge 2248 terminating in a stop surface 2250 is formed in the outer portion of the flange 2240.

The top wall 2230 of the upper case half 2224 integrally forms two resilient, bifurcated engagement tabs 2252 extending forwardly from the leading edge 2253 thereof for mounting the case 2206 to the trim panel 2208. A first, generally rectangular opening 2254 extends through a portion of the upper partial rear wall 2236 and the adjacent flange 2242. A second, semi-circular opening 2256 extends through a portion of the upper partial rear wall 2236 and the adjacent flange 2242. A pair of spaced-apart pedestals 2258 are integrally formed in the top wall 2230 and extend downwardly, terminating on an mounting surface 2260.

The lower case half 2226 defines a bottom wall 2262, left and right lower partial side walls 2264 and 2266, respectively, and an lower partial rear wall 2268. The uppermost edges of the left and right upper partial side walls 2264 and 2266 transition into laterally outwardly extending integral flanges 2270 and 2272, respectively, and the uppermost most edge of the lower partial rear wall 2268 transitions into a rearwardly extending integral flange 2274. Flanges 2270, 2274 and 2272 extend substantially continuously about the upper edge of the lower case half 2226 to provide a seat surface with the upper case half 2224 and to rigidify the overall structure of the housing assembly 2200. A laterally inwardly transiting notch edge 2276 terminating in a stop surface 2278 is formed in the outer portion of the flange 2270. Likewise, a laterally inwardly transiting notch edge 2280 terminating in a stop surface 2282 is formed in the outer portion of the flange 2272.

The bottom wall 2262 of the lower case half 2226 integrally forms two resilient, bifurcated engagement tabs 2284 extending forwardly from the leading edge 2285 thereof for mounting the case 2206 to the trim panel 2208. A first, generally rectangular opening 2286 extends through a portion of the lower partial rear wall 2268 and the adjacent flange 2274. A second, semi-circular opening 2288 extends through a por-

tion of the lower partial rear wall **2268** and the adjacent flange **2274**. Rectangular openings **2254** and **2286** are in lateral register to cooperatively form a rectangular opening in the rear wall of the case **2206**. Likewise, semi-circular openings **2256** and **2288** are in lateral register to cooperatively form a round opening in the rear wall of the case **2206**. A pair of spaced-apart pedestals **2294** are integrally formed in the bottom wall **2262** and extend upwardly, terminating in a mounting surface **2296**. A short locating boss **2298** extends above the mounting surface **2296**. A patch of wire screen **2300** is exposed on one or more of the mounting surfaces **2260** and **2296** to affect electrical interconnection with an electronic device subsequently mounted within the case **2206**.

Referring to FIG. **62**, an electronic component configured to be carried within a cavity defined by the case **2206**. An electronic circuit assembly **2302** consists of a generally planer substrate or circuit board **2304** configured to carry processors **2306**, integrated circuits **2307**, discrete components **2308**, a heat sink **2309** and interconnecting circuit traces. As best seen in FIG. **66**, circuit components can be mounted on both sides of the circuit board **2304**. A multi-circuit connector **2310** is mounted on a leading edge **2312** of the circuit board **2304** for interfacing with the trim panel **2208**. A multi-circuit power and output connector **2312** and an antenna feed connector **2314** are mounted on a trailing edge **2316** of the circuit board **2304** for interfacing with the host vehicle wire harness and antenna cable. The circuit board **2304** has a pair of spaced-apart mounting holes **2318** positioned to register with their respective mounting pedestals **2294**. Ground pads **2320** are formed on one or both sides of the circuit board **2304** concentric with their respective mounting holes **2318**.

The case **2206** is assembled by placing it on a generally flat work surface with the internal surfaces of the case halves **2224** and **2226** facing upwards. The electronic circuit assembly **2302** is installed by manually aligning it within one of the case halves **2224/2226**. Inso doing, the power/input connector **2312** is nestingly received within the rectangular opening **2286** and the antenna feed connector **2314** is nestingly received within the semi-circular opening **2288** of the lower case half **2226**. Simultaneously, the pedestals **2294** register with their respective mounting holes **2318** with the locating boss **2298** extending there through. When placed in the assembled position, the mounting surface **2296** of each pedestal **2294** retains the electronic circuit assembly **2302** in a spaced relation above the inner surface of the lower case half **2226** and the exposed wire screen patch electrically contacts the adjacent ground pad **2320**.

Referring to FIG. **63**, after installation of the electronic circuit assembly **2302** on the lower case half **2226**, the upper case half **2224** is manually folded about  $180^\circ$  counterclockwise from the position illustrated in FIG. **62** about living hinge **2228** axis X-X to assume its assembled (closed) position illustrated in FIG. **63**. The subassembly of the case **2206** with the electronic circuit assembly **2302** is completed by the installation of fasteners such as screws **2322** through holes **2261** in upper pedestals **2258**, and through mounting holes **2318** in the circuit board **2304**, threadably into corresponding holes **2299** in pedestals **2294**.

When in the closed position, the flanges **2240**, **2242** and **2244** of upper case half **2224** abut flanges **2272**, **2274** and **2276**, respectively, of lower case half **2226** to assure a rigid structure of case **2206**. Inso doing, openings **2254** and **2256** engage and capture the power/output connector **2312** and antenna feed connector **2314** in their installed positions. Furthermore, when in the closed position, notched edge **2276** and stop surface **2278** of flange **2270** register with notched edge

**2244** and stop surface **2246** of flange **2238** to define left-hand notch **2218** and stop surface **2220** of FIG. **60**. Similarly, when in the closed position, notched edge **2280** and stop surface **2282** of flange **2272** register with notched edge **2248** and stop surface **2250** of flange **2240** to define right-hand notch **2218** and stop surface **2220** of FIG. **60**.

As illustrated in FIG. **63**, the clamshell-type case **2206** forms a three-dimensional configuration defining a substantially closed cavity **2324** which, in application shields the electronic circuit assembly **2302** from electrical anomalies as described herein above. It is contemplated that the case can be configured to fully enclose the electronic circuit assembly **2302** by the addition of integral front wall portions, or alternatively, to enclose the electronic circuit assembly **2302** in combination with a discrete metal or composite front closure member **70** (refer FIG. **3**) or, preferably, by mounting the case **2206** directly to the rear surface of the trim panel **2208** as illustrated in FIG. **64**.

Referring to FIG. **64**, final assembly of the electronic system housing assembly **2200** is affected by manual mating engagement of the case **2200**—electronic circuit **2302** subassembly with the operator accessible trim panel **2208**. The trim panel **2208** is constructed substantially as described herein above, with the exception that a rear surface closure member **2326** protectively encloses internal components of the trim panel **2208**. The closure member **2326** has an array of slot openings **2328** arranged to register with engagement tabs **2252** extending forwardly from the case **2206**. A multi-circuit plug **2330** extends through the closure member **2326** to matingly engage the circuit board connector assembly **2310** to complete the electrical interface between the electronic circuit assembly **2302** and the trim panel circuitry. During final assembly, each engagement tab **2252** registers with and engages an associated slot opening **2328**. Accordingly, no separate fasteners are required. If desired, the screws **2322** of FIG. **63** can be replaced by appropriate self-engaging features formed with the case halves **2224** and **2226**.

Referring to FIGS. **65**, **66** and **66A**, details of the fully assembled electronic system housing assembly **2200** are illustrated. When fully assembled, the electronic circuit assembly **2302** is supported at two locations between cooperating pedestals **2258** and **2294**, as well as at two locations along the rear case wall **2236** and **2268** via (1.) power output/connector **2314** extending through rectangular opening **2254** and **2286** and (2.) antenna feed connector **2314** extending through circular opening **2256** and **2288**. The electronic circuit assembly **2302** is generally centered vertically within the cavity **3324** formed by the case **2206** with components carried on both the upper and lower surfaces of the circuit board **2304**. It is contemplated that other features for positioning, locating, spacing, and/or isolating the electronic circuit assembly **2302** as well as other components disposed within the case **2206** or externally thereof can be integrally formed in as part of the hydroforming process. For example, a heat sink can be mounted externally of the case via integral retention features such as described earlier herein with the addition of a window in the case **2206** for routing a thermal interconnection with a power device disposed within the case **2206**.

Referring to FIG. **67**, a hydroforming process for producing composite material is illustrated, including drawing polymeric sheet material off upper and lower continuous rolls **2332** and **2334** to enclose an intermediate layer of wire screen from a third roll **2336**. The three discrete sheets are heated at station **2338**, rolled together at station **2340**, hydroformed at station **2342**, cut-off or die cut, scribed, punched and treated at a station **2344**, and, finally, assembled at a workstation **2346**.



Referring to FIGS. 68-71, details and operation of the hydroform station 2342 are illustrated. The hydroform station 2342 includes an upper die portion 2346 and a lower die portion 2348. The upper die portion 2346 includes a top wall 2350 and downwardly extending peripheral side walls 2352 defining a downwardly opening cavity 2354 and which serves as a draw ring and an upper blank holder 2356. A closed flexible bladder 2358 occupies the entire volume of the cavity 2354. The bladder 2358 is entirely filled with a substantially incompressible liquid such as hydraulic fluid 2360. In operation, the exposed, lower wall 2362 of the bladder 2358 acts upon the upper surface of a work piece blank 2364 disposed immediately there below.

The hydraulic fluid 2360 in the bladder 2358 is selectively pressurized/de-pressurized from a reservoir 2366 fluidly coupled with the bladder 2358 via a sealed feed line 2368. A piston 2370 is displacable within the reservoir 2366 to effect the controlled pressurization/de-pressurization of the bladder 2358 in response to a control valve 2374 fed by a pressure source 2372. A pressure sensor 2376 communicating with the bladder 2358 operates to sense and display the instantaneous pressure therein and provide a feedback signal to the control valve.

The lower die portion 2348 includes a bottom wall 2378 and upwardly extending peripheral side walls 2380 defining an upwardly opening cavity 2382 and serves as a lower blank holder 2384. A male punch 2386 is disposed within said walls 2380 and is displacable upwardly/downwardly. The upper surface 2388 of the male punch 2386 forms fixed contours and concavities which substantially mimic the basic "as molded" shape of the case 2206 of FIGS. 60-66. In the released position illustrated in FIG. 68, the male punch 2386 is in its fully-retracted, downward most position, with the bottom surface 2390 of the male punch 2386 in close proximity with bottom wall 2378. The variable volume extending between the bottom surface 2390 of the male punch 2386 and the inner bottom wall 2378 of the lower die portion 2348 defines a sealed cavity 2392. Cavity 2392 is filled with an incompressible liquid such as hydraulic fluid which is selectively pressurized/de-pressurized from a pressurized reservoir feed 2394 through a control valve 2396 interconnected with cavity 2392 through a sealed feed line 2398. Suitable controllers 2400 and 2402 provide control signals to activate, cycle and deactivate the hydroforming station 2342.

Referring to FIGS. 67 and 68, feedstock for the hydroform station 2342 consists of a continuous upper sheet 2404 of relatively rigid polymer material from upper roll 2332, a continuous lower sheet 2406 of relatively rigid polymer material from lower roll 2334, and a continuous intermediate sheet 2408 of conductive material (preferably perforated sheet or wire screen) from middle roll 2336. The three sheets are heated and rolled together at station 2340, forming a continuous sheet of at least partially coalesced composite, which enters the hydroforming station 2342 either as a continuous sheet or as work piece blank 2364. Although cutting, punching and trimming process steps are illustrated as taking place in a subsequent process step at station 2344, they can be implemented within the hydroforming station 2342 whereby, the continuous composite sheet material can be formed to net or final shape in the hydroform station 2342.

Referring to FIG. 68, the hydroforming station 2342 is illustrated at the beginning or first step of a cycle of operation. As illustrated, the fluid in both the upper and lower die portions 2346 and 2348, respectively, have their hydraulic fluids de-pressurized, whereby the bladder 2358 is fully drawn upwardly into the cavity 2354 of the upper die portion 2346 and the male punch 2386 is fully drawn downwardly into the

cavity 2382 of the lower die portion 2348. As indicated by arrow 2410, the upper and lower die portions 2346 and 2348, respectively, are vertically separated sufficiently to enable horizontal insertion of the work piece blank 2364 in register with the upper and lower blank holders 2356 and 2384, respectively.

Referring to FIG. 69, the hydroforming station 2342 is illustrated at the second step of a cycle of operation. As illustrated, the work piece blank 2364 has been registered with the upper and lower blank holders 2356 and 2384, respectively, and the upper and lower die portions 2346 and 2348, respectively, have been closed to clampingly engage the peripheral edge of work piece blank 2364. The fluid in the bladder 2358 in the upper die portion 2346 has been pressurized, whereby the lower bladder wall 2362 is distended downwardly at least partially into the cavity 2382 of the lower die portion 2348. In so doing, the lower bladder wall 2362 displaces the exposed portion of the work piece 2364 downwardly into at least partial engagement and conformance with the upper surface 2388 of the male punch 2386. This is accomplished by opening valve 2374 to drive piston 2370 to its downward most limit of travel, thereby injecting additional fluid into the bladder 2358. As indicated by the pressure sensor 2376, the pressure within the bladder 2358 has increased sufficiently to at least partially deform the work piece 2364.

Referring to FIG. 70, the hydroforming station 2342 is illustrated at the third step of a cycle of operation. As illustrated, the bladder 2358 remains fully charged with fluid and, simultaneously, control valve 2396 is opened by controller 2402, diverting pressurized fluid into sealed cavity 2392 through feed line 2398. As cavity 2392 fills, the male punch 2386 is forcefully displaced upwardly against the exposed lower surface of the work piece blank 2364 until the offsetting downward force applied by the fluid-filled bladder applies an offsetting force. In so doing, the lower bladder wall 2362 displaces the exposed portion of the work piece 2364 downwardly into complete engagement and conformance with the upper surface 2388 of the male punch 2386. As indicated by the pressure sensor 2376, the pressure within the bladder 2358 has increased sufficiently to fully deform the work piece 2364 into its final net shape.

Referring to FIG. 71, the hydroforming station 2342 is illustrated at the fourth step of a cycle of operation. As illustrated, the sealed cavity 2392 in the lower die portion 2348 has been drained, lowering the male punch 2386 back to its retracted position illustrated in FIG. 68. Simultaneously, the bladder 2358 has been partially drained with the fluid flowing back into the reservoir 2366, driving the piston 2370 back to its original position illustrated in FIG. 68. As indicated by the pressure sensor 2376, the pressure within the bladder 2358 has returned to its initial released value. Finally, the upper and lower die portions 2346 and 2348, respectively, have been opened to release the peripheral edge of work piece blank 2364 which has been transformed into a fully coalesced composite case 2412. Subsequently, the compression molded hydroformed case 2412 is horizontally removed from the hydroforming station 2342 and transferred to the trim-punch station 2344 (if required), and ultimately to the final assembly station 2346.

Referring to FIGS. 72-74, the coalescence process that takes place in the work piece blank 2346 during the process steps of FIGS. 68-71 is illustrated. FIG. 72 illustrates a representative broken segment of wire screen 2414 consisting of a number of substantially horizontal, spaced filaments 2416 and a number of substantially vertical, spaced filaments 2418 configured in a basket weave to form an array of openings or

interstices **2420** there between. It is contemplated that other weave types or, alternatively, an array of perforations formed in a sheet of conductive material can be employed in practicing the present invention.

Referring to FIG. **73**, a representative arrangement of an upper polymer sheet **2422**, a lower polymer sheet **2424** and an intermediate sheet of wire screen **2426** juxtaposed as fed into the roller station **2340** of FIG. **67** is illustrated. As illustrated, the upper and lower polymer sheets **2422** and **2424**, respectively, are not yet deformed, but may be adhered or bonded to one another by adhesive, welding, plating, coating or the like. The roller station **2340** presses the three sheets **2422**, **2424** and **2426** together in intimate surface contact as a "sandwich". The sheets **2422**, **2424** and **2426** may be partially deformed in this step, but retain their distinctive discrete appearance. During the next process steps (refer FIGS. **69** and **70**) the bladder **2358** applies high downward pressure to the entire exposed surface of the composite as indicated by an arrow **2428**. Simultaneously or subsequently, the male punch **2386** applies a high, substantially offsetting upward pressure to the entire exposed lower surface of the composite as indicated by an arrow **2430**.

Referring to FIG. **74**, the process affected by the hydroforming station **2342**, wherein the substantially discrete layers of the composite feed stock or work piece blank are compressed and reduced into a coalesced composite, is illustrated. An important aspect of the hydroforming process is that the individual filaments of the wire screen are reshaped during hydroforming from their original serpentine configuration to their final net form simultaneously as adjacent polymer material flows inwardly, encasing the elements in a unified structure. Because of this phenomena, the individual filaments are supported along their entire length, and are not unduly stressed and do not tend to undesirable localized necking, thinning or rupturing. FIG. **74** illustrates, in cartoon form, localized flow regions **4232** which extend inwardly from both polymer sheets through adjacent interstices and around the individual strands or filaments composing the wire mesh. Taking a macroscopic view, the discrete generally planar constituent sheets of polymer and conductive materials are locally selectively deformed by the hydroforming process in conformance with the concavities defined by the male punch while avoiding localized thinning or rupturing.

When inner and outer polymer sheets of nearly equal thickness are employed, the flow of the polymer material during the hydroforming process will result in the wire mesh being oriented substantially centrally in the resultant composite structure, with a knit line **2434** between the two polymer sheets being centered with the nominal center plane A-A of the wire mesh **2426**. In this condition, material from each of the two sheets of polymer material fully encases at least segments of the individual wire filaments, resulting in an extremely robust composite structure, which is not prone to delamination. Alternatively, with inner and outer polymer sheets of differing thickness, the flow of the polymer material during the hydroforming process will result in the wire mesh being oriented closer to the outer surface of the composite structure associated with the thinner polymer sheet. This can position the wire mesh, or a selected portion thereof adjacent a surface of the composite structure or actually exposed through.

Electronic assemblies typically contain a circuit board assembly that may have ground points from the circuit board to the enclosure. When the enclosure has been constructed of a non-metallic material such as plastic, the grounding and shielding has been provided by a variety of methods including, but not limited to using a metal wire mesh that is formed

and insert molded with the structure of the plastic enclosure (see FIG. **27**). Another method may include using localized shields that are assembled and soldered to the circuit board. (see U.S. Pat. Appln. No. 2009/0122507). However, this approach only provides a shield, not a ground. While plastic enclosures are desirable for manufacturing assembly simplification through the elimination of fasteners as well as weight reductions from metal enclosures, the capitalization to provide a wire mesh insert to a molded plastic part has been a drawback especially in low volume applications. Also, the manufacturing process flow has typically coupled the wire mesh insert fabrication cell directly with the plastic molding process, which may not be desired if the molding press utilization is not at a high enough percentage of the available press time. Another limitation of insert molding of wire mesh in plastic is the ability to check for the wire mesh presence or any anomalies after molding without using an X-ray or running a special translucent or clear material, which is not generally used for a typical application. For audio and navigation system assemblies, as the enclosure evolves away from containing a playback mechanism and the circuit board assemblies are integrated into a single circuit board that has to function as a key board and main board oriented for user interface, the insert molded wire mesh in plastic capability is limited by the tendency to avoid using the mesh in the trim plate portion of the package that is typically identified as a decorative part which is not conducive to receiving the wire mesh needed for the shield or ground aspect that may be required for the enclosure.

By molding wire mesh directly into a pliable material such as silicone rubber, a more efficient shielding and grounding component can be produced to provide a flexible member that can be incorporated within an enclosed system. This will provide a more efficient shielding and grounding capability by minimizing the amount of wire mesh needed to perform the same functions as a wire mesh insert molded in a plastic enclosure. This allows the grounding and shielding to be reduced to the direct area of the circuit board as opposed to the volumetric boundary of the actual enclosure around the circuit board, which may be larger to facilitate the inclusion of other features not relevant to the shielding or grounding. The pliable material has the capability to have molded features to enable assembly to the circuit board to ensure both a secure attachment of the part as well as a preassembled ground point contact that may be further enabled with the assembly into the mechanical structure of the enclosure (see FIG. **82**). These may, as an example, be a push/pull through style detail used in silicone rubber switch pads assembled by switch control boards (see FIG. **83**). Another example may be a molded groove that has exposed mesh to provide the interface for the contact from the ground point of the circuit board to the mesh that will be further enhanced when the mesh in the pliable material with the circuit board assembly is slid into the enclosure to where a compressive force is applied as the circuit board assembly is seated. The pliable material can also be used to provide stand-offs to prevent the wire mesh from contacting components on the circuit board as well as the material itself can be used to prevent contact of the wire mesh to areas of the circuit board that must remain insulated from the wire mesh.

Another advantage of the present invention, as an example, is if the pliable material is a silicone rubber and the rubber is produced in a compression mold, the mesh can be formed directly in the mold, eliminating having to use a forming station that is necessary with the insert molded wire mesh in plastic method.

The wire mesh in rubber may be constructed to encapsulate the circuit board assembly if necessary, but the more likely approach may be to cover the top with mesh and utilize a copper layer of the circuit board on the bottom and possibly plating the circuit board edges to provide the ground and shield for that portion of the assembly. This enables an easier assembly and reduces the mesh size. Also, any combination of layers and plated edges may be used to provide the best method according to the application as best determined by empirical testing.

The present invention enables separated shielding and grounding of multiple circuit board assemblies within an enclosure, if required. Also, the shielding provided by the present invention allows for removal and replacement in the event a circuit board component requires inspection or repair after assembly. With the silicone rubber material capability allowing for an almost clear or translucent appearance, the wire mesh can be inspected if required for presence or anomalies after the insert molding operation.

For a radio application or one where there may be a power device such as an amplifier on the circuit board that must be affixed with an external heat sink, the wire mesh in rubber approach can be designed to include an area of rubber that will provide the power device an interposer comprised of a special heat transfer compound much like a Sill Pad that will enable the heat transfer from the circuit board mounted device through the rubber to the heat sink component external to the enclosure. The thermally conductive rubber portion can be insert molded in the silicone rubber, just like the wire mesh to eliminate the addition of heat sink grease which is the typical approach for the assembly. Although in some cases it may be desired to simply provide an open area for the typical application of the heat sink grease to the device interface to the heat sink as a method for heat dissipation from the circuit board assembly.

Also, as stated before as the radio assembly evolves away from containing a playback mechanism and the separate circuit boards are integrated into a single board that functions as a key board and main board, the present invention offers the capability to provide the frontal shield that, if required, could be incorporated in the silicone rubber of the switch pad. The wire mesh can be removed during the die cut process in the switch dome areas to allow the switch contact and still provide an adequate shield for the circuit board on the front side if needed.

With an enclosure where a seal is needed, the rubber portion of the present invention can perform the duty of a seal with the correct orientation of the halves of the enclosure which provides less parts to fulfill the requirements of the assembly.

The assembly to the enclosure can be accomplished by several methods including direct connection to the circuit board as described earlier via push/pull throughs and the exposed mesh in a groove. The wire mesh with rubber component may also be loaded directly to the enclosure with features from the enclosure to help locate and capture the rubber such that the circuit board or boards requiring the shields and grounding can be assembled afterward.

Finally, besides the shielding and grounding capabilities, the rubber can provide rattle prevention and the compliant nature of the material enables less tolerance stack-up considerations by conforming to the non-compliant features of the assembly components.

Referring to FIGS. 75 and 76, a flexible enclosure assembly 2500 for insulating electronic circuit assemblies from electrical anomalies, is illustrated. Flexible enclosure assembly 2500 is formed by first die-cutting a preform 2502 con-

structed of electrically conductive sheet material such as wire mesh. The preform 2502 can be punch-formed from a continuous roll of stock in a preferably two-dimensional form. The preform 2502 is subsequently selectively insert molded within a framework 2504 of relatively flexible electrically insulating material such as silicone elastomeric material. The framework 2504 serves to form a peripheral frame portion 2506 enclosing the edges of the preform 2502 to prevent fraying or unraveling of conductive wire mesh strands. This prevents exposure of sharp preform edges during the assembly process and reduces the likelihood of electrical shorts in application. The framework 2504 further forms a base portion 2508 which is thicker, and somewhat more rigid than the peripheral frame portion 2506 and is configured for positioning and mounting an electronic circuit assembly 2510 (refer FIGS. 77 and 78) within the enclosure assembly 2500. The framework also forms ribs 2512 operative to rigidify the overall framework 2504, standoffs 2514 to ensure maintenance of minimum separation between the preform 2502 and electrically conductive components of the electronic circuit assembly 2510, and guide extensions 2516 operative to interact with the base portion 2508 to form one or more expanded cavities within the enclosure assembly 2010 after final assembly. The peripheral frame portion 2506, base portion 2508, ribs 2512, standoffs 2514 and guide extensions 2516 are integrally formed simultaneously from the same material such as silicone elastomeric material by injection molding. Alternatively, they can be molded by a multi-shot process wherein elastomeric material having differing properties (ex. durometer rating, thermal conductivity, and electrical conductivity) can be employed at different locations of the framework 2504. The ribs 2512 are positioned to extend between two spaced-apart locations of the framework 2504 to enhance localized stability while maintaining flexibility of the overall enclosure assembly 2500. The guide extensions 2516 are positioned to embrace locations of the electronic circuit assembly 2510 such as the substrate, PCB or circuit components carried thereon.

The peripheral frame portion 2506 and ribs 2512 have a nominal thickness of dimension "t", and the base portion 2508 has a nominal dimension "3t", whereby, in assembly, the electronic circuit assembly 2510 is matingly supported by the base portion 2508 and the thinner sectioned portions of the enclosure assembly resiliently conform around the electronic circuit assembly 2510.

The enclosure assembly 2500 forms a top half portion 2518 and a bottom half portion 2520, interconnected by a flexible interconnecting bridge or "living hinge" 2522 extending along axis W-W. The base portion 2508 is integrally formed in the bottom half 2520 of assembly 2500 and defines locating and engagement features 2524 for receiving locating tabs (not illustrated) extending from the electronic circuit assembly 2500, and through passages 2526 and recesses 2528 aligned to register with heat generating power devices in the electronic circuit assembly 2510 for enhanced ventilation.

The top half portion 2518 of the flexible enclosure assembly 2500 is dimensioned somewhat larger than the bottom half 2520, and forms leftwardly and rightwardly laterally extending side flaps 2530 and 2532, respectively, as well as a longitudinally extending end flap 2534. The side flaps 2536, 2538 and 2580 are integrally carried and extend from the upper portion 2518 of the preform 2502, interconnected through flexure axes Z, Y and X, respectively, in cantilevered fashion, terminating in free end portions. The top half portion 2518 forms a plurality of shaped openings 2536, 2538 and 2540, each surrounded by a peripheral frame portion 2542, 2544 and 2546, respectively. The shaped openings 2536,

**2538** and **2540**, each have the wire mesh removed to enable out-sized components carried on the electronic circuit assembly to extend there through. Further, each is dimensioned and shaped to closely conform with their associated out-sized component to minimize potential leakage of electrical anomalies. A peripheral frame portion **2546** defines the opening **2540** while enclosing the edge of the screen.

Referring to FIGS. **76-78**, a shielded electronic circuit assembly **2548** is completed by securing the fully-formed electronic circuit assembly **2510**, including a rigid substrate such as a printed circuit board (PCB) **2550**, to the base portion **2508** of the flexible enclosure assembly **2500**. Next, the top half portion **2518** of the flexible enclosure assembly **2500** is rotated nearly 180 degrees about living hinge **2522** axis W-W to fully cover the electronic circuit assembly **2510**. In so doing, outsized components, namely an electrical connector receptacle **2552**, an antenna lead connector receptacle **2554** and an electrolytic capacitor **2556** extend outwardly through their respective shaped openings **2536**, **2538** and **2540**, respectively.

The assembly of shielded electronic circuit assembly **2548** is completed by serially rotating the flaps **2534**, **2532** and **2530** 180 degrees about their respective living hinge axes X, Y and Z, whereby the outermost portions of flaps **2530**, **2532** and **2534** about the lowermost surface of the bottom half portion **2520** of the flexible enclosure assembly **2500**. The flaps **2530**, **2532** and **2534** are retained in their design intent position illustrated in FIG. **78** by double sided tape dressed along the lowermost surfaces of the peripheral frame portions of the flaps adhesively engaging the adjacent bottom surface of the bottom half portion **2520** of the flexible enclosure assembly **2500**. Alternatively, the flaps **2530**, **2532** and **2534** are retained in their design intent position illustrated in FIG. **78** by self-engaging cooperating latch features (not illustrated) formed in the flaps **2530**, **2532** and **2534** and the bottom half portion **2520** of the flexible enclosure assembly **2500**. During their 180 degree rotation, the flaps form relatively large radius or squared side walls to fully cover any gap or spacing between the top and bottom half portions, **2518** and **2520**, respectively.

FIGS. **77** and **78** illustrate a fully assembled shielded electronic circuit assembly **2548** ready for installation in a final application.

Referring to FIG. **79**, final assembly of the shielded electronic circuit assembly **2548** is effected by manual mating engagement with an operator accessible trim panel **2558**. The trim panel **2558** is constructed substantially as described herein above, with the exception that a rear surface closure member **2560** protectively encloses internal components of the trim panel **2558**. The closure member **2560** has an array of integrally formed lock tabs **2562** arranged to self-engage with the upper and lower side walls and outer surface of the shielded electronic circuit assembly **2548**. A multi-circuit plug **2564** extends through the closure member **2560** to matingly engage the circuit board connector assembly **2566** extending through the bottom half portion **2520** of the shielded electronic circuit assembly **2548** to complete the electrical interface between the shielded electronic circuit assembly **2548** and the trim panel **2558** circuitry. During final assembly, each lock tab **2562** registers with and engages an associated engagement surface **2568**. Accordingly, no separate fasteners are required to affect final assembly of the shielded electronic circuit assembly **2448** or interconnecting the shielded electronic circuit assembly **2448** with the trim panel **2558**. As illustrated, the electrical connector receptacle

**2552** and antenna lead connector receptacle **2554** face downwardly when the finalized assembly **2570** is installed within a host vehicle.

Referring to FIGS. **80** and **81**, an alternative application of the shielded electronic circuit assembly **2548** is illustrated wherein the shielded electronic circuit assembly **2548** of FIGS. **77** and **78** is installed remotely from any direct operator displays or controls. For such remote applications, the electronic circuit assembly **2548** is nestingly disposed within a substantially closed elastomeric housing consisting of a box-like case **2572** and a closure member **2574**. The rear wall **2576** of the case **2572** has first and second openings **2578** and **2580**, for receiving the electrical connector receptacle **2552** and antenna lead connector receptacle **2554**, respectively.

The case **2572** has integral abutment surfaces **2586** formed therein. The closure member **2574** has corresponding engagement tabs **2582** integrally formed therein. After the shielded electronic circuit assembly **2548** is nestingly disposed within the case **2572**, the closure member **2574** is installed by the snap action and self-engagement of the engagement tabs **2582** and corresponding engagement surfaces **2584**. Again, no separate fasteners are required to affect final assembly. Lastly, the remote assembly **2586** is adapted for in-vehicle installation via slip-fit mounting features **2588** integrally formed on the bottom surface **2590** of the case **2572**.

Referring to FIG. **82**, an alternative embodiment of the present invention employs an electronic circuit assembly **2592** including a printed circuit board **2594** with an electrically conductive sheet **2596** mounted on the lower surface of the PCB **2594**. The conductive sheet **2596** can be copper sheet, wire mesh or the like. The upper surface of the PCB **2594**, as well as electronic componentry **2598** carried on the PCB **2594** is isolated from external electrical anomalies by a closed flexible wire mesh box **2600**, in combination with the conductive sheet **2596**. The closed flexible wire mesh box **2600** has a top wall **2602** integrally formed with side walls **2604** extending about the perimeter of the top wall **2602**. The closed flexible wire mesh box **2600** is locally rigidified by a being insert molded within framework **2606** of relatively flexible electrically insulating material such as silicone elastomeric material. The framework **2606** serves to form a peripheral frame portion **2608** enclosing the edges of the wire mesh preform to prevent fraying or unraveling of conductive wire mesh strands. This prevents exposure of sharp preform edges during the assembly process and reduces the likelihood of electrical shorts in application. The framework **2606** also forms a corner-edge frame portion **2610** extending along the edges and corners formed between adjacent top and side walls **2602** and **2604**, respectively, as well as localized extensions/standoffs **2612** keeping hot or electrically conductive components **2598** spaced from adjacent wire mesh. The type of elastomeric material employed in such locations can be thermally conductive or thermally insulative.

The lowermost portion of the side walls **2604** forms integral outwardly directed wire mesh flanges **2614** also insert molded within the peripheral frame portion **2608** normally to the adjacent side wall **2604**. The flanges **2614** register with a ground pad or contacts **2616** formed on the upper surface of the PCB **2574** to ensure that the closed flexible wire mesh box **2600** is robustly electrically grounded. Alternatively, the wire mesh box **2600** can, if required, be electrically biased by a conductive lead from the associated electronic circuit assembly **2510**. The peripheral frame portion **2608** extends outwardly beyond the adjacent edge surface **2618** of the PCB **2594** and terminates in an upwardly and downwardly integral locating flange **2620**. The locating flange serves to positionally align and lockingly register the closed flexible wire mesh

box **2600** with the associated PCB **2594**. The locating flange **2620** is integrally interconnected with the peripheral frame portion **2608** by an intermediate neck region.

During final assembly of the electronic circuit assembly **2592**, the combined outermost portions of the PCB **2594** and peripheral frame portion **2608** of the subassembly of the closed flexible wire mesh box **2600** and the PCB **2594** is compression-fit within an inwardly opening C-shaped rigid retention channel **2624** formed in an associated mount or housing **2626**. The retention channel **2624** is dimensioned to ensure that the housing **2626** applies continuous compressive loading downwardly against the elastomeric neck region **2622** and upwardly against the bottom surface of the PCB **2594** as indicated by arrows **2628** and **2630**, respectively.

Referring to the previously described embodiments of the invention as reflected in FIG. **79** and FIGS. **80-81**, the continuous compressive loading of the shielded electronic circuit subassembly **2548** (illustrated in FIGS. **77** and **78**), is affected, as in the case of the embodiment of FIG. **82**. In the case of the embodiment illustrated in FIG. **79**, the four lock tabs **4562** simultaneously engage their respective engagement surfaces **2568** in the shielded electronic circuit subassembly **2548** after it is pressed downwardly into engagement with the trim panel **2558**, compressing the silicone elastomeric material making up the framework **2504**. These compressive forces, maintain the flaps **2530**, **2532** and **2534** in their design intent positions illustrated in FIG. **78**. In the case of the embodiment illustrated in FIGS. **80** and **81**, the shielded electronic circuit subassembly **2548** is compressed as it is being installed within the case **2572**. After final assembly, a degree of residual compressive forces on the silicone elastomeric material making up the framework **2504** will remain. These compressive forces also maintain the flaps **2530**, **2532** and **2534** in their design intent positions illustrated in FIG. **78**.

Referring to FIG. **83**, another feature of the present invention is illustrated. A peripheral frame portion **2632** of silicone elastomeric material has a wire mesh preform **2634** insert molded therein, which overlays the upper surface of a PCB **2636**. An elongated push/pull through feature **2638** dimensioned for interference with and extending through a through passage **2640** formed in the PCB **2636** (and adjacent wire mesh preform **2634**) is integrally formed with the peripheral frame portion **2632**. This provides a simple and inexpensive, yet tenacious point of interconnection between the peripheral frame portion **2632** and associated PCB **2636** that can be easily removed for servicing and/or replacement.

Many types of molded silicone elastomeric material can be employed in practicing the present invention. It is envisioned that a single type of homogenous material having a mid-range durometer Shore A rating can be successfully employed in insert molding the wire mesh preform within the framework described in connection with FIGS. **75-78** described herein above. However, with the utilization of more sophisticated multi-shot molding techniques, a more utilitarian framework structure can be achieved.

Referring to FIG. **84**, a wire mesh preform **2642** can be insert molded within a foldable framework **2644** to form a tailored flexible enclosure assembly **2646**. Regions **2648** and **2650** which, in application, do not require significant amounts of flexure or resilience, can be formed from a more rigid material, such as 75 durometer Shore A. Region **2652** which, in application, requires a significant degree of flexure or resilience, can be formed from a less rigid material, such as 45 durometer Shore A. Furthermore, the thickness of the silicone elastomeric material within region **2652** can be thinned to define a living hinge **2654** to better define specific

folding axes. The specified durometer ratings follow the ASTM D2000 classification standard.

Referring to FIG. **85**, a switch pad dome **2656** can be incorporated within a flexible enclosure assembly **2658** mounted on the upper surface of a PCB **2660**. A conductive sheet **2662** of copper, wire mesh or the like is affixed to the lower surface of the PCB **2660**. A wire mesh preform **2664** is insert molded within a framework **2666** mounted to the upper surface of the PCB **2660**. A frusto-conically shaped region **2668** extends above the upper surface of the PCB **2660** to form the switch "dome". This region **2668** which, in application, requires a significant degree of flexure or resilience, can be formed from a less rigid material, such as 45 durometer Shore A. A circumferentially surrounding region **2670** which, in application, do not require significant amounts of flexure or resilience, can be formed from a more rigid material, such as 75 durometer Shore A. A circle of wire mesh, concentric with the switch pad dome **2656**, is removed to enable switch contacts to function. A first electrical contact **2672** is affixed to the inner surface **2674** of the apex **2674** of the dome **2656** for manual displacement there with. The outer surface **2676** of the apex **2674** of the dome **2656** defines a switch actuation point. A second electrical contact **2678** is fixedly attached to the upper surface of the PCB **2660** in line of displacement of the first contact **2672**.

It is to be understood that the invention has been described with reference to specific embodiments and variations to provide the features and advantages previously described and that the embodiments are susceptible of modification as will be apparent to those skilled in the art.

Furthermore, it is contemplated that many alternative, common inexpensive materials can be employed to construct the basis constituent components. Accordingly, the forgoing is not to be construed in a limiting sense.

The invention has been described in an illustrative manner, and it is to be understood that the terminology, which has been used is intended to be in the nature of words of description rather than of limitation.

Obviously, many modifications and variations of the present invention are possible in light of the above teachings. It is, therefore, to be understood that within the scope of the appended claims, wherein reference numerals are merely for illustrative purposes and convenience and are not in any way limiting, the invention, which is defined by the following claims as interpreted according to the principles of patent law, including the Doctrine of Equivalents, may be practiced otherwise than is specifically described.

What is claimed:

1. A flexible enclosure assembly configurable to envelop an electronic circuit assembly to shield electronic circuit assembly components from electrical anomalies, said flexible enclosure assembly comprising:

a preform blank formed of pliable electrically conductive sheet material shaped to define upper and lower closure portions integrally interconnected along a first hinge axis, and a plurality of sidewall closure portions, each said sidewall closure portion integrally interconnected with said upper closure portion along a related discrete dedicated hinge axis;

a framework formed of resilient elastomeric material insert molded over selected portions of said preform blank, said framework comprising a base portion operative to mountingly engage said electronic circuit assembly; and means operative to secure a free end of each said sidewall closure portion to said lower closure portion.

2. The flexible enclosure assembly of claim 1, wherein said means operative to secure the free end of each said sidewall

closure portion to said lower closure portion comprises a relatively rigid external mounting structure operative to continuously compressively load said flexible enclosure assembly.

3. The flexible enclosure assembly of claim 2, wherein said relatively rigid external mounting structure comprises an audio system trim panel.

4. The flexible enclosure assembly of claim 2, wherein said relatively rigid external mounting structure comprises a substantially closed housing assembly.

5. The flexible enclosure assembly of claim 1, wherein said framework cooperates with said preform blank to form living hinges along each said axis.

6. The flexible enclosure assembly of claim 1, wherein said preform blank is formed from electrically conductive wire mesh.

7. The flexible enclosure assembly of claim 1, wherein said elastomeric material comprises natural silicone rubber or neoprene based material having a characteristic range of 45-75 durometer Shore A.

8. The flexible enclosure assembly of claim 1, wherein said framework comprises a peripheral frame portion extending circumferentially about and enclosing the exposed edges of the upper and lower closure portions and the sidewall closure portions of said preform blank.

9. The flexible enclosure assembly of claim 1, wherein said framework comprises at least one rib portion extending between opposed locations of said peripheral frame portion.

10. The flexible enclosure assembly of claim 1, wherein said framework comprises elongated guide extensions formed in said upper closure portion and extending downwardly therefrom to engage registering features of an electronic circuit assembly substrate or upstanding components.

11. The flexible enclosure assembly of claim 1, wherein said framework comprises a standoff formed in said upper closure portion and extending downwardly therefrom to ensure spacing maintenance between said upper and lower closure portions and any intermediate electronic circuit assembly components.

12. The flexible enclosure assembly of claim 1, wherein said framework comprises at least one opening formed in said upper closure portion, wherein said opening is configured and dimensioned to receive an outsize electrical component mounted on said electronic circuit assembly and extending outwardly through said opening.

13. The flexible enclosure assembly of claim 1, wherein said outsize electrical component comprises an electrical and/or antenna connector receptacle.

14. The flexible enclosure assembly of claim 1, wherein said preform blank is configured for electrical interconnection with a ground circuit within said electronic circuit assembly.

15. The flexible enclosure assembly of claim 1, wherein said elastomeric material is transparent or translucent.

16. The flexible enclosure assembly of claim 1, wherein said preform blank is electrically isolated from conductive elements of said electronic circuit assembly.

17. The flexible enclosure assembly of claim 1, wherein said preform blank is electrically biased said electronic circuit assembly.

18. The flexible enclosure assembly of claim 1, wherein said electronic circuit assembly comprises a circuit board or substrate supporting electrical components and conductive traces comprising an electrical circuit.

19. The flexible enclosure assembly of claim 1, wherein one portion of said framework employs elastomeric material having a first, relatively high thermal resistance value and a second portion of said framework employs elastomeric material having a second, relatively low characteristic thermal resistance value.

20. The flexible enclosure assembly of claim 19, wherein said second, thermally conductive framework portion is disposed near a heat sink portion of a power device in said electronic circuit assembly.

21. The flexible enclosure assembly of claim 20, wherein said thermally conductive framework portion contains conductive material therein.

22. A method of fabricating an electronic apparatus in a shielded housing, said method comprising the steps of:

forming a sheet of composite material comprising at least one layer of pliable electrically conductive material capable of providing electromagnetic shielding partially insert molded within a framework formed of relatively pliable elastomeric material, and said sheet defining a plurality of wall panels interconnected by bendable regions, at least one of said wall panels having an engagement feature formed therewith;

locating said electronic apparatus adjacent to at least one of said wall panels;

folding said wall panels along said bendable regions to form said shielded housing; and engaging said engagement feature to retain said shielded housing in a three-dimensional configuration.

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